

ARM7<sup>TM</sup> Soft IP Support in ProASIC3 ARM7-Ready Devices



# **Features and Benefits**

### High Capacity

- 30 k to 1 Million System Gates Up to 144 kbits of True Dual-Port SRAM
- Up to 300 User I/Os

### Reprogrammable Flash Technology

- 130-nm, 7-Layer Metal (6 Copper), Flash-Based CMOS Process
- Live At Power-Up (LAPU) Level 0 Support
- Single-Chip Solution
- Retains Programmed Design When Powered Off
- **On-Chip User Nonvolatile Memory** 
  - 1 kbit of FlashROM (FROM)

### **High Performance**

- 350 MHz System Performance
- 3.3 V, 66 MHz 64-Bit PCI (except A3P030)

### In-System Programming (ISP) and Security

- Secure ISP Using On-Chip 128-Bit Advanced Encryption Standard (AES) Decryption (except A3P030) via JTAG (IEEE1532-compliant) FlashLock<sup>®</sup> to Secure FPGA Contents

### Low Power

- 1.5 V Core Voltage for Low Power Support for 1.5-V-Only Systems
- Low-Impedance Flash Switches

### High-Performance Routing Hierarchy

- Segmented, Hierarchical Routing and Clock Structure
- Ultra-Fast Local and Long-Line Network
- Enhanced High-Speed, Very-Long-Line Network
- High-Performance, Low-Skew Global Network

#### Table 1 • ProASIC3 Product Family

- Architecture Supports Ultra-High Utilization Advanced I/O
  - 700 Mbps DDR, LVDS-Capable I/Os (A3P250 and above)
  - 1.5 V, 1.8 V, 2.5 V, and 3.3 V Mixed-Voltage Operation
  - Bank-Selectable I/O Voltages Up to 4 Banks per Chip •
  - Single-Ended I/O Standards: LVTTL, LVCMOS 3.3 V/ 2.5 V/ 1.8 V/1.5 V, 3.3 V PCI/3.3 V PCI-X (except A3P030), and LVCMOS 2.5 V/5.0 V Input
  - Differential I/O Standards: LVPECL and LVDS (A3P250 and above)
  - I/O Registers on Input, Output, and Enable Paths
  - Hot-Swappable and Cold Sparing I/Os (A3P030 only)
  - Programmable Output Slew Rate (except A3P030) and Drive Strength

  - Weak Pull-Up/Down IEEE1149.1 (JTAG) Boundary Scan Test
  - Pin-Compatible Packages Across the ProASIC3 Family

#### Clock Conditioning Circuit (CCC) and PLL (except A3P030)

- Six CCC Blocks, One with an Integrated PLL
- Flexible Phase-Shift, Multiply/Divide, and Delay Capabilities
- Wide Input Frequency Range (1.5 MHz to 350 MHz)

### SRAMs and FIFOs (except A3P030)

- Variable-Aspect Ratio 4,608-Bit RAM Blocks (x1, x2, x4, x9, x18 Organizations Available)
- True Dual-Port SRAM (except x18)
- 24 SRAM and FIFO Configurations with Synchronous Operation up to 350 MHz

#### **ARM7** Processor

Soft Core Support in ARM7-Ready Devices

ProASIC3 Devices	A3P030	A3P060	A3P125	A3P250	A3P400	A3P600	A3P1000
ARM7-Ready ProASIC3 Devices <sup>1</sup>				M7A3P250	M7A3P400	M7A3P600	M7A3P1000
System Gates	30 k	60 k	125 k	250 k	400 k	600 k	1 M
VersaTiles (D-Flip-Flops)	768	1,536	3,072	6,144	9,216	13,824	24,576
RAM kbits (1,024 bits)	-	18	36	36	54	108	144
4,608 Bit Blocks	-	4	8	8	12	24	32
FlashROM (FROM) Bits	1 k	1 k	1 k	1 k	1 k	1 k	1 k
Secure (AES) ISP <sup>2</sup>	-	Yes	Yes	Yes	Yes	Yes	Yes
Integrated PLL in CCCs	-	1	1	1	1	1	1
VersaNet Globals <sup>3</sup>	6	18	18	18	18	18	18
I/O Banks	2	2	2	4	4	4	4
Maximum User I/Os	81	96	133	157	194	227	300
Package Pins QFN VQFP TQFP PQFP FBGA	QN132 VQ100	VQ100 TQ144 FG144	VQ100 TQ144 PQ208 FG144	VQ100 PQ208 FG144, FG256 <sup>5</sup>	PQ208 FG144, FG256, FG484	PQ208 FG144, FG256, FG484	PQ208 FG144, FG256, FG484

#### Notes:

1. Refer to the CoreMP7 datasheet for more information.

AES is not available for ARM7-ready ProASIC3 devices. 2

Six chip (main) and three guadrant global networks are available for A3P060 and above. 3

For higher densities and support of additional features, refer to the ProASIC3E Flash FPGAs datasheet. 4.

This package is not supported for the M7A3P250 device. 5.

# I/Os Per Package

ProASIC3 Devices	A3P030	A3P060	A3P125	A3P	250 <sup>2</sup>	A3P4	100 <sup>2</sup>	A3P	600	A3P	1000
ARM7-Ready ProASIC3 Devices				M7A3	8P250 <sup>4</sup>	M7A3	3P400	M7A3	3P600	M7A3	P1000
Package	Single-Ended I/O	Single-Ended I/O	Single-Ended I/O	Single-Ended I/O <sup>1</sup>	Differential I/O Pairs						
QN132	81	_	-	_	-	_	-		-	-	—
VQ100	79	71	71	68	13	_	-		-	-	-
TQ144	-	91	100	-	-	_	-	-	_	-	-
PQ208	-	-	133	151	34	151	33	154	35	154	35
FG144	-	96	97	97	24	97	24	97	24	97	25
FG256	-	-	-	157	38	178	38	179	45	177	44
FG484	-	_	_	_	_	194	38	227	56	300	74

### Notes:

1. Each used differential I/O pair reduces the number of single-ended I/Os available by two.

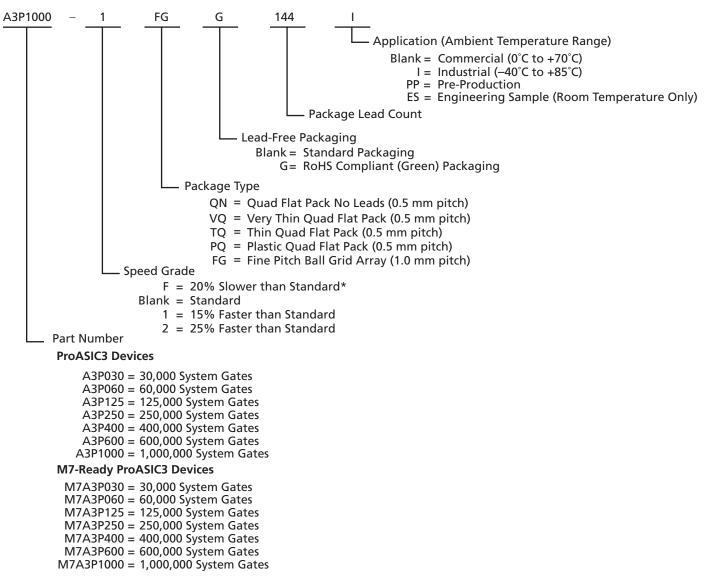
2. For A3P250 and A3P400 devices, the maximum number of LVPECL pairs in east and west banks cannot exceed 15. Refer to "Package Pin Assignments" starting on page 4-1 for position assignments of the 15 LVPECL pairs.

3. FG256 and FG484 are footprint-compatible packages.

4. The FG256 package is not supported for the M7A3P250 device.



# **ProASIC3 Ordering Information**



**Note:** \*–F Speed Grade – DC and switching based only on simulation. The characteristics are subject to change after establishing FPGA specifications. Some restrictions might be added and will be reflected in future revisions of this document. This speed grade is only supported in commercial temperature range.

# **Temperature Grade Offerings**

	A3P030	A3P060	A3P125	A3P250	A3P400	A3P600	A3P1000
Package				M7A3P250	M7A3P400	M7A3P600	M7A3P1000
QN132	C, I	-	-	-	_	_	-
VQ100	C, I	C, I	С, І	С, І	_	_	-
TQ144	-	C, I	С, І	-	_	_	-
PQ208	-	-	С, І	С, І	C, I	C, I	C, I
FG144	-	C, I	С, І	С, І	C, I	C, I	C, I
FG256	-	-	-	C, I	C, I	C, I	C, I
FG484	-	-	-	-	C, I	C, I	C, I

**Note:** C = Commercial Temperature Range: 0°C to 70°C AmbientI = Industrial Temperature Range: -40°C to 85°C Ambient

# **Speed Grade and Temperature Grade Matrix**

	-F <sup>3</sup>	Std.	-1	-2
С	✓	✓	1	$\checkmark$
I	_	1	1	$\checkmark$

Notes:

- 1. C = Commercial Temperature Range: 0°C to 70°C Ambient
- 2. I = Industrial Temperature Range: -40°C to 85°C Ambient

3. DC and switching characteristics for –F speed grade targets based only on simulation. The characteristics provided for –F speed grade are subject to change after establishing FPGA specifications. Some restrictions might be added and will be reflected in future revisions of this document. The –F speed grade is only supported in commercial temperature range.

Datasheet references made to ProASIC3 devices also apply to ARM7-ready ProASIC3 devices. The part numbers start with M7.

Contact your local Actel representative for device availability (http://www.actel.com/contact/offices/index.html).



# **Device Architecture**

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## Package Pin Assignments

132-Pin	QFN .	• •	• •	·	 •	 • •	 •	 •	• •	• •	• •	•••	• •		•	 •	• •	•	• •	 •	• •	·	• •	•	• •	•	 • •	• •	• •	-	•	4-1
100-Pin	VQFP	• •			 •	 • •	 •	 •		• •	• •	• •	•	• •		 •		•	• •								 • •	• •		•		4-2
144-Pin	TQFP	• •			 •	 • •	 •	 •		• •	• •	• •	•	• •		 •		•	• •								 • •	• •				4-6
208-Pin	PQFP	• •			 •	 • •	 •	 •		• •	• •	• •	•	• •		 •		•	• •								 • •	• •		•	4	-11
144-Pin																																
256-Pin	FBGA				 •	 	 •	 •					• •					•				•		•			 	• •		•	4	-29
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# **Introduction and Overview**

# **General Description**

ProASIC3, the third-generation family of Actel Flash FPGAs, offers performance, density, and features beyond those of the ProASIC<sup>PLUS®</sup> family. The nonvolatile Flash technology gives ProASIC3 devices the advantage of being a secure, low-power, single-chip solution that is live at power-up. ProASIC3 is reprogrammable and offers time-to-market benefits at an ASIC-level unit cost. These features enable designers to create high-density systems using existing ASIC or FPGA design flows and tools.

ProASIC3 devices offer 1 kbit of on-chip, programmable, nonvolatile FlashROM (FROM) memory storage as well as clock conditioning circuitry based on an integrated phase-locked loop (PLL). The A3P030 device has no PLL or RAM support. ProASIC3 devices have up to 1 million system gates, supported with up to 144 kbits of true dual-port SRAM, and up to 288 user I/Os.

ProASIC3 devices support the ARM7 soft IP core in devices with at least 250 k system gates. The ARM7-ready devices have Actel ordering numbers that begin with M7A3P and do not support AES decryption.

# Flash Advantages

### **Reduced Cost of Ownership**

Advantages to the designer extend beyond low-unit cost, performance, and ease of use. Unlike SRAM-based FPGAs, the Flash-based ProASIC3 devices allow for all functionality to be live at power-up; no external boot PROM is required. On-board security mechanisms prevent access to all the programming information and enable secure remote updates of the FPGA logic. Designers can perform secure remote in-system reprogramming to support future design iterations and field upgrades with confidence that valuable intellectual property (IP) cannot be compromised or copied. Secure ISP can be performed using the industry-standard AES algorithm. The ProASIC3 family device architecture mitigates the need for ASIC migration at higher user volumes. This makes the ProASIC3 family a cost-effective ASIC replacement solution, especially for applications in the consumer, networking/communications, computing, and avionics markets.

### Security

The nonvolatile, Flash-based ProASIC3 devices require no boot PROM, so there is no vulnerable external bitstream that can be easily copied. ProASIC3 devices incorporate FlashLock, which provides a unique combination of reprogrammability and design security without external overhead, advantages that only an FPGA with nonvolatile, Flash programming can offer.

ProASIC3 devices utilize a 128-bit Flash-based lock and a separate AES key to secure programmed intellectual property and configuration data. In addition, all FROM data in the ProASIC3 devices can be encrypted prior to loading, using the industry-leading AES-128 (FIPS192) bit block cipher encryption standard. The AES standard was adopted by the National Institute of Standards and Technology (NIST) in 2000, and replaces the 1977 DES standard. ProASIC3 devices have a built-in AES decryption engine and a Flash-based AES key that make them the most comprehensive programmable logic device security solution available today. ProASIC3 devices with AES-based security allow for secure, remote field updates over public networks such as the Internet, and ensure that valuable IP remains out of the hands of system overbuilders, system cloners, and IP thieves. The contents of a programmed ProASIC3 device cannot be read back, although secure design verification is possible.

ARM7-ready ProASIC3 devices support all security measures except for AES decryption.

Security, built into the FPGA fabric, is an inherent component of the ProASIC3 family. The Flash cells are located beneath seven metal layers, and many device design and layout techniques have been used to make invasive attacks extremely difficult. ProASIC3, with FlashLock and AES security, is unique in being highly resistant to both invasive and noninvasive attacks. Your valuable IP is protected and secure, making remote ISP possible. A ProASIC3 device provides the most impenetrable security for programmable logic designs.

## **Single Chip**

Flash-based FPGAs store the configuration information in on-chip Flash cells. Once programmed, the configuration data is an inherent part of the FPGA structure and no external configuration data needs to be loaded at system power-up (unlike SRAM-based FPGAs). Therefore, Flashbased ProASIC3 FPGAs do not require system configuration components such as EEPROMs or microcontrollers to load the device configuration data. This reduces bill-of-materials costs and printed circuit board (PCB) area, and increases security and system reliability.

### Live at Power-Up

The Actel Flash-based ProASIC3 devices support Level 0 of the live at power-up (LAPU) classification standard. This feature helps in system component initialization, execution of critical tasks before the processor wakes up, setup and configuration of memory blocks, clock generation, and bus activity management. The LAPU feature of Flash-based ProASIC3 devices greatly simplifies total system design and reduces total system cost, often eliminating the need for Complex Programmable Logic Devices (CPLDs) and clock generation PLLs that are used for this purpose in a system. In addition, glitches and brownouts in system power will not corrupt the ProASIC3 device's Flash configuration, and unlike SRAMbased FPGAs, the device will not have to be reloaded when system power is restored. This enables the reduction or complete removal of the configuration PROM, expensive voltage monitor, brownout detection, and clock generator devices from the PCB design. Flashbased ProASIC3 devices simplify total system design, and reduce cost and design risk, while increasing system reliability and improving system initialization time.

**Refer to the** "I/O Power-Up and Supply Voltage Thresholds for Power-On Reset (Commercial and Industrial)" section on page 3-3.

### **Firm Errors**

Firm errors occur most commonly when high-energy neutrons, generated in the upper atmosphere, strike a configuration cell of an SRAM FPGA. The energy of the collision can change the state of the configuration cell and thus change the logic, routing, or I/O behavior in an unpredictable way. These errors are impossible to prevent in SRAM FPGAs. The consequence of this type of error can be a complete system failure. Firm errors do not exist in the configuration memory of ProASIC3 Flashbased FPGAs. Once it is programmed, the Flash cell configuration element of ProASIC3 FPGAs cannot be altered by high-energy neutrons and is therefore immune to them. Recoverable (or soft) errors occur in the user data SRAM of all FPGA devices. These can easily be mitigated by using error detection and correction (EDAC) circuitry built into the FPGA fabric.

### **Low Power**

Flash-based ProASIC3 devices exhibit power characteristics similar to an ASIC, making them an ideal choice for power-sensitive applications. ProASIC3 devices have only a very limited power-on current surge, and no high-current transition period, both of which occur on many FPGAs.

ProASIC3 devices also have low dynamic power consumption to further maximize power savings.

# **Advanced Flash Technology**

The ProASIC3 family offers many benefits, including nonvolatility and reprogrammability through an advanced Flash-based, 130-nm LVCMOS process with seven layers of metal. Standard CMOS design techniques are used to implement logic and control functions. The combination of fine granularity, enhanced flexible routing resources, and abundant Flash switches allows for very high logic utilization without compromising device routability or performance. Logic functions within the device are interconnected through a four-level routing hierarchy.

## **Advanced Architecture**

The proprietary ProASIC3 architecture provides granularity comparable to standard-cell ASICs. The ProASIC3 device consists of five distinct and programmable architectural features (Figure 1-1 on page 1-3 and Figure 1-2 on page 1-3):

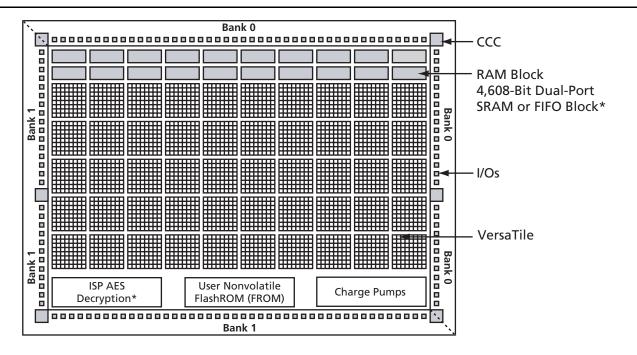
- FPGA VersaTiles
- Dedicated FlashROM (FROM) memory
- Dedicated SRAM/FIFO memory<sup>1</sup>
- Extensive clock conditioning circuitry (CCC) and  $\ensuremath{\mathsf{PLLs}}^1$
- Advanced I/O structure

The FPGA core consists of a sea of VersaTiles. Each VersaTile can be configured as a three-input logic function or as a D-flip-flop (with or without enable), or as a latch by programming the appropriate Flash switch interconnections. The versatility of the ProASIC3 core tile as either a three-input look-up-table (LUT) equivalent or as a D-flip-flop/latch with enable allows for efficient use of the FPGA fabric. The VersaTile capability is unique to the Actel ProASIC families of Flash-based FPGAs. VersaTiles are connected with any of the four levels of routing hierarchy. Flash switches are distributed throughout the device to provide nonvolatile, reconfigurable interconnect programming. Maximum core utilization is possible for virtually any design.

In addition, extensive on-chip programming circuitry allows for rapid, single-voltage (3.3 V) programming of the ProASIC3 devices via an IEEE1532 JTAG interface.

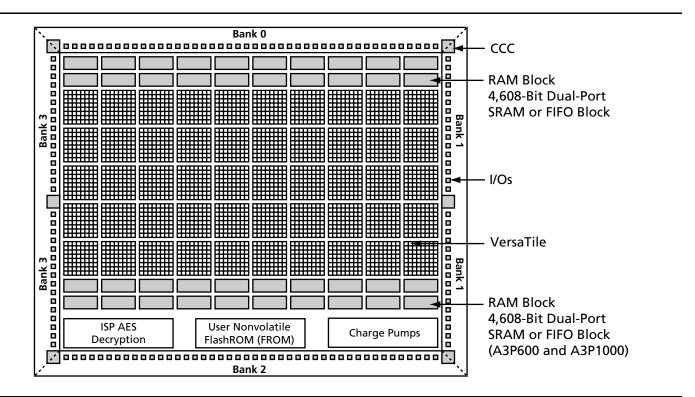
<sup>1.</sup> The APA030 does not support PLL and SRAM.





#### *Note:* \*Not supported by A3P030.

Figure 1-1 • Device Architecture Overview with Two I/O Banks (A3P030, A3P060, A3P125)



*Figure 1-2* • Device Architecture Overview with Four I/O Banks (A3P250, A3P400, A3P600, and A3P1000)

## VersaTiles

The ProASIC3 core consists of VersaTiles, which have been enhanced from the ProASIC<sup>PLUS</sup> core tiles. The ProASIC3 VersaTile supports the following:

- All three-input logic functions LUT-3 equivalent
- Latch with clear or set
- D-flip-flop with clear or set
- Enable D-flip-flop with clear or set

Refer to Figure 1-3 for VersaTile configurations.

For more information about VersaTiles, refer to the "VersaTile" section on page 2-2.

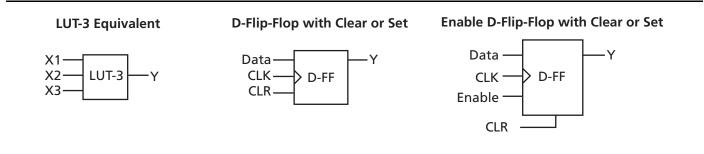


Figure 1-3 • VersaTile Configurations

### User Nonvolatile FlashROM (FROM)

Actel ProASIC3 devices have 1 kbit of on-chip, useraccessible, nonvolatile FlashROM (FROM). The FROM can be used in diverse system applications:

- Internet protocol addressing (wireless or fixed)
- System calibration settings
- Device serialization and/or inventory control
- Subscription-based business models (for example, set-top boxes)
- Secure key storage for secure communications algorithms
- Asset management/tracking
- Date stamping
- Version management

The FROM is written using the standard ProASIC3 IEEE1532 JTAG programming interface. The core can be individually programmed (erased and written), and onchip AES decryption can be used selectively to securely load data over public networks (except in the A3P030 device), such as security keys stored in the FROM for a user design.

The FROM can be programmed via the JTAG programming interface, and its contents can be read back either through the JTAG programming interface or via direct FPGA core addressing. Note that the FROM can ONLY be programmed from the JTAG interface, and cannot be programmed from the internal logic array.

The FROM is programmed as 8 banks of 128 bits; however, reading is performed on a random byte-by-

byte basis. A 7-bit address from the FPGA core defines which of the 8 banks and which of the 16 bytes within that bank are being read. The three most significant bits (MSBs) of the FROM address determine the bank, and the four least significant bits (LSBs) of the FROM address define the byte.

The Actel ProASIC3 development software solutions, Libero<sup>®</sup> Integrated Design Environment (IDE) and Designer v6.1 or later, have extensive support for the FROM memory. One such feature is auto-generation of sequential programming files for applications requiring a unique serial number in each part. The second part allows the inclusion of static data for system version control. Data for the FROM can be generated quickly and easily using Actel Libero IDE and Designer software tools. Comprehensive programming file support is also included to allow for easy programming of large numbers of parts with differing FROM contents.

## **SRAM and FIFO**

ProASIC3 devices (except in the A3P030 device) have embedded SRAM blocks along the north and south sides of the device. Each variable-aspect-ratio SRAM block is 4,608 bits in size. Available memory configurations are 256x18, 512x9, 1kx4, 2kx2, or 4kx1 bits. The individual blocks have independent read and write ports that can be configured with different bit widths on each port. For example, data can be sent through a 4-bit port and read as a single bitstream. The embedded SRAM blocks can be initialized via the device JTAG port (ROM emulation mode), using the UJTAG macro (except for the A3P030



device). For more information, refer to the application note, *UJTAG Applications in ProASIC3/E Devices*.

In addition, every SRAM block has an embedded FIFO control unit. The control unit allows the SRAM block to be configured as a synchronous FIFO without using additional core VersaTiles. The FIFO width and depth are programmable. The FIFO also features programmable Almost-Empty (AEMPTY) and Almost-Full (AFULL) flags in addition to the normal Empty and Full flags. The embedded FIFO control unit contains the counters necessary for the generation of the read and write address pointers. The embedded SRAM/FIFO blocks can be cascaded to create larger configurations.

## PLL and Clock Conditioning Circuitry (CCC)

ProASIC3 devices provide designers with very flexible clock conditioning capabilities. Each member of the ProASIC3 family contains six CCCs. One CCC (center west side) has a PLL (Figure 2-10 on page 2-11). The A3P030 does not have a PLL.

The six CCC blocks are located in the four corners and the centers of the east and west sides.

All six CCC blocks are usable; the four corner CCCs and the east CCC allow simple clock delay operations as well as clock spine access (refer to the "Clock Conditioning Circuits" section on page 2-15 for more information).

The inputs of the six CCC blocks are accessible from the FPGA core or from one of several I/O inputs located near the CCC that have dedicated connections to the CCC block.

The CCC block has the following key features:

- Wide input frequency range (f<sub>IN\_CCC</sub>) = 1.5 MHz to 350 MHz
- Output frequency range (f<sub>OUT\_CCC</sub>) = 0.75 MHz to 350 MHz
- Clock delay adjustment via programmable and fixed delays from –7.56 ns to +11.12 ns
- Two programmable delay types; refer to Figure 2-17 on page 2-19, Table 2-4 on page 2-20, and the "Features Supported on Every I/O" section on page 2-31 for more information.
- Clock skew minimization
- Clock frequency synthesis (for PLL only)

Additional CCC specifications:

- Internal phase shift = 0°, 90°, 180°, and 270°. Output phase shift depends on the output divider configuration (for PLL only).
- Output duty cycle = 50% ± 1.5% or better (for PLL only)
- Low output jitter: worst case < 2.5% × clock period peak-to-peak period jitter when single global network used (for PLL only)

- Maximum acquisition time = 150 µs (for PLL only)
- Low power consumption of 5 mW
- Exceptional tolerance to input period jitter allowable input jitter is up to 1.5 ns (for PLL only)
- Four precise phases; maximum misalignment between adjacent phases of 40 ps × (350 MHz / f<sub>OUT CCC</sub>) (for PLL only)

## **Global Clocking**

ProASIC3 devices have extensive support for multiple clocking domains. In addition to the CCC and PLL support described above, there is a comprehensive global clock distribution network.

Each VersaTile input and output port has access to nine VersaNets: six chip (main) and three quadrant global networks (Figure 2-10 on page 2-11). The VersaNets can be driven by the CCC or directly accessed from the core via multiplexers (MUXes). The VersaNets can be used to distribute low-skew clock signals or for rapid distribution of high-fanout nets.

## I/Os with Advanced I/O Standards

The ProASIC3 family of FPGAs features a flexible I/O structure, supporting a range of voltages (1.5 V, 1.8 V, 2.5 V, and 3.3 V). ProASIC3 FPGAs support many different I/O standards: single-ended and differential.

For more information, see Table 2-19 on page 2-45.

The I/Os are organized into banks, with two or four banks per device. Refer to Table 2-18 on page 2-44 for details on I/O bank configuration. The configuration of these banks determines the I/O standards supported (see Table 2-18 on page 2-44 for more information).

Each I/O module contains several input, output, and enable registers (Figure 2-23 on page 2-32). These registers allow the implementation of the following:

- Single-Data-Rate applications
- Double-Data-Rate applications DDR LVDS I/O for point-to-point communications

# **Related Documents**

# **Application Notes**

In-System Programming (ISP) in ProASIC3/E Using FlashPro3 http://www.actel.com/documents/PA3\_E\_ISP\_AN.pdf ProASIC3/E FlashROM (FROM) http://www.actel.com/documents/PA3\_E\_FROM\_AN.pdf ProASIC3/E Security http://www.actel.com/documents/PA3\_E\_Security\_AN.pdf ProASIC3/E SRAM/FIFO Blocks http://www.actel.com/documents/PA3\_E\_SRAMFIFO\_AN.pdf Programming a ProASIC3/E Using a Microprocessor http://www.actel.com/documents/PA3\_E\_Microprocessor\_AN.pdf UJTAG Applications in ProASIC3/E Devices http://www.actel.com/documents/PA3\_E\_UJTAG\_AN.pdf Using DDR for ProASIC3/E Devices http://www.actel.com/documents/PA3\_E\_DDR\_AN.pdf Using Global Resources in Actel ProASIC3/E Devices http://www.actel.com/documents/PA3\_E\_Global\_AN.pdf Power-Up/Down Behavior of ProASIC3/E Devices http://www.actel.com/documents/ProASIC3 E PowerUp AN.pdf

For additional ProASIC3 application notes, go to http://www.actel.com/techdocs/appnotes/products.aspx.

# **User's Guides**

ACTgen Cores Reference Guide http://www.actel.com/documents/gen\_refguide\_ug.pdf Designer User's Guide http://www.actel.com/documents/designer\_ug.pdf ProASIC3/E Macro Library Guide http://www.actel.com/documents/pa3\_libguide\_ug.pdf



# **Device Architecture**

# Introduction

# Flash Technology

### **Advanced Flash Switch**

Unlike SRAM FPGAs, the ProASIC3 family uses a live on power-up ISP Flash switch as its programming element. Flash cells are distributed throughout the device to provide nonvolatile, reconfigurable programming to connect signal lines to the appropriate VersaTile inputs and outputs. In the Flash switch, two transistors share the floating gate, which stores the programming information (Figure 2-1). One is the sensing transistor, which is only used for writing and verification of the floating gate voltage. The other is the switching transistor. The latter is used to connect or separate routing nets, or to configure VersaTile logic. It is also used to erase the floating gate. Dedicated high-performance lines are connected as required using the Flash switch for fast, low-skew, global signal distribution throughout the device core. Maximum core utilization is possible for virtually any design. The use of the Flash switch technology also removes the possibility of firm errors, which are increasingly common in SRAM-based FPGAs.

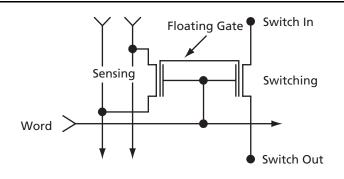


Figure 2-1 • ProASIC3 Flash-Based Switch

# **Device Overview**

The ProASIC3 device family consists of five distinct programmable architectural features (Figure 2-2 and Figure 2-3 on page 2-3):

- FPGA fabric/core (VersaTiles)
- Routing and clock resources (VersaNets)
- FlashROM (FROM) memory
- Dedicated SRAM/FIFO memory (except A3P030)
- Advanced I/O structure

# **Core Architecture**

## VersaTile

The proprietary ProASIC3 family architecture provides granularity comparable to gate arrays. The ProASIC3 device core consists of a sea-of-VersaTiles architecture.

As illustrated in Figure 2-4 on page 2-4, there are four inputs in a logic VersaTile cell, and each VersaTile can be configured using the appropriate Flash switch connections:

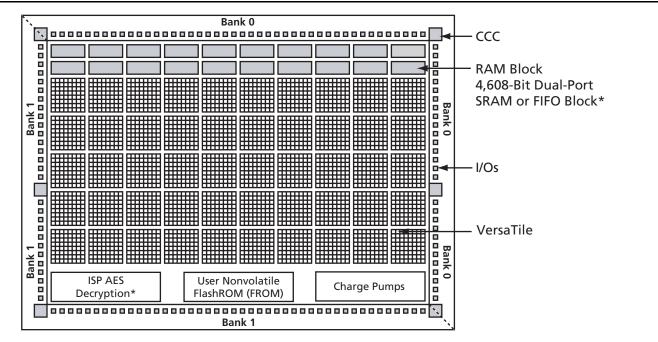
- Any three-input logic function
- Latch with clear or set
- D-flip-flop with clear or set
- Enable D-flip-flop with clear or set (on a fourth input)

VersaTiles can flexibly map the logic and sequential gates of a design. The inputs of the VersaTile can be inverted (allowing bubble pushing), and the output of the tile can connect to high-speed, very-long-line routing resources. VersaTiles and larger functions are connected with any of the four levels of routing hierarchy.

When the VersaTile is used as an enable D-flip-flop, the SET/CLR is supported by a fourth input. The fourth input is routed to the core cell over the VersaNet (global) network.

The SET/CLR signal can only be routed to this fourth input over the VersaNet (global) network. However, if in the user design, the SET/CLR signal is not routed over the VersaNet network, a compile warning message will be given and the intended logic function will be implemented by two VersaTiles instead of one.

The output of the VersaTile is F2 when the connection is to the ultra-fast local lines, or YL when the connection is to the efficient long-lines or very-long-lines resources.



Note: \*Not supported by A3P030.

Figure 2-2 • Device Architecture Overview with Two I/O Banks (A3P030, A3P060, A3P125)



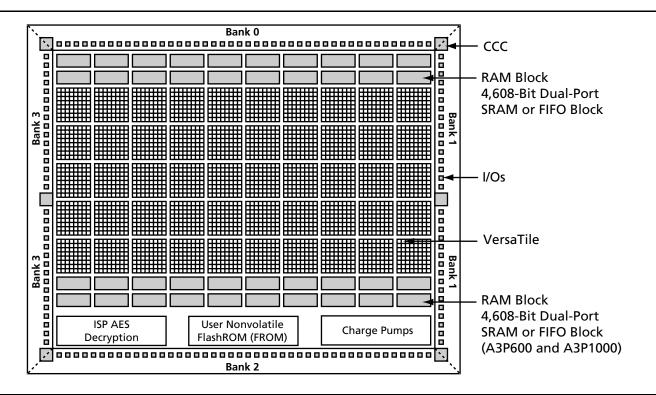
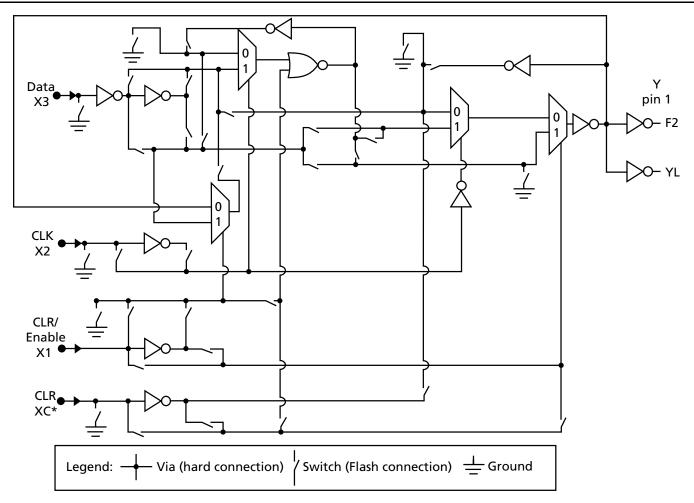


Figure 2-3 • Device Architecture Overview with Four I/O Banks (A3P250, A3P400, A3P600, A3P1000)



**Note:** \*This input can only be connected to the global clock distribution network. Figure 2-4 • **ProASIC3 Core VersaTile** 



## Array Coordinates

During many place-and-route operations in the Actel Designer software tool, it is possible to set constraints that require array coordinates. Table 2-1 is provided as a reference. The array coordinates are measured from the lower left (0, 0). They can be used in region constraints for specific logic groups/blocks, designated by a wildcard, and can contain core cells, memories, and I/Os.

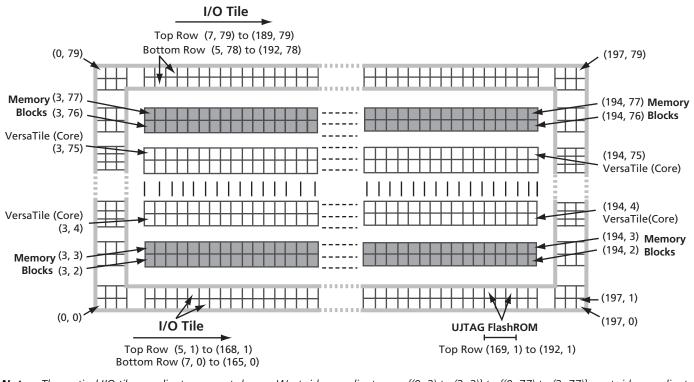
 Table 2-1 provides array coordinates of core cells and memory blocks.

I/O and cell coordinates are used for placement constraints. Two coordinate systems are needed because there is not a one-to-one correspondence between I/O cells and core cells. In addition, the I/O coordinate system changes depending on the die/package combination. It is not listed in Table 2-1. The Designer ChipPlanner tool provides array coordinates of all I/O locations. I/O and cell coordinates are used for placement constraints. However, I/O placement is easier by package pin assignment.

Figure 2-5 on page 2-6 illustrates the array coordinates of an A3P600 device. For more information on how to use array coordinates for region/placement constraints, see the *Designer User's Guide* or online help (available in the software) for ProASIC3 software tools.

		Versa	aTiles		Memor	y Rows	1	All
	м	in.	M	ax.	Bottom	Тор	Min.	Max.
Device	x	У	x	У	(x, y)	(x, y)	(x, y)	(x, y)
A3P030	-	-	_	_	_	_	_	-
A3P060	3	2	66	25	None	(3, 26)	(0, 0)	(69, 29)
A3P125	3	2	130	25	None	(3, 26)	(0, 0)	(133, 29)
A3P250	3	2	130	49	None	(3, 50)	(0, 0)	(133, 53)
A3P400	3	2	194	49	None	(3, 50)	(0, 0)	(197, 53)
A3P600	3	4	194	75	(3, 2)	(3, 76)	(0, 0)	(197, 79)
A3P1000	3	4	258	99	(3, 2)	(3, 100)	(0, 0)	(261, 103)

Table 2-1 • ProASIC3 Array Coordinates



Note: The vertical I/O tile coordinates are not shown. West side coordinates are {(0, 2) to (2, 2)} to {(0, 77) to (2, 77)}; east side coordinates are {(195, 2) to (197, 2)} to {(195, 77) to (197, 77)}.

Figure 2-5 • Array Coordinates for A3P600



## **Routing Architecture**

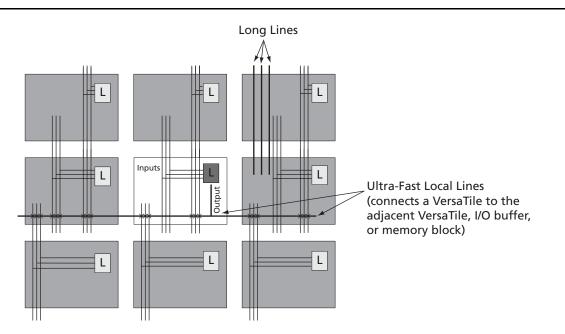
### **Routing Resources**

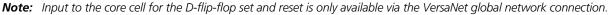
The routing structure of ProASIC3 devices is designed to provide high performance through a flexible four-level hierarchy of routing resources: ultra-fast local resources, efficient long-line resources, high-speed, very-long-line resources, and the high-performance VersaNet networks.

The ultra-fast local resources are dedicated lines that allow the output of each VersaTile to connect directly to every input of the eight surrounding VersaTiles (Figure 2-6). The exception to this is that the SET/CLR input of a VersaTile configured as a D-type flip-flop is driven only by the VersaTile global network.

The efficient, long-line resources provide routing for longer distances and higher fanout connections. These resources vary in length (spanning 1, 2, or 4 VersaTiles), run both vertically and horizontally, and cover the entire ProASIC3 device (Figure 2-7 on page 2-8). Each VersaTile can drive signals onto the efficient long-line resources, which can access every input of every VersaTile. Active buffers are inserted automatically by routing software to limit the loading effects. The high-speed, very-long-line resources, which span the entire device with minimal delay, are used to route very long or high-fanout nets: length +/-12 VersaTiles in the vertical direction and length +/-16 in the horizontal direction from a given core VersaTile (Figure 2-8 on page 2-9). Very long lines in ProASIC3 devices have been enhanced over those in previous ProASIC families. This provides a significant performance boost for long-reach signals.

The high-performance VersaNet global networks are low-skew, high-fanout nets that are accessible from external pins or from internal logic (Figure 2-9 on page 2-10). These nets are typically used to distribute clocks, resets, and other high-fanout nets requiring minimum skew. The VersaNet networks are implemented as clock trees, and signals can be introduced at any junction. These can be employed hierarchically with signals accessing every input on all VersaTiles.





*Figure 2-6* • Ultra-Fast Local Lines Connected to the Eight Nearest Neighbors

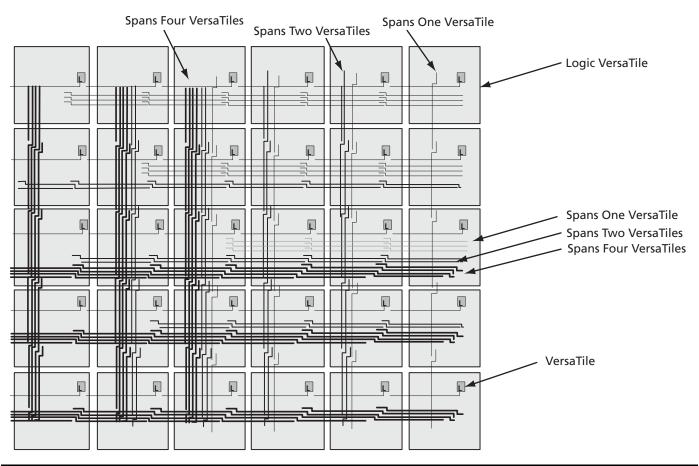


Figure 2-7 • Efficient Long-Line Resources



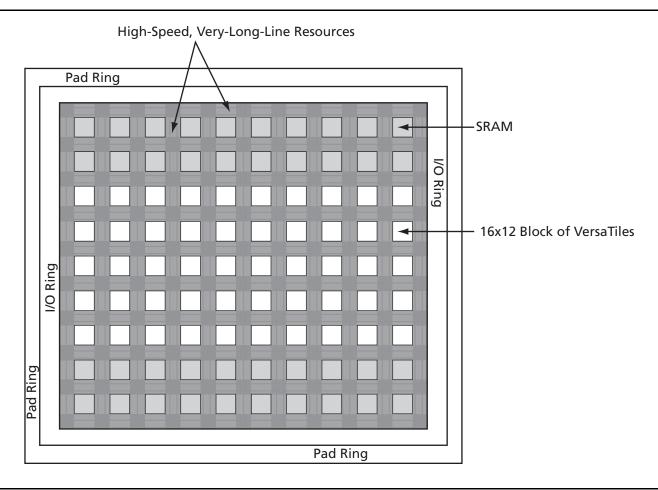


Figure 2-8 • Very-Long-Line Resources

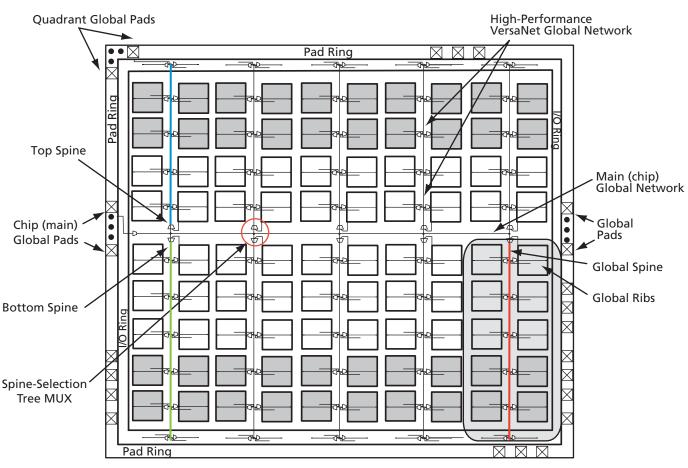
## **Clock Resources (VersaNets)**

ProASIC3 devices offer powerful and flexible control of circuit timing through the use of analog circuitry. Each chip has up to six CCCs. The west CCC also contains a phase-locked loop (PLL) core, delay lines, phase shifter (0°, 90°, 180°, 270°), and clock multiplier/dividers. Each CCC has all the circuitry needed for the selection and interconnection of inputs to the VersaNet global network. The east and west CCCs each have access to three VersaNet global lines on each side of the chip (six total lines). The CCCs at the four corners each have access to three Quadrant global lines on each quadrant of the chip (except A3P030).

### Advantages of the VersaNet Approach

One of the architectural benefits of ProASIC3 is the set of powerful and low-delay VersaNet global networks. ProASIC3 offers six chip (main) global networks that are distributed from the center of the FPGA array (Figure 2-9). In addition, ProASIC3 devices have three regional globals in each of the four chip quadrants. Each core VersaTile has access to nine global network resources: three quadrant and six chip (main) global networks, and a total of 18 globals on the device. Each of these networks contains spines and ribs that reach all the VersaTiles in the quadrants (Figure 2-10 on page 2-11). This flexible VersaNet global network architecture allows users to map up to 144 different internal/external clocks in a ProASIC3 device. Details on the VersaNet networks are given in Table 2-2 on page 2-11. The flexible use of the ProASIC3 VersaNet global network allows the designer to address several design requirements. User applications that are clock-resourceintensive can easily route external or gated internal clocks using VersaNet global routing networks. Designers can also drastically reduce delay penalties and minimize resource usage by mapping critical, high-fanout nets to the VersaNet global network.

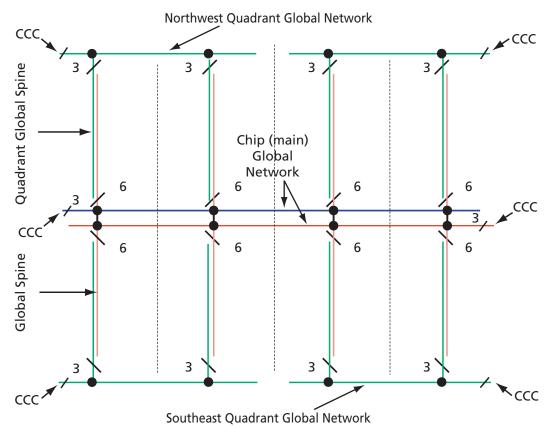
In A3P030 devices, all six VersaNets are driven from three southern I/Os, located toward the east and west sides. These tiles can be configured to select a central I/O on the respective side or an internal routed signal as the input signal. The A3P030 does not support any clock conditioning circuitry nor does it contain the VersaNet global network concept of top and bottom spines.



Note: Not applicable to the A3P030 device.

Figure 2-9 • Overview of ProASIC3 VersaNet Global Network





*Note:* This does not apply to the A3P030 device. Figure 2-10 • Global Network Architecture

<i>Table 2-2</i> •	ProASIC3 Globals/Spines/Rows by Device
--------------------	--

	A3P030	A3P060	A3P125	A3P250	A3P400	A3P600	A3P1000
Global VersaNets (Trees)*	6	9	9	9	9	9	9
VersaNet Spines/Tree	4	4	4	8	8	12	16
Total Spines	24	36	36	72	72	108	144
VersaTiles in Each Top or Bottom Spine	384	384	384	768	768	1,152	1,536
Total VersaTiles	768	1,536	3,072	6,144	9,216	13,824	24,576
Rows in Each Top or Bottom Spine	_	12	12	24	24	36	48

Note: \*There are six chip (main) globals and three globals per quadrant (except in the A3P030 device).

### VersaNet Global Networks and Spine Access

The ProASIC3 architecture contains a total of 18 segmented global networks that can access the VersaTiles, SRAM memory, and I/O tiles on the ProASIC3 device. There are nine global network resources in each device quadrant: three quadrant globals and six chip (main) global networks. Each device has a total of 18 globals. These VersaNet global networks offer fast, low-skew routing resources for high-fanout nets, including clock signals. In addition, these highly-segmented global networks offer users the flexibility to create low-skew local networks using spines for up to 144 internal/ external clocks (in an A3P1000 device) or other high-fanout nets in ProASIC3 devices. Optimal usage of these low-skew networks can result in significant improvement in design performance on ProASIC3 devices.

The nine spines available in a vertical column reside in global networks with two separate regions of scope: the quadrant global network, which has three spines, and the chip (main) global network, which has six spines. Note that there are three quadrant spines in each quadrant of the device (except for A3P030). There are four quadrant global network regions per device (Figure 2-10 on page 2-11).

The spines are the vertical branches of the global network tree, shown in Figure 2-11 on page 2-13. Each spine in a vertical column of a chip (main) global network is further divided into two equal-length spine segments: one in the top and one in the bottom half of the die. Each spine and its associated ribs cover a certain area of the ProASIC3 device (the "scope" of the spine; see Figure 2-9 on page 2-10). Each spine is accessed by the dedicated global network MUX tree architecture, which defines how a particular spine is driven—either by the signal on the global network from a CCC, for example, or another net defined by the user (Figure 2-12 on page 2-14). Quadrant spines can be driven from user I/Os on the north and south sides of the die. The ability to drive spines in the quadrant global networks can have a significant effect on system performance for high-fanout inputs to a design.

Details of the chip (main) global network spine-selection MUX are presented in Figure 2-12 on page 2-14. The spine drivers for each spine are located in the middle of the die.

Quadrant spines are driven from a north or south rib. Access to the top and bottom ribs is from the corner CCC or from the I/O on the north and south sides of the device.

For details on using spines in ProASIC3 devices, see the Actel application note Using Global Resources in Actel ProASIC3/E Devices.



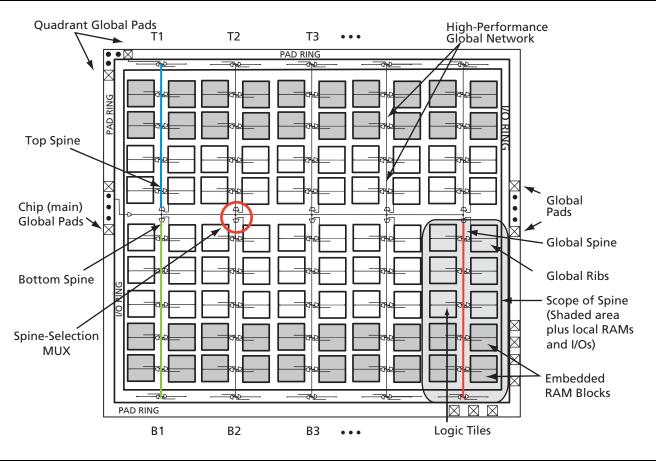


Figure 2-11 • Spines in a Global Clock Tree Network

# **Clock Aggregation**

Clock aggregation allows for multi-spine clock domains. A MUX tree provides the necessary flexibility to allow long lines or I/Os to access domains of one, two, or four global spines. Signal access to the clock aggregation system is achieved through long-line resources in the central rib, and also through local resources in the north and south ribs, allowing I/Os to directly feed into the clock system. As Figure 2-13 indicates, this access system is contiguous. There is no break in the middle of the chip for the north and south I/O VersaNet access. This is different from the quadrant clocks, located in these ribs, which only reach the middle of the rib. Refer to the Using Global Resources in Actel ProASIC3/E Devices application note.

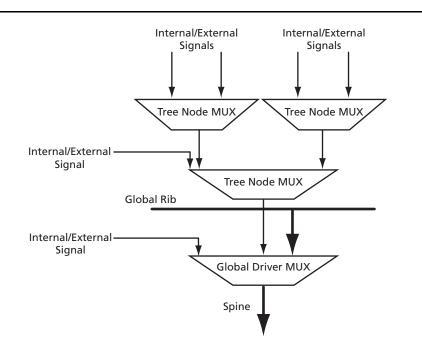


Figure 2-12 • Spine Selection MUX of Global Tree

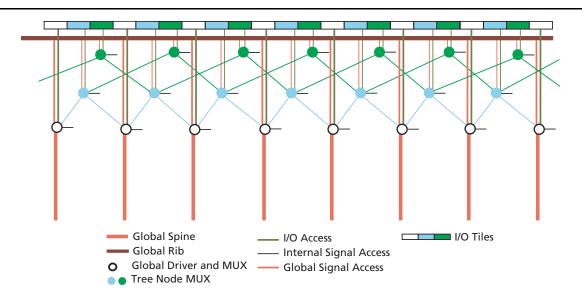


Figure 2-13 • Clock Aggregation Tree Architecture



# **Clock Conditioning Circuits**

## **Overview of Clock Conditioning Circuitry**

In ProASIC3 devices, the clock conditioning circuits (CCCs) are used to implement frequency division, frequency multiplication, phase shifting, and delay operations.

The CCCs are available in six chip locations – each of the four chip corners and in the middle of the east and west chip sides.

Each CCC can implement up to three independent global buffers (with or without programmable delay), or a PLL function (programmable frequency division/ multiplication, phase shift, and delays) with up to three global outputs. Unused global outputs of a PLL can be used to implement independent global buffers, up to a maximum of three global outputs for a given CCC.

A global buffer can be placed in any of the three global locations (CLKA-GLA, CLKB-GLB, and CLKC-GLC) of a given CCC.

A PLL macro uses the CLKA CCC input to drive its reference clock. It uses the GLA and optionally the GLB and GLC global outputs to drive the global networks. A PLL macro can also drive the YB and YC regular core outputs. The GLB (or GLC) global outputs cannot be reused if the YB (or YC) outputs are used (Figure 2-14 on page 2-16). Refer to the "PLL Macro" section on page 2-17 for more information.

Each global buffer, as well as the PLL reference clock, can be driven from one of the following:

- Three dedicated single-ended I/Os using a hardwired connection
- Two dedicated differential I/Os using a hardwired connection
- The FPGA core

The CCC block is fully configurable, either via Flash configuration bits set in the programming bitstream or through an asynchronous interface. This asynchronous interface is dynamically accessible from inside the ProASIC3 device to permit parameter changes (such as divide ratios) during device operation. To increase the versatility and flexibility of the clock conditioning system, the CCC configuration is determined either by the user during the design process, with configuration data being stored in Flash memory as part of the device programming procedure, or by writing data into a dedicated shift register during normal device operation. This latter mode allows the user to dynamically reconfigure the CCC without the need for core programming. The shift register is accessed through a simple serial interface. Refer to the UJTAG Applications in ProASIC3/E Device application note and the "CCC Electrical Specifications" section on page 2-20 for more information.

### **Global Buffers with No Programmable Delays**

The CLKBUF and CLKBUF\_LVPECL/LVDS macros are composite macros that include an I/O macro driving a global buffer, which uses a hardwired connection.

The CLKBUF, CLKBUF\_LVPECL/LVDS, and CLKINT macros are pass-through clock sources and do not use the PLL or provide any programmable delay functionality.

The CLKINT macro provides a global buffer function driven by the FPGA core.

Many specific CLKBUF macros support the wide variety of single-ended and differential I/O standards supported by ProASIC3 devices. The available CLKBUF macros are described in the *ProASIC3/E Macro Library Guide*.

### **Global Buffer with Programmable Delay**

The CLKDLY macro is a pass-through clock source that does not use the PLL, but provides the ability to delay the clock input using a programmable delay. The CLKDLY macro takes the selected clock input and adds a userdefined delay element. This macro generates an output clock phase shift from the input clock.

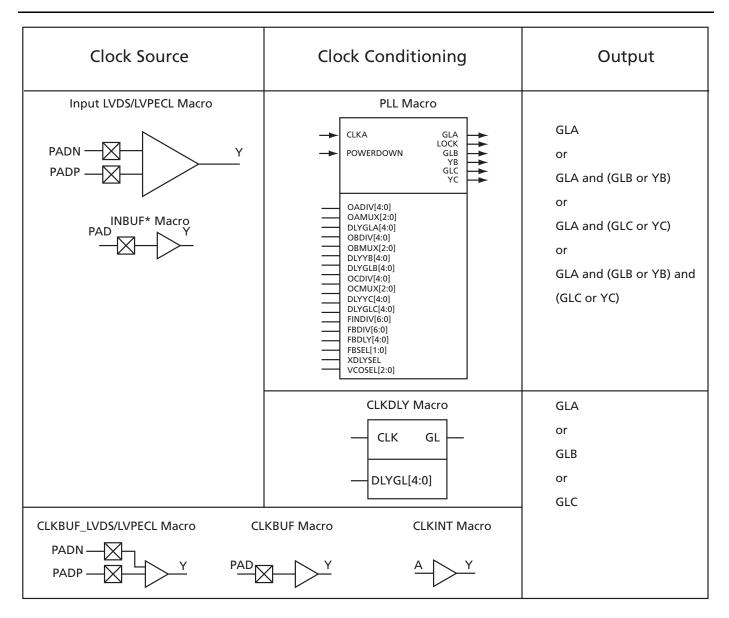
The CLKDLY macro can be driven by an INBUF\* macro to create a composite macro, where the I/O macro drives the global buffer (with programmable delay) using a hardwired connection. In this case, the I/O must be placed in one of the dedicated global I/O locations.

Many specific INBUF macros support the wide variety of single-ended and differential I/O standards supported by the ProASIC3 family. The available INBUF macros are described in the *ProASIC3/E Macro Library Guide*.

The CLKDLY macro can be driven directly from the FPGA core.

The CLKDLY macro can also be driven from an I/O that is routed through the FPGA regular routing fabric. In this case, users must instantiate a special macro, PLLINT, to differentiate from the hardwired I/O connection described earlier.

The visual CLKDLY configuration in the ACTgen part of the Libero IDE and Designer tools allows the user to select the desired amount of delay, and configures the delay elements appropriately. ACTgen also allows the user to select where the input clock is coming from. ACTgen will automatically instantiate the special macro, PLLINT, when needed.



#### Notes:

- 1. Visit the Actel website for future application notes concerning dynamic PLL reconfiguration. The PLL is only supported on the west center CCC. The A3P030 has no PLL support. Refer to the "PLL Macro" section on page 2-17 for signal descriptions.
- 2. Refer to the ProASIC3/E Macro Library Guide for more information.
- 3. Many specific INBUF macros support the wide variety of single-ended and differential I/O standards supported by the ProASIC3 family. The available INBUF macros are described in the ProASIC3/E Macro Library Guide.

Figure 2-14 • ProASIC3 CCC Options

### PLL Macro<sup>1</sup>

The PLL functionality of the clock conditioning block is supported by the PLL macro. Note that the PLL macro reference clock uses the CLKA input of the CCC block, which is only accessible from the global A[0:2] package pins. Refer to Figure 2-15 on page 2-18 for more information.

The PLL macro provides five derived clocks (three independent) from a single reference clock. The PLL macro also provides power-down input and lock output signals. See Figure 2-17 on page 2-19 for more information.

Inputs:

- CLKA: selected clock input
- Powerdown (active low): disables PLLs. The default state is Powerdown On (active low).

Outputs:

- Lock: indicates that PLL output has locked on the input reference signal
- GLA, GLB, GLC: outputs to respective global networks
- YB, YC: allows output from the CCC to be routed back to the FPGA core

As previously described, the PLL allows up to five flexible and independently-configurable clock outputs. Figure 2-19 on page 2-21 illustrates the various clock output options and delay elements.

As illustrated, the PLL supports three distinct output frequencies from a given input clock. Two of these (GLB and GLC) can be routed to the B and C global network access, respectively, and/or routed to the device core (YB and YC).

There are five delay elements to support phase control on all five outputs (GLA, GLB, GLC, YB, and YC).

There is also a delay element in the feedback loop that can be used to advance the clock relative to the reference clock.

The PLL macro reference clock can be driven by an INBUF\* macro to create a composite macro, where the I/O macro drives the global buffer (with programmable delay) using a hardwired connection. In this case, the I/O must be placed in one of the dedicated global I/O locations.

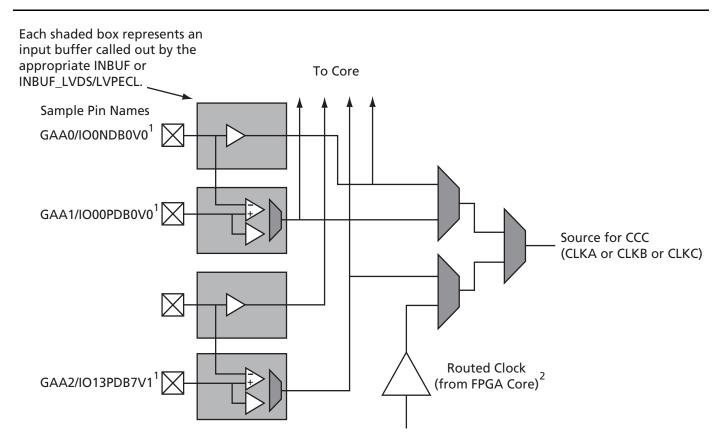
The PLL macro reference clock can be driven by an INBUF\* macro to create a composite macro, where the I/O macro drives the global buffer (with programmable delay) using a hardwired connection. In this case, the I/O must be placed in one of the dedicated global I/O locations.

The PLL macro reference clock can be driven directly from the FPGA core.

The PLL macro reference clock can also be driven from an I/O that is routed through the FPGA regular routing fabric. In this case, users must instantiate a special macro, PLLINT, to differentiate from the hardwired I/O connection described earlier.

The visual PLL configuration in ACTgen, associated with the Libero IDE and Designer tools, will derive the necessary internal divider ratios based on the input frequency and desired output frequencies selected by the user. ACTgen also allows the user to select the various delays and phase shift values necessary to adjust the phases between the reference clock (CLKA) and the derived clocks (GLA, GLB, GLC, YB and YC). ACTgen also allows the user to select where the input clock is coming from. ACTgen automatically instantiates the special macro, PLLINT, when needed.

<sup>1.</sup> The A3P030 device does not support PLL.



GAA[0:2]: GA represents global in the northwest corner of the device. A[0:2]: designates specific A clock source.

### Notes:

- 1. Represents the global input pins. Globals have direct access to the clock conditioning block and are not routed via the FPGA fabric. Refer to the "User I/O Naming Convention" on page 2-46 for more information.
- Instantiate the routed clock source input as follows:
   a) Connect the output of a logic element to the clock input of PLL, CLKDLY, or CLKINT macro.
   b) Do not place a clock source I/O (INBUF or INBUF\_LVPECL/LVDS) in a relevant global pin location.
- 3. LVDS-based clock sources are only available on A3P250 through A3P1000 family members. A3P060 and A3P125 only support singleended clock sources. The A3P030 device does not support this feature.

### *Figure 2-15* • Clock Input Sources Including CLKBUF, CLKBUF\_LVDS/LVPECL, and CLKINT

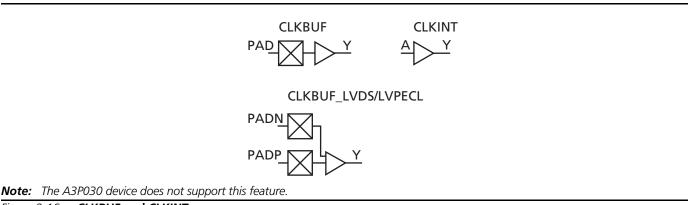


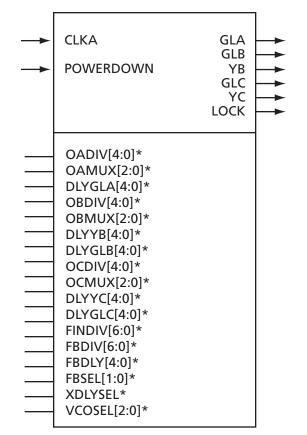
Figure 2-16 • CLKBUF and CLKINT



Table 2-3 • Available Selections of I/O Standards within CLKBUF and CLKBUF\_LVDS/LVPECL Macros

CLKBUF Macros
CLKBUF_LVCMOS5
CLKBUF_LVCMOS33*
CLKBUF_LVCMOS18
CLKBUF_LVCMOS15
CLKBUF_PCI
CLKBUF_LVDS
CLKBUF_LVPECL

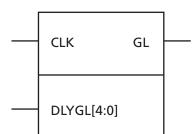
**Note:** \*By default, the CLKBUF macro uses the 3.3 V LVTTL I/O technology. For more details refer to the ProASIC3/E Macro Library Guide.

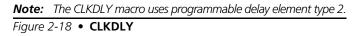


**Note:** \*Visit the Actel website for future application notes concerning the dynamic PLL. The A3P030 device does not support PLL.

Figure 2-17 • CCC/PLL Macro







# **CCC Electrical Specifications**

Timing Characteristics

### Table 2-4 ProASIC3 CCC/PLL Specification

Parameter	Min.	Тур.	Max.	Unit
Clock Conditioning Circuitry Input Frequency f <sub>IN_CCC</sub>	1.5		350	MHz
Clock Conditioning Circuitry Output Frequency f <sub>OUT_CCC</sub>	0.75		350	MHz
Delay Increments in Programmable Delay Blocks <sup>1, 2</sup>		160		ps
Number of Programmable Values in Each Programmable Delay Block			32	
Input Period Jitter			1.5	ns
CCC Output Peak-to-Peak Period Jitter F <sub>CCC_OUT</sub>	Max Pe			
	1 Global Network Used		3 Global Networks Used	
0.75 MHz to 24 MHz	0.50%		0.70%	
24 MHz to 100 MHz	1.00%		1.20%	
100 MHz to 250 MHz	1.75%		2.00%	
250 MHz to 350 MHz	2.50%		5.60%	
Acquisition Time			150	μs
Output Duty Cycle	48.5		51.5	%
Delay Range in Block: Programmable Delay 1 <sup>1, 2</sup>	0.6		5.56	ns
Delay Range in Block: Programmable Delay 2 <sup>1, 2</sup>	0.025		5.56	ns
Delay Range in Block: Fixed Delay <sup>1, 2</sup>		2.2		ns

Notes:

1. This delay is a function of voltage and temperature. See Table 3-6 on page 3-4 for deratings.

2.  $T_J = 25^{\circ}C, V_{CC} = 1.5 V$ 

3. The A3P030 device does not support PLL.



# CCC Physical Implementation<sup>2</sup>

The CCC circuit is composed of the following (Figure 2-19):

- PLL core
- Three phase selectors
- Six programmable delays and one fixed delay that advance/delay phase
- Five programmable frequency dividers that provide frequency multiplication/division (not shown in Figure 2-19, because they are automatically configured based on the user's required frequencies)
- One dynamic shift register that provides CCC dynamic reconfiguration capability

## **CCC Programming**

The clock conditioning circuit block is fully configurable, either via static Flash configuration bits in the array, set by the user in the programming bitstream, or through an asynchronous dedicated shift register dynamically accessible from inside the ProASIC3 device. The dedicated shift register permits parameter changes such as PLL divide ratios and delays during device operation. This latter mode allows the user to dynamically reconfigure the PLL without the need for core programming. The register file is accessed through a simple serial interface. Refer to the *UJTAG Applications in ProASIC3/E Devices* application note for more information.

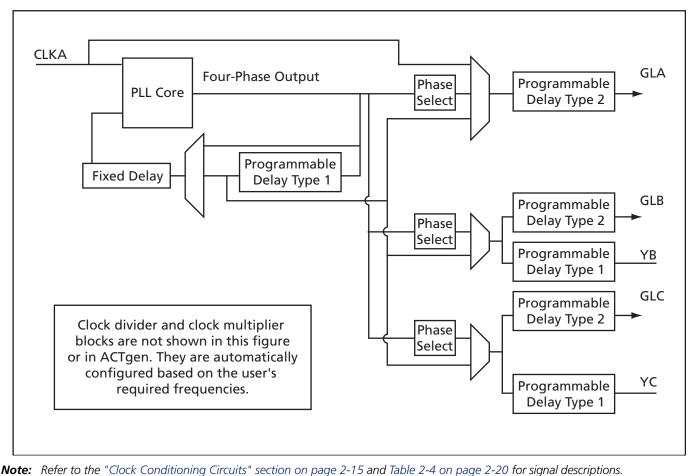


Figure 2-19 • PLL Block

2. The A3P030 device does not support PLL.

# Nonvolatile Memory (NVM)

## **Overview of User Nonvolatile FlashROM (FROM)**

ProASIC3 devices have 1 kbit of on-chip nonvolatile Flash memory that can be read from the FPGA core fabric. The FROM is arranged in 8 banks of 128 bits during programming. The 128 bits in each bank are addressable as 16 bytes during the read back of the FROM from the FPGA core (Figure 2-20).

The FROM can only be programmed via the IEEE1532 JTAG port. It cannot be programmed directly from the FPGA core. When programming, each of the 8 128-bit banks can be selectively reprogrammed. The FROM can only be reprogrammed on a bank boundary. Programming involves an automatic, on-chip bank erase prior to reprogramming the bank. The FROM supports asynchronous read with a nominal 10 ns access time. The FROM can be read on byte boundaries. The upper 3 bits of the FROM address from the FPGA core define the bank that is being accessed. The lower 4 bits of the FROM address from the FPGA core define which of the 16 bytes in the bank is being accessed.

		Byt	e Νι	umbe	er in	ı Bar	ık		4 LSB of ADDR (READ)								
		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Bank Number 3 MSB of ADDR (READ)	7																
	6																
	5																
	4																
	3																
	2																
	1																
of	0																

Figure 2-20 • FROM Architecture

# SRAM and FIFO<sup>3</sup>

ProASIC3 devices have embedded SRAM blocks along the north side of the device. In addition, A3P600 and A3P100 have an embedded SRAM block on the south side of the device. To meet the needs of high-performance designs, the memory blocks operate strictly in synchronous mode for both read and write operations. The read and write clocks are completely independent, and each may operate at any desired frequency less than or equal to 350 MHz.

- 4kx1, 2kx2, 1kx4, 512x9 (dual-port RAM two read, two write or one read, one write)
- 512x9, 256x18 (two-port RAM one read and one write)
- Sync write, sync pipelined / nonpipelined read

The ProASIC3 memory block includes dedicated FIFO control logic to generate internal addresses and external flag logic (Full, Empty, AFULL, AEMPTY). Block diagrams of the memory modules are illustrated in Figure 2-21 on page 2-24.

During RAM operation, addresses are sourced by the user logic and the FIFO controller is ignored. In FIFO mode, the internal addresses are generated by the FIFO controller and routed to the RAM array by internal MUXes. Refer to Figure 2-22 on page 2-25 for more information about the implementation of the embedded FIFO controller.

The ProASIC3 architecture enables the read and write sizes of RAMs to be organized independently, allowing for bus conversion. For example, the write side size can be set to 256x18 and the read size to 512x9.

Both the write width and read width for the RAM blocks can be specified independently with the WW (write width) and RW (read width) pins. The different DxW configurations are: 256x18, 512x9, 1kx4, 2kx2, and 4kx1.

Refer to the allowable RW and WW values supported for each of the RAM macro types in Table 2-5 on page 2-26.

When widths of one, two, and four are selected, the ninth bit is unused. For example, when writing nine-bit values and reading four-bit values, only the first four bits and the second four bits of each nine-bit value are addressable for read operations. The ninth bit is not accessible.

Conversely, when writing four-bit values and reading nine-bit values, the ninth bit of a read operation will be undefined. The RAM blocks employ little-endian byte order for read and write operations.

3. The A3P030 device does not support SRAM and FIFO.

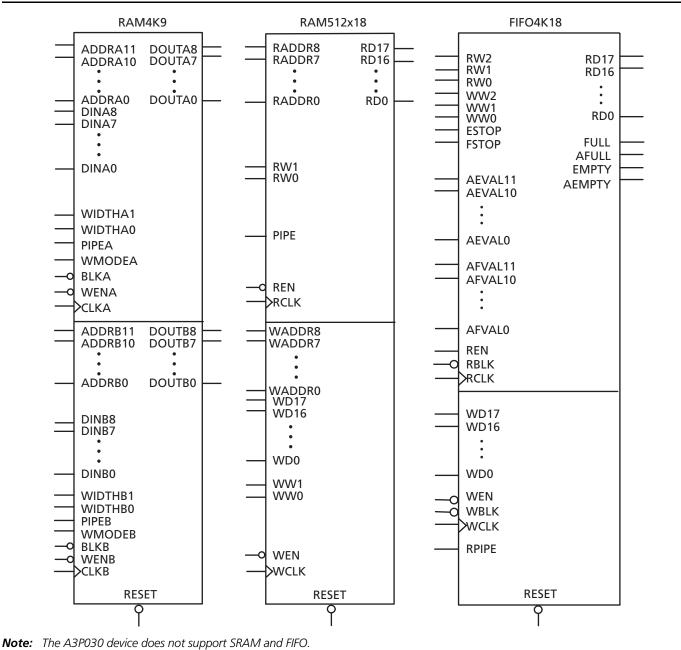
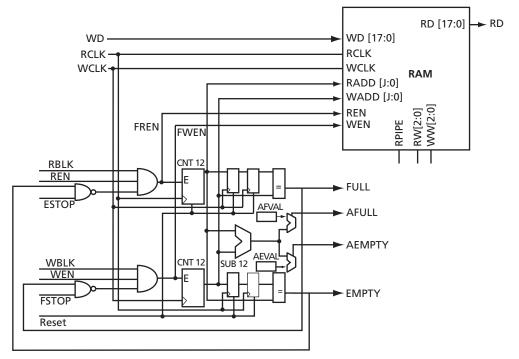


Figure 2-21 • Supported Basic RAM Macros





**Note:** The A3P030 device does not support SRAM and FIFO.

Figure 2-22 • ProASIC3 RAM Block with Embedded FIFO Controller

## Signal Descriptions for RAM4K9<sup>4</sup>

The following signals are used to configure the RAM4K9 memory element:

#### WIDTHA and WIDTHB

These signals enable the RAM to be configured in one of four allowable aspect ratios (Table 2-5).

#### Table 2-5 • Allowable Aspect Ratio Settings for WIDTHA[1:0]

WIDTHA1, WIDTHA0	WIDTHB1, WIDTHB0	DxW
00	00	4kx1
01	01	2kx2
10	10	1kx4
11	11	512x9

**Note:** The aspect ratio settings are constant and cannot be changed on-the-fly.

#### **BLKA and BLKB**

These signals are active low and will enable the respective ports when asserted. When a BLKx signal is deasserted, that port's outputs hold the previous value.

#### WENA and WENB

These signals switch the RAM between read and write modes for the respective ports. A Low on these signals indicates a write operation, and a High indicates a read.

#### CLKA and CLKB

These are the clock signals for the synchronous read and write operations. These can be driven independently or with the same driver.

#### PIPEA and PIPEB

These signals are used to specify pipelined read on the output. A Low on PIPEA and/or PIPEB indicates a nonpipelined read and the data appears on the corresponding output in the same clock cycle. A High indicates a pipelined read and data appears on the corresponding output in the next clock cycle.

#### WMODEA and WMODEB

These signals are used to configure the behavior of the output when RAM is in the write mode. A Low on these signals makes the output retain data from the previous read. A High indicates pass-through behavior where the data being written will appear immediately on the output. This signal is overridden when the RAM is being read.

#### RESET

This active low signal resets the output to zero when asserted. It does not reset the contents of the memory.

#### ADDRA and ADDRB

These are used as read or write addresses, and they are 12 bits wide. When a depth of less than 4k is specified, the unused high-order bits must be grounded (Table 2-6).

Table 2-6 •	Address Pins Unused/Used for Various
	Supported Bus Widths

	ADDRx	
DxW	Unused	Used
4kx1	None	[11:0]
2kx2	[11]	[10:0]
1kx4	[11:10]	[9:0]
512x9	[11:9]	[8:0]

**Note:** The "x" in ADDRx implies A or B.

#### **DINA and DINB**

These are the input data signals, and they are nine bits wide. Not all nine bits are valid in all configurations. When a data width less than nine is specified, unused high-order signals must be grounded (Table 2-7).

#### **DOUTA and DOUTB**

These are the nine-bit output data signals. Not all nine bits are valid in all configurations. As with DINA and DINB, high-order bits may not be used (Table 2-7). The output data on unused pins is undefined.

••		
	DINx/DOUTx	
DxW	Unused	Used
4kx1	[8:1]	[0]
2kx2	[8:2]	[1:0]
1kx4	[8:4]	[3:0]
512x9	None	[8:0]

Table 2-7Unused/Used Input and Output Data Pins for<br/>Various Supported Bus Widths

**Note:** The "x" in DINx or DOUTx implies A or B.

<sup>4.</sup> The A3P030 device does not support SRAM and FIFO.



# Signal Descriptions for RAM512X18<sup>5</sup>

RAM512X18 has slightly different behavior than the RAM4K9, as it has dedicated read and write ports.

#### WW and RW

These signals enable the RAM to be configured in one of the two allowable aspect ratios (Table 2-8).

WW1, WWO	RW1, RW0	DxW
01	01	512x9
10	10	256x18
00, 11	00, 11	Reserved

Table 2-8 • Aspect Ratio Settings for WW[1:0]

#### WD and RD

These are the input and output data signals, and they are 18 bits wide. When a 512x9 aspect ratio is used for write, WD[17:9] are unused and must be grounded. If this aspect ratio is used for read, then RD[17:9] are undefined.

#### WADDR and RADDR

These are read and write addresses, and they are nine bits wide. When the 256x18 aspect ratio is used for write and/or read, WADDR[8] and/or RADDR[8] are/is unused and must be grounded.

#### WCLK and RCLK

These signals are the write and read clocks, respectively. They are both active high.

#### WEN and REN

These signals are the write and read enables, respectively. They are both active low by default. These signals can be configured as active high.

#### RESET

This active low signal resets the output to zero when asserted. It does not reset the contents of the memory.

#### PIPE

This signal is used to specify pipelined read on the output. A Low on PIPE indicates a nonpipelined read and the data appears on the output in the same clock cycle. A High indicates a pipelined read and data appears on the output in the next clock cycle.

#### Clocking

The dual-port SRAM blocks are only clocked on the rising edge. ACTgen allows falling-edge triggered clocks by adding inverters to the netlist, hence achieving dual-port SRAM blocks that are clocked on either edge (rising or falling). For dual-port SRAM, each port can be clocked on either edge and/or by separate clocks by port. ProASIC3 devices support inversion (bubble pushing) throughout the FPGA architecture, including the clock input to the SRAM modules. Inversions added to the SRAM clock pin on the design schematic or in the HDL code will be automatically accounted for during design compile without incurring additional delay in the clock path.

The two-port SRAM can be clocked on the rising edge or falling edge of the WCLK and RCLK.

If negative-edge RAM and FIFO clocking is selected for memory macros, clock edge inversion management (bubble pushing) is automatically used within the ProASIC3 development tools, without performance penalty.

#### **Modes of Operation**

There are two read modes and one write mode:

- Read Nonpipelined (synchronous one clock edge): In the standard read mode, new data is driven onto the RD bus in the same clock cycle following RA and REN valid. The read address is registered on the read port clock active edge and data appears at RD after the RAM access time. Setting PIPE to OFF enables this mode.
- Read Pipelined (synchronous two clock edges): The pipelined mode incurs an additional clock delay from the address to the data but enables operation at a much higher frequency. The read address is registered on the read port active clock edge, and the read data is registered and appears at RD after the second read clock edge. Setting the PIPE to ON enables this mode.
- Write (synchronous one clock edge): On the write clock active edge, the write data is written into the SRAM at the write address when WEN is high. The setup times of the write address, write enables, and write data are minimal with respect to the write clock. Write and read transfers are described with timing requirements in the "DDR Module Specifications" section on page 3-37.

#### **RAM Initialization**

Each SRAM block can be individually initialized on power-up by means of the JTAG port using the UJTAG mechanism (refer to the "JTAG 1532" section on page 2-51 and the *ProASIC3/E SRAM/FIFO Blocks* application note). The shift register for a target block can be selected and loaded with the proper bit configuration to enable serial loading. The 4,608 bits of data can be loaded in a single operation.

<sup>5.</sup> The A3P030 device does not support SRAM and FIFO.

# Signal Descriptions for FIFO4K18<sup>6</sup>

The following signals are used to configure the FIFO4K18 memory element:

#### WW and RW

These signals enable the FIFO to be configured in one of the five allowable aspect ratios (Table 2-9).

Table 2-9 •	Aspect Ratio Settin	as for WW[2:0]
	Aspect nutio settin	

WW2, WW1, WW0	RW2, RW1, RW0	DxW
000	000	4kx1
001	001	2kx2
010	010	1kx4
011	011	512x9
100	100	256x18
101, 110, 111	101, 110, 111	Reserved

#### WBLK and RBLK

These signals are active low and will enable the respective ports when low. When the RBLK signal is high, that port's outputs hold the previous value.

#### WEN and REN

Read and write enables. WEN is active low and REN is active high by default. These signals can be configured as active high or low.

#### WCLK and RCLK

These are the clock signals for the synchronous read and write operations. These can be driven independently or with the same driver.

#### RPIPE

This signal is used to specify pipelined read on the output. A Low on RPIPE indicates a nonpipelined read and the data appears on the output in the same clock cycle. A High indicates a pipelined read and data appears on the output in the next clock cycle.

#### RESET

This active low signal resets the output to zero when asserted. It resets the FIFO counters. It also sets all the RD pins low, the Full and AFULL pins low, and the Empty and AEMPTY pins high (Table 2-10).

#### WD

This is the input data bus and is 18 bits wide. Not all 18 bits are valid in all configurations. When a data width less than 18 is specified, unused higher-order signals must be grounded (Table 2-10).

#### RD

This is the output data bus and is 18 bits wide. Not all 18 bits are valid in all configurations. Like the WD bus, highorder bits become unusable if the data width is less than 18. The output data on unused pins is undefined (Table 2-10).

Table 2-10 • Input Data Signal Usage for Different Aspect Ratios

DxW	WD/RD Unused
4kx1	WD[17:1], RD[17:1]
2kx2	WD[17:2], RD[17:2]
1kx4	WD[17:4], RD[17:4]
512x9	WD[17:9], RD[17:9]
256x18	_

#### ESTOP, FSTOP

ESTOP is used to stop the FIFO read counter from further counting once the FIFO is empty (i.e., the Empty flag goes high). A High on this signal inhibits the counting.

FSTOP is used to stop the FIFO write counter from further counting once the FIFO is full (i.e., the Full flag goes high). A High on this signal inhibits the counting.

For more information on these signals, refer to the "ESTOP and FSTOP Usage" section.

#### FULL, EMPTY

When the FIFO is full and no more data can be written, the Full flag asserts high. The Full flag is synchronous to WCLK to inhibit writing immediately upon detection of a full condition and to prevent overflows. Since the write address is compared to a resynchronized (and thus timedelayed) version of the read address, the Full flag will remain asserted until two WCLK active edges after a read operation eliminates the full condition.

When the FIFO is empty and no more data can be read, the Empty flag asserts high. The Empty flag is synchronous to RCLK to inhibit reading immediately upon detection of an empty condition and to prevent underflows. Since the read address is compared to a resynchronized (and thus time delayed) version of the write address, the Empty flag will remain asserted until two RCLK active edges, after a write operation, removes the empty condition.

For more information on these signals, refer to the "FIFO Flag Usage Considerations" section on page 2-29.

#### AFULL, AEMPTY

These are programmable flags and will be asserted on the threshold specified by AFVAL and AEVAL, respectively.

When the number of words stored in the FIFO reaches the amount specified by AEVAL while reading, the AEMPTY output will go high. Likewise, when the number of words stored in the FIFO reaches the amount specified by AFVAL while writing, the AFULL output will go high.

<sup>6.</sup> The A3P030 device does not support SRAM and FIFO.



#### AFVAL, AEVAL

The AEVAL and AFVAL pins are used to specify the almost-empty and almost-full threshold values, respectively. They are 12-bit signals. For more information on these signals, refer to the "FIFO Flag Usage Considerations" section.

#### ESTOP and FSTOP Usage

The ESTOP pin is used to stop the read counter from counting any further once the FIFO is empty (i.e., the EMPTY flag goes high). Likewise, the FSTOP pin is used to stop the write counter from counting any further once the FIFO is full (i.e., the Full flag goes high).

The FIFO counters in the ProASIC3 device start the count at 0, reach the maximum depth for the configuration (e.g., 511 for a 512x9 configuration), and then restart at 0. An example application for the ESTOP, where the read counter keeps counting, would be writing to the FIFO once and reading the same content over and over without doing another write.

#### FIFO Flag Usage Considerations

The AEVAL and AFVAL pins are used to specify the 12-bit AEMPTY and AFULL threshold values, respectively. The FIFO contains separate 12-bit write address (WADDR) and read address (RADDR) counters. WADDR is incremented every time a write operation is performed, and RADDR is incremented every time a read operation is performed. Whenever the difference between WADDR and RADDR is greater than or equal to AFVAL, the AFULL output is asserted. Likewise, whenever the difference between WADDR and RADDR is less than or equal to AEVAL, the AEMPTY output is asserted. To handle different read and write aspect ratios, AFVAL and AEVAL are expressed in terms of total data bits instead of total data words. When users specify AFVAL and AEVAL in terms of read or write words, the ACTgen tool translates them into bit addresses and configures these signals automatically. ACTgen configures the AFULL flag, AFULL, to assert when the write address exceeds the read address by at least a predefined value. In a 2kx8 FIFO, for example, a value of 1,500 for AFVAL means that the AFULL flag will be asserted after a write when the difference between the write address and the read address reaches 1,500 (there have been at least 1,500 more writes than reads). It will stay asserted until the difference between the write and read addresses drops below 1,500.

The AEMPTY flag is asserted when the difference between the write address and the read address is less than a predefined value. In the example above, a value of 200 for AEVAL means that the AEMPTY flag will be asserted when a read causes the difference between the write address and the read address to drop to 200. It will stay asserted until that difference rises above 200. Note that the FIFO can be configured with different read and write widths; In this case the AFVAL setting is based on the number of write data entries and the AEVAL setting is based on the number of read data entries. For aspect ratios of 512x9 and 256x18, only 4,096 bits can be addressed by the 12 bits of AFVAL and AEVAL, the number of words must be multiplied by 8 and 16, instead of 9 and 18. The ACTgen tool automatically uses the proper values. To avoid half-words being written or read, which could happen if different read and write aspect ratios are specified, the FIFO will assert Full or Empty as soon as at least a minimum of one word cannot be written or read. For example, if a two-bit word is written and a four-bit word is being read, FIFO will remain in the Empty state when the first word is written. This occurs even if the FIFO is not completely empty, because in this case a complete word cannot be read. The same is applicable in the Full state. If a four-bit word is written and a two-bit word is read, the FIFO is full and one word is read. The FULL flag will remain asserted because a complete word cannot be written at this point.

Refer to the *ProASIC3/E SRAM/FIFO Blocks* application note for more information.

# **Advanced I/Os**

## Introduction

ProASIC3 devices feature a flexible I/O structure, supporting a range of mixed voltages (1.5 V, 1.8 V, 2.5 V, and 3.3 V) through a bank-selectable voltage. Table 2-11 on page 2-30, Table 2-12 on page 2-30, and Table 2-18 on page 2-44 show the voltages and the compatible I/O standards. I/Os provide programmable slew rates (except A3P030), drive strengths, weak pull-up, and weak pull-down circuits. 3.3 V PCI and 3.3 V PCI-X are 5 V tolerant. See the "5 V Input Tolerance" section on page 2-37 for possible implementations of 5 V tolerance.

All I/Os are in a known state during power-up and any power-up sequence is allowed without current impact. Refer to the for more information.

## I/O Tile

The ProASIC3 I/O tile provides a flexible, programmable structure for implementing a large number of I/O standards. In addition, the registers available in the I/O tile in selected I/O banks can be used to support highperformance register inputs and outputs, with register enable if desired (Figure 2-23 on page 2-32). The registers can also be used to support the JESD-79C Double Data Rate (DDR) standard within the I/O structure (see the "Double Data Rate (DDR) Support" section on page 2-33 for more information).

As depicted in Figure 2-23 on page 2-32, all I/O registers share one CLR port. The output register and output enable register share one CLK port. Refer to the "I/O Registers" section on page 2-32 for more information.

#### I/O Banks and I/O Standards Compatibility

I/Os are grouped into I/O voltage banks. There are four I/O banks on the A3P250 through A3P1000. The A3P030, A3P060, and A3P125 have two I/O banks. Each I/O voltage bank has dedicated input/output supply and ground voltages (VMV/GNDQ for input buffers and V<sub>CCI</sub>/GND for output buffers). Because of these dedicated supplies, only I/Os with compatible standards can be assigned to the same I/O voltage bank. Table 2-12 shows the required voltage compatibility values for each of these voltages.

For more information about I/O and global assignments to I/O banks, refer to the specific pin table of the device in the "Package Pin Assignments" section on page 4-1 and the "User I/O Naming Convention" section on page 2-46.

I/O standards are compatible if their  $V_{CCI}$  and VMV values are identical. VMV and GNDQ are "quiet" input power supply pins and are not used on A3P030.

#### Table 2-11 • ProASIC3 Supported I/O Standards

	A3P030	A3P060	A3P125	A3P250	A3P400	A3P600	A3P1000
Single-Ended	•					•	
LVTTL/LVCMOS 3.3 V, LVCMOS 2.5 V/1.8 V/1.5 V, LVCMOS 2.5/5.0 V	1	1	1	1	1	1	1
3.3 V PCI/3.3 V PCI-X	_	1	1	1	1	1	1
Differential							
LVPECL and LVDS	_	_	_	1	1	1	1

Table 2-12 • V<sub>CCI</sub> Voltages and Compatible Standards

V <sub>CCI</sub> and VMV (typical)	Compatible Standards
3.3 V	LVTTL/LVCMOS 3.3, PCI 3.3, LVPECL
2.5 V	LVCMOS 2.5, LVCMOS 2.5/5.0, LVDS
1.8 V	LVCMOS 1.8
1.5 V	LVCMOS 1.5



# Features Supported on Every I/O

Table 2-13 lists all features supported by transmitter/receiver for single-ended and differential I/Os.

#### Table 2-13 • I/O Features

Feature	Description
Single-Ended Transmitter Features	<ul> <li>Hot insertion in every mode except PCI or 5 V input tolerant (these modes use clamp diodes and do not allow hot insertion) (A3P030 only)</li> </ul>
	Weak pull-up and pull-down
	• Two slew rates (except A3P030)
	<ul> <li>Skew between output buffer enable/disable time: 2 ns delay (delay on rising edge) and 0 ns delay on falling edge (see "Selectable Skew between Output Buffer Enable/ Disable Time" on page 2-41 for more information)</li> </ul>
	Three drive strengths
	<ul> <li>5 V tolerant receiver ("5 V Input Tolerance" section on page 2-37)</li> </ul>
	• LVTTL/LVCMOS 3.3 V outputs compatible with 5 V TTL inputs ("5 V Output Tolerance" section on page 2-40)
	High performance (Table 2-14)
Single-Ended Receiver Features	Electrostatics Discharge (ESD) protection
	• High performance (Table 2-14)
	• Separate ground and power planes, GNDQ/VMV, for input buffers only to avoid output-induced noise in the input circuitry
Differential Receiver Features (A3P250 through A3P1000)	ESD protection
	• High performance (Table 2-14)
	• Separate ground and power plane, GNDQ, and VMV pins for input buffers only to avoid output-induced noise in the input circuitry
CMOS-Style LVDS or LVPECL Transmitter	• Two I/Os and external resistors are used to provide a CMOS- style LVDS or LVPECL transmitter solution
	Weak pull-up and pull-down
	Fast slew rate

# Table 2-14 • Maximum I/O Frequency for Single-Ended and Differential I/Os (maximum drive strength and high slew selected)

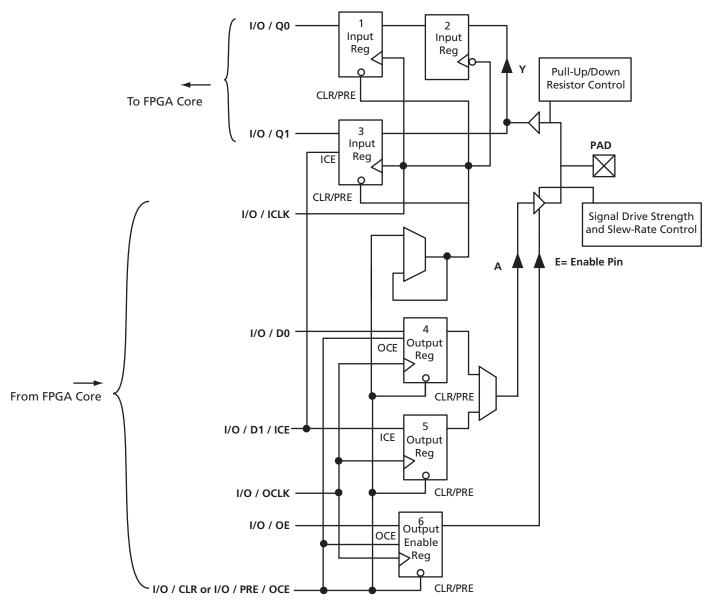
Specification	Performance Up To
LVTTL/LVCMOS 3.3 V	200 MHz
LVCMOS 2.5 V	250 MHz
LVCMOS 1.8 V	200 MHz
LVCMOS 1.5 V	130 MHz
PCI	200 MHz
PCI-X	200 MHz
LVDS	350 MHz
LVPECL	350 MHz

#### I/O Registers

Each I/O module contains several input, output, and enable registers. Refer to Figure 2-23 for a simplified representation of the I/O block.

The number of input registers is selected by a set of switches (not shown in Figure 2-23) between registers to implement single or differential data transmission to and from the FPGA core. The Designer software sets these switches for the user.

A common CLR/PRE signal is employed by all I/O registers when I/O register combining is used. Input Register 2 does not have a CLR/PRE pin, as this register is used for DDR implementation. The I/O registers combining must satisfy some rules.



Note: ProASIC3 I/Os have registers to support DDR functionality (see the "Double Data Rate (DDR) Support" section on page 2-33 for more information).

Figure 2-23 • I/O Block Logical Representation



## Double Data Rate (DDR) Support

ProASIC3 devices support 350 MHz DDR inputs and outputs. In DDR mode, new data is present on every transition of the clock signal. Clock and data lines have identical bandwidths and signal integrity requirements, making it very efficient for implementing very highspeed systems.

In addition, high-speed DDR interfaces can be implemented using LVDS.

#### Input Support for DDR

The basic structure to support a DDR input is shown in Figure 2-24. Three input registers are used to capture incoming data, which is presented to the core on each rising edge of the I/O register clock.

Each I/O tile on ProASIC3 devices supports DDR inputs.

#### **Output Support for DDR**

The basic DDR output structure is shown in Figure 2-25 on page 2-34. New data is presented to the output every half clock cycle. Note: DDR macros and I/O registers do not require additional routing. The combiner automatically recognizes the DDR macro and pushes its registers to the I/O register area at the edge of the chip. The routing delay from the I/O registers to the I/O buffers is already taken into account in the DDR macro.

Refer to the Actel application note Using DDR for ProASIC3/E Devices for more information.

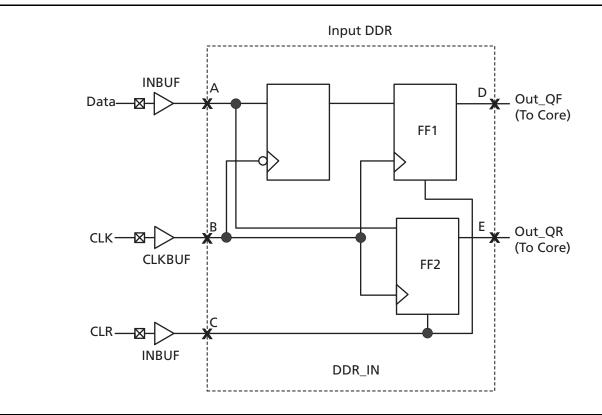


Figure 2-24 • DDR Input Register Support in ProASIC3 Devices

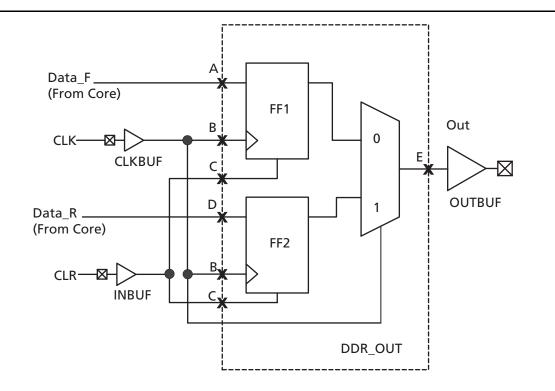


Figure 2-25 • DDR Output Support in ProASIC3 Devices



#### Hot-Swap Support

Hot-swapping (also called hot plugging) is the operation of hot insertion or hot removal of a card in (or from) a powered-up system. The levels of hot-swap support and examples of related applications are described in Table 2-15. The I/Os also need to be configured in hot insertion mode if hot plugging compliance is required. The A3P030 device has an I/O structure that allows the support of Level 3 and Level 4 hot swap with only two levels of staging.

For boards and cards with three levels of staging, it is required that card power supplies have time to reach their final value before the I/Os are connected. Pay attention to the sizing of power supply decoupling

Table 2-15• Levels of Hot-Swap Support

capacitors on the card to ensure that the power supplies are not overloaded with capacitance.

Cards with three levels of staging should have the following sequence:

- Grounds
- Powers
- I/Os and other pins

For Level 3 and Level 4 compliance with the A3P030 device, cards with two levels of staging should have the following sequence:

- Grounds
- Powers, I/Os, other pins

Hot swapping Level	Description	Power Applied to Device	Bus State	Card Ground Connection	Device Circuitry Connected to Bus Pins		Compliance of ProASIC3 Devices
1	Cold Swap	No	_	_	_	System and card with Actel's FPGA chip are powered down, then the card gets plugged into the system, then the power supplies are turned on for the system but not for the FPGA on the card.	Other ProASIC3 devices: Compliant if the bus switch is used to isolate FPGA I/Os from the rest of the system.
2	Hot Swap while reset	Yes	Held in reset state	Must be made and maintained for 1 msec before, during, and after insertion/ removal		specification Reset control circuitry isolates the card busses until the card supplies are at their	
3	Hot Swap while bus idle	Yes	Held idle (no ongoing I/O processes during insertion/ removal)		glitch-free during power	activity on the bus. It is critical that the logic states set on the bus	with cards with two levels of staging. Other ProASIC3 devices: Compliant with cards with three levels of staging.
4	Hot Swap on an active bus	Yes	Bus may have active I/O processes ongoing, but device being inserted or removed must be idle		Level 3	states set on the bus signal do not get	with cards with two levels of staging.

#### **Cold-Sparing Support**

Cold-sparing means that a subsystem with no power applied (usually a circuit board) is electrically connected to the system that is in operation. This means that all input buffers of the subsystem must present very high input impedance with no power applied so as not to disturb the operating portion of the system.

A3P030 device fully supports cold-sparing since the I/O clamp diode is always off (see table 2-16). For other ProASIC3 devices, due to the I/O clamp diode always being active, cold-sparing can be accomplished by either employing bus switch to isolate the device I/Os from the rest of the system, or by driving each ProASIC3 IO pin to 0 V.

In designs where ProASIC3 A3P030 are expected to be cold sparing compliant after supplies are turned off, a discharge resistor, switched resistor, or discharge path needs to be provided from each power supply to ground. If the resistor is chosen, the resistor value must be calculated based on decoupling capacitance on a given power supply on the board (this decoupling capacitor is in parallel with this resistor). The RC constant should ensure full discharge of supplies before cold-sparing functionality is required. The resistor is necessary to ensure that the power pins get discharged to ground every time there is an interruption of power supply on the device.

#### **Electrostatic Discharge (ESD) Protection**

ProASIC3 devices are tested per JEDEC Standard JESD22-A114-B.

ProASIC3 devices contain clamp diodes at every I/O, global, and power pad. Clamp diodes protect all device pads against damage from ESD as well as from excessive voltage transients.

Each I/O has two clamp diodes. One diode has its positive (P) side connected to the pad and its negative (N) side connected to  $V_{CCI}$ . The second diode has its P side connected to GND, and its N side connected to the pad. During operation, these diodes are normally biased in the Off state, except when transient voltage is significantly above  $V_{CCI}$  or below GND levels.

In A3P030, the first diode is always off. On other ProASIC3 devices, the clamp diode is always on and cannot be switched off.

By selecting the appropriate I/O configuration, the diode is turned on or off. Refer to Table 2-16 for more information about the I/O standards and the clamp diode.

The second diode is always connected to the pad, regardless of the I/O configuration selected.

	Clamp Diode <sup>1</sup>		Hot Insertion		5 V Input Tolerance <sup>2</sup>			
I/O Assignment	A3P030	Other ProASIC3 Devices	A3P030	Other ProASIC3 Devices	A3P030	Other ProASIC3 Devices	Input Buffer	Output Buffer
3.3 V LVTTL/LVCMOS	No	Yes	Yes	No	Yes <sup>2</sup>	Yes <sup>2</sup>	Enabled	/Disabled
3.3 V PCI, 3.3 V PCI-X	N/A	Yes	N/A	No	N/A	Yes <sup>2</sup>	Enabled	/Disabled
LVCMOS 2.5 V <sup>4</sup>	No	Yes	Yes	No	Yes <sup>2</sup>	Yes <sup>3</sup>	Enabled	/Disabled
LVCMOS 2.5 V / 5.0 V $^5$	No	Yes	Yes	No	Yes <sup>2</sup>	Yes <sup>3</sup>	Enabled	/Disabled
LVCMOS 1.8 V	No	Yes	Yes	No	No	No	Enabled/Disabled	
LVCMOS 1.5 V	No	Yes	Yes	No	No	No	Enabled/Disabled	
Differential, LVDS/ LVPECL <sup>6</sup>	N/A	Yes	N/A	No	N/A	No	Enabled	/Disabled

#### Table 2-16 • I/O Hot-Swap and 5 V Input Tolerance Capabilities

#### Notes:

1. The clamp diode is always off for the A3P030 device and always active for other ProASIC3 devices.

2. Can be implemented with an external IDT bus switch, resistor divider, or zener with resistor.

3. Can be implemented with an external resistor and an internal clamp diode.

4. LVCMOS 2.5 V I/O standard is supported by the A3P030 device only. In the ACTgen Cores Reference Guide, select the LVCMOS25 macro for LVCMOS 2.5 V I/O standard support for the A3P030 device.

5. LVCMOS 2.5 V / 5.0 V I/O standard is supported by all ProASIC3 devices except A3P030. In the ACTgen Cores Reference Guide, select the LVCMOS5 macro for LVCMOS2.5 V / 5.0 V I/O standard for all ProASIC3 devices except A3P030.

6. Bidirectional LVDS or LVPECL buffers are not supported. I/Os can either be configured as input buffers or output buffers.



#### 5 V Input Tolerance

I/Os can support 5 V input tolerance when LVTTL 3.3 V, LVCMOS 3.3 V, LVCMOS 2.5 V, and LVCMOS 2.5 V configurations are used (see Table 2-17 on page 2-40 for more details). There are four recommended solutions (see Figure 2-26 to Figure 2-29 on page 2-40 for details of board and macro setups) to achieve 5 V receiver tolerance. All the solutions meet a common requirement of limiting the voltage at the I/O input to 3.6 V or less. In fact, the I/O absolute maximum voltage rating is 3.6 V, and any voltage above 3.6 V may cause long term gate oxide failures.

#### Solution 1

The board-level design needs to ensure that the reflected waveform at the pad does not exceed the limits provided in Table 3-3 on page 3-2. This is a long term reliability requirement.

This scheme will also work for a 3.3 VPCI / PCI-X configuration, but the internal diode should not be used for clamping, and the voltage must be limited by the two external resistors as explained below. Relying on the diode clamping would create an excessive pad DC voltage of 3.3 V + 0.7 V = 4 V.

Here are some examples of possible resistor values (based on a simplified simulation model with no line effects, and 10  $\Omega$  transmitter output resistance, where Rtx\_out\_high = (V<sub>CCI</sub> - V<sub>OH</sub>)/I<sub>OH</sub>, Rtx\_out\_low = V<sub>OL</sub> / I<sub>OL</sub>).

Example 1 (high speed, high current):

 $Rtx_out_high = Rtx_out_low = 10 \Omega$ 

R1 = 36 Ω (+/–5%), P(r1)min = 0.069 Ω

R2 = 82 Ω (+/–5%), P(r2)min = 0.158 Ω

 $\label{eq:lmax_tx} \mbox{Imax_tx} = 5.5 \mbox{ V / } (82 \ \mbox{$^{\circ}$} 0.95 \ \mbox{$^{\circ}$} 36 \ \mbox{$^{\circ}$} 0.95 \ \mbox{$^{\circ}$} +10) = 45.04 \ \mbox{$^{\circ}$} \ \mbox{$$ 

 $t_{RISE} = t_{FALL} = 0.85$  ns at C\_pad\_load = 10 pF (includes up to 25% safety margin)

 $t_{\text{RISE}}$  =  $t_{\text{FALL}}$  = 4 ns at C\_pad\_load = 50 pF (includes up to 25% safety margin)

Example 2 (low-medium speed, medium current):

Rtx\_out\_high = Rtx\_out\_low = 10  $\Omega$ 

R1 = 220 Ω (+/–5%), P(r1)min = 0.018 Ω

R2 = 390 Ω (+/–5%), P(r2)min = 0.032 Ω

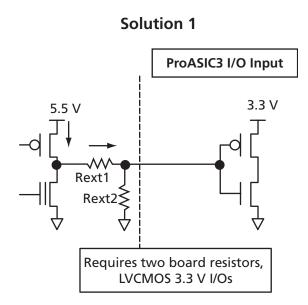
Imax\_tx = 5.5 V / (220 \* 0.95 + 390 \* 0.95 +10) = 9.17 mA

 $t_{RISE} = t_{FALL} = 4$  ns at C\_pad\_load = 10 pF (includes up to 25% safety margin)

 $t_{RISE} = t_{FALL} = 20$  ns at C\_pad\_load = 50 pF (includes up to 25% safety margin)

Other values of resistors are also allowed as long as the resistors are sized appropriately to limit the voltage at the receiving end to  $2.5 \text{ V} < \text{Vin}(\text{rx}) < 3.6 \text{ V}^*$  when the transmitter sends a logic '1'. This range of Vin\_dc(rx) must be assured for any combination of transmitter supply (5 V +/- 0.5 V), transmitter output resistance, and board resistor tolerances.

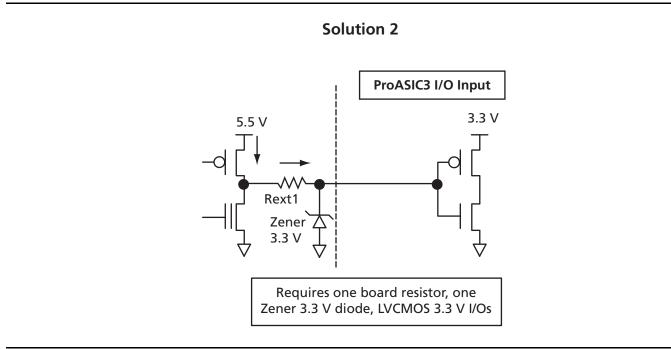
Temporary overshoots are allowed according to Table 3-3 on page 3-2.



#### Solution 2

The board-level design must ensure that the reflected waveform at the pad does not exceed limits provided in Table 3-3 on page 3-2. This is a long-term reliability requirement.

This scheme will also work for a 3.3 V PCI/PCIX configuration, but the internal diode should not be used for clamping, and the voltage must be limited by the external resistors and zener, as shown in Figure 2-27. Relying on the diode clamping would create an excessive pad DC voltage of 3.3 V + 0.7 V = 4 V.

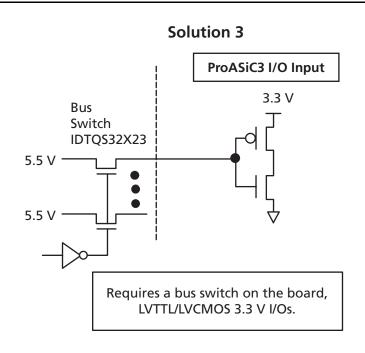


#### Figure 2-27 • Solution 2

#### Solution 3

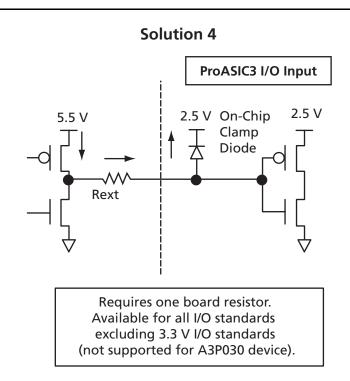
The board-level design must ensure that the reflected waveform at the pad does not exceed limits provided in Table 3-3 on page 3-2. This is a long-term reliability requirement.

This scheme will also work for a 3.3 V PCI/PCIX configuration, but the internal diode should not be used for clamping, and the voltage must be limited by the bus switch, as shown in Figure 2-28. Relying on the diode clamping would create an excessive pad DC voltage of 3.3 V + 0.7 V = 4 V.



#### Figure 2-28 • Solution 3

#### Solution 4



#### Figure 2-29 • Solution 4

Table 2-17	• Comparison Table for 5 V Compliant Receiver Scheme
------------	--

Solution	Board Components	Speed	Current Limitations
1	Two resistors	Low to High <sup>1</sup>	Limited by transmitter's drive strength
2	Resistor and Zener 3.3 V	Medium	Limited by transmitter's drive strength
3	Bus switch	High	N/A
4	Resistor <sup>2</sup> $R = 250 \Omega \text{ at } T_J = 70^{\circ}C$ $R = 500 \Omega \text{ at } T_J = 85^{\circ}C$ $R = 1000 \Omega \text{ at } T_J = 100^{\circ}C$	Low	Diode current 12 mA at T <sub>J</sub> = 70°C 6 mA at T <sub>J</sub> = 85°C 3 mA at T <sub>J</sub> = 100°C

Notes:

1. Speed and current consumption increase as the board resistance values decrease.

2. Resistor values ensure I/O diode long term reliability.

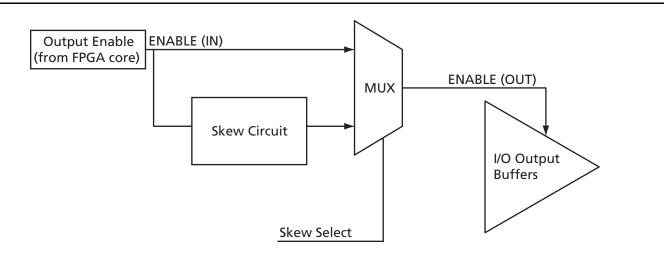
#### **5 V Output Tolerance**

ProASIC3 I/Os must be set to 3.3 V LVTTL or 3.3 V LVCMOS mode to reliably drive 5 V TTL receivers. It is also critical that there be NO external I/O pull-up resistor to 5 V, since this resistor would pull the I/O pad voltage beyond the 3.6 V absolute maximum value, and consequently cause damage to the I/O.

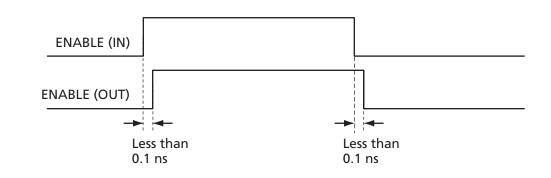
When set to 3.3 V LVTTL or 3.3 V LVCMOS mode, ProASIC3 I/Os can directly drive signals into 5 V TTL receivers. In fact,  $V_{OL} = 0.4$  V and  $V_{OH} = 2.4$  V in both 3.3 V LVTTL and 3.3 V LVCMOS modes exceed the  $V_{IL} = 0.8$  V and  $V_{IH} = 2$  V level requirements of 5 V TTL receivers. Therefore, level '1' and level '0' will be recognized correctly by 5 V TTL receivers.

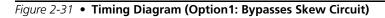
# Selectable Skew between Output Buffer Enable/Disable Time

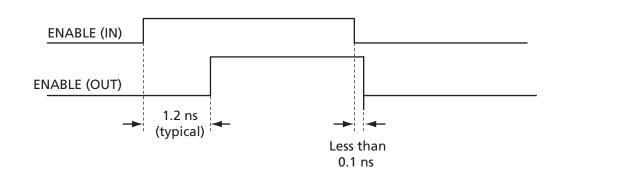
The configurable skew block is used to delay the output buffer assertion (enable) without affecting deassertion (disable) time.

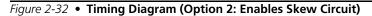


#### Figure 2-30 • Block Diagram of Output Enable Path









At the system level, the skew circuit can be used in applications where transmission activities on bidirectional data lines need to be coordinated. This circuit, when selected, provides a timing margin that can prevent bus contention and subsequent data loss and/or transmitter over-stress due to transmitter-to-transmitter current shorts. Figure 2-33 presents an example of the skew circuit implementation in a bidirectional communication system. Figure 2-34 shows how bus contention is created, and Figure 2-32 on page 2-41 shows how it can be avoided with the skew circuit.

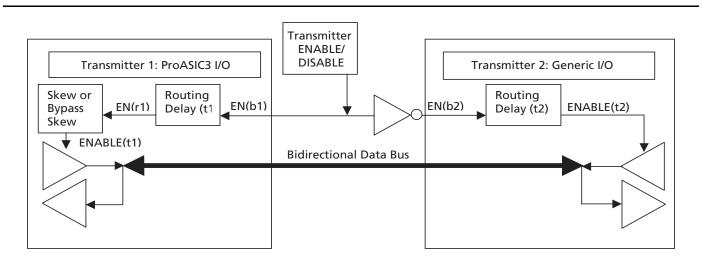


Figure 2-33 • Example of Implementation of Skew Circuits in Bidirectional Transmission Systems Using ProASIC3 Devices

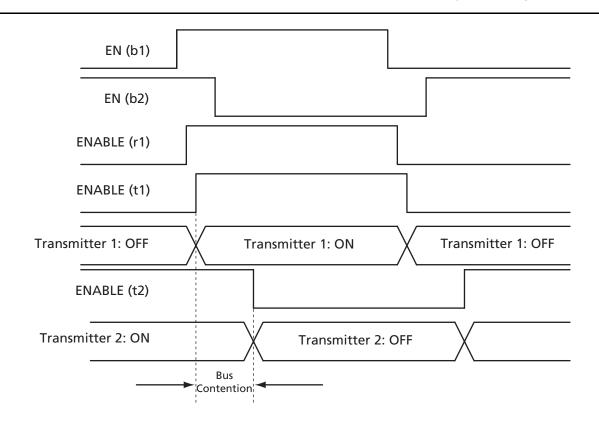


Figure 2-34 • Timing Diagram (Bypasses Skew Circuit)



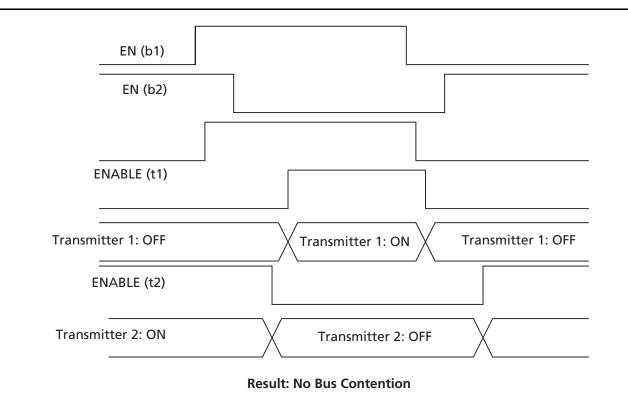


Figure 2-35 • Timing Diagram (with Skew Circuit Selected)

### I/O Software Support

In the ProASIC3 development software, default settings have been defined for the various I/O standards that are supported. Changes can be made to the default settings via the use of attributes; however, not all I/O attributes are applicable for all I/O standards. Table 2-18 lists the valid I/O attributes that can be manipulated by the user for each I/O standard.

Single-ended I/O standards in ProASIC3 support up to five different drive strengths.

I/O Standards	SLEW (output only)	OUT_DRIVE (output only)	SKEW (all macros with OE) *	RES_PULL	OUT_LOAD (output only)	COMBINE_REGISTER
LVTTL/LVCMOS 3.3 V	✓	1	1	1	1	1
LVCMOS 2.5 V	✓	1	1	✓	1	1
LVCMOS 2.5/5.0 V	<i>✓</i>	1	1	1	1	1
LVCMOS 1.8 V	✓	1	1	✓	1	1
LVCMOS 1.5 V	✓	1	1	✓	1	1
PCI (3.3 V)			1		1	1
PCI-X (3.3 V)	✓		1		1	1
LVDS			<i>✓</i>		1	1
LVPECL			1		1	1

Table 2-18 • I/O Attributes vs. I/O Standard Applications

**Note:** \*Applies to all ProASIC3 devices except A3P030.

Table 2-19 lists the default values for the above selectable I/O attributes as well as those that are preset for that I/O standard. See Table 2-21 for SLEW and OUT\_DRIVE settings.

I/O Standards	SLEW (output only)	OUT_DRIVE (output only)	SKEW) (tribuf and bibuf only)	RES_PULL	OUT_LOAD (output only)	COMBINE_REGISTER
LVTTL/LVCMOS 3.3 V	See Table 2-21	See Table 2-21	Off	None	35 pF	-
LVCMOS 2.5 V			Off	None	35 pF	-
LVCMOS 2.5/5.0 V			Off	None	35 pF	-
LVCMOS 1.8 V			Off	None	35 pF	-
LVCMOS 1.5 V			Off	None	35 pF	-
PCI (3.3 V)			Off	None	10 pF	-
PCI-X (3.3 V)			Off	None	10 pF	-
LVDS			Off	None	0 pF	_
LVPECL			Off	None	0 pF	_

#### Table 2-19 • I/O Default Attributes

#### Weak Pull-Up and Weak Pull-Down Resistors

ProASIC3 devices support optional weak pull-up and pull-down resistors per I/O pin. When the I/O is pulled up, it is connected to the  $V_{CCI}$  of its corresponding I/O bank. When it is pulled-down it is connected to GND. Refer to Table 3-20 on page 3-16 for more information.

#### Slew Rate Control and Drive Strength

ProASIC3 devices support output slew rate control: high and low. The A3P030 device does not support slew rate control. The high slew rate option is recommended to minimize the propagation delay. This high-speed option may introduce noise into the system if appropriate signal integrity measures are not adopted. Selecting a low slew rate reduces this kind of noise but adds some delays in the system. Low slew rate is recommended when bus transients are expected. Drive strength should also be selected according to the design requirements and noise immunity of the system. The output slew rate and multiple drive strength controls are available in LVTTL/LVCMOS 3.3 V, LVCMOS 2.5 V, LVCMOS 2.5 V / 5.0 V input, LVCMOS 1.8 V, and LVCMOS 1.5 V. All other I/O standards have a high output slew rate by default.

For A3P030, refer to Table 2-20; for other ProASIC3 devices, refer to Table 2-21 for more information about the slew rate and drive strength specification.

Table 2-20 •	A3P030 I/O Standards—OUT_DRIVE Settings
--------------	---

	0	JT_DRIVE (m	A)
I/O Standards	2	4	8
LVTTL/LVCMOS 3.3 V	1	1	1
LVCMOS 2.5 V	1	1	1
LVCMOS 1.8 V	1	1	-
LVCMOS 1.5 V	1	-	-

Table 2-21 • Other ProASIC3 Device I/O Standards—SLEW and OUT_DRIVE Settings
--

OUT_DRIVE (mA)								
I/O Standards	2	4	6	8	12	16	SI	ew
LVTTL/LVCMOS 3.3 V	1	1	1	1	1	1	High	Low
LVCMOS 2.5 V	$\checkmark$	1	1	1	1	_	High	Low
LVCMOS 1.8 V	1	1	1	1	_	_	High	Low
LVCMOS 1.5 V	$\checkmark$	1	-	_	_	-	High	Low

#### **User I/O Naming Convention**

Due to the comprehensive and flexible nature of ProASIC3 device user I/Os, a naming scheme is used to show the details of the I/O (Figure 2-36 and Figure 2-37 on page 2-47). The name identifies to which I/O bank it belongs, as well as the pairing and pin polarity for differential I/Os.

I/O Nomenclature = Gmn/IOuxwBy

Gmn is only used for I/Os that also have CCC access - i.e., global pins.

- G = Global
- m = Global pin location associated with each CCC on the device: A (northwest corner), B (northeast corner), C (east middle), D (southeast corner), E (southwest corner), and F (west middle).
- n = Global input MUX and pin number of the associated Global location m, either A0, A1,A2, B0, B1, B2, C0, C1, or C2. Figure 2-15 on page 2-18 shows the three input pins per each clock source MUX at the CCC location m.
- u = I/O pair number in the bank, starting at 00 from the northwest I/O bank in a clockwise direction.
- x = P (Positive) or N (Negative) for differential pairs, or R (Regular single-ended) for the I/Os that support single-ended and voltage-referenced I/O standards only. U (Positive-LVDS only) or V (Negative-LVDS only) restrict the I/O differential pair from being selected as LVPECL pair.
- w = D (Differential Pair), P (Pair), S (Single-Ended). D (Differential Pair) if both members of the pair are bonded out to adjacent pins or are separated only by one GND or NC pin; P (Pair) if both members of the pair are bonded out but do not meet the adjacency requirement; or S (Single-Ended) if the I/O pair is not bonded out. For Differential (D) pairs, adjacency for ball grid packages means only vertical or horizontal. Diagonal adjacency does not meet the requirements for a true differential pair.

B = Bank

y = Bank number [0..3]. The Bank number starts at 0 from the northwest I/O bank and proceeds in a clockwise direction.

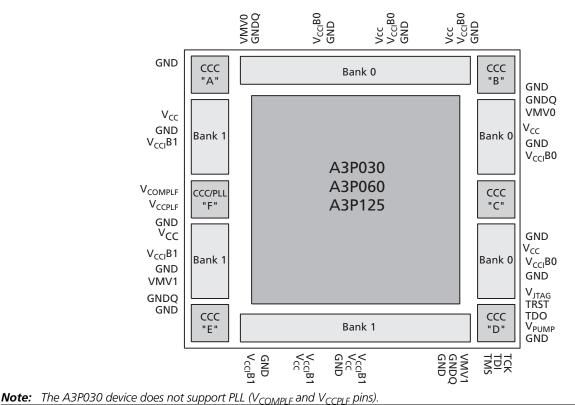


Figure 2-36 • Naming Conventions of ProASIC3 Devices with Two I/O Banks



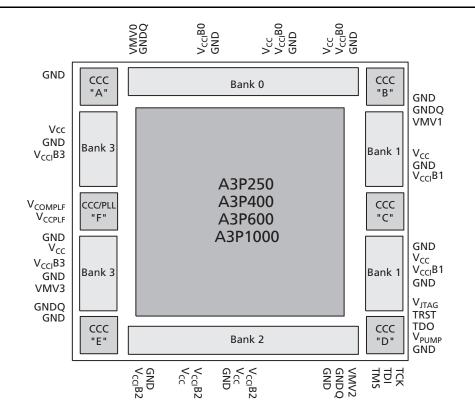


Figure 2-37 • Naming Conventions of ProASIC3 Devices with Four I/O Banks

# **Pin Descriptions**

# **Supply Pins**

GND

#### Ground

Ground supply voltage to the core, I/O outputs, and I/O logic.

#### GNDQ Ground (quiet)

Quiet ground supply voltage to input buffers of I/O banks. Within the package, the GNDQ plane is decoupled from the simultaneous switching noise originated from the output buffer ground domain. This minimizes the noise transfer within the package, and improves input signal integrity. GNDQ needs to always be connected on the board to GND.

#### V<sub>CC</sub> Core Supply Voltage

Supply voltage to the FPGA core, nominal 1.5 V.

#### V<sub>CCI</sub>Bx I/O Supply Voltage

Supply voltage to the bank's I/O output buffers and I/O logic. Bx is the I/O bank number. There are eight I/O banks on ProASIC3 devices plus a dedicated V<sub>JTAG</sub> bank. Each bank can have a separate V<sub>CCI</sub> connection. All I/Os in a bank will run off the same V<sub>CCI</sub>Bx supply. V<sub>CCI</sub> can be 1.5 V, 1.8 V, 2.5 V, or 3.3 V nominal voltage. Unused I/O banks should have their corresponding V<sub>CCI</sub> pins tied to GND.

#### VMVx I/O Supply Voltage (quiet)

Quiet supply voltage to the input buffers of each I/O bank. X is the bank number. Within the package, the VMV plane is decoupled from the simultaneous switching noise originated from the output buffer  $V_{CC}$ domain. This minimizes the noise transfer within the package, and improves input signal integrity. Each bank must have at least one VMV connection. All I/Os in a bank run off the same VMVx supply. VMV is used to provide a quiet supply voltage to the input buffers of each I/O bank. VMVx can be 1.5 V, 1.8 V, 2.5 V, or 3.3 V nominal voltage. Unused I/O banks should have their corresponding VMV pins tied to GND. VMV and  $V_{CCL}$ should be at the same voltage within a given I/O bank. Used VMV pins must be connected to the corresponding V<sub>CCI</sub> pins of the same bank (i.e., VMV0 to V<sub>CCI</sub>B0, VMV1 to V<sub>CCI</sub>B1, etc.).

#### V<sub>CCPLF</sub> PLL Supply Voltage<sup>7</sup>

Supply voltage to analog PLL, nominal 1.5 V. If unused,  $V_{CCPLF}$  should be tied to GND. Refer to the PLL application note for a complete board solution for the PLL analog power supply and ground.

#### V<sub>COMPLF</sub> PLL Ground<sup>7</sup>

Ground to analog PLL. Unused  $V_{\mbox{COMPLF}}$  pin should be connected to GND.

#### VJTAG JTAG Supply Voltage

ProASIC3 devices have a separate bank for the dedicated JTAG pins. The JTAG pins can be run at any voltage from 1.5 V to 3.3 V (nominal). Isolating the JTAG power supply in a separate I/O bank gives greater flexibility with supply selection and simplifies power supply and printed circuit board design. If the JTAG interface is not used nor planned to be used, the V<sub>JTAG</sub> pin together with the TRST pin could be tied to GND.

### V<sub>PUMP</sub> Programming Supply Voltage

ProASIC3 devices support single-voltage ISP programming of the configuration Flash and FROM. For programming,  $V_{PUMP}$  should be 3.3 V nominal. During normal device operation,  $V_{PUMP}$  can be left floating or can be tied (pulled up) to any voltage between 0 V and 3.6 V.

## **User Pins**

#### I/O User Input/Output

The I/O pin functions as an input, output, tristate, or bidirectional buffer. Input and output signal levels are compatible with the I/O standard selected. Unused I/O pins are configured as inputs with pull-up resistors.

During programming, I/Os become tristated and weakly pulled up to  $V_{CCI}$ . With  $V_{CCI}$ , VMV and  $V_{CC}$  supplies continuously powered-up, and the device transitions from programming to operating mode, the I/Os get instantly configured to the desired user configuration.

#### GL Globals

GL I/Os have access to certain clock conditioning circuitry (and the PLL) and/or have direct access to the global network (spines). Additionally, the global I/Os can be used as I/Os, since they have identical capabilities. Unused GL pins are configured as inputs with pull-up resistors. See more detailed descriptions of global I/O connectivity in the "Clock Conditioning Circuits" section on page 2-15.

Refer to the "User I/O Naming Convention" section on page 2-46 for a description of naming of global pins.

<sup>7.</sup> The A3P030 device does not support this feature.



# **JTAG Pins**

ProASIC3 devices have a separate bank for the dedicated JTAG pins. The JTAG pins can be run at any voltage from 1.5 V to 3.3 V (nominal). Isolating the JTAG power supply in a separate I/O bank gives greater flexibility with supply selection and simplifies power supply and printed circuit board design. If the JTAG interface is not used nor planned to be used, the V<sub>JTAG</sub> pin together with the TRST pin could be tied to GND.

#### TCK Test Clock

Test clock input for JTAG boundary scan, ISP, and UJTAG. The TCK pin does not have an internal pull-up/down resistor. If JTAG is not used, Actel recommends tying off TCK to GND or  $V_{JTAG}$  through a resistor placed close to the FPGA pin. This prevents JTAG operation in case TMS enters an undesired state.

Note that to operate at all  $V_{JTAG}$  voltages, 500  $\Omega$  to 1  $k\Omega$  will satisfy the requirements. Refer to Table 2-22 for more information.

 
 Table 2-22
 Recommended Tie-Off Values for the TCK and TRST Pins

V <sub>JTAG</sub>	Tie Off Resistance <sup>2, 3</sup>
V <sub>JTAG</sub> at 3.3 V	200 $\Omega$ to 1 k $\Omega$
V <sub>JTAG</sub> at 2.5 V	200 Ω to 1 kΩ
V <sub>JTAG</sub> at 1.8 V	500 $\Omega$ to 1 k $\Omega$
V <sub>JTAG</sub> at 1.5 V	500 Ω to 1 kΩ

Notes:

1. Equivalent parallel resistance if more than one device is on JTAG chain.

- 2. The TCK pin can be pulled-up/down.
- 3. The TRST pin can only be pulled-down.

Note that to operate at all V<sub>JTAG</sub> voltages, 500  $\Omega$  to 1 k $\Omega$  will satisfy the requirements.

#### TDI Test Data Input

Serial input for JTAG boundary scan, ISP, and UJTAG usage. There is an internal weak pull-up resistor on the TDI pin.

#### TDO Test Data Output

Serial output for JTAG boundary scan, ISP, and UJTAG usage.

# TMS Test Mode Select

The TMS pin controls the use of the IEEE1532 boundary scan pins (TCK,TDI, TDO, TRST). There is an internal weak pull-up resistor on the TMS pin.

#### TRST Boundary Scan Reset Pin

The TRST pin functions as an active-low input to asynchronously initialize (or reset) the boundary scan circuitry. There is an internal weak pull-up resistor on the TRST pin. If JTAG is not used, an external pull-down resistor could be included to ensure the TAP is held in reset mode. The resistor values must be chosen from Table 2-22 and must satisfy the parallel resistance value requirement. The values in Table 2-22 correspond to the resistor recommended when a single device is used and to the equivalent parallel resistor when multiple devices are connected via a JTAG chain.

In critical applications an upset in the JTAG circuit could allow entering an undesired JTAG state. In such cases, Actel recommends tying off TRST to GND through a resistor placed close to the FPGA pin.

Note that to operate at all VJTAG voltages, 500  $\Omega$  to 1  $k\Omega$  will satisfy the requirements.

# **Special Function Pins**

#### NC No Connect

This pin is not connected to circuitry within the device. These pins can be driven to any voltage or can be left floating with no effect on the operation of the device.

#### DC Don't Connect

This pin should not be connected to any signals on the printed circuit board (PCB). These pins should be left unconnected.

# **Software Tools**

# **Overview of Tools Flow**

The ProASIC3 family of FPGAs is fully supported by both Actel Libero IDE and Designer FPGA Development software. Actel Libero IDE is an integrated design manager that seamlessly integrates design tools while guiding the user through the design flow, managing all design and log files, and passing necessary design data among tools. Additionally, Libero IDE allows users to integrate both schematic and HDL synthesis into a single flow and verify the entire design in a single environment (see the *Libero IDE flow diagram* located on the Actel website). Libero IDE includes Synplify<sup>®</sup> AE from Synplicity<sup>®</sup>, ViewDraw<sup>®</sup> AE from Mentor Graphics<sup>®</sup>, ModelSim<sup>®</sup> HDL Simulator from Mentor Graphics, WaveFormer Lite<sup>™</sup> AE from SynaptiCAD<sup>®</sup>, PALACE<sup>™</sup> AE Physical Synthesis from Magma Design Automation<sup>™</sup>, and Designer software from Actel.

Actel Designer software is a place-and-route tool and provides a comprehensive suite of back-end support tools for FPGA development. The Designer software includes the following:

- Timer a world-class integrated static timing analyzer and constraints editor that supports timing-driven place-and-route
- NetlistViewer a design netlist schematic viewer
- ChipPlanner a graphical floorplanner viewer and editor
- SmartPower tool which enables the designer to quickly estimate the power consumption of a design
- PinEditor a graphical application for editing pin assignments and I/O attributes
- I/O Attribute Editor tool which displays all assigned and unassigned I/O macros and their attributes in a spreadsheet format

With the Designer software, a user can lock the design pins before layout while minimally impacting the results of place-and-route. Additionally, Actel back-annotation flow is compatible with all the major simulators. Another tool included in the Designer software is the ACTgen core generator, which easily creates popular and commonly used logic functions for implementation into your schematic or HDL design.

Actel Designer software is compatible with the most popular FPGA design entry and verification tools from EDA vendors, such as Mentor Graphics, Synplicity, Synopsys, and Cadence<sup>®</sup>. The Designer software is available for both the Windows<sup>®</sup> and UNIX operating systems.

# Programming

Programming can be performed using various programming tools, such as Silicon Sculptor II (BP Micro Systems) or FlashPro3 (Actel).

The user can generate \*.stp programming files from the Designer software and can use these files to program a device.

ProASIC3 devices can be programmed in system. For more information on ISP of ProASIC3 devices, refer to the In-System Programming (ISP) in ProASIC3/E Using FlashPro3 and Programming a ProASIC3/E Using a Microprocessor application notes.

# Security

ProASIC3 devices have a built-in 128-bit AES decryption core (except the A3P030 device). The decryption core facilitates secure, in-system programming of the FPGA core array fabric and the FROM. The FROM and the FPGA core fabric can be programmed independently from each other, allowing the FROM to be updated without the need for change to the FPGA core fabric. The AES master key is stored in on-chip nonvolatile memory (Flash). The AES master key can be preloaded into parts in a secure programming environment (such as the Actel in-house programming center) and then "blank" parts can be shipped to an untrusted programming or manufacturing center for final personalization with an AES encrypted bitstream. Late stage product changes or personalization can be implemented easily and securely by simply sending a STAPL file with AES encrypted data. Secure remote field updates over public networks (such as the Internet) are possible by sending and programming a STAPL file with AES encrypted data.

# **128-Bit AES Decryption<sup>8</sup>**

The 128-bit AES standard (FIPS-192) block cipher is the NIST (National Institute of Standards and Technology) replacement for the DES (Data Encryption Standard FIPS46-2). AES has been designed to protect sensitive government information well into the 21st century. It replaces the aging DES, which NIST adopted in 1977 as a Federal Information Processing Standard used by federal agencies to protect sensitive, unclassified information. The 128-bit AES standard has  $3.4 \times 10^{38}$  possible 128-bit key variants, and it has been estimated that it would take 1,000 trillion years to crack 128-bit AES cipher text using exhaustive techniques. Keys are stored (securely) in ProASIC3 devices in nonvolatile Flash memory. All programming files sent to the device can be authenticated by the part prior to programming to

<sup>8.</sup> The A3P030 device does not support AES decryption.



ensure that bad programming data is not loaded into the part that may possibly damage it. All programming verification is performed on-chip, ensuring that the contents of ProASIC3 devices remain secure.

ARM7-ready ProASIC3 devices do not support the AES decryption capability.

AES decryption can also be used on the 1,024-bit FROM to allow for secure remote updates of the FROM contents. This allows for easy, secure support for subscription model products. See the application note, *ProASIC3/E Security*, for more details.

# ISP

ProASIC3 devices support IEEE1532 ISP via JTAG and require a single V<sub>PUMP</sub> voltage of 3.3 V during programming. In addition, programming via a Microcontroller (MCU) in a target system can be achieved. See the application note *In-System Programming (ISP) in ProASIC3/E Using FlashPro3* for more details.

# JTAG 1532

#### Programming

ProASIC3 devices support the JTAG-based IEEE1532 standard for ISP. As part of this support, when a ProASIC3 device is in an unprogrammed state, all user I/O pins are disabled. This is achieved by keeping the global IO\_EN signal deactivated, which also has the effect of disabling the input buffers. Consequently, the SAMPLE instruction will have no effect while the ProASIC3 device is in this unprogrammed state—different behavior from that of the ProASIC<sup>PLUS</sup> device family. This is done because SAMPLE is defined in the IEEE1532 specification as a noninvasive instruction. If the input buffers were to be enabled by SAMPLE temporarily turning on the I/Os, then it would not truly be a noninvasive instruction. Refer to the standard or the *In-System Programming (ISP) in ProASIC3/E Using FlashPro3* application note for more details.

For JTAG timing information of setup, hold, and fall times refer to the *FlashPro User's Guide*.

#### **Boundary Scan**

ProASIC3 devices are compatible with IEEE Standard 1149.1, which defines a hardware architecture and the set of mechanisms for boundary scan testing. The basic ProASIC3 boundary scan logic circuit is composed of the TAP (test access port) controller, test data registers, and instruction register (Figure 2-38 on page 2-52). This circuit supports all mandatory IEEE 1149.1 instructions (EXTEST, SAMPLE/PRELOAD, and BYPASS) and the optional IDCODE instruction (Table 2-24 on page 2-52).

Each test section is accessed through the TAP, which has five associated pins: TCK (test clock input), TDI, TDO (test data input and output), TMS (test mode selector), and TRST (test reset input). TMS, TDI, and TRST are equipped with pull-up resistors to ensure proper operation when no input data is supplied to them. These pins are dedicated for boundary scan test usage. Refer to the "JTAG Pins" section on page 2-49 for pull-up/down recommendations for TDO and TCK pins. The TAP controller is a 4-bit state machine (16 states) that operates as shown in Figure 2-38 on page 2-52. The 1s and 0s represent the values that must be present at TMS at a rising edge of TCK for the given state transition to occur. IR and DR indicate that the instruction register or the data register is operating in that state.

V <sub>JTAG</sub>	Tie-off Resistance*
V <sub>JTAG</sub> at 3.3 V	200 $\Omega$ to 1 k $\Omega$
V <sub>JTAG</sub> at 2.5 V	200 $\Omega$ to 1 k $\Omega$
V <sub>JTAG</sub> at 1.8 V	500 $\Omega$ to 1 k $\Omega$
V <sub>JTAG</sub> at 1.5 V	500 Ω to 1 kΩ

**Note:** \*Equivalent parallel resistance if more than one device is on JTAG chain.

The TAP controller receives two control inputs (TMS and TCK) and generates control and clock signals for the rest of the test logic architecture. On power-up, the TAP controller enters the Test-Logic-Reset state. To guarantee a reset of the controller from any of the possible states, TMS must remain high for five TCK cycles. The TRST pin may also be used to asynchronously place the TAP controller in the Test-Logic-Reset state.

ProASIC3 devices support three types of test data registers: bypass, device identification, and boundary scan. The bypass register is selected when no other register needs to be accessed in a device. This speeds up test data transfer to other devices in a test data path. The 32-bit device identification register is a shift register with four fields (LSB, ID number, part number, and version). The boundary scan register observes and controls the state of each I/O pin. Each I/O cell has three boundary scan register cells, each with a serial-in, serialout, parallel-in, and parallel-out pin.

The serial pins are used to serially connect all the boundary scan register cells in a device into a boundary scan register chain, which starts at the TDI pin and ends at the TDO pin. The parallel ports are connected to the internal core logic I/O tile and the input, output, and control ports of an I/O buffer to capture and load data into the register to control or observe the logic state of each I/O.

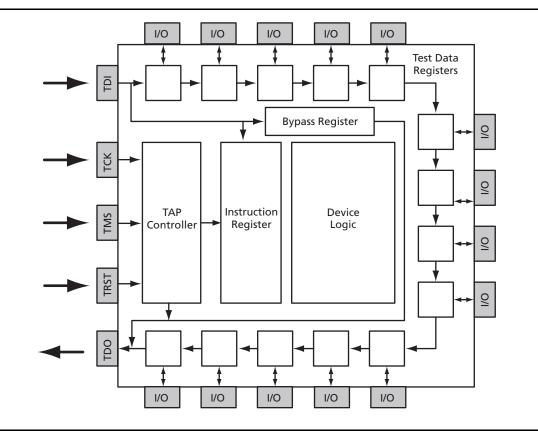


Figure 2-38 • Boundary Scan Chain in ProASIC3

#### Table 2-24 • Boundary Scan Opcodes

	Hex Opcode
EXTEST	00
HIGHZ	07
USERCODE	OE
SAMPLE/PRELOAD	01
IDCODE	OF
CLAMP	05
BYPASS	FF



# **DC and Switching Characteristics**

# **General Specifications**

DC and switching characteristics for -F speed grade targets are based only on simulation.

The characteristics provided for –F speed grade are subject to change after establishing FPGA specifications. Some restrictions might be added and will be reflected in future revisions of this document. The –F speed grade is only supported in the commercial temperature range.

# **Operating Conditions**

Stresses beyond those listed in the Table 3-1 may cause permanent damage to the device.

Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the recommended operating ranges specified in Table 3-2 on page 3-2.

Symbol	Parameter	Limits	Units
V <sub>CC</sub>	DC core supply voltage	–0.3 to 1.65	V
V <sub>JTAG</sub>	JTAG DC voltage	-0.3 to 3.75	V
V <sub>PUMP</sub>	Programming voltage	-0.3 to 3.75	V
V <sub>CCPLL</sub>	Analog power supply (PLL)	-0.3 to 1.65	V
V <sub>CCI</sub>	DC I/O output buffer supply voltage	-0.3 to 3.75	V
VMV	DC I/O input buffer supply voltage	-0.3 to 3.75	V
VI	l/O input voltage	-0.3 V to 3.6 V (when I/O hot insertion mode is enabled) -0.3 V to ( $V_{CCI}$ + 1 V) or 3.6 V, whichever voltage is lower (when I/O hot-insertion mode is disabled)	V

Table 3-1 • Absolute Maximum Ratings

#### Notes:

1. Device performance is not guaranteed if storage temperature exceeds 110°C.

2. The device should be operated within the limits specified by the datasheet. During transitions, the input signal may undershoot or overshoot according to the limits shown in Table 3-3 on page 3-2.

Symbol	Parame	ter	Commercial	Industrial	Units
T <sub>a</sub>	Ambient temperature		0 to +70	-40 to +85	°C
V <sub>CC</sub>	1.5 V DC core supply voltage		1.425 to 1.575	1.425 to 1.575	V
V <sub>JTAG</sub>	JTAG DC voltage		1.4 to 3.6	1.4 to 3.6	V
V <sub>PUMP</sub>	Programming voltage	Programming Mode	3.0 to 3.6	3.0 to 3.6	V
		Operation <sup>3</sup>	0 to 3.6	0 to 3.6	V
V <sub>CCPLL</sub>	Analog power supply (PLL)		1.4 to 1.6	1.4 to 1.6	V
$V_{CCI}$ and $VMV$	1.5 V DC supply voltage		1.425 to 1.575	1.425 to 1.575	V
	1.8 V DC supply voltage		1.7 to 1.9	1.7 to 1.9	V
	2.5 V DC supply voltage		2.3 to 2.7	2.3 to 2.7	V
	3.3 V DC supply voltage		3.0 to 3.6	3.0 to 3.6	V
	LVDS differential I/O		2.375 to 2.625	2.375 to 2.625	V
	LVPECL differential I/O		3.0 to 3.6	3.0 to 3.6	V

#### Table 3-2 • Recommended Operating Conditions

Notes:

1. The ranges given here are for power supplies only. The recommended input voltage ranges specific to each I/O standard are given in Table 3-13 on page 3-14. VMV and V<sub>CCI</sub> should be at the same voltage within a given I/O bank.

2. All parameters representing voltages are measured with respect to GND unless otherwise specified.

3. V<sub>PUMP</sub> can be left floating during operation (not programming mode).

#### Table 3-3 • Overshoot and Undershoot Limits (as measured on quiet I/Os)<sup>1</sup>

V <sub>CCI</sub> and VMV	Average V <sub>CCI</sub> -GND Overshoot or Undershoot Duration as Percentage of Clock Cycle <sup>2</sup>	Maximum Overshoot/ Undershoot <sup>2</sup>
2.7 V or less	10%	1.4 V
	5%	1.49 V
3 V	10%	1.1 V
	5%	1.19 V
3.3 V	10%	0.79 V
	5%	0.88 V
3.6 V	10%	0.45 V
	5%	0.54 V

Notes:

1. Based on reliability requirements at 85°C.

2. The duration is allowed at one cycle out of six clock cycles (estimated SSO density over cycles). If the overshoot/undershoot occurs at one out of two cycles, then the maximum overshoot/undershoot has to be reduced by 0.15 V.

Table 3-4 •	Flash Programming,	Storage, and	<b>Operating Limits</b>
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Product		Program	Storage Te	mperature	Maximum Operating Junction
Grade	Programming Cycles	Retention	Min.	Max.	Temperature T <sub>J</sub> (°C)
Commercial	500	20 years	0	110	110
Industrial	500	20 years	-40	110	110

Note: This is a stress rating only. Functional operation at any other condition other than those indicated is not implied.



# I/O Power-Up and Supply Voltage Thresholds for Power-On Reset (Commercial and Industrial)

Sophisticated power-up management circuitry is designed into every ProASIC3 device. These circuits ensure easy transition from the powered-off state to the powered-up state of the device. The many different supplies can power-up in any sequence with minimized current spikes or surges. In addition, the I/O will be in a known state through the power-up sequence. The basic principle is shown in Figure 3-1.

There are five regions to consider during power-up.

ProASIC3 I/Os are activated only if ALL of the following three conditions are met:

- 1. V<sub>CC</sub> and V<sub>CCI</sub> are above the minimum specified trip points (Figure 3-1).
- 2.  $V_{CCI} > V_{CC} 0.75 V$  (Typical).
- 3. Chip is in the operating mode.

#### V<sub>CCI</sub> Trip Point:

Ramping up: 0.6 V < trip\_point\_up < 1.2 V Ramping down: 0.5 V < trip\_point\_down < 1.1 V

#### V<sub>CC</sub> Trip Point:

Ramping up: 0.6 V < trip\_point\_up < 1.1 V

Ramping down: 0.5 V < trip\_point\_down < 1 V

 $V_{CC}$  and  $V_{CCI}$  ramp-up trip points are about 100 mV higher than ramp-down trip points. This specifically built-in hysteresis prevents undesirable power-up oscillations and current surges. Note the following:

- During programming, I/Os become tristated and weakly pulled up to V<sub>CCI</sub>.
- JTAG supply, PLL power supplies, and charge pump V<sub>PUMP</sub> supply have no influence on I/O behavior.

#### **Internal Power-Up Activation Sequence**

- 1. Core
- 2. Input buffers
- 3. Output buffers, after 200 ns delay from input buffer activation.

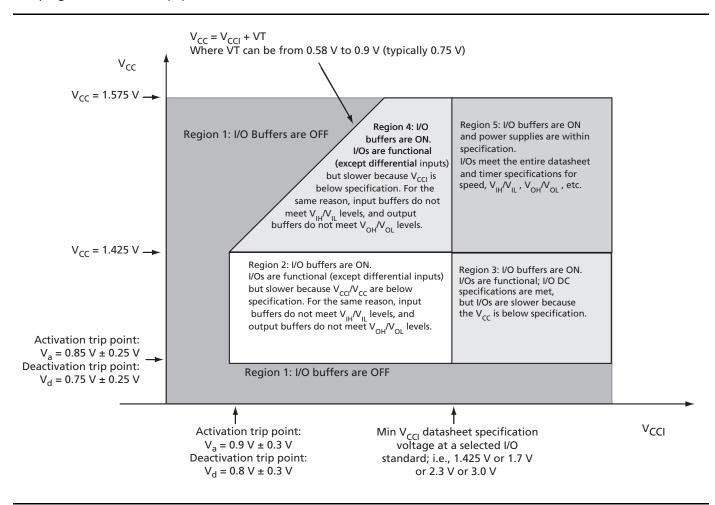


Figure 3-1 • I/O State as a Function of V<sub>CCI</sub> and V<sub>CC</sub> Voltage Levels

# **Thermal Characteristics**

#### Introduction

The temperature variable in the Actel Designer software refers to the junction temperature, not the ambient temperature. This is an important distinction because dynamic and static power consumption cause the chip junction to be higher than the ambient temperature.

EQ 3-1 can be used to calculate junction temperature.

$$T_J = Junction Temperature = \Delta T + T_a$$

EQ 3-1

Where  $T_a = Ambient Temperature$ 

 $\Delta T$  = Temperature gradient between junction (silicon) and ambient  $\Delta T$  =  $\theta_{ja}$  \* P

 $\theta_{ja}$  = Junction-to-ambient of the package.  $\theta_{ja}$  numbers are located in Table 3-5.

P = Power dissipation

### **Package Thermal Characteristics**

The device junction-to-case thermal resistivity is  $\theta_{jc}$  and the junction-to-ambient air thermal resistivity is  $\theta_{ja}$ . The thermal characteristics for  $\theta_{ja}$  are shown for two air flow rates. The absolute maximum junction temperature is 110°C. EQ 3-2 shows a sample calculation of the absolute maximum power dissipation allowed for a 484-pin FBGA package at commercial temperature and still air.

Maximum Power Allowed = 
$$\frac{\text{Max. junction temp. (°C)} - \text{Max. ambient temp. (°C)}}{\theta_{ja}(°C/W)} = \frac{150°C - 70°C}{20.5°C/W} = 3.90 \text{ W}$$
  
EQ 3-2

#### Table 3-5Package Thermal Resistivities

				$ heta_{ja}$		
Package Type	Pin Count	$\theta_{jc}$	Still Air	200 ft./min.	500 ft./min.	Units
Quad Flat No Lead (QFN)	132	13.2	28.9	24.6	23.1	C/W
Very Thin Quad Flat Pack (VQFP)	100	10.0	35.3	29.4	27.1	C/W
Thin Quad Flat Pack (TQFP)	144	11.0	33.5	28.0	25.7	C/W
Plastic Quad Flat Package (PQFP)	208	8.0	26.1	22.5	20.8	C/W
Plastic Quad Flat Package (PQFP) with embedded heat spreader	208	3.8	16.2	13.3	11.9	C/W
Fine Pitch Ball Grid Array (FBGA)	144	3.8	26.9	22.9	21.5	C/W
	256	3.8	26.6	22.8	21.5	C/W
	484	3.2	20.5	17.0	15.9	C/W

#### **Temperature and Voltage Derating Factors**

Table 3-6 • Temperature and Voltage Derating Factors for Timing Delays (Normalized to  $T_J = 70^{\circ}$ C,  $V_{CC} = 1.425$  V)

Array Voltage V <sub>CC</sub>		Junction Temperature (°C)				
(V)	–40°C	0°C	25°C	70°C	85°C	110°C
1.425	0.88	0.93	0.95	1.00	1.02	1.05
1.500	0.83	0.87	0.89	0.94	0.96	0.98
1.575	0.80	0.84	0.86	0.91	0.92	0.95



# **Calculating Power Dissipation**

# **Quiescent Supply Current**

#### Table 3-7 • Quiescent Supply Current Characteristics

	A3P030	A3P060	A3P125	A3P250	A3P400	A3P600	A3P1000
Typical (25°C)	2 mA	2 mA	2 mA	3 mA	3 mA	5 mA	8 mA
Maximum (Commercial)	10 mA	10 mA	10 mA	20 mA	20 mA	30 mA	50 mA
Maximum (Industrial)	15 mA	15 mA	15 mA	30 mA	30 mA	45 mA	75 mA

Notes:

1.  $I_{DD}$  Includes  $V_{CC}$ ,  $V_{PUMP}$ ,  $V_{CC}$ , and VMV currents. Values do not include I/O static contribution, which is shown in Table 3-8 and Table 3-9 on page 3-6.

2. –F speed grade devices may experience higher standby I<sub>DD</sub> of up to five times the standard I<sub>DD</sub> and higher I/O leakage.

# **Power Per I/O Pin**

#### Table 3-8 • Summary of I/O Input Buffer Power (Per Pin) – Default I/O Software Settings

	VMV (V)	Static Power P <sub>DC2</sub> (mW) <sup>1</sup>	Dynamic Power P <sub>AC9</sub> (µW/MHz) <sup>2</sup>
Single-Ended		•	•
3.3 V LVTTL / 3.3 V LVCMOS	3.3	-	16.69
2.5 V LVCMOS	2.5	-	5.12
1.8 V LVCMOS	1.8	-	2.13
1.5 V LVCMOS (JESD8-11)	1.5	-	1.45
3.3 V PCI	3.3	-	18.11
3.3 V PCI-X	3.3	-	18.11
Differential	•	•	•
LVDS	2.5	2.26	1.20
LVPECL	3.3	5.72	1.87
Notoci	•	•	P

Notes:

1.  $P_{DC2}$  is the static power (where applicable) measured on VMV.

2.  $P_{AC9}$  is the total dynamic power measured on  $V_{CC}$  and VMV.

	C <sub>LOAD</sub> (pF)	V <sub>CCI</sub> (V)	Static Power P <sub>DC3</sub> (mW) <sup>2</sup>	Dynamic Power P <sub>AC10</sub> (µW/MHz) <sup>3</sup>
Single-Ended			•	
3.3 V LVTTL / 3.3 V LVCMOS	35	3.3	-	468.67
2.5 V LVCMOS	35	2.5	-	267.48
1.8 V LVCMOS	35	1.8	-	138.32
1.5 V LVCMOS (JESD8-11)	35	1.5	-	96.13
3.3 V PCI	10	3.3	-	201.02
3.3 V PCI-X	10	3.3	-	201.02
Differential			• •	
LVDS	-	2.5	7.74	88.92
LVPECL	-	3.3	19.54	166.52

#### Table 3-9 • Summary of I/O Output Buffer Power (Per Pin) – Default I/O Software Settings<sup>1</sup>

Notes:

1. Dynamic power consumption is given for standard load and software default drive strength and output slew.

2.  $P_{DC3}$  is the static power (where applicable) measured on  $V_{CCI}$ .

3.  $P_{AC10}$  is the total dynamic power measured on  $V_{CC}$  and  $V_{CCI}$ .

# **Power Consumption of Various Internal Resources**

#### Table 3-10 • Different Components Contributing to Dynamic Power Consumption in ProASIC3 Devices

Parameter	Definition	Device Specific Dynamic Power (μW/MHz)
		A3P250
P <sub>AC1</sub>	Clock contribution of a Global Rib	100
P <sub>AC2</sub>	Clock contribution of a Global Spine	10
P <sub>AC3</sub>	Clock contribution of a VersaTile row	1.00
P <sub>AC4</sub>	Clock contribution of a VersaTile used as a sequential module	0.11
P <sub>AC5</sub>	First contribution of a VersaTile used as a sequential module	0.07
P <sub>AC6</sub>	Second contribution of a VersaTile used as a sequential module	0.29
P <sub>AC7</sub>	Contribution of a VersaTile used as a combinatorial Module	0.29
P <sub>AC8</sub>	Average contribution of a routing net	0.70
P <sub>AC9</sub>	Contribution of an I/O input pin (standard dependent)	See Table 3-7 on page 3-5.
P <sub>AC10</sub>	Contribution of an I/O output pin (standard dependent)	See Table 3-8 on page 3-5
P <sub>AC11</sub>	Average contribution of a RAM block during a read operation	25.00
P <sub>AC12</sub>	Average contribution of a RAM block during a write operation	30.00
P <sub>AC13</sub>	First contribution of a PLL	4.00
P <sub>AC14</sub>	Second contribution of a PLL	2.00

**Note:** \*For a different output load, drive strength, or slew rate, Actel recommends using the Actel Power spreadsheet calculator or SmartPower tool in Libero IDE software.



# **Power Calculation Methodology**

The section below describes a simplified method to estimate power consumption of an application. For more accurate and detailed power estimations, use the SmartPower tool in Actel Libero IDE software.

The power calculation methodology described below uses the following variables:

- The number of PLLs as well as the number and the frequency of each output clock generated
- The number of combinatorial and sequential cells used in the design
- The internal clock frequencies
- The number and the standard of I/O pins used in the design
- The number of RAM blocks used in the design
- Toggle rates of I/O pins as well as VersaTiles—guidelines are provided in Table 3-11 on page 3-9
- Enable rates of output buffers—guidelines are provided for typical applications in Table 3-12 on page 3-9
- Read rate and write rate to the memory—guidelines are provided for typical applications in Table 3-12 on page 3-9. The calculation should be repeated for each clock domain defined in the design.

### Methodology

#### Total Power Consumption—P<sub>TOTAL</sub>

 $P_{TOTAL} = P_{STAT} + P_{DYN}$ 

P<sub>STAT</sub> is the total static power consumption.

P<sub>DYN</sub> is the total dynamic power consumption.

#### Total Static Power Consumption—P<sub>STAT</sub>

 $P_{STAT} = P_{DC1} + N_{INPUTS} * P_{DC2} + N_{OUTPUTS} * P_{DC3}$ 

N<sub>INPUTS</sub> is the number of I/O input buffers used in the design.

N<sub>OUTPUTS</sub> is the number of I/O output buffers used in the design.

#### Total Dynamic Power Consumption—PDYN

 $P_{DYN} = P_{CLOCK} + P_{S-CELL} + P_{C-CELL} + P_{NET} + P_{INPUTS} + P_{OUTPUTS} + P_{MEMORY} + P_{PLL}$ 

#### Global Clock Contribution—P<sub>CLOCK</sub>

 $P_{CLOCK} = (P_{AC1} + N_{SPINE} * P_{AC2} + N_{ROW} * P_{AC3} + N_{S-CELL} * P_{AC4}) * F_{CLK}$ 

N<sub>SPINE</sub> is the number of global spines used in the user design—guideline are provided in Table 3-11 on page 3-9.

N<sub>ROW</sub> is the number of VersaTile rows used in the design—guidelines are provided in Table 3-11 on page 3-9. F<sub>CLK</sub> is the global clock signal frequency.

 $N_{S-CELL}$  is the number of VersaTiles used as sequential modules in the design.

#### Sequential Cells Contribution—P<sub>S-CELL</sub>

 $\mathsf{P}_{\mathsf{S-CELL}} = \mathsf{N}_{\mathsf{S-CELL}} * (\mathsf{P}_{\mathsf{AC5}} + \alpha_1 * \mathsf{P}_{\mathsf{AC6}}) * \mathsf{F}_{\mathsf{CLK}}$ 

N<sub>S-CELL</sub> is the number of VersaTiles used as sequential modules in the design. When a multi-tile sequential cell is used, it should be accounted for as 1.

 $\alpha_1$  is the toggle rate of VersaTile outputs—guidelines are provided in Table 3-11 on page 3-9.

F<sub>CLK</sub> is the global clock signal frequency.

#### Combinational Cells Contribution—P<sub>C-CELL</sub>

 $P_{C-CELL} = N_{C-CELL} * \alpha 1 * P_{AC7} * F_{CLK}$ 

 $N_{C-CELL}$  is the number of VersaTiles used as combinatorial modules in the design.

 $\alpha_1$  is the toggle rate of VersaTile outputs—guidelines are provided in Table 3-11 on page 3-9.

F<sub>CLK</sub> is the global clock signal frequency.

#### Routing Net Contribution—P<sub>NET</sub>

 $\mathsf{P}_{\mathsf{NET}} = (\mathsf{N}_{\mathsf{S}\mathsf{-}\mathsf{CELL}} + \mathsf{N}_{\mathsf{C}\mathsf{-}\mathsf{CELL}}) * \alpha_1 * \mathsf{P}_{\mathsf{AC8}} * \mathsf{F}_{\mathsf{CLK}}$ 

N<sub>S-CELL</sub> is the number VersaTiles used as sequential modules in the design.

N<sub>C-CELL</sub> is the number of VersaTiles used as combinatorial modules in the design.

 $\alpha_1$  is the toggle rate of VersaTile outputs—guidelines are provided in Table 3-11 on page 3-9.

F<sub>CLK</sub> is the global clock signal frequency.

#### I/O Input Buffer Contribution—PINPUTS

 $P_{INPUTS} = N_{INPUTS} * \alpha_2 * P_{AC9} * F_{CLK}$ 

 $N_{\mbox{\scriptsize INPUTS}}$  is the number of I/O input buffers used in the design.

 $lpha_2$  is the I/O buffer toggle rate—guidelines are provided in Table 3-11 on page 3-9.

F<sub>CLK</sub> is the global clock signal frequency.

#### I/O Output Buffer Contribution—POUTPUTS

 $P_{OUTPUTS} = N_{OUTPUTS} * \alpha_2 * \beta_1 * P_{AC10} * F_{CLK}$ 

N<sub>OUTPUTS</sub> is the number of I/O output buffers used in the design.

 $lpha_2$  is the I/O buffer toggle rate—guidelines are provided in Table 3-11 on page 3-9.

 $\beta_1$  is the I/O buffer enable rate—guidelines are provided in Table 3-12 on page 3-9.

F<sub>CLK</sub> is the global clock signal frequency.

#### RAM Contribution—P<sub>MEMORY</sub>

 $\begin{array}{l} \mathsf{P}_{\mathsf{MEMORY}} = \mathsf{P}_{\mathsf{AC}11} * \mathsf{N}_{\mathsf{BLOCKS}} * \mathsf{F}_{\mathsf{READ-CLOCK}} * \beta_2 + \mathsf{P}_{\mathsf{AC}12} * \\ \mathsf{N}_{\mathsf{BLOCK}} * \mathsf{F}_{\mathsf{WRITE-CLOCK}} * \beta_3 \end{array}$ 

N<sub>BLOCKS</sub> is the number RAM blocks used in the design.

F<sub>READ-CLOCK</sub> is the memory read clock frequency.

 $\beta_2$  is the RAM enable rate for read operations.

F<sub>WRITE-CLOCK</sub> is the memory write clock frequency.

 $\beta_3$  the RAM enable rate for write operations—guidelines are provided in Table 3-12 on page 3-9.

#### PLL/CCC Contribution—PPLL

 $P_{PLL} = P_{AC13} * F_{CLKIN} + \Sigma P_{AC14} * F_{CLKOUT}$ 

F<sub>CLKIN</sub> is the input clock frequency.

F<sub>CLKOUT</sub> is the output clock frequency.<sup>1</sup>

<sup>1.</sup> The PLL dynamic contribution depends on the input clock frequency, the number of output clock signals generated by the PLL, and the frequency of each output clock. If a PLL is used to generate more than one output clock, include each output clock in the formula by adding its corresponding contribution ( $P_{AC14} * F_{CLKOUT}$  product) to the total PLL contribution.



# Guidelines

#### **Toggle Rate Definition**

A toggle rate defines the frequency of a net or logic element relative to a clock. It is a percentage. If the toggle rate of a net is 100%, this means that this net switches at half the clock frequency. Below are some examples:

- The average toggle rate of a shift-register is 100% because all flip-flop outputs toggle at half of the clock frequency.
- The average toggle rate of an 8-bit counter is 25%:
  - Bit 0 (LSB) = 100%
  - Bit 1 = 50%

- Bit 2 = 25%
- ...
- Bit 7 (MSB) = 0.78125%
- The average toggle rate is = (100% + 50% + 25% + 12.5% + ... 0.78125%) / 8.

### **Enable Rate Definition**

Output enable rate is the average percentage of time during which tristate outputs are enabled. When nontristate output buffers are used, the enable rate should be 100%.

Table 3-11 • To	oggle Rate Guidelines Recommended for Power Calculation
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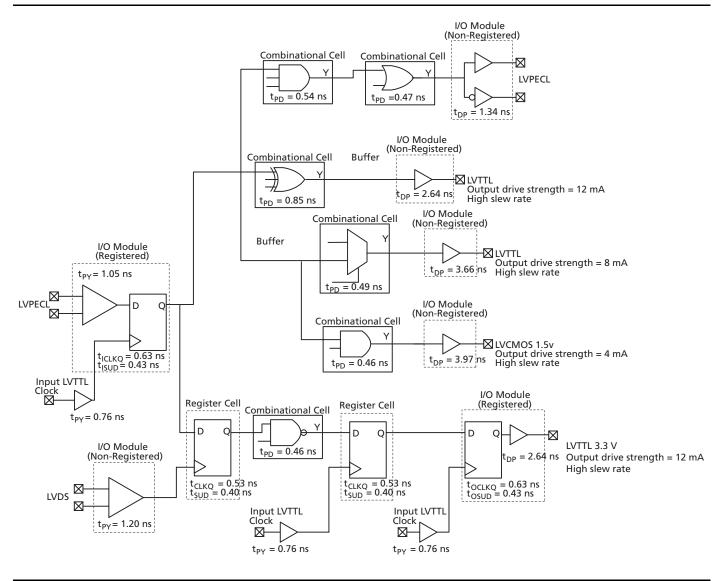
Component	Definition	Guideline		
$\alpha_1$	Toggle rate of VersaTile outputs	10%		
α <sub>2</sub>	I/O buffer toggle rate	10%		

#### Table 3-12 • Enable Rate Guidelines Recommended for Power Calculation

Component	Definition	Guideline		
β1	I/O output buffer enable rate	100%		
β2	RAM enable rate for read operations	12.5%		
β <sub>3</sub>	RAM enable rate for write operations	12.5%		

# **User I/O Characteristics**

# **Timing Model**



*Figure 3-2* • Timing Model Operating Conditions: –2 Speed, Commercial Temperature Range (T<sub>J</sub> = 70°C), Worst Case V<sub>CC</sub> = 1.425 V



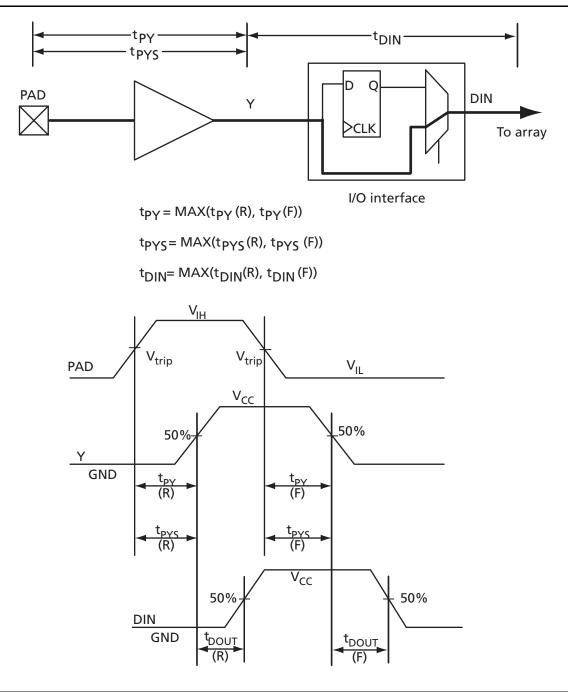


Figure 3-3 • Input Buffer Timing Model and Delays (example)

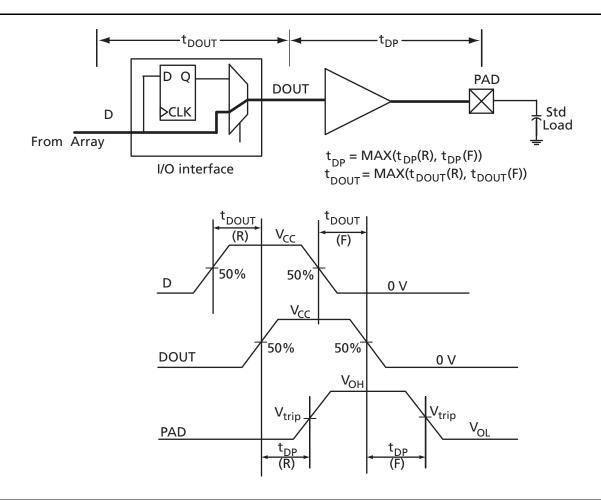
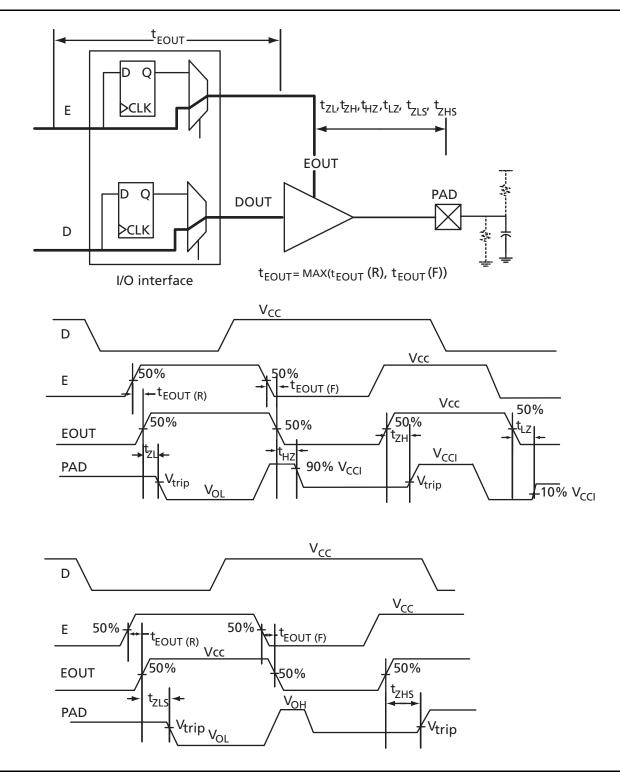
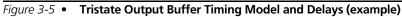


Figure 3-4 • Output Buffer Model and Delays (example)







# **Overview of I/O Performance**

# Summary of I/O DC Input and Output Levels – Default I/O Software Settings

Table 3-13Summary of Maximum and Minimum DC Input and Output Levels Applicable to Commercial and Industrial<br/>Conditions

	Drive Slew			V <sub>IL</sub>	V <sub>IH</sub>		V <sub>OL</sub>	V <sub>OH</sub>	I <sub>OL</sub>	I <sub>OH</sub>
I/O Standard	Strength	Rate	Min, V	Max, V	Min, V	Max, V	Max, V	Min, V	mA	mA
3.3 V LVTTL / 3.3 V LVCMOS	12 mA	High	-0.3	0.8	2	3.6	0.4	2.4	12	12
2.5 V LVCMOS	12 mA	High	-0.3	0.7	1.7	3.6	0.7	1.7	12	12
1.8 V LVCMOS	8 mA	High	-0.3	0.35 * V <sub>CCI</sub>	0.65 * V <sub>CCI</sub>	3.6	0.45	V <sub>CCI</sub> – 0.45	8	8
1.5 V LVCMOS	4 mA	High	-0.3	0.30 * V <sub>CCI</sub>	0.7 * V <sub>CCI</sub>	3.6	0.25 * V <sub>CCI</sub>	0.75 * V <sub>CCI</sub>	4	4
3.3 V PCI		Per PCI specifications								
3.3 V PCI-X		Per PCI-X specifications								

Note: Currents are measured at 85°C junction temperature.

#### Table 3-14 • Summary of Maximum and Minimum DC Input Levels Applicable to Commercial and Industrial Conditions

	Comm	ercial <sup>1</sup>	Industrial <sup>2</sup>				
	IIL	I <sub>IH</sub>	I <sub>IL</sub>	I <sub>IH</sub>			
DC I/O Standards	μΑ	μA	μΑ	μΑ			
3.3 V LVTTL /3.3V LVCMOS	10	10	15	15			
2.5 V LVCMOS	10	10	15	15			
1.8 V LVCMOS	10	10	15	15			
1.5 V LVCMOS	10	10	15	15			
3.3 V PCI	10	10	15	15			
3.3 V PCI-X	10	10	15	15			

#### Notes:

1. Commercial range (0°C <  $T_I$  < 70°C)

2. Industrial range (-40°C <  $T_1$  < 85°C)

# Summary of I/O Timing Characteristics – Default I/O Software Settings

#### Table 3-15 • Summary of AC Measuring Points

Standard	Measuring Trip Point (V <sub>trip</sub> )
3.3 V LVTTL / 3.3 V LVCMOS	1.4 V
2.5 V LVCMOS	1.2 V
1.8 V LVCMOS	0.90 V
1.5 V LVCMOS	0.75 V
3.3 V PCI	0.285 * V <sub>CCI</sub> (RR)
	0.615 * V <sub>CCI</sub> (FF)
3.3 V PCI-X	0.285 * V <sub>CCI</sub> (RR)
	0.615 * V <sub>CCI</sub> (FF)

#### Table 3-16I/O AC Parameter Definitions

Parameter	Parameter Definition
t <sub>DP</sub>	Data to Pad delay through the Output Buffer
t <sub>PY</sub>	Pad to Data delay through the Input Buffer
t <sub>DOUT</sub>	Data to Output Buffer delay through the I/O interface
t <sub>EOUT</sub>	Enable to Output Buffer Tristate Control delay through the I/O interface
t <sub>DIN</sub>	Input Buffer to Data delay through the I/O interface
t <sub>HZ</sub>	Enable to Pad delay through the Output Buffer—high to Z
t <sub>ZH</sub>	Enable to Pad delay through the Output Buffer—Z to high
t <sub>LZ</sub>	Enable to Pad delay through the Output Buffer—low to Z
t <sub>ZL</sub>	Enable to Pad delay through the Output Buffer—Z to low
t <sub>ZHS</sub>	Enable to Pad delay through the Output Buffer with delayed enable—Z to high
t <sub>ZLS</sub>	Enable to Pad delay through the Output Buffer with delayed enable—Z to low

# Table 3-17Summary of I/O Timing Characteristics—Software Default SettingsCommercial-Case Conditions: TJ = 70°C, Worst Case V<sub>CC</sub> = 1.425 V, Worst Case V<sub>CCI</sub> = 3.0 V

I/O Standard	Drive Strength (mA)	Slew Rate	Capacitive Load (pF)	External Resistor	tьоит	top	t <sub>DIN</sub>	tpy	tEOUT	t <sub>zı</sub>	HZŦ	tız	t <sub>HZ</sub>	t <sub>zus</sub>	tzHS	Units
3.3 V LVTTL / 3.3 V LVCMOS	12 mA	High	35 pF	-	0.49	2.64	0.03	0.76	0.32	2.69	2.11	2.40	2.68	4.36	3.78	ns
2.5 V LVCMOS	12 mA	High	35pF	-	0.49	2.66	0.03	0.98	0.32	2.71	2.56	2.47	2.57	4.38	4.23	ns
1.8 V LVCMOS	8 mA	High	35pF	-	0.49	3.32	0.03	0.91	0.32	3.12	3.32	2.64	2.53	4.79	4.99	ns
1.5 V LVCMOS	4 mA	High	35pF	-	0.49	3.97	0.03	1.07	0.32	3.62	3.97	2.79	2.54	5.29	5.64	ns
3.3 V PCI	Per PCI spec	High	10pF	25 <sup>2</sup>	0.49	2.00	0.03	0.65	0.32	2.04	1.46	2.40	2.68	3.71	3.13	ns
3.3 V PCI-X	Per PCI-X spec	High	10pF	25 <sup>2</sup>	0.49	2.00	0.03	0.65	0.32	2.04	1.46	2.40	2.68	3.71	3.13	ns
LVDS	24 mA	High	-	-	0.49	1.37	0.03	1.20	N/A	N/A	N/A	N/A	N/A	N/A	N/A	ns
LVPECL	24 mA	High	_	-	0.49	1.34	0.03	1.05	N/A	N/A	N/A	N/A	N/A	N/A	N/A	ns

#### Notes:

1. For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

2. Resistance is used to measure I/O propagation delays as defined in PCI specifications. See Figure 3-10 on page 3-26 for connectivity. This resistor is not required during normal operation.

# **Detailed I/O DC Characteristics**

#### Table 3-18Input Capacitance

Symbol	Definition Conditions		Min.	Max.	Units
C <sub>IN</sub>	Input Capacitance	out Capacitance V <sub>IN</sub> = 0, f = 1.0 MHz		8	pF
C <sub>INCLK</sub>	Input Capacitance on the clock pin	V <sub>IN</sub> = 0, f = 1.0 MHz		8	pF

#### Table 3-19 • I/O Output Buffer Maximum Resistances<sup>1</sup>

		R <sub>PULL-DOWN</sub>	R <sub>PULL-UP</sub>	
Standard	Drive Strength	<b>(</b> Ω <b>)</b> <sup>2</sup>	<b>(</b> Ω) <sup>3</sup>	
3.3 V LVTTL / 3.3 V LVCMOS	4 mA	100	300	
	8 mA	50	150	
	12 mA	25	75	
	16 mA	25	75	
2.5 V LVCMOS	4 mA	100	200	
	8 mA	50	100	
	12 mA	25	50	
1.8 V LVCMOS	2 mA	200	225	
	4 mA	100	112	
	8 mA	50	56	
1.5 V LVCMOS	2 mA	200	224	
	4 mA	100	112	
3.3 V PCI/PCI-X	Per PCI/PCI-X specification	25	75	

#### Notes:

- 1. These maximum values are provided for informational reasons only. Minimum output buffer resistance values depend on V<sub>CC</sub>, drive strength selection, temperature, and process. For board design considerations and detailed output buffer resistances, use the corresponding IBIS models located on the Actel website at http://www.actel.com/techdocs/models/ibis.html.
- 2. R<sub>(PULL-DOWN-MAX)</sub> = (V<sub>OLspec</sub>) / I<sub>OLspec</sub>
- 3. R<sub>(PULL-UP-MAX)</sub> = (V<sub>CCImax</sub> V<sub>OHspec</sub>) / I<sub>OHspec</sub>

# Table 3-20 • I/O Weak Pull-Up/Pull-Down Resistances

Minimum and Maximum Weak Pull-Up/Pull-Down Resistance Valu	Jes
--	-----

	R <sub>(WEAK</sub>	PULL-UP) <sup>1</sup> 2)	R <sub>(WEAK PULL-DOWN)</sub> <sup>2</sup> (Ω)		
V <sub>CCI</sub>	Min.	Max.	Min.	Max.	
3.3 V	10 k	45 k	10 k	45 k	
2.5 V	11 k	55 k	12 k	74 k	
1.8 V	18 k	70 k	17 k	110 k	
1.5 V	19 k	90 k	19 k	140 k	

### Notes:

1. R<sub>(WEAK PULL-UP-MAX)</sub> = (V<sub>OLspec</sub>) / I<sub>(WEAK PULL-UP-MIN)</sub>

2.  $R_{(WEAK PULL-UP-MAX)} = (V_{CCImax} - V_{OHspec}) / I_{(WEAK PULL-UP-MIN)}$ 

#### Table 3-21 • I/O Short Currents I<sub>OSH</sub>/I<sub>OSL</sub>

	Drive Strength	I <sub>OSH</sub> (mA)*	l <sub>OSL</sub> (mA)*
3.3 V LVTTL / 3.3 V LVCMOS	4 mA	25	27
	8 mA	51	54
	12 mA	103	109
	16 mA	103	109
2.5 V LVCMOS	4 mA	16	18
	8 mA	32	37
	12 mA	65	74
1.8 V LVCMOS	2 mA	9	11
	4 mA	17	22
	8 mA	35	44
1.5 V LCMOS	2 mA	13	16
	4 mA	25	33

*Note: \*TJ* = 100°C

The length of time an I/O can withstand I<sub>OSH</sub>/I<sub>OSL</sub> events depends on the junction temperature. The reliability data below is based on a 3.3 V, 12 mA I/O setting, which is the worst case for this type of analysis.

For example, at 110°C, the short current condition would have to be sustained for more than three months to cause a reliability concern. The I/O design does not contain any short circuit protection, but such protection would only be needed in extremely prolonged stress conditions.

Table 3-22 • Short Current Event Duration before Failure

Temperature	Time Before Failure
-40°C	> 20 years
0°C	> 20 years
25°C	> 20 years
70°C	5 years
85°C	2 years
100°C	6 months
110°C	3 months

Table 3-23 • I/O Input Rise Time, Fall Time, and Related I/O Reliability

Input Buffer	Input Rise/Fall Time (Min.)	Input Rise/fall Time (Max.)	Reliability
LVTTL/LVCMOS	No requirement	10 ns*	20 years (110°C)
LVDS/LVPECL	No requirement	10 ns*	10 years (100°C)

**Note:** \*The Maximum Input rise/fall time is related only to the noise induced into the input buffer trace. If the noise is low, then the rise time and fall time of input buffers, when Schmitt trigger is disabled, can be increased beyond the maximum value. The longer the rise/fall times, the more susceptible the input signal is to the board noise. Actel recommends signal integrity evaluation/ characterization of the system to ensure that there is no excessive noise coupling into input signals.

# Single-Ended I/O Characteristics

# 3.3 V LVTTL / 3.3 V LVCMOS

Low-Voltage Transistor-Transistor Logic (LVTTL) is a general purpose standard (EIA/JESD) for 3.3 V applications. It uses an LVTTL input buffer and push-pull output buffer.

3.3 V LVTTL / 3.3 V LVCMOS	V <sub>IL</sub>		V <sub>IH</sub>		V <sub>OL</sub>	V <sub>он</sub>	I <sub>OL</sub>	I <sub>OH</sub>	I <sub>OSL</sub>	I <sub>OSH</sub>	IIL	I <sub>IH</sub>
Drive Strength	Min, V	Max, V	Min, V	Max, V	Max, V	Min, V	mA	mA	Max, mA <sup>1</sup>	Max, mA <sup>1</sup>	μA <sup>2</sup>	μA <sup>2</sup>
4 mA	-0.3	0.8	2	3.6	0.4	2.4	4	4	27	25	10	10
8 mA	-0.3	0.8	2	3.6	0.4	2.4	8	8	54	51	10	10
12 mA	-0.3	0.8	2	3.6	0.4	2.4	12	12	109	103	10	10
16 mA	-0.3	0.8	2	3.6	0.4	2.4	16	16	109	103	10	10

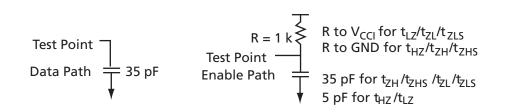
Table 3-24 • Minimum and Maximum DC Input and Output Levels

#### Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.

3. Software default selection highlighted in gray.



#### Figure 3-6 • AC Loading

#### Table 3-25 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	C <sub>LOAD</sub> (pF)
0	3.3	1.4	35

**Note:** \*Measuring point =  $V_{trip}$ . See Table 3-15 on page 3-14 for a complete table of trip points.

Commercial-Case Conditions:  $T_J = 70^{\circ}$ C, Worst Case V<sub>CC</sub> = 1.425 V, Worst Case V<sub>CCI</sub> = 3.0 V

Drive Strength (mA)	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
4 mA	–F	0.79	12.32	0.05	1.22	0.51	12.55	10.69	3.18	2.95	15.23	13.37	ns
	Std.	0.66	10.26	0.04	1.02	0.43	10.45	8.90	2.64	2.46	12.68	11.13	ns
	-1	0.56	8.72	0.04	0.86	0.36	8.89	7.57	2.25	2.09	10.79	9.47	ns
	-2	0.49	7.66	0.03	0.76	0.32	7.80	6.64	1.98	1.83	9.47	8.31	ns
8 mA	–F	0.79	8.74	0.05	1.22	0.51	8.90	7.55	3.58	3.65	11.59	10.23	ns
	Std.	0.66	7.27	0.04	1.02	0.43	7.41	6.28	2.98	3.04	9.65	8.52	ns
	–1	0.56	6.19	0.04	0.86	0.36	6.30	5.35	2.54	2.59	8.20	7.25	ns
	-2	0.49	5.43	0.03	0.76	0.32	5.53	4.69	2.23	2.27	7.20	6.36	ns
12 mA	–F	0.79	6.70	0.05	1.22	0.51	6.83	5.85	3.85	4.10	9.51	8.54	ns
	Std.	0.66	5.58	0.04	1.02	0.43	5.68	4.87	3.21	3.42	7.92	7.11	ns
	-1	0.56	4.75	0.04	0.86	0.36	4.84	4.14	2.73	2.91	6.74	6.05	ns
	-2	0.49	4.17	0.03	0.76	0.32	4.24	3.64	2.39	2.55	5.91	5.31	ns
16 mA	–F	0.79	6.70	0.05	1.22	0.51	6.83	5.85	3.85	4.10	9.51	8.54	ns
	Std.	0.66	5.58	0.04	1.02	0.43	5.68	4.87	3.21	3.42	7.92	7.11	ns
	–1	0.56	4.75	0.04	0.86	0.36	4.84	4.14	2.73	2.91	6.74	6.05	ns
	-2	0.49	4.17	0.03	0.76	0.32	4.24	3.64	2.39	2.55	5.91	5.31	ns

Note: For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

Table 3-27 •	3.3 V LVTTL / 3.3 V LVCMOS High Slew	
	Commercial-Case Conditions: $T_1 = 70^{\circ}$ C, Worst Case $V_{CC} = 1.425$ V, Worst Case $V_{CCI} = 3.0$ V	

Drive Strength (mA)	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>zL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>zLS</sub>	t <sub>zHS</sub>	Units
4 mA	-F	0.79	9.20	0.05	1.22	0.51	9.37	7.91	3.18	3.14	12.05	10.60	ns
	Std.	0.66	7.66	0.04	1.02	0.43	7.80	6.59	2.65	2.61	10.03	8.82	ns
	-1	0.56	6.51	0.04	0.86	0.36	6.63	5.60	2.25	2.22	8.54	7.51	ns
	-2	0.49	5.72	0.03	0.76	0.32	5.82	4.92	1.98	1.95	7.49	6.59	ns
8 mA	-F	0.79	5.89	0.05	1.22	0.51	6.00	4.89	3.59	3.85	8.69	7.57	ns
	Std.	0.66	4.91	0.04	1.02	0.43	5.00	4.07	2.99	3.20	7.23	6.31	ns
	-1	0.56	4.17	0.04	0.86	0.36	4.25	3.46	2.54	2.73	6.15	5.36	ns
	-2	0.49	3.66	0.03	0.76	0.32	3.73	3.04	2.23	2.39	5.40	4.71	ns
12 mA	–F	0.79	4.24	0.05	1.22	0.51	4.32	3.39	3.86	4.30	7.01	6.08	ns
	Std.	0.66	3.53	0.04	1.02	0.43	3.60	2.82	3.21	3.58	5.83	5.06	ns
	-1	0.56	3.00	0.04	0.86	0.36	3.06	2.40	2.73	3.05	4.96	4.30	ns
	-2	0.49	2.64	0.03	0.76	0.32	2.69	2.11	2.40	2.68	4.36	3.78	ns
16 mA	–F	0.79	4.24	0.05	1.22	0.51	4.32	3.39	3.86	4.30	7.01	6.08	ns
	Std.	0.66	3.53	0.04	1.02	0.43	3.60	2.82	3.21	3.58	5.83	5.06	ns
	-1	0.56	3.00	0.04	0.86	0.36	3.06	2.40	2.73	3.05	4.96	4.30	ns
	-2	0.49	2.64	0.03	0.76	0.32	2.69	2.11	2.40	2.68	4.36	3.78	ns

#### Notes:

1. Software default selection highlighted in gray.

# 2.5 V LVCMOS

Low-Voltage CMOS for 2.5 V is an extension of the LVCMOS standard (JESD8-5) used for general purpose 2.5 V applications. It uses a 5-V-tolerant input buffer and push-pull output buffer.

2.5 V LVCMOS	v	/IL	V <sub>IH</sub>		V <sub>OL</sub>	V <sub>OH</sub>	I <sub>OL</sub>	I <sub>ОН</sub>	I <sub>OSL</sub>	I <sub>OSH</sub>	Ι <sub>ΙL</sub>	I <sub>IH</sub>
Drive Strength	Min, V	Max, V	Min, V	Max, V	Max, V	Min, V	mA	mA	Max, mA <sup>1</sup>	Max, mA <sup>1</sup>	μA²	μA <sup>2</sup>
4 mA	-0.3	0.7	1.7	3.6	0.7	1.7	4	4	18	16	10	10
8 mA	-0.3	0.7	1.7	3.6	0.7	1.7	8	8	37	32	10	10
12 mA	-0.3	0.7	1.7	3.6	0.7	1.7	12	12	74	65	10	10

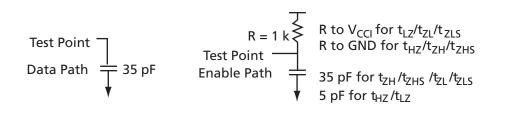
Table 3-28 • Minimum and Maximum DC Input and Output Levels

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.

*3.* Software default selection highlighted in gray.



#### Figure 3-7 • AC Loading

Table 3-29 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	C <sub>LOAD</sub> (pF)
0	2.5	1.2	35

**Note:** \*Measuring point =  $V_{trip}$ . See Table 3-15 on page 3-14 for a complete table of trip points.



#### Table 3-30**2.5 V LVCMOS Low Slew**

Commercial-Case Conditions:  $T_J = 70^{\circ}$ C, Worst Case  $V_{CC} = 1.425$  V, Worst Case  $V_{CCI} = 2.3$  V

Drive Strength (mA)	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
4 mA	–F	0.72	13.69	0.05	1.57	0.51	13.47	13.69	3.22	2.65	16.16	16.38	ns
	Std.	0.60	11.40	0.04	1.31	0.43	11.22	11.40	2.68	2.20	13.45	13.63	ns
	-1	0.51	9.69	0.04	1.11	0.36	9.54	9.69	2.28	1.88	11.44	11.60	ns
	-2	0.45	8.51	0.03	0.98	0.32	8.38	8.51	2.00	1.65	10.05	10.18	ns
8 mA	–F	0.72	9.56	0.05	1.57	0.51	9.74	9.39	3.66	3.47	12.43	12.07	ns
	Std.	0.60	7.96	0.04	1.31	0.43	8.11	7.81	3.05	2.89	10.34	10.05	ns
	-1	0.51	6.77	0.04	1.11	0.36	6.90	6.65	2.59	2.46	8.80	8.55	ns
	-2 0.45 5.94 0.03	0.03	0.98	0.32	6.05	5.83	2.28	2.16	7.72	7.50	ns		
12 mA	–F	0.72	7.42	0.05	1.57	0.51	7.56	7.11	3.97	3.99	10.25	9.79	ns
	Std.	0.60	6.18	0.04	1.31	0.43	6.29	5.92	3.30	3.32	8.53	8.15	ns
	-1	0.51	5.26	0.04	1.11	0.36	5.35	5.03	2.81	2.83	7.25	6.94	ns
	-2	0.45	4.61	0.03	0.98	0.32	4.70	4.42	2.47	2.48	6.37	6.09	ns

Note: For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

Table 3-31 •	2.5 V LVCMOS High Slew	
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```
Commercial-Case Conditions: T_J = 70^{\circ}C, Worst Case V_{CC} = 1.425 V, Worst Case V_{CCI} = 2.3 V
```

Drive Strength (mA)	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>zL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
4 mA	–F	0.79	10.41	0.05	1.57	0.51	9.41	10.41	3.22	2.77	12.09	13.09	ns
	Std.	0.66	8.66	0.04	1.31	0.43	7.83	8.66	2.68	2.30	10.07	10.90	ns
	-1	0.56	7.37	0.04	1.11	0.36	6.66	7.37	2.28	1.96	8.56	9.27	ns
	-2	0.49	6.47	0.03	0.98	0.32	5.85	6.47	2.00	1.72	7.52	8.14	ns
8 mA	–F	0.72	6.21	0.05	1.57	0.51	6.05	6.21	3.66	3.60	8.74	8.89	ns
	Std.	0.60	5.17	0.04	1.31	0.43	5.04	5.17	3.05	3.00	7.27	7.40	ns
	-1	0.51	4.39	0.04	1.11	0.36	4.28	4.39	2.59	2.55	6.19	6.30	ns
	-2	0.45	3.86	0.03	0.98	0.32	3.76	3.86	2.28	2.24	5.43	5.53	ns
12 mA	–F	0.79	6.21	0.05	1.57	0.51	6.05	6.21	3.66	3.60	8.74	8.89	ns
	Std.	0.66	5.17	0.04	1.31	0.43	5.04	5.17	3.05	3.00	7.27	7.40	ns
	-1	0.56	4.39	0.04	1.11	0.36	4.28	4.39	2.59	2.55	6.19	6.30	ns
	-2	0.49	3.86	0.03	0.98	0.32	3.76	3.86	2.28	2.24	5.43	5.53	ns

Notes:

1. Software default selection highlighted in gray.

## **1.8 V LVCMOS**

Low-voltage CMOS for 1.8 V is an extension of the LVCMOS standard (JESD8-5) used for general purpose 1.8 V applications. It uses 1.8 V input buffer and push-pull output buffer.

1.8 V LVCMOS		V <sub>IL</sub>	V <sub>IH</sub>		V <sub>OL</sub>	V <sub>OH</sub>	I <sub>OL</sub>	I <sub>ОН</sub>	I <sub>OSL</sub>	I <sub>OSH</sub>	Ι <sub>ΙL</sub>	IIH
Drive Strength	Min, V	Max, V	Min, V	Max, V	Max, V	Min, V	mA	mA	Max, mA <sup>1</sup>	Max, mA <sup>1</sup>	μA²	μA²
2 mA	-0.3	0.35 * V <sub>CCI</sub>	0.65 * V <sub>CCI</sub>	3.6	0.45	V <sub>CCI</sub> – 0.45	2	2	11	9	10	10
4 mA	-0.3	0.35 * V <sub>CCI</sub>	0.65 * V <sub>CCI</sub>	3.6	0.45	V <sub>CCI</sub> – 0.45	4	4	22	17	10	10
8 mA	-0.3	0.35 * V <sub>CCI</sub>	0.65 * V <sub>CCI</sub>	3.6	0.45	V <sub>CCI</sub> – 0.45	8	8	44	35	10	10

Table 3-32 • Minimum and Maximum DC Input and Output Levels

#### Notes:

- 1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.
- 2. Currents are measured at 85°C junction temperature.
- 3. Software default selection highlighted in gray.

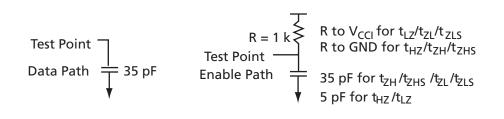


Figure 3-8 • AC Loading

Table 3-33 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	C <sub>LOAD</sub> (pF)
0	1.8	0.9	35

**Note:** \*Measuring point =  $V_{trip}$ . See Table 3-15 on page 3-14 for a complete table of trip points.



#### Table 3-34**1.8 V LVCMOS Low Slew**

Commercial-Case Conditions:  $T_J = 70^{\circ}$ C, Worst Case V<sub>CC</sub> = 1.425 V, Worst Case V<sub>CCI</sub> = 1.7 V

Drive Strength (mA)	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
2 mA	–F	0.79	18.66	0.05	1.46	0.51	16.95	18.66	3.34	1.92	19.64	21.34	ns
	Std.	0.66	15.53	0.04	1.22	0.43	14.11	15.53	2.78	1.60	16.35	17.77	ns
	-1	0.56	13.21	0.04	1.04	0.36	12.01	13.21	2.36	1.36	13.91	15.11	ns
	-2	0.49	11.60	0.03	0.91	0.32	10.54	11.60	2.07	1.19	12.21	13.27	ns
4 mA	–F	0.72	12.58	0.05	1.46	0.51	12.51	12.58	3.88	3.28	15.19	15.27	ns
	Std.	0.60	10.48	0.04	1.22	0.43	10.41	10.48	3.23	2.73	12.65	12.71	ns
	-1	0.51	8.91	0.04	1.04	0.36	8.86	8.91	2.75	2.33	10.76	10.81	ns
	-2	0.45	7.82	0.03	0.91	0.32	7.77	7.82	2.41	2.04	9.44	9.49	ns
8mA	–F	0.79	9.67	0.05	1.46	0.51	9.85	9.42	4.25	3.93	12.53	12.11	ns
	Std.	0.66	8.05	0.04	1.22	0.43	8.20	7.84	3.54	3.27	10.43	10.08	ns
	-1	0.56	6.85	0.04	1.04	0.36	6.97	6.67	3.01	2.78	8.88	8.57	ns
	-2	0.49	6.01	0.03	0.91	0.32	6.12	5.86	2.64	2.44	7.79	7.53	ns

**Note:** For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

#### Table 3-35 • 1.8 V LVCMOS High Slew

Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst Case V<sub>CC</sub> = 1.425 V, Worst Case V<sub>CCI</sub> = 1.7 V

Drive Strength (mA)	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
2 mA	–F	0.79	14.25	0.05	1.46	0.51	10.97	14.25	3.33	1.99	13.66	16.94	ns
	Std.	0.66	11.86	0.04	1.22	0.43	9.14	11.86	2.77	1.66	11.37	14.10	ns
	-1	0.56	10.09	0.04	1.04	0.36	7.77	10.09	2.36	1.41	9.67	11.99	ns
	-2	0.49	8.86	0.03	0.91	0.32	6.82	8.86	2.07	1.24	8.49	10.53	ns
4 mA	–F	0.72	8.31	0.05	1.46	0.51	7.04	8.31	3.87	3.41	9.73	10.99	ns
	Std.	0.60	6.91	0.04	1.22	0.43	5.86	6.91	3.22	2.84	8.10	9.15	ns
	-1	0.51	5.88	0.04	1.04	0.36	4.99	5.88	2.74	2.41	6.89	7.78	ns
	-2	0.45	5.16	0.03	0.91	0.32	4.38	5.16	2.41	2.12	6.05	6.83	ns
8 mA	–F	0.79	5.34	0.05	1.46	0.51	5.02	5.34	4.24	4.06	7.71	8.03	ns
	Std.	0.66	4.45	0.04	1.22	0.43	4.18	4.45	3.53	3.38	6.42	6.68	ns
	-1	0.56	3.78	0.04	1.04	0.36	3.56	3.78	3.00	2.88	5.46	5.69	ns
	-2	0.49	3.32	0.03	0.91	0.32	3.12	3.32	2.64	2.53	4.79	4.99	ns

Notes:

1. Software default selection highlighted in gray.

## 1.5 V LVCMOS (JESD8-11)

Low-voltage CMOS for 1.5 V is an extension of the LVCMOS standard (JESD8-5) used for general purpose 1.5 V applications. It uses 1.5 V input buffer and push-pull output buffer.

1.5 V LVCMOS	V <sub>IL</sub>		V <sub>IH</sub>		V <sub>OL</sub>	V <sub>OH</sub>	I <sub>OL</sub>	I <sub>OH</sub>	I <sub>OSL</sub>	I <sub>OSH</sub>	IIL	I <sub>IH</sub>
Drive Strength	Min, V	Max, V	Min, V	Max, V	Max, V	Min, V	mA	mA	Max, mA <sup>1</sup>	Max, mA <sup>1</sup>	μA²	μA²
2 mA	-0.3	0.30 * V <sub>CCI</sub>	0.7 * V <sub>CCI</sub>	3.6	0.25 * V <sub>CCI</sub>	0.75 * V <sub>CCI</sub>	2	2	16	13	10	10
4 mA	-0.3	0.30 * V <sub>CCI</sub>	0.7 * V <sub>CCI</sub>	3.6	0.25 * V <sub>CCI</sub>	0.75 * V <sub>CCI</sub>	4	4	33	25	10	10

Table 3-36 • Minimum and Maximum DC Input and Output Levels

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.

3. Software default selection highlighted in gray.

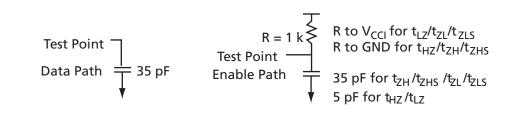


Figure 3-9 • AC Loading

Table 3-37 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	C <sub>LOAD</sub> (pF)
0	1.5	0.75	35

**Note:** \*Measuring point =  $V_{trip.}$  See Table 3-15 on page 3-14 for a complete table of trip points.



#### Table 3-381.5 V LVCMOS Low Slew

```
Commercial-Case Conditions: T_J = 70^{\circ}C, Worst Case V_{CC} = 1.425 V, Worst Case V_{CCI} = 1.4 V
```

Drive Strength (mA)	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>zL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
2 mA	—F	0.79	15.35 6	0.052	1.728	0.514	15.38 7	15.35 6	4.081	3.176	18.07 3	18.04 2	ns
	Std.	0.66	12.78	0.04	1.44	0.43	12.81	12.78	3.40	2.64	15.05	15.02	ns
	-1	0.56	10.87	0.04	1.22	0.36	10.90	10.87	2.89	2.25	12.80	12.78	ns
	-2	0.49	9.55	0.03	1.07	0.32	9.57	9.55	2.54	1.97	11.24	11.22	ns
4 mA	–F	0.79	12.02	0.05	1.73	0.51	12.25	11.47	4.50	3.93	14.93	14.15	ns
	Std.	0.66	10.01	0.04	1.44	0.43	10.19	9.55	3.75	3.27	12.43	11.78	ns
	-1	0.56	8.51	0.04	1.22	0.36	8.67	8.12	3.19	2.78	10.57	10.02	ns
	-2	0.49	7.47	0.03	1.07	0.32	7.61	7.13	2.80	2.44	9.28	8.80	ns

Note: For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

#### Table 3-391.5 V LVCMOS High Slew

Commercial-Case Conditions:  $T_J = 70^{\circ}$ C, Worst Case V<sub>CC</sub> = 1.425 V, Worst Case V<sub>CCI</sub> = 1.4 V

Drive Strength (mA)	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>zL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
2 mA	–F	0.79	10.05	0.05	1.73	0.51	8.20	10.05	4.07	3.32	10.88	12.73	ns
	Std.	0.66	8.36	0.04	1.44	0.43	6.82	8.36	3.39	2.77	9.06	10.60	ns
	-1	0.56	7.11	0.04	1.22	0.36	5.80	7.11	2.88	2.35	7.71	9.02	ns
	-2	0.49	6.24	0.03	1.07	0.32	5.10	6.24	2.53	2.06	6.76	7.91	ns
4 mA	–F	0.79	6.38	0.05	1.73	0.51	5.83	6.38	4.49	4.09	8.51	9.07	ns
	Std.	0.66	5.31	0.04	1.44	0.43	4.85	5.31	3.74	3.40	7.09	7.55	ns
	-1	0.56	4.52	0.04	1.22	0.36	4.13	4.52	3.18	2.89	6.03	6.42	ns
	-2	0.49	3.97	0.03	1.07	0.32	3.62	3.97	2.79	2.54	5.29	5.64	ns

#### Notes:

1. Software default selection highlighted in gray.

## 3.3 V PCI, 3.3 V PCI-X

Peripheral Component Interface for 3.3 V standard specifies support for 33 MHz and 66 MHz PCI Bus applications.

Table 3-40 •	Minimum and Ma	aximum DC Input a	nd Output Levels
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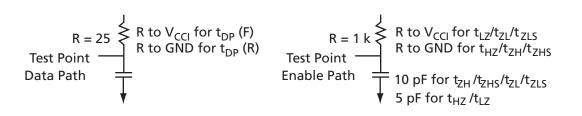
3.3 V PCI/PCI-X	V <sub>IL</sub>		/ <sub>IL</sub> V <sub>IH</sub>		V <sub>OL</sub>	V <sub>OH</sub>	I <sub>OL</sub>	I <sub>ОН</sub>	I <sub>OSL</sub>	I <sub>OSH</sub>	Ι <sub>ΙL</sub>	I <sub>IH</sub>
Drive Strength	Min, V	Max, V Min, V Max, V N		Max, V	Min, V	mA	mA	Max, mA <sup>1</sup>	Max, mA <sup>1</sup>	μA²	μA²	
Per PCI specification		Per PCI curves										10

#### Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.

AC loadings are defined per the PCI/PCI-X specifications for the data path; Actel loadings for enable path characterization are described in Figure 3-10.



### Figure 3-10 • AC Loading

AC loading are defined per PCI/PCI-X specifications for the data path; Actel loading for tristate is described in Table 3-41.

#### Table 3-41 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	C <sub>LOAD</sub> (pF)
0	3.3	0.285 * $V_{CCI}$ for $t_{DP(R)}$	10
		0.615 * $V_{CCI}$ for $t_{DP(F)}$	

**Note:** \*Measuring point =  $V_{trip}$ . See Table 3-15 on page 3-14 for a complete table of trip points.

#### Timing Characteristics

Table 3-42 • 3.3 V PCI/PCI-X

Commercial-Case Conditions:  $T_J = 70^{\circ}$ C, Worst Case  $V_{CC} = 1.425$  V, Worst Case  $V_{CCI} = 3.0$  V

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
-F	0.79	3.22	0.05	1.04	0.51	3.28	2.34	3.86	4.30	5.97	5.03	ns
Std.	0.66	2.68	0.04	0.86	0.43	2.73	1.95	3.21	3.58	4.97	4.19	ns
-1	0.56	2.28	0.04	0.73	0.36	2.32	1.66	2.73	3.05	4.22	3.56	ns
-2	0.49	2.00	0.03	0.65	0.32	2.04	1.46	2.40	2.68	3.71	3.13	ns



# **Differential I/O Characteristics**

### Physical Implementation

Configuration of the I/O modules as a differential pair is handled by Actel Designer software when the user instantiates a differential I/O macro in the design.

Differential I/Os can also be used in conjunction with the embedded Input Register (InReg), Output Register (OutReg), Enable Register (EnReg), and Double Data Rate (DDR). However, there is no support for bidirectional I/Os or tristates with these standards.

### LVDS

Low-Voltage Differential Signal (ANSI/TIA/EIA-644) is a high-speed, differential I/O standard. It requires that one data bit is carried through two signal lines, so two pins are needed. It also requires external resistor termination.

The full implementation of the LVDS transmitter and receiver is shown in an example in Figure 3-11. The building blocks of the LVDS transmitter-receiver are one transmitter macro, one receiver macro, three board resistors at the transmitter end, and one resistor at the receiver end. The values for the three driver resistors are different from those used in the LVPECL implementation, because the output standard specifications are different.

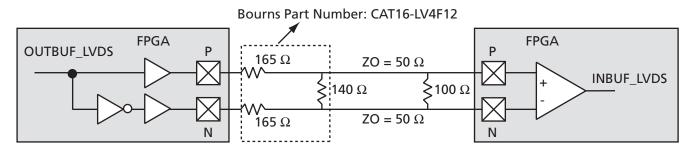


Figure 3-11 • LVDS Circuit Diagram and Board-Level Implementation

Table 3-43 •	Minimum and Maximum DC Input and Output Levels
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DC Parameter	Description	Min.	Тур.	Max.	Units
V <sub>CCI</sub>	Supply Voltage	2.375	2.5	2.625	V
V <sub>OL</sub>	Output Low Voltage	0.9	1.075	1.25	V
V <sub>OH</sub>	Output High Voltage	1.25	1.425	1.6	V
VI	Input Voltage	0		2.925	V
V <sub>ODIFF</sub>	Differential Output Voltage	250	350	450	mV
V <sub>OCM</sub>	Output Common Mode Voltage	1.125	1.25	1.375	V
V <sub>ICM</sub>	Input Common Mode Voltage	0.05	1.25	2.35	V
V <sub>IDIFF</sub>	Input Differential Voltage	100	350		mV

Notes:

1. ±5%

2. Differential input voltage =  $\pm$  350 mV.

#### Table 3-44 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)		
1.075	1.325	Cross point		

**Note:** \*Measuring point =  $V_{trip}$ . See Table 3-6 on page 3-4 for a complete table of trip points.

# Timing CharacteristicsTable 3-45LVDS

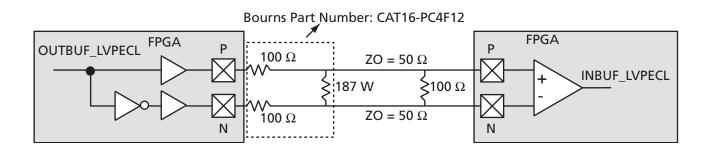
```
Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst Case V<sub>CC</sub> = 1.425 V, Worst Case V<sub>CCI</sub> = 2.3 V
```

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	Units
-F	0.79	2.20	0.05	1.92	ns
Std.	0.66	1.83	0.04	1.60	ns
-1	0.56	1.56	0.04	1.36	ns
-2	0.49	1.37	0.03	1.20	ns



### LVPECL

Low-Voltage Positive Emitter-Coupled Logic (LVPECL) is another differential I/O standard. It requires that one data bit is carried through two signal lines. Like LVDS, two pins are needed. It also requires external resistor termination. The full implementation of the LVDS transmitter and receiver is shown in an example in Figure 3-12. The building blocks of the LVPECL transmitter-receiver are one transmitter macro, one receiver macro, three board resistors at the transmitter end, and one resistor at the receiver end. The values for the three driver resistors are different from those used in the LVDS implementation, because the output standard specifications are different.



#### Figure 3-12 • LVPECL Circuit Diagram and Board-Level Implementation

Table 3-46 •	Minimum and Maximum DC Input and Output Levels
--------------	--

DC Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
V <sub>CCI</sub>	Supply Voltage	3	.0	3	.3	3	.6	V
V <sub>OL</sub>	Output Low Voltage	0.96	1.27	1.06	1.43	1.30	1.57	V
V <sub>OH</sub>	Output High Voltage	1.8	2.11	1.92	2.28	2.13	2.41	V
V <sub>IL</sub> , V <sub>IH</sub>	Input Low, Input High voltages	0	3.3	0	3.6	0	3.9	V
V <sub>ODIFF</sub>	Differential Output Voltage	0.625	0.97	0.625	0.97	0.625	0.97	V
V <sub>OCM</sub>	Output Common Mode Voltage	1.762	1.98	1.762	1.98	1.762	1.98	V
V <sub>ICM</sub>	Input Common Mode Voltage	1.01	2.57	1.01	2.57	1.01	2.57	V
V <sub>IDIFF</sub>	Input Differential Voltage	300		300		300		mV

Table 3-47 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)
1.64	1.94	Cross point

**Note:** \*Measuring point =  $V_{trip}$ . See Table 3-15 on page 3-14 for a complete table of trip points.

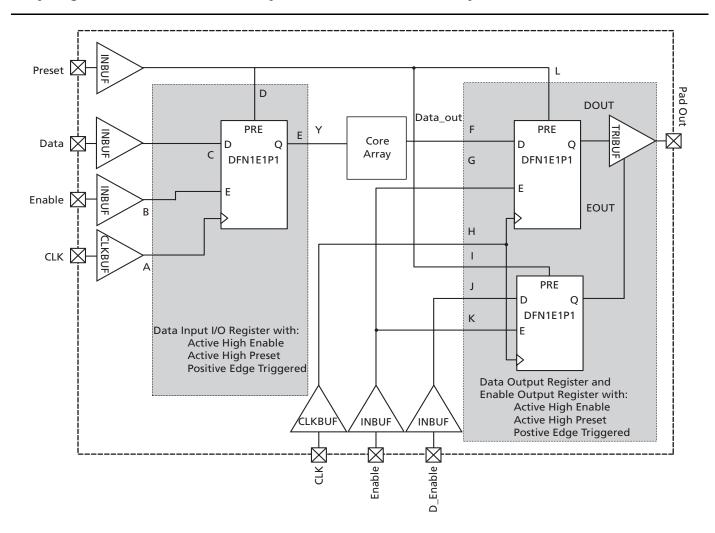
#### **Timing Characteristics**

Table 3-48 • LVPECL

Commercial-Case Conditions:  $T_J = 70^{\circ}$ C, Worst Case  $V_{CC} = 1.425$  V, Worst Case  $V_{CCI} = 3.0$  V

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	Units
-F	0.79	2.16	0.05	1.69	ns
Std.	0.66	1.80	0.04	1.40	ns
-1	0.56	1.53	0.04	1.19	ns
-2	0.49	1.34	0.03	1.05	ns

# **I/O Register Specifications**



# Fully Registered I/O Buffers with Synchronous Enable and Asynchronous Preset

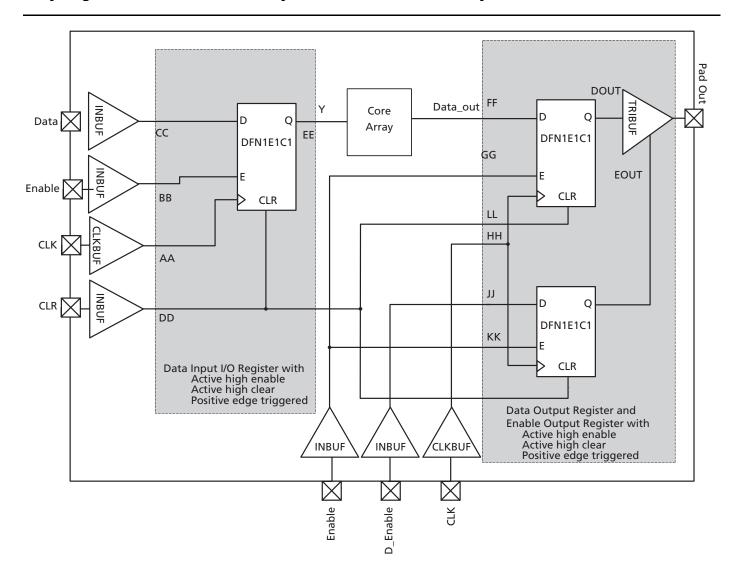
Figure 3-13 • Timing Model of Registered I/O Buffers with Synchronous Enable and Asynchronous Preset



Parameter Name	Parameter Definition	Measuring Nodes (From, To)*
t <sub>oclkq</sub>	Clock-to-Q of the Output Data Register	H, DOUT
t <sub>osud</sub>	Data Setup time for the Output Data Register	F, H
t <sub>OHD</sub>	Data Hold time for the Output Data Register	F, H
t <sub>osue</sub>	Enable Setup time for the Output Data Register	G, H
t <sub>OHE</sub>	Enable Hold time for the Output Data Register	G, H
t <sub>OPRE2Q</sub>	Asynchronous Preset-to-Q of the Output Data Register	L, DOUT
t <sub>orempre</sub>	Asynchronous Preset removal time for the Output Data Register	L, H
torecpre	Asynchronous Preset Recovery time for the Output Data Register	L, H
t <sub>oeclkq</sub>	Clock-to-Q of the Output Enable Register	H, EOUT
t <sub>oesud</sub>	Data Setup time for the Output Enable Register	J, H
t <sub>OEHD</sub>	Data Hold time for the Output Enable Register	J, H
t <sub>oesue</sub>	Enable Setup time for the Output Enable Register	К, Н
t <sub>OEHE</sub>	Enable Hold time for the Output Enable Register	К, Н
t <sub>OEPRE2Q</sub>	Asynchronous Preset-to-Q of the Output Enable Register	I, EOUT
t <sub>oerempre</sub>	Asynchronous Preset Removal time for the Output Enable Register	I, H
t <sub>oerecpre</sub>	Asynchronous Preset Recovery time for the Output Enable Register	I, H
t <sub>ICLKQ</sub>	Clock-to-Q of the Input Data Register	А, Е
t <sub>ISUD</sub>	Data Setup time for the Input Data Register	С, А
t <sub>IHD</sub>	Data Hold time for the Input Data Register	С, А
t <sub>ISUE</sub>	Enable Setup time for the Input Data Register	В, А
t <sub>IHE</sub>	Enable Hold time for the Input Data Register	В, А
t <sub>IPRE2Q</sub>	Asynchronous Preset-to-Q of the Input Data Register	D, E
t <sub>IREMPRE</sub>	Asynchronous Preset Removal time for the Input Data Register	D, A
t <sub>IRECPRE</sub>	Asynchronous Preset Recovery time for the Input Data Register	D, A

 Table 3-49
 Parameter Definition and Measuring Nodes

*Note:* \*See Figure 3-13 on page 3-30 for more information.



# Fully Registered I/O Buffers with Synchronous Enable and Asynchronous Clear

Figure 3-14 • Timing Model of the Registered I/O Buffers with Synchronous Enable and Asynchronous Clear

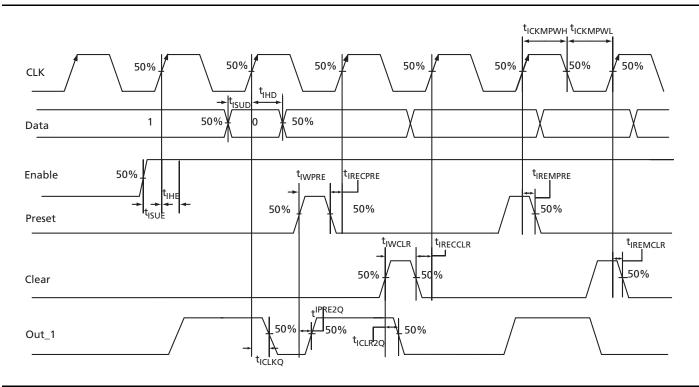


Parameter Name	Parameter Definition	Measuring Nodes (From, To)*
t <sub>oclkq</sub>	Clock-to-Q of the Output Data Register	HH, DOUT
t <sub>osud</sub>	Data Setup time for the Output Data Register	FF, HH
t <sub>OHD</sub>	Data Hold time for the Output Data Register	FF, HH
t <sub>osue</sub>	Enable Setup time for the Output Data Register	GG, HH
t <sub>OHE</sub>	Enable Hold time for the Output Data Register	GG, HH
t <sub>oclr2Q</sub>	Asynchronous Clear-to-Q of the Output Data Register	LL, DOUT
t <sub>oremclr</sub>	Asynchronous Clear Removal time for the Output Data Register	LL, HH
t <sub>orecclr</sub>	Asynchronous Clear Recovery time for the Output Data Register	LL, HH
t <sub>oeclkq</sub>	Clock-to-Q of the Output Enable Register	HH, EOUT
t <sub>oesud</sub>	Data Setup time for the Output Enable Register	JJ, HH
t <sub>OEHD</sub>	Data Hold time for the Output Enable Register	JJ, HH
t <sub>OESUE</sub>	Enable Setup time for the Output Enable Register	КК, НН
t <sub>OEHE</sub>	Enable Hold time for the Output Enable Register	КК, НН
t <sub>OECLR2Q</sub>	Asynchronous Clear-to-Q of the Output Enable Register	II, EOUT
t <sub>oeremclr</sub>	Asynchronous Clear Removal time for the Output Enable Register	II, HH
t <sub>OERECCLR</sub>	Asynchronous Clear Recovery time for the Output Enable Register	II, HH
t <sub>ICLKQ</sub>	Clock-to-Q of the Input Data Register	AA, EE
t <sub>ISUD</sub>	Data Setup time for the Input Data Register	CC, AA
t <sub>IHD</sub>	Data Hold time for the Input Data Register	CC, AA
t <sub>ISUE</sub>	Enable Setup time for the Input Data Register	BB, AA
t <sub>IHE</sub>	Enable Hold time for the Input Data Register	BB, AA
t <sub>ICLR2Q</sub>	Asynchronous Clear-to-Q of the Input Data Register	DD, EE
t <sub>IREMCLR</sub>	Asynchronous Clear Removal time for the Input Data Register	DD, AA
t <sub>IRECCLR</sub>	Asynchronous Clear Recovery time for the Input Data Register	DD, AA

Table 3-50 •	Parameter	<b>Definition and</b>	Measuring Nodes
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*Note:* \*See Figure 3-14 on page 3-32 for more information.

# **Input Register**



#### Figure 3-15 • Input Register Timing Diagram

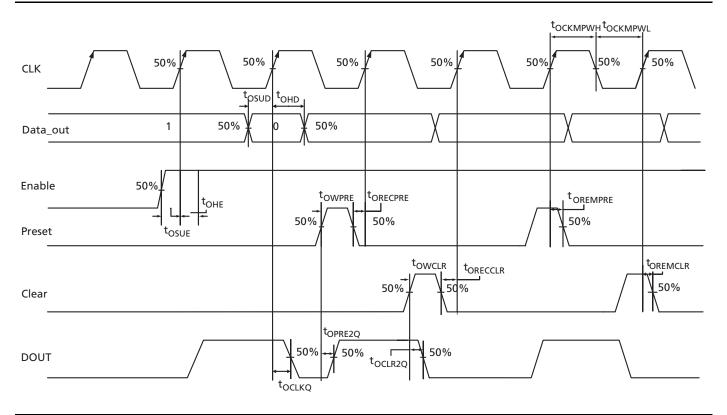
### **Timing Characteristics**

# Table 3-51Input Data Register Propagation Delays<br/>Commercial-Case Conditions: TJ = 70°C, Worst Case V<sub>CC</sub> = 1.425 V

Parameter	Description	-2	-1	Std.	-F	Units
t <sub>ICLKQ</sub>	Clock-to-Q of the Input Data Register	0.63	0.71	0.84	1.01	ns
t <sub>ISUD</sub>	Data Setup time for the Input Data Register	0.43	0.49	0.57	0.69	ns
t <sub>IHD</sub>	Data Hold time for the Input Data Register	0.00	0.00	0.00	0.00	ns
t <sub>ISUE</sub>	Enable Setup time for the Input Data Register	0.43	0.49	0.57	0.69	ns
t <sub>IHE</sub>	Enable Hold time for the Input Data Register	0.00	0.00	0.00	0.00	ns
t <sub>ICLR2Q</sub>	Asynchronous Clear-to-Q of the Input Data Register	0.57	0.65	0.76	1.01	ns
t <sub>IPRE2Q</sub>	Asynchronous Preset-to-Q of the Input Data Register	0.45	0.51	0.60	0.72	ns
t <sub>IREMCLR</sub>	Asynchronous Clear Removal time for the Input Data Register	0.00	0.00	0.00	0.00	ns
t <sub>IRECCLR</sub>	Asynchronous Clear Recovery time for the Input Data Register	0.10	0.10	0.10	0.10	ns
t <sub>IREMPRE</sub>	Asynchronous Preset Removal time for the Input Data Register	0.00	0.00	0.00	0.00	ns
t <sub>IRECPRE</sub>	Asynchronous Preset Recovery time for the Input Data Register	0.10	0.10	0.10	0.10	ns
t <sub>IWCLR</sub>	Asynchronous Clear Minimum Pulse Width for the Input Data Register	0.25	0.28	0.33	0.40	ns
t <sub>IVVPRE</sub>	Asynchronous Preset Minimum Pulse Width for the Input Data Register	0.25	0.28	0.33	0.40	ns
t <sub>ICKMPWH</sub>	Clock Minimum Pulse Width High for the Input Data Register	0.36	0.41	0.48	0.58	ns
t <sub>ICKMPWL</sub>	Clock Minimum Pulse Width Low for the Input Data Register	0.41	0.46	0.54	0.65	ns



# **Output Register**



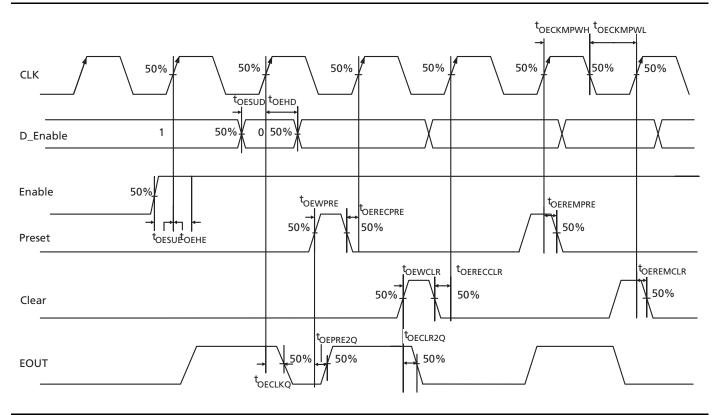
### Figure 3-16 • Output Register Timing Diagram

### **Timing Characteristics**

# Table 3-52Output Data Register Propagation DelaysCommercial-Case Conditions: TJ = 70°C, Worst Case V<sub>CC</sub> = 1.425 V

Parameter	Description	-2	-1	Std.	-F	Units
t <sub>OCLKQ</sub>	Clock-to-Q of the Output Data Register	0.63	0.71	0.84	1.01	ns
t <sub>OSUD</sub>	Data Setup time for the Output Data Register	0.43	0.49	0.57	0.69	ns
t <sub>OHD</sub>	Data Hold time for the Output Data Register	0.00	0.00	0.00	0.00	ns
t <sub>OSUE</sub>	Enable Setup time for the Output Data Register	0.43	0.49	0.57	0.69	ns
t <sub>OHE</sub>	Enable Hold time for the Output Data Register	0.00	0.00	0.00	0.00	ns
t <sub>OCLR2Q</sub>	Asynchronous Clear-to-Q of the Output Data Register	0.57	0.65	0.76	1.01	ns
t <sub>OPRE2Q</sub>	Asynchronous Preset-to-Q of the Output Data Register	0.45	0.51	0.60	0.72	ns
t <sub>oremclr</sub>	Asynchronous Clear Removal time for the Output Data Register	0.00	0.00	0.00	0.00	ns
t <sub>ORECCLR</sub>	Asynchronous Clear Recovery time for the Output Data Register	0.24	0.27	0.32	0.38	ns
t <sub>OREMPRE</sub>	Asynchronous Preset Removal time for the Output Data Register	0.00	0.00	0.00	0.00	ns
t <sub>ORECPRE</sub>	Asynchronous Preset Recovery time for the Output Data Register	0.24	0.27	0.32	0.38	ns
t <sub>owclr</sub>	Asynchronous Clear Minimum Pulse Width for the Output Data Register	0.26	0.29	0.34	0.41	ns
t <sub>OWPRE</sub>	Asynchronous Preset Minimum Pulse Width for the Output Data Register	0.26	0.29	0.34	0.41	ns
t <sub>оскмрwн</sub>	Clock Minimum Pulse Width High for the Output Data Register	0.38	0.43	0.51	0.61	ns
t <sub>OCKMPWL</sub>	Clock Minimum Pulse Width Low for the Output Data Register	0.43	0.49	0.57	0.69	ns

# **Output Enable Register**



### Figure 3-17 • Output Enable Register Timing Diagram

#### **Timing Characteristics**

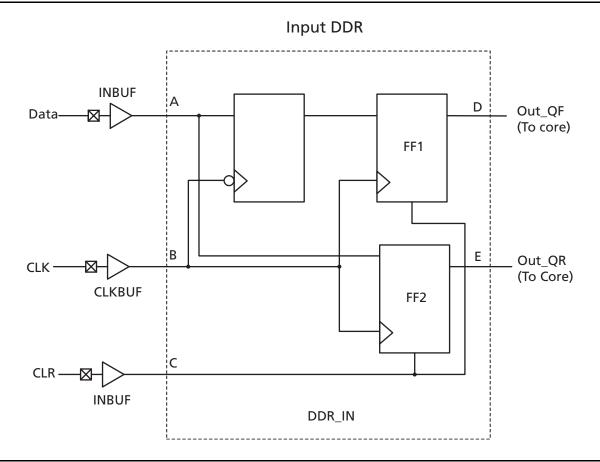
# Table 3-53Output Enable Register Propagation Delays<br/>Commercial-Case Conditions: TJ = 70°C, Worst Case V<sub>CC</sub> = 1.425 V

Parameter	Description	-2	-1	Std.	-F	Units
t <sub>oeclkq</sub>	Clock-to-Q of the Output Enable Register	0.63	0.71	0.84	1.01	ns
t <sub>OESUD</sub>	Data Setup time for the Output Enable Register	0.43	0.49	0.57	0.69	ns
t <sub>OEHD</sub>	Data Hold time for the Output Enable Register	0.00	0.00	0.00	0.00	ns
t <sub>OESUE</sub>	Enable Setup time for the Output Enable Register	0.43	0.49	0.57	0.69	ns
t <sub>OEHE</sub>	Enable Hold time for the Output Enable Register	0.00	0.00	0.00	0.00	ns
t <sub>OECLR2Q</sub>	Asynchronous Clear-to-Q of the Output Enable Register	0.63	0.71	0.84	1.01	ns
t <sub>OEPRE2Q</sub>	Asynchronous Preset-to-Q of the Output Enable Register	0.45	0.51	0.60	0.72	ns
t <sub>OEREMCLR</sub>	Asynchronous Clear Removal time for the Output Enable Register	0.00	0.00	0.00	0.00	ns
t <sub>OERECCLR</sub>	Asynchronous Clear Recovery time for the Output Enable Register	0.22	0.25	0.30	0.36	ns
t <sub>OEREMPRE</sub>	Asynchronous Preset Removal time for the Output Enable Register	0.00	0.00	0.00	0.00	ns
t <sub>OERECPRE</sub>	Asynchronous Preset Recovery time for the Output Enable Register	0.22	0.25	0.30	0.36	ns
t <sub>OEWCLR</sub>	Asynchronous Clear Minimum Pulse Width for the Output Enable Register	0.26	0.29	0.34	0.41	ns
t <sub>OEWPRE</sub>	Asynchronous Preset Minimum Pulse Width for the Output Enable Register	0.26	0.29	0.34	0.41	ns
t <sub>oeckmpwh</sub>	Clock Minimum Pulse Width High for the Output Enable Register	0.38	0.43	0.51	0.61	ns
t <sub>oeckmpwl</sub>	Clock Minimum Pulse Width Low for the Output Enable Register	0.43	0.49	0.57	0.69	ns



# **DDR Module Specifications**

# Input DDR Module



# Figure 3-18 • Input DDR Timing Model

## Table 3-54Parameter Definitions

Parameter Name	Parameter Definition	Measuring Nodes (From, To)
t <sub>DDRICLKQ1</sub>	Clock-to-Out Out_QR	B, D
t <sub>DDRICLKQ2</sub>	Clock-to-Out Out_QF	B, E
t <sub>DDRISUD</sub>	Data Setup time of DDR input	А, В
t <sub>DDRIHD</sub>	Data Hold time of DDR input	А, В
t <sub>DDRICLR2Q1</sub>	Clear-to-Out Out_QR	C, D
t <sub>DDRICLR2Q2</sub>	Clear-to-Out Out_QF	С, Е
t <sub>DDRIREMCLR</sub>	Clear Removal	С, В
t <sub>DDRIRECCLR</sub>	Clear Recovery	С, В

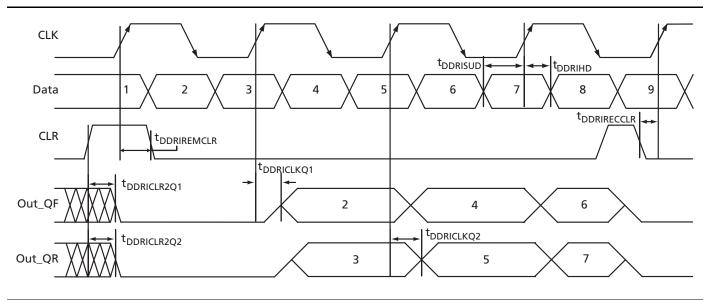


Table 3-55 • Input DDR Timing Diagram

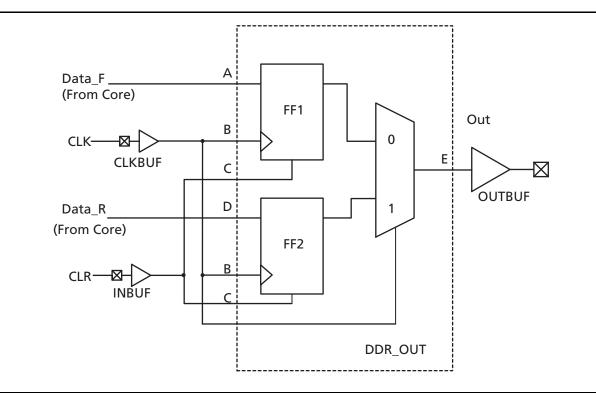
#### **Timing Characteristics**

Table 3-56Input DDR Propagation Delays<br/>Commercial-Case Conditions: TJ = 70°C, Worst Case VCC = 1.425 V

Parameter	Description	-2	-1	Std.	-F	Units
t <sub>DDRICLKQ1</sub>	Clock-to-Out Out_QR for Input DDR	0.63	0.71	0.84	1.01	ns
t <sub>DDRICLKQ2</sub>	Clock-to-Out Out_QF for Input DDR	0.63	0.71	0.84	1.01	ns
t <sub>DDRISUD</sub>	Data Setup for Input DDR	0.53	0.61	0.71	0.86	ns
t <sub>DDRIHD</sub>	Data Hold for Input DDR	0.00	0.00	0.00	0.00	ns
t <sub>DDRICLR2Q1</sub>	Asynchronous Clear-to-Out Out_QR for Input DDR	0.57	0.65	0.76	0.91	ns
t <sub>DDRICLR2Q2</sub>	Asynchronous Clear-to-Out Out_QF for Input DDR	0.57	0.65	0.76	0.91	ns
t <sub>DDRIREMCLR</sub>	Asynchronous Clear Removal time for Input DDR	0.00	0.00	0.00	0.00	ns
t <sub>DDRIRECCLR</sub>	Asynchronous Clear Recovery time for Input DDR	0.22	0.25	0.30	0.36	ns
t <sub>DDRIWCLR</sub>	Asynchronous Clear Minimum Pulse Width for Input DDR					ns
t <sub>DDRICKMPWH</sub>	Clock Minimum Pulse Width High for Input DDR					ns
t <sub>DDRICKMPWL</sub>	Clock Minimum Pulse Width Low for Input DDR					ns
F <sub>DDRIMAX</sub>	Maximum Frequency for Input DDR					MHz



# **Output DDR Module**



# Figure 3-19 • Output DDR Timing Model

### Table 3-57 • Parameter Definitions

Parameter Name	Parameter Definition	Measuring Nodes (From, To)
t <sub>DDROCLKQ</sub>	Clock-to-Out	B, E
t <sub>DDROCLR2Q</sub>	Asynchronous Clear-to-Out	С, Е
t <sub>DDROREMCLR</sub>	Clear Removal	С, В
t <sub>DDRORECCLR</sub>	Clear Recovery	С, В
t <sub>DDROSUD1</sub>	Data Setup Data_F	А, В
t <sub>DDROSUD2</sub>	Data Setup Data_R	D, B
t <sub>DDROHD1</sub>	Data Hold Data_F	А, В
t <sub>DDROHD2</sub>	Data Hold Data_R	D, B

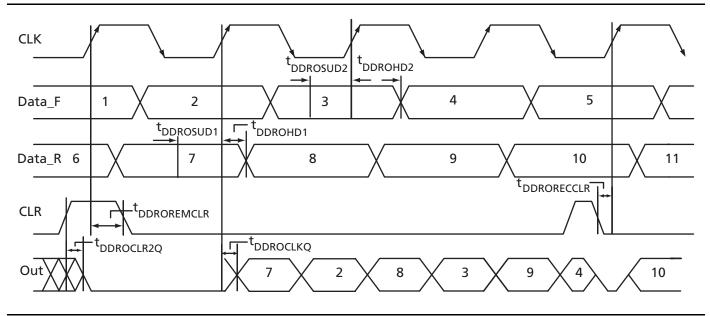


Figure 3-20 • Output DDR Timing Diagram

# Table 3-58Output DDR Propagation DelaysCommercial-Case Conditions: TJ = 70°C, Worst Case V<sub>CC</sub> = 1.425 V

Parameter	Description	-2	-1	Std.	-F	Units
t <sub>DDROCLKQ</sub>	Clock-to-Out of DDR for Output DDR	0.63	0.71	0.84	1.01	ns
t <sub>DDROSUD1</sub>	Data_F Data Setup for Output DDR	0.43	0.49	0.57	0.69	ns
t <sub>DDROSUD2</sub>	Data_R Data Setup for Output DDR	0.43	0.49	0.57	0.69	ns
t <sub>DDROHD1</sub>	Data_F Data Hold for Output DDR	0.00	0.00	0.00	0.00	ns
t <sub>DDROHD2</sub>	Data_R Data Hold for Output DDR	0.00	0.00	0.00	0.00	ns
t <sub>DDROCLR2Q</sub>	Asynchronous Clear-to-Out for Output DDR	0.57	0.65	0.76	0.91	ns
t <sub>ddroremclr</sub>	Asynchronous Clear Removal time for Output DDR	0.00	0.00	0.00	0.00	ns
t <sub>ddrorecclr</sub>	Asynchronous Clear Recovery time for Output DDR	0.22	0.25	0.30	0.36	ns
t <sub>DDROWCLR1</sub>	Asynchronous Clear Minimum Pulse Width for Output DDR					ns
t <sub>DDROCKMPWH</sub>	Clock Minimum Pulse Width High for the Output DDR					ns
t <sub>DDROCKMPWL</sub>	Clock Minimum Pulse Width Low for the Output DDR					ns
F <sub>DDOMAX</sub>	Maximum Frequency for the Output DDR					MHz



# **VersaTile Characteristics**

# VersaTile Specifications as a Combinatorial Module

The ProASIC3 library offers all combinations of LUT-3 combinatorial functions. In this section, timing characteristics are presented for a sample of the library. For more details, refer to the *ProASIC3/E Macro Library Guide*.

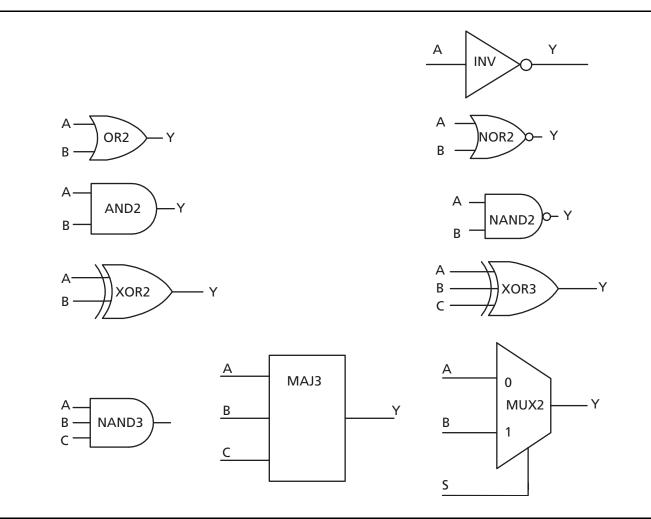


Figure 3-21 • Sample of Combinatorial Cells

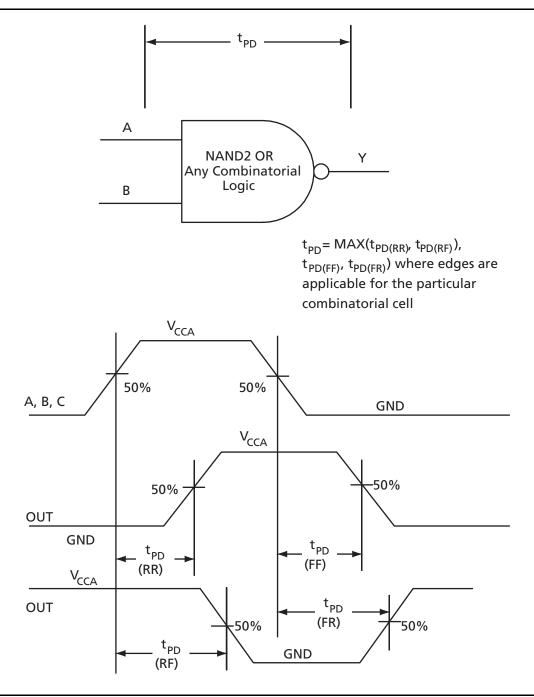


Figure 3-22 • Timing Model and Waveforms

	al-Case Conditions.	ij = 70 c, wois			1		
Combinatorial Cell	Equation	Parameter	-2	-1	Std.	-F	Units
INV	Y = !A	t <sub>PD</sub>	0.40	0.46	0.54	0.65	ns
AND2	$Y=A\cdotB$	t <sub>PD</sub>	0.47	0.54	0.63	0.76	ns
NAND2	$Y = !(A \cdot B)$	t <sub>PD</sub>	0.47	0.54	0.63	0.76	ns
OR2	Y = A + B	t <sub>PD</sub>	0.49	0.55	0.65	0.78	ns
NOR2	Y = !(A + B)	t <sub>PD</sub>	0.49	0.55	0.65	0.78	ns
XOR2	$Y = A \bigoplus B$	t <sub>PD</sub>	0.74	0.84	0.99	1.19	ns
MAJ3	Y = MAJ (A, B, C)	t <sub>PD</sub>	0.70	0.79	0.93	1.12	ns
XOR3	$Y = A \oplus B \oplus C$	t <sub>PD</sub>	0.87	1.00	1.17	1.41	ns
MUX2	Y = A !S + B S	t <sub>PD</sub>	0.51	0.58	0.68	0.81	ns
AND3	$Y = A \cdot B \cdot C$	t <sub>PD</sub>	0.56	0.64	0.75	0.90	ns

Table 3-59 • Combinatorial Cell Propagation Delays Commercial-Case Conditions: T<sub>1</sub> = 70°C, Worst Case V<sub>CC</sub> = 1.425 V

Note: For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

# VersaTile Specifications as a Sequential Module

The ProASIC3 library offers a wide variety of sequential cells including flip-flops and latches. Each have a data input and optional Enable, Clear, or Preset. In this section, timing characteristics are presented for a representative sample from the library. For more details, refer to the *ProASIC3/E Macro Library Guide*.

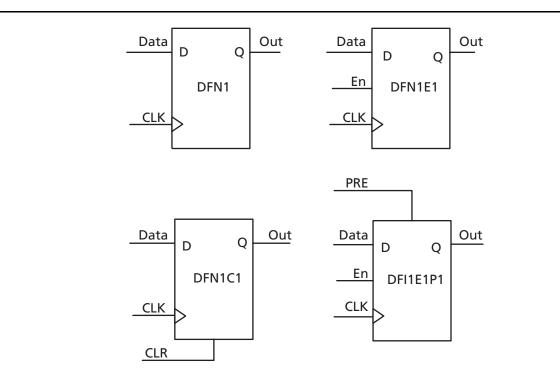


Figure 3-23 • Sample of Sequential Cells

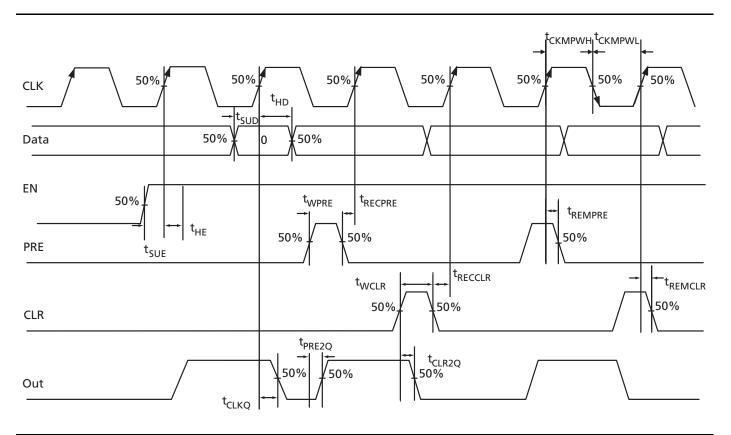


Figure 3-24 • Timing Model and Waveforms

#### Table 3-60Register Delays

```
Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst Case V<sub>CC</sub> = 1.425 V
```

Parameter	Description	-2	-1	Std.	-F	Units
t <sub>CLKQ</sub>	Clock-to-Q of the Core Register	0.55	0.63	0.74	0.89	ns
t <sub>SUD</sub>	Data Setup time for the Core Register	0.43	0.49	0.57	0.69	ns
t <sub>HD</sub>	Data Hold time for the Core Register	0.00	0.00	0.00	0.00	ns
t <sub>SUE</sub>	Enable Setup time for the Core Register	0.45	0.52	0.61	0.73	ns
t <sub>HE</sub>	Enable Hold time for the Core Register	0.00	0.00	0.00	0.00	ns
t <sub>CLR2Q</sub>	Asynchronous Clear-to-Q of the Core Register	0.40	0.45	0.53	0.64	ns
t <sub>PRE2Q</sub>	Asynchronous Preset-to-Q of the Core Register	0.40	0.45	0.53	0.64	ns
t <sub>REMCLR</sub>	Asynchronous Clear Removal time for the Core Register	0.00	0.00	0.00	0.00	ns
t <sub>RECCLR</sub>	Asynchronous Clear Recovery time for the Core Register	0.22	0.25	0.30	0.36	ns
t <sub>REMPRE</sub>	Asynchronous Preset Removal time for the Core Register	0.00	0.00	0.00	0.00	ns
t <sub>RECPRE</sub>	Asynchronous Preset Recovery time for the Core Register	0.22	0.25	0.30	0.36	ns
t <sub>WCLR</sub>	Asynchronous Clear Minimum Pulse Width for the Core Register	0.26	0.29	0.34	0.41	ns
t <sub>WPRE</sub>	Asynchronous Preset Minimum Pulse Width for the Core Register	0.26	0.29	0.34	0.41	ns
t <sub>CKMPWH</sub>	Clock Minimum Pulse Width High for the Core Register	0.38	0.43	0.51	0.61	ns
t <sub>CKMPWL</sub>	Clock Minimum Pulse Width Low for the Core Register	0.43	0.49	0.57	0.69	ns



# **Global Resource Characteristics**

# A3P250 Clock Tree Topology

Clock delays are device-specific. Figure 3-25 is an example of a global tree used for clock routing. The global tree presented in Figure 3-25 is driven by a CCC located on the west side of the A3P250 device. It is used to drive all D-flip-flops in the device.

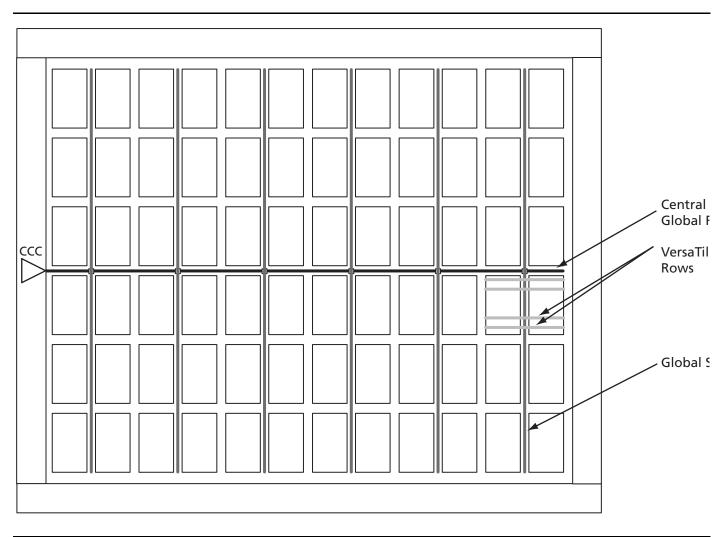


Figure 3-25 • Example of Global Tree Use in an A3P250 Device for Clock Routing

# **Global Tree Timing Characteristics**

Global clock delays include the central rib delay, the spine delay, and the row delay. Delays do not include I/O input buffer clock delays, as these are I/O standard dependent and the clock may be driven and conditioned internally by the CCC module. For more details on clock conditioning capabilities, refer to the "Clock Conditioning Circuits" section on page 2-15. Table 3-61 to Table 3-66 on page 3-48 present minimum and maximum global clock delays within each device. Minimum and maximum delays are measured with minimum and maximum loading.

### Timing Characteristics

### Table 3-61 A3P060 Global Resource

		-	-2	-	1	St	d.	-	F	
Parameter	Description	Min. <sup>1</sup>	Max. <sup>2</sup>	Units						
t <sub>RCKL</sub>	Input Low Delay for Global Clock	1.05	1.18	1.02	1.34	1.20	1.58	1.44	1.91	ns
t <sub>RCKH</sub>	Input High Delay for Global Clock	1.07	1.19	1.02	1.36	1.21	1.60	1.45	1.91	ns
	Minimum Pulse Width High for Global Clock									ns
-NCKIVIF VVL	Minimum Pulse Width Low for Global Clock									ns
t <sub>RCKSW</sub>	Maximum Skew for Global Clock		0.14		0.34		0.40		0.47	ns
F <sub>RMAX</sub>	Maximum Frequency for Global Clock									MHz

#### Notes:

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).

2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).

3. For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

### Table 3-62A3P125 Global Resource

Commercial-Case Conditions: T <sub>J</sub> = 70°C, V <sub>CC</sub> = 1.425 V
--

		-	2	-	1	St	:d.	-	F	
Parameter	Description	Min. <sup>1</sup>	Max. <sup>2</sup>	Units						
t <sub>RCKL</sub>	Input Low Delay for Global Clock	1.10	1.23	1.08	1.40	1.26	1.64	1.52	1.99	ns
t <sub>rckh</sub>	Input High Delay for Global Clock	1.12	1.24	1.07	1.41	1.26	1.66	1.52	1.98	ns
	Minimum Pulse Width High for Global Clock									ns
	Minimum Pulse Width Low for Global Clock									ns
t <sub>rcksw</sub>	Maximum Skew for Global Clock		0.14		0.34		0.40		0.47	ns
F <sub>rmax</sub>	Maximum Frequency for Global Clock									MHz

Notes:

2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).

3. For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

<sup>1.</sup> Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).

### Table 3-63A3P250 Global Resource

		-	-2	-	1	St	d.	_	F	
Parameter	Description	Min. <sup>1</sup>	Max. <sup>2</sup>	Units						
t <sub>RCKL</sub>	Input Low Delay for Global Clock	1.10	1.22	1.07	1.40	1.26	1.64	1.52	1.99	ns
t <sub>RCKH</sub>	Input High Delay for Global Clock	1.11	1.24	1.07	1.41	1.26	1.65	1.52	1.98	ns
	Minimum Pulse Width High for Global Clock									ns
-NCKIVIFVVL	Minimum Pulse Width Low for Global Clock									ns
t <sub>rcksw</sub>	Maximum Skew for Global Clock		0.14		0.34		0.39		0.47	ns
F <sub>rmax</sub>	Maximum Frequency for Global Clock									MHz

### Commercial-Case Conditions: T<sub>J</sub> = 70°C, V<sub>CC</sub> = 1.425 V

#### Notes:

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).

2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).

3. For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

#### Table 3-64 • A3P400 Global Resource

Commercial-Case Conditions: T<sub>J</sub> = 70°C, V<sub>CC</sub> = 1.425 V

		-	2	-	1	St	d.	-	F	
Parameter	Description	Min. <sup>1</sup>	Max. <sup>2</sup>	Units						
t <sub>RCKL</sub>	Input Low Delay for Global Clock	1.15	1.27	1.13	1.45	1.33	1.70	1.59	2.06	ns
t <sub>RCKH</sub>	Input High Delay for Global Clock	1.16	1.28	1.12	1.46	1.32	1.72	1.59	2.05	ns
	Minimum Pulse Width High for Global Clock									ns
	Minimum Pulse Width Low for Global Clock									ns
t <sub>RCKSW</sub>	Maximum Skew for Global Clock		0.13		0.34		0.40		0.47	ns
F <sub>RMAX</sub>	Maximum Frequency for Global Clock									Mhz

Notes:

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).

2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).

3. For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

#### Table 3-65 • A3P600 Global Resource

```
Commercial-Case Conditions: T<sub>J</sub> = 70°C, V<sub>CC</sub> = 1.425 V
```

		-	2	-	1	St	d.	_	F	
Parameter	Description	Min. <sup>1</sup>	Max. <sup>2</sup>	Units						
t <sub>RCKL</sub>	Input Low Delay for Global Clock	1.15	1.27	1.13	1.45	1.33	1.70	1.59	2.06	ns
t <sub>RCKH</sub>	Input High Delay for Global Clock	1.16	1.28	1.12	1.46	1.32	1.72	1.59	2.05	ns
	Minimum Pulse Width High for Global Clock									ns
	Minimum Pulse Width Low for Global Clock									ns
t <sub>rcksw</sub>	Maximum Skew for Global Clock		0.13		0.34		0.40		0.47	ns
F <sub>rmax</sub>	Maximum Frequency for Global Clock									MHz

#### Notes:

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).

2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).

3. For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

#### Table 3-66A3P1000 Global Resource

Commercial-Case Conditions: T<sub>J</sub> = 70°C, V<sub>CC</sub> = 1.425 V

		-	2	-	1	St	d.	-	F	
Parameter	Description	Min. <sup>1</sup>	Max. <sup>2</sup>	Units						
t <sub>RCKL</sub>	Input Low Delay for Global Clock	1.19	1.32	1.18	1.50	1.39	1.76	1.67	2.13	ns
t <sub>RCKH</sub>	Input High Delay for Global Clock	1.20	1.32	1.18	1.51	1.38	1.77	1.66	2.12	ns
	Minimum Pulse Width High for Global Clock									ns
	Minimum Pulse Width Low for Global Clock									ns
t <sub>rcksw</sub>	Maximum Skew for Global Clock		0.13		0.33		0.39		0.47	ns
F <sub>RMAX</sub>	Maximum Frequency for Global Clock									MHz

Notes:

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).

2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).

3. For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.



# **Embedded SRAM and FIFO Characteristics**

# SRAM

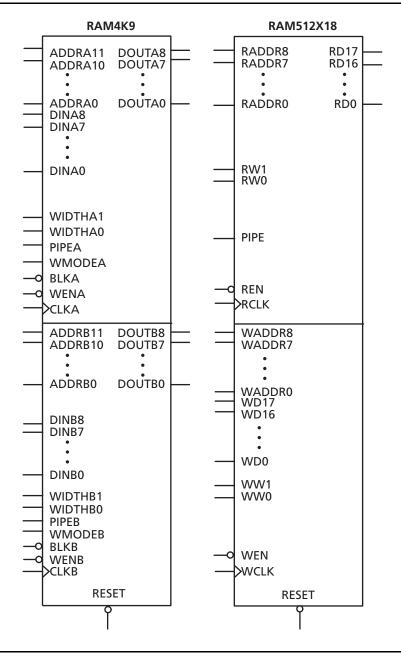
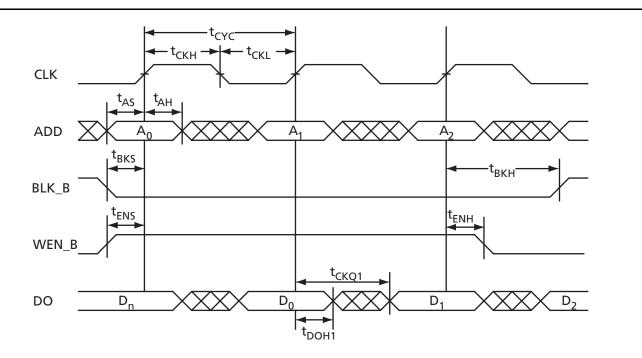
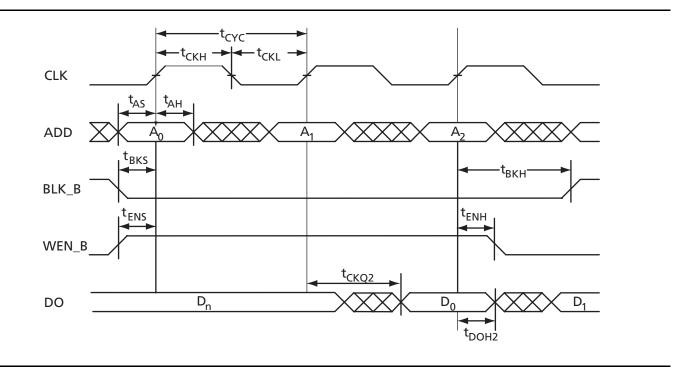


Figure 3-26 • RAM Models

# **Timing Waveforms**



## Figure 3-27 • RAM Read for Flow-Through Output



### Figure 3-28 • RAM Read for Pipelined Output



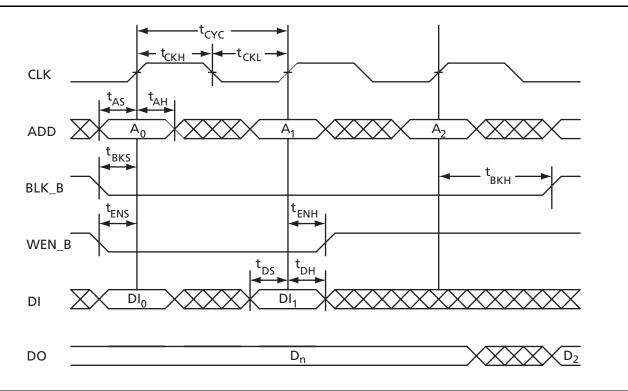


Figure 3-29 • RAM Write, Output Retained (WMODE = 0)

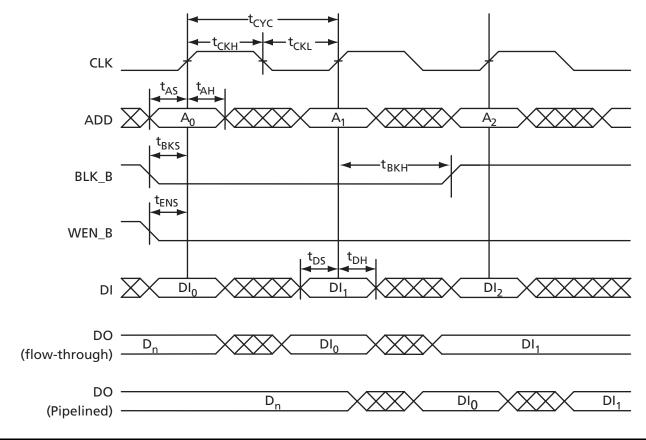
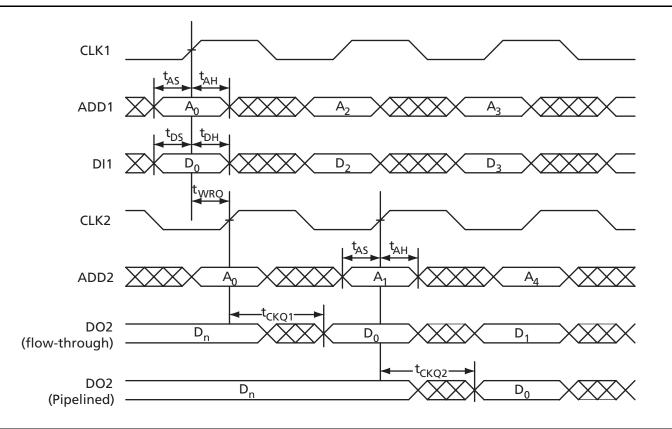
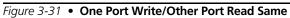


Figure 3-30 • RAM Write, Output as Write Data (WMODE = 1)







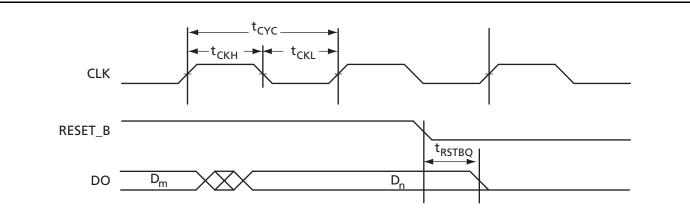


Figure 3-32 • RAM Reset

# **Timing Characteristics**

### Table 3-67 • RAM4K9

Commercial-Case Conditions:  $T_J = 70^{\circ}$ C, Worst Case V<sub>CC</sub> = 1.425 V

Parameter	Description	-2	-1	Std.	-F	Units
t <sub>AS</sub>	Address Setup time	0.25	0.28	0.33	0.40	ns
t <sub>AH</sub>	Address Hold time	0.00	0.00	0.00	0.00	ns
t <sub>ENS</sub>	REN_B,WEN_B Setup time	0.14	0.16	0.19	0.23	ns
t <sub>ENH</sub>	REN_B, WEN_B Hold time	0.10	0.11	0.13	0.16	ns
t <sub>BKS</sub>	BLK_B Setup time	0.23	0.27	0.31	0.37	ns
t <sub>BKH</sub>	BLK_B Hold time	0.00	0.00	0.00	0.00	ns
t <sub>DS</sub>	Input data (DI) Setup time	0.18	0.21	0.25	0.29	ns
t <sub>DH</sub>	Input data (DI) Hold time	0.00	0.00	0.00	0.00	ns
t <sub>CKQ1</sub>	Clock High to New Data Valid on DO (output retained, WMODE = 0)	1.79	2.03	2.39	2.87	ns
	Clock High to New Data Valid on DO (flow-through, WMODE = 1)	2.36	2.68	3.15	3.79	ns
t <sub>CKQ2</sub>	Clock HIGH to New Data Valid on DO (pipelined)	0.89	1.02	1.20	1.44	ns
t <sub>rstbq</sub>	RESET_B Low to Data Out Low on DO (flow through)	0.92	1.05	1.23	1.48	ns
	RESET_B Low to Data Out Low on DO (pipelined)	0.92	1.05	1.23	1.48	ns
t <sub>remrstb</sub>	RESET_B Removal	0.00	0.00	0.00	0.00	ns
t <sub>recrstb</sub>	RESET_B Recovery	0.00	0.00	0.00	0.00	ns
t <sub>MPWRSTB</sub>	RESET_B Minimum Pulse Width	0.22	0.25	0.29	0.35	ns
t <sub>CYC</sub>	Clock Cycle time	2.10	2.38	2.80	3.36	ns

**Note:** For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

### *Table 3-68* • **RAM512X18**

### Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst Case V<sub>CC</sub> = 1.425 V

Parameter	Description	-2	-1	Std.	-F	Units
t <sub>AS</sub>	Address Setup time	0.25	0.28	0.33	0.40	ns
t <sub>AH</sub>	t <sub>AH</sub> Address Hold time		0.00	0.00	0.00	ns
t <sub>ENS</sub>	REN_B,WEN_B Setup time	0.18	0.20	0.24	0.28	ns
t <sub>ENH</sub>	REB_B, WEN_B Hold time	0.06	0.07	0.08	0.09	ns
t <sub>DS</sub>	Input data (DI) Setup time	0.18	0.21	0.25	0.29	ns
tDH	DH Input data (DI) Hold time		0.00	0.00	0.00	ns
t <sub>CKQ1</sub>	Clock High to New Data Valid on DO (output retained, WMODE = 0)	2.16	2.46	2.89	3.47	ns
t <sub>CKQ2</sub>	Clock High to New Data Valid on DO (pipelined)	0.90	1.02	1.20	1.44	ns
t <sub>rstbq</sub>	RESET_B Low to Data Out Low on DO (flow through)	0.92	1.05	1.23	1.48	ns
	RESET_B Low to Data Out Low on DO (pipelined)	0.92	1.05	1.23	1.48	ns
t <sub>remrstb</sub>	RESET_B Removal	0.00	0.00	0.00	0.00	ns
t <sub>RECRSTB</sub>	RESET_B Recovery	0.00	0.00	0.00	0.00	ns
t <sub>MPWRSTB</sub>	RESET_B Minimum Pulse Width	0.22	0.25	0.29	0.35	ns
t <sub>CYC</sub>	Clock Cycle time	2.10	2.38	2.80	3.36	ns

Note: For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.



# **FIFO**

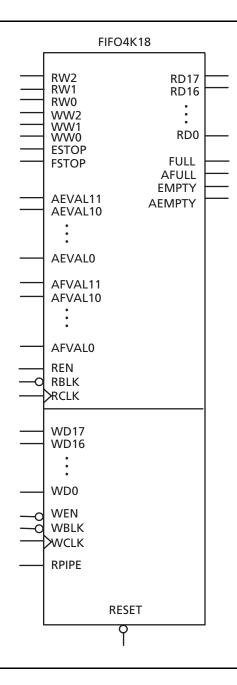
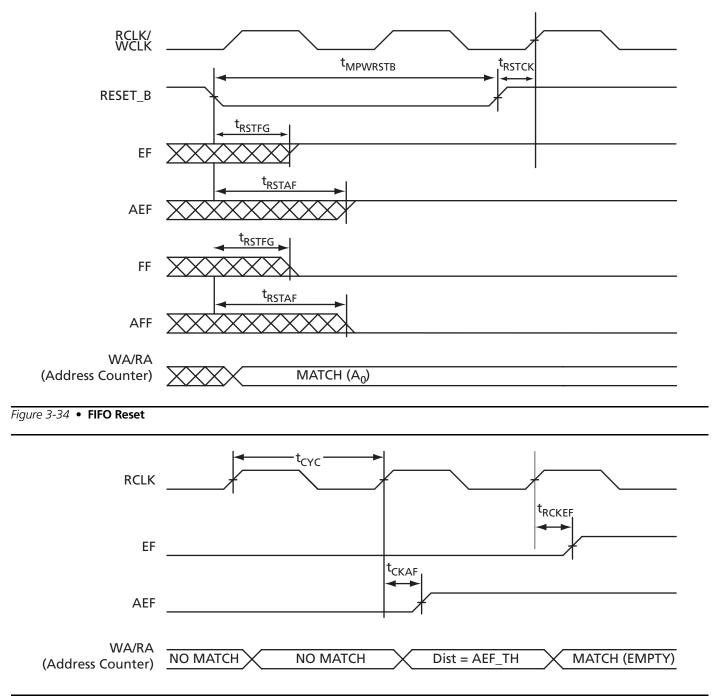
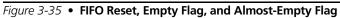


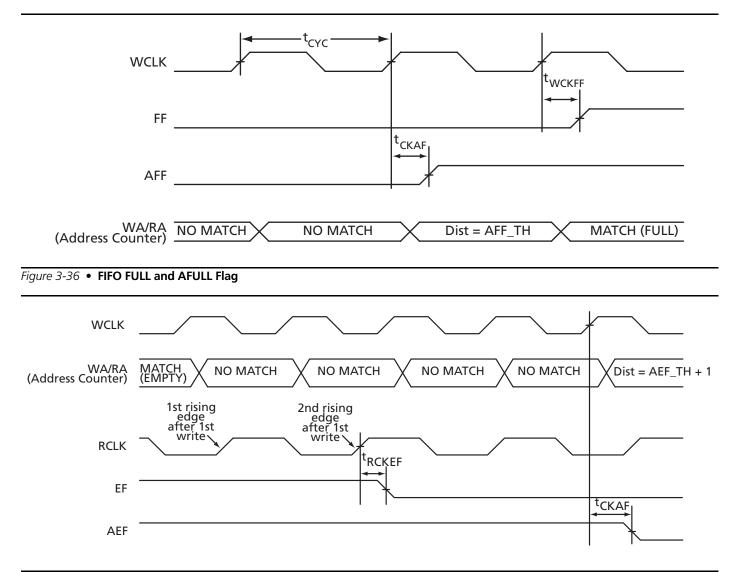
Figure 3-33 • FIFO Model

# **Timing Waveforms**











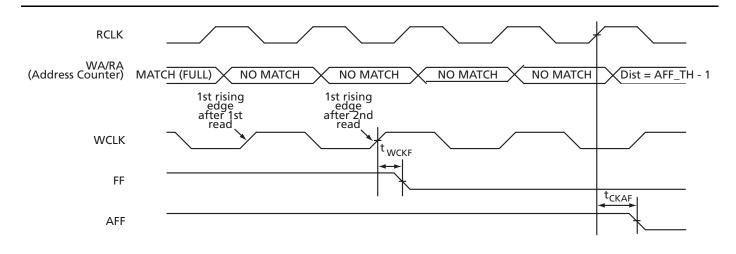


Figure 3-38 • FULL and ALFULL Deassertion

## **Timing Characteristics**

Table 3-69 • FIFO

Commercial-Case Conditions: T<sub>J</sub> = 70°C, V<sub>CC</sub> = 1.425 V

Parameter	Description	-2	-1	Std.	–F	Units
t <sub>ENS</sub>	REN_B,WEN_B Setup time	0.21	0.24	0.29	0.35	ns
t <sub>ENH</sub>	REN_B, WEN_B Hold time	0.02	0.02	0.02	0.03	ns
t <sub>BKS</sub>	t <sub>BKS</sub> BLK_B Setup time		0.29	0.34	0.40	ns
t <sub>BKH</sub>	BLK_B Hold time	0.00	0.00	0.00	0.00	ns
t <sub>DS</sub>	Input data (DI) Setup time	0.18	0.21	0.25	0.29	ns
t <sub>DH</sub>	Input data (DI) Hold time	0.00	0.00	0.00	0.00	ns
t <sub>CKQ1</sub>	Clock High to New Data Valid on DO (flow-through)	2.36	2.68	3.15	3.79	ns
t <sub>CKQ2</sub>	Clock High to New Data Valid on DO (pipelined)	0.89	1.02	1.20	1.44	ns
t <sub>RCKEF</sub>	RCLK High to Empty Flag Valid	1.72	1.96	2.30	2.76	ns
t <sub>WCKFF</sub>	WCLK High to Full Flag Valid	1.63	1.86	2.18	2.62	ns
t <sub>CKAF</sub>	Clock High to Almost Empty/Full Flag Valid	3.72	4.24	4.99	5.99	ns
t <sub>RSTFG</sub>	RESET_B Low to Empty/Full Flag valid	1.69	1.93	2.27	2.72	ns
t <sub>RSTAF</sub>	RESET_B Low to Almost-Empty/Full Flag Valid	3.66	4.17	4.90	5.89	ns
t <sub>RSTBQ</sub>	RESET_B Low to Data out Low on DO (flow through)	0.92	1.05	1.23	1.48	ns
	RESET_B Low to Data out Low on DO (pipelined)	0.92	1.05	1.23	1.48	ns
t <sub>remrstb</sub>	RESET_B Removal	0.00	0.00	0.00	0.00	ns
t <sub>RECRSTB</sub>	RESET_B Recovery	0.00	0.00	0.00	0.00	ns
t <sub>MPWRSTB</sub>	RESET_B Minimum Pulse Width	0.21	0.24	0.29	0.34	ns
t <sub>CYC</sub>	Clock Cycle time	2.06	2.33	2.75	3.29	ns

**Note:** For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.

# **Embedded FROM Characteristics**

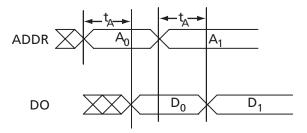


Figure 3-39 • Timing Diagram



# **Timing Characteristics**

Table 3-70 •	Embedded FROM Access Time
--------------	---------------------------

Parameter	Description	-2	-1	Std.	Units
t <sub>A</sub>	Data Access Time	10	10	10	ns

# **JTAG 1532 Characteristics**

JTAG timing delays do not include JTAG I/Os. To obtain complete JTAG timing, add I/O buffer delays to the corresponding standard selected, refer to the I/O Timing characteristics for more details.

## **Timing Characteristics**

Table 3-71 • JTAG 1532

Commercial-Case Conditions: T<sub>J</sub> = 70°C, worst-case V<sub>CC</sub> = 1.425 V

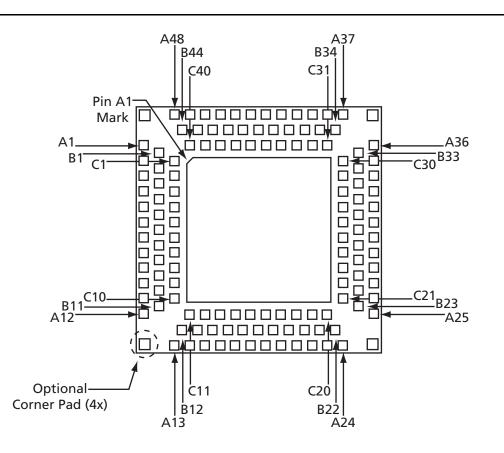
Parameter	Description	-2	-1	Std.	Units
t <sub>DISU</sub>	Test Data Input Setup Time				ns
t <sub>DIHD</sub>	Test Data Input Hold Time				ns
t <sub>TMSSU</sub>	Test Mode Select Setup Time				ns
t <sub>TMDHD</sub>	Test Mode Select Hold Time				ns
t <sub>TCK2Q</sub>	Clock to Q (Data Out)				ns
t <sub>RSTB2Q</sub>	Reset to Q (Data Out)				ns
F <sub>TCKMAX</sub>	TCK maximum frequency	20	20	20	MHz
t <sub>TRSTREM</sub>	ResetB Removal time				ns
t <sub>TRSTREC</sub>	ResetB Recovery time				ns
t <sub>TRSTMPW</sub>	ResetB minimum pulse				ns

Note: For specific junction temperature and voltage-supply levels, refer to Table 3-6 on page 3-4 for derating values.



# Package Pin Assignments

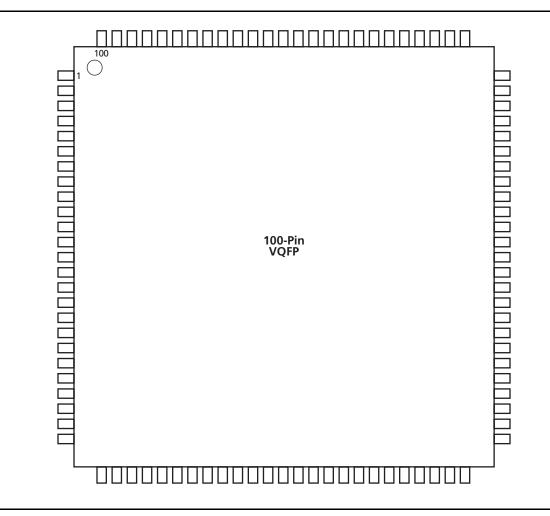
# 132-Pin QFN



### Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.actel.com/products/rescenter/package/index.html.

# 100-Pin VQFP



### Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.actel.com/products/rescenter/package/index.html.

ProASIC3 Flash Fa	amily FPGAs

100-Pin VQFP*		
Pin Number	A3P060 Function	Pin Nu
1	GND	3
2	GAA2/IO51RSB1	3
3	IO52RSB1	3
4	GAB2/IO53RSB1	4
5	IO95RSB1	4
6	GAC2/IO94RSB1	4
7	IO93RSB1	4
8	IO92RSB1	4
9	GND	4
10	GFB1/IO87RSB1	4
11	GFB0/IO86RSB1	4
12	V <sub>COMPLF</sub>	4
13	GFA0/IO85RSB1	4
14	V <sub>CCPLF</sub>	5
15	GFA1/IO84RSB1	5
16	GFA2/IO83RSB1	5
17	V <sub>CC</sub>	5
18	V <sub>CCI</sub> B1	5
19	GEC1/IO77RSB1	5
20	GEB1/IO75RSB1	5
21	GEB0/IO74RSB1	5
22	GEA1/IO73RSB1	5
23	GEA0/IO72RSB1	5
24	VMV1	6
25	GNDQ	6
26	GEA2/IO71RSB1	6
27	GEB2/IO70RSB1	6
28	GEC2/IO69RSB1	6
29	IO68RSB1	6
30	IO67RSB1	6
31	IO66RSB1	6
32	IO65RSB1	6
33	IO64RSB1	6
34	IO63RSB1	7
35	IO62RSB1	7
36	IO61RSB1	7.
		L

100-Pin VQFP*		
Pin Number	A3P060 Function	
37	V <sub>CC</sub>	
38	GND	
39	V <sub>CCI</sub> B1	
40	IO60RSB1	
41	IO59RSB1	
42	IO58RSB1	
43	GDC2/IO57RSB1	
44	GDB2/IO56RSB1	
45	GDA2/IO55RSB1	
46	IO54RSB1	
47	ТСК	
48	TDI	
49	TMS	
50	NC	
51	GND	
52	V <sub>PUMP</sub>	
53	NC	
54	TDO	
55	TRST	
56	V <sub>JTAG</sub>	
57	GDA1/IO49RSB0	
58	GDC0/IO46RSB0	
59	GDC1/IO45RSB0	
60	IO44RSB0	
61	GCB2/IO42RSB0	
62	GCA0/IO40RSB0	
63	GCA1/IO39RSB0	
64	GCC0/IO36RSB0	
65	GCC1/IO35RSB0	
66	V <sub>CCI</sub> B0	
67	GND	
68	V <sub>CC</sub>	
69	IO31RSB0	
70	GBC2/IO29RSB0	
71	GBB2/IO27RSB0	
72	IO26RSB0	

100-Pin VQFP*		
Pin Number	A3P060 Function	
73	GBA2/IO25RSB0	
74	VMV0	
75	GNDQ	
76	GBA1/IO24RSB0	
77	GBA0/IO23RSB0	
78	GBB1/IO22RSB0	
79	GBB0/IO21RSB0	
80	GBC1/IO20RSB0	
81	GBC0/IO19RSB0	
82	IO18RSB0	
83	IO17RSB0	
84	IO15RSB0	
85	IO13RSB0	
86	IO11RSB0	
87	V <sub>CCI</sub> B0	
88	GND	
89	V <sub>CC</sub>	
90	IO10RSB0	
91	IO09RSB0	
92	IO08RSB0	
93	GAC1/IO07RSB0	
94	GAC0/IO06RSB0	
95	GAB1/IO05RSB0	
96	GAB0/IO04RSB0	
97	GAA1/IO03RSB0	
98	GAA0/IO02RSB0	
99	IO01RSB0	
100	IOOORSBO	

100-Pin VQFP*		100-P
Pin Number	A3P125 Function	Pin Number
1	GND	39
2	GAA2/IO67RSB1	40
3	IO68RSB1	41
4	GAB2/IO69RSB1	42
5	IO132RSB1	43
6	GAC2/IO131RSB1	44
7	IO130RSB1	45
8	IO129RSB1	46
9	GND	47
10	GFB1/IO124RSB1	48
11	GFB0/IO123RSB1	49
12	V <sub>COMPLF</sub>	50
13	GFA0/IO122RSB1	51
14	V <sub>CCPLF</sub>	52
15	GFA1/IO121RSB1	53
16	GFA2/IO120RSB1	54
17	V <sub>CC</sub>	55
18	V <sub>CCI</sub> B1	56
19	GEC0/IO111RSB1	57
20	GEB1/IO110RSB1	58
21	GEB0/IO109RSB1	59
22	GEA1/IO108RSB1	60
23	GEA0/IO107RSB1	61
24	VMV1	62
25	GNDQ	63
26	GEA2/IO106RSB1	64
27	GEB2/IO105RSB1	65
28	GEC2/IO104RSB1	66
29	IO102RSB1	67
30	IO100RSB1	68
31	IO99RSB1	69
32	IO97RSB1	70
33	IO96RSB1	71
34	IO95RSB1	72
35	IO94RSB1	73
36	IO93RSB1	74
37	V <sub>CC</sub>	75
38	GND	76

100-Pin VQFP*		
Pin Number	A3P125 Function	
39	V <sub>CCI</sub> B1	
40	IO87RSB1	
41	IO84RSB1	
42	IO81RSB1	
43	IO75RSB1	
44	GDC2/IO72RSB1	
45	GDB2/IO71RSB1	
46	GDA2/IO70RSB1	
47	ТСК	
48	TDI	
49	TMS	
50	VMV1	
51	GND	
52	V <sub>PUMP</sub>	
53	NC	
54	TDO	
55	TRST	
56	V <sub>JTAG</sub>	
57	GDA1/IO65RSB0	
58	GDC0/IO62RSB0	
59	GDC1/IO61RSB0	
60	GCC2/IO59RSB0	
61	GCB2/IO58RSB0	
62	GCA0/IO56RSB0	
63	GCA1/IO55RSB0	
64	GCC0/IO52RSB0	
65	GCC1/IO51RSB0	
66	V <sub>CCI</sub> B0	
67	GND	
68	V <sub>CC</sub>	
69	IO47RSB0	
70	GBC2/IO45RSB0	
71	GBB2/IO43RSB0	
72	IO42RSB0	
73	GBA2/IO41RSB0	
74	VMV0	
75	GNDQ	
76	GBA1/IO40RSB0	

100-Pin VQFP*		
Pin Number	A3P125 Function	
77	GBA0/IO39RSB0	
78	GBB1/IO38RSB0	
79	GBB0/IO37RSB0	
80	GBC1/IO36RSB0	
81	GBC0/IO35RSB0	
82	IO32RSB0	
83	IO28RSB0	
84	IO25RSB0	
85	IO22RSB0	
86	IO19RSB0	
87	V <sub>CCI</sub> B0	
88	GND	
89	V <sub>CC</sub>	
90	IO15RSB0	
91	IO13RSB0	
92	IO11RSB0	
93	IO09RSB0	
94	IO07RSB0	
95	GAC1/IO05RSB0	
96	GAC0/IO04RSB0	
97	GAB1/IO03RSB0	
98	GAB0/IO02RSB0	
99	GAA1/IO01RSB0	
100	GAA0/IO00RSB0	

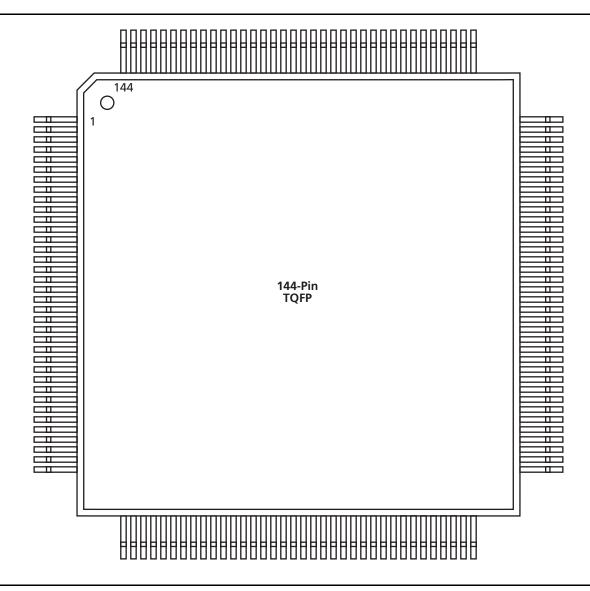
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ProASIC3 Flash Fan	nily FPGAs

100-Pin VQFP*		
Pin Number	A3P250 Function	F
1	GND	
2	GAA2/IO118UDB3	
3	IO118VDB3	
4	GAB2/IO117UDB3	
5	IO117VDB3	
6	GAC2/IO116UDB3	
7	IO116VDB3	
8	IO112PSB3	
9	GND	
10	GFB1/IO109PDB3	
11	GFB0/IO109NDB3	
12	V <sub>COMPLF</sub>	
13	GFA0/IO108NPB3	
14	V <sub>CCPLF</sub>	
15	GFA1/IO108PPB3	
16	GFA2/IO107PSB3	
17	V <sub>CC</sub>	
18	V <sub>CCI</sub> B3	
19	GFC2/IO105PSB3	
20	GEC1/IO100PDB3	
21	GEC0/IO100NDB3	
22	GEA1/IO98PDB3	
23	GEA0/IO98NDB3	
24	VMV3	
25	GNDQ	
26	GEA2/IO97RSB2	
27	GEB2/IO96RSB2	
28	GEC2/IO95RSB2	
29	IO93RSB2	
30	IO92RSB2	
31	IO91RSB2	
32	IO90RSB2	
33	IO88RSB2	
34	IO86RSB2	
35	IO85RSB2	
36	IO84RSB2	
Noto: *Pofor to t	the "User I/O Naming Conv	

100-Pin VQFP*		
Pin Number	A3P250 Function	
37	V <sub>CC</sub>	
38	GND	
39	V <sub>CCI</sub> B2	
40	IO77RSB2	
41	IO74RSB2	
42	IO71RSB2	
43	GDC2/IO63RSB2	
44	GDB2/IO62RSB2	
45	GDA2/IO61RSB2	
46	GNDQ	
47	ТСК	
48	TDI	
49	TMS	
50	VMV2	
51	GND	
52	V <sub>PUMP</sub>	
53	NC	
54	TDO	
55	TRST	
56	V <sub>JTAG</sub>	
57	GDA1/IO60USB1	
58	GDC0/IO58VDB1	
59	GDC1/IO58UDB1	
60	IO52NDB1	
61	GCB2/IO52PDB1	
62	GCA1/IO50PDB1	
63	GCA0/IO50NDB1	
64	GCC0/IO48NDB1	
65	GCC1/IO48PDB1	
66	V <sub>CCI</sub> B1	
67	GND	
68	V <sub>CC</sub>	
69	IO43NDB1	
70	GBC2/IO43PDB1	
71	GBB2/IO42PSB1	
72	IO41NDB1	

100-	Pin VQFP*
Pin Number	A3P250 Function
73	GBA2/IO41PDB1
74	VMV1
75	GNDQ
76	GBA1/IO40RSB0
77	GBA0/IO39RSB0
78	GBB1/IO38RSB0
79	GBB0/IO37RSB0
80	GBC1/IO36RSB0
81	GBC0/IO35RSB0
82	IO29RSB0
83	IO27RSB0
84	IO25RSB0
85	IO23RSB0
86	IO21RSB0
87	V <sub>CCI</sub> B0
88	GND
89	V <sub>CC</sub>
90	IO15RSB0
91	IO13RSB0
92	IO11RSB0
93	GAC1/IO05RSB0
94	GAC0/IO04RSB0
95	GAB1/IO03RSB0
96	GAB0/IO02RSB0
97	GAA1/IO01RSB0
98	GAA0/IO00RSB0
99	GNDQ
100	VMV0

# 144-Pin TQFP



## Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.actel.com/products/rescenter/package/index.html.

ProASIC3 Flash Family FPGAs

144-1	Pin TQFP*	
Pin Number	A3P060 Function	Pin Nun
1	GAA2/IO51RSB1	37
2	IO52RSB1	38
3	GAB2/IO53RSB1	39
4	IO95RSB1	40
5	GAC2/IO94RSB1	41
6	IO93RSB1	42
7	IO92RSB1	43
8	IO91RSB1	44
9	V <sub>CC</sub>	45
10	GND	46
11	V <sub>CCI</sub> B1	47
12	IO90RSB1	48
13	GFC1/IO89RSB1	49
14	GFC0/IO88RSB1	50
15	GFB1/IO87RSB1	51
16	GFB0/IO86RSB1	52
17	V <sub>COMPLF</sub>	53
18	GFA0/IO85RSB1	54
19	V <sub>CCPLF</sub>	55
20	GFA1/IO84RSB1	56
21	GFA2/IO83RSB1	57
22	GFB2/IO82RSB1	58
23	GFC2/IO81RSB1	59
24	IO80RSB1	60
25	IO79RSB1	61
26	IO78RSB1	62
27	GND	63
28	V <sub>CCI</sub> B1	64
29	GEC1/IO77RSB1	65
30	GEC0/IO76RSB1	66
31	GEB1/IO75RSB1	67
32	GEB0/IO74RSB1	68
33	GEA1/IO73RSB1	69
34	GEA0/IO72RSB1	70
35	VMV1	71
36	GNDQ	72

	Pin TQFP*
Pin Number	A3P060 Function
37	NC
38	GEA2/IO71RSB1
39	GEB2/IO70RSB1
40	GEC2/IO69RSB1
41	IO68RSB1
42	IO67RSB1
43	IO66RSB1
44	IO65RSB1
45	V <sub>CC</sub>
46	GND
47	V <sub>CCI</sub> B1
48	NC
49	IO64RSB1
50	NC
51	IO63RSB1
52	NC
53	IO62RSB1
54	NC
55	IO61RSB1
56	NC
57	NC
58	IO60RSB1
59	IO59RSB1
60	IO58RSB1
61	GDC2/IO57RSB1
62	NC
63	GND
64	NC
65	GDB2/IO56RSB1
66	GDA2/IO55RSB1
67	IO54RSB1
68	GNDQ
69	ТСК
70	TDI
71	TMS
72	VMV1

144-1	Pin TQFP*
Pin Number	A3P060 Function
73	V <sub>PUMP</sub>
74	NC
75	TDO
76	TRST
77	V <sub>JTAG</sub>
78	GDA0/IO50RSB0
79	GDB0/IO48RSB0
80	GDB1/IO47RSB0
81	V <sub>CCI</sub> B0
82	GND
83	IO44RSB0
84	GCC2/IO43RSB0
85	GCB2/IO42RSB0
86	GCA2/IO41RSB0
87	GCA0/IO40RSB0
88	GCA1/IO39RSB0
89	GCB0/IO38RSB0
90	GCB1/IO37RSB0
91	GCC0/IO36RSB0
92	GCC1/IO35RSB0
93	IO34RSB0
94	IO33RSB0
95	NC
96	NC
97	NC
98	V <sub>CCI</sub> B0
99	GND
100	V <sub>CC</sub>
101	IO30RSB0
102	GBC2/IO29RSB0
103	IO28RSB0
104	GBB2/IO27RSB0
105	IO26RSB0
106	GBA2/IO25RSB0
107	VMV0
108	GNDQ

 36
 GNDQ
 72

 Note: \*Refer to the "User I/O Naming Convention" section on page 2-46.

144-1	Pin TQFP*
Pin Number	A3P060 Function
109	NC
110	NC
111	GBA1/IO24RSB0
112	GBA0/IO23RSB0
113	GBB1/IO22RSB0
114	GBB0/IO21RSB0
115	GBC1/IO20RSB0
116	GBC0/IO19RSB0
117	V <sub>CCI</sub> B0
118	GND
119	V <sub>CC</sub>
120	IO18RSB0
121	IO17RSB0
122	IO16RSB0
123	IO15RSB0
124	IO14RSB0
125	IO13RSB0
126	IO12RSB0
127	IO11RSB0
128	NC
129	IO10RSB0
130	IO09RSB0
131	IO08RSB0
132	GAC1/IO07RSB0
133	GAC0/IO06RSB0
134	NC
135	GND
136	NC
137	GAB1/IO05RSB0
138	GAB0/IO04RSB0
139	GAA1/IO03RSB0
140	GAA0/IO02RSB0
141	IO01RSB0
142	IOOORSBO
143	GNDQ
144	VMV0

ProASIC3 Flash Fa	amily FPGAs

144_	144_Pin TQFP*		
Pin Number	A3P125 Function	Pin Nu	
1	GAA2/IO67RSB1	37	
2	IO68RSB1	38	
3	GAB2/IO69RSB1	39	
4	IO132RSB1	40	
5	GAC2/IO131RSB1	41	
6	IO130RSB1	42	
7	IO129RSB1	43	
8	IO128RSB1	44	
9	V <sub>CC</sub>	45	
10	GND	46	
11	V <sub>CCI</sub> B1	47	
12	IO127RSB1	48	
13	GFC1/IO126RSB1	49	
14	GFC0/IO125RSB1	50	
15	GFB1/IO124RSB1	51	
16	GFB0/IO123RSB1	52	
17	V <sub>COMPLF</sub>	53	
18	GFA0/IO122RSB1	54	
19	V <sub>CCPLF</sub>	55	
20	GFA1/IO121RSB1	56	
21	GFA2/IO120RSB1	57	
22	GFB2/IO119RSB1	58	
23	GFC2/IO118RSB1	59	
24	IO117RSB1	60	
25	IO116RSB1	6	
26	IO115RSB1	62	
27	GND	63	
28	V <sub>CCI</sub> B1	64	
29	GEC1/IO112RSB1	65	
30	GEC0/IO111RSB1	66	
31	GEB1/IO110RSB1	67	
32	GEB0/IO109RSB1	68	
33	GEA1/IO108RSB1	69	
34	GEA0/IO107RSB1	70	
35	VMV1	71	
36	GNDQ	72	

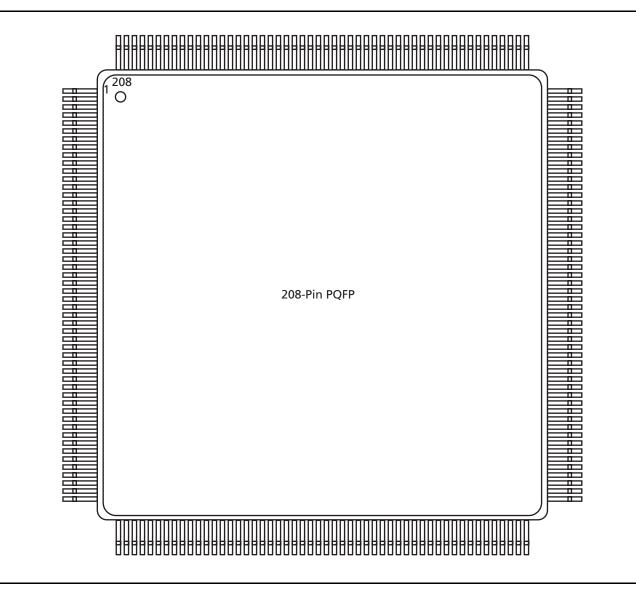
144_	144_Pin TQFP*	
Pin Number	A3P125 Function	
37	NC	
38	GEA2/IO106RSB1	
39	GEB2/IO105RSB1	
40	GEC2/IO104RSB1	
41	IO103RSB1	
42	IO102RSB1	
43	IO101RSB1	
44	IO100RSB1	
45	V <sub>CC</sub>	
46	GND	
47	V <sub>CCI</sub> B1	
48	IO99RSB1	
49	IO97RSB1	
50	IO95RSB1	
51	IO93RSB1	
52	IO92RSB1	
53	IO90RSB1	
54	IO88RSB1	
55	IO86RSB1	
56	IO84RSB1	
57	IO83RSB1	
58	IO82RSB1	
59	IO81RSB1	
60	IO80RSB1	
61	IO79RSB1	
62	V <sub>CC</sub>	
63	GND	
64	V <sub>CCI</sub> B1	
65	GDC2/IO72RSB1	
66	GDB2/IO71RSB1	
67	GDA2/IO70RSB1	
68	GNDQ	
69	TCK	
70	TDI	
71	TMS	
72	VMV1	

144_	Pin TQFP*
Pin Number	A3P125 Function
73	V <sub>PUMP</sub>
74	NC
75	TDO
76	TRST
77	V <sub>JTAG</sub>
78	GDA0/IO66RSB0
79	GDB0/IO64RSB0
80	GDB1/IO63RSB0
81	V <sub>CCI</sub> B0
82	GND
83	IO60RSB0
84	GCC2/IO59RSB0
85	GCB2/IO58RSB0
86	GCA2/IO57RSB0
87	GCA0/IO56RSB0
88	GCA1/IO55RSB0
89	GCB0/IO54RSB0
90	GCB1/IO53RSB0
91	GCC0/IO52RSB0
92	GCC1/IO51RSB0
93	IO50RSB0
94	IO49RSB0
95	NC
96	NC
97	NC
98	V <sub>CCI</sub> B0
99	GND
100	V <sub>CC</sub>
101	IO47RSB0
102	GBC2/IO45RSB0
103	IO44RSB0
104	GBB2/IO43RSB0
105	IO42RSB0
106	GBA2/IO41RSB0
107	VMV0
108	GNDQ

144_	144_Pin TQFP*	
Pin Number	A3P125 Function	
109	GBA1/IO40RSB0	
110	GBA0/IO39RSB0	
111	GBB1/IO38RSB0	
112	GBB0/IO37RSB0	
113	GBC1/IO36RSB0	
114	GBC0/IO35RSB0	
115	IO34RSB0	
116	IO33RSB0	
117	V <sub>CCI</sub> B0	
118	GND	
119	V <sub>CC</sub>	
120	IO29RSB0	
121	IO28RSB0	
122	IO27RSB0	
123	IO25RSB0	
124	IO23RSB0	
125	IO21RSB0	
126	IO19RSB0	
127	IO17RSB0	
128	IO16RSB0	
129	IO14RSB0	
130	IO12RSB0	
131	IO10RSB0	
132	IO08RSB0	
133	IO06RSB0	
134	V <sub>CCI</sub> B0	
135	GND	
136	V <sub>CC</sub>	
137	GAC1/IO05RSB0	
138	GAC0/IO04RSB0	
139	GAB1/IO03RSB0	
140	GAB0/IO02RSB0	
141	GAA1/IO01RSB0	
142	GAA0/IO00RSB0	
143	GNDQ	
144	VMV0	



# 208-Pin PQFP



## Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.actel.com/products/rescenter/package/index.html.

208-Pin PQFP*	
Pin Number	A3P125 Function
1	GND
2	GAA2/IO67RSB1
3	IO68RSB1
4	GAB2/IO69RSB1
5	IO132RSB1
6	GAC2/IO131RSB1
7	NC
8	NC
9	IO130RSB1
10	IO129RSB1
11	NC
12	IO128RSB1
13	NC
14	NC
15	NC
16	V <sub>CC</sub>
17	GND
18	V <sub>CCI</sub> B1
19	IO127RSB1
20	NC
21	GFC1/IO126RSB1
22	GFC0/IO125RSB1
23	GFB1/IO124RSB1
24	GFB0/IO123RSB1
25	V <sub>COMPLF</sub>
26	GFA0/IO122RSB1
27	V <sub>CCPLF</sub>
28	GFA1/IO121RSB1
29	GND
30	GFA2/IO120RSB1
31	NC
32	GFB2/IO119RSB1
33	NC
34	GFC2/IO118RSB1
35	IO117RSB1
36	NC
37	IO116RSB1
38	IO115RSB1

208-Pin PQFP*	
Pin Number	A3P125 Function
39	NC
40	V <sub>CCI</sub> B1
41	GND
42	IO114RSB1
43	IO113RSB1
44	GEC1/IO112RSB1
45	GEC0/IO111RSB1
46	GEB1/IO110RSB1
47	GEB0/IO109RSB1
48	GEA1/IO108RSB1
49	GEA0/IO107RSB1
50	VMV1
51	GNDQ
52	GND
53	NC
54	NC
55	GEA2/IO106RSB1
56	GEB2/IO105RSB1
57	GEC2/IO104RSB1
58	IO103RSB1
59	IO102RSB1
60	IO101RSB1
61	IO100RSB1
62	V <sub>CCI</sub> B1
63	IO99RSB1
64	IO98RSB1
65	GND
66	IO97RSB1
67	IO96RSB1
68	IO95RSB1
69	IO94RSB1
70	IO93RSB1
71	V <sub>CC</sub>
72	V <sub>CCI</sub> B1
73	IO92RSB1
74	IO91RSB1
75	IO90RSB1
76	IO89RSB1

208-Pin PQFP*	
Pin Number A3P125 Function	
77	IO88RSB1
78	IO87RSB1
79	IO86RSB1
80	IO85RSB1
81	GND
82	IO84RSB1
83	IO83RSB1
84	IO82RSB1
85	IO81RSB1
86	IO80RSB1
87	IO79RSB1
88	V <sub>CC</sub>
89	V <sub>CCI</sub> B1
90	IO78RSB1
91	IO77RSB1
92	IO76RSB1
93	IO75RSB1
94	IO74RSB1
95	IO73RSB1
96	GDC2/IO72RSB1
97	GND
98	GDB2/IO71RSB1
99	GDA2/IO70RSB1
100	GNDQ
101	ТСК
102	TDI
103	TMS
104	VMV1
105	GND
106	V <sub>PUMP</sub>
107	NC
108	TDO
109	TRST
110	V <sub>JTAG</sub>
111	GDA0/IO66RSB0
112	GDA1/IO65RSB0
113	GDB0/IO64RSB0
114	GDB1/IO63RSB0

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	rin PQFP*
Pin Number	A3P125 Function
115	GDC0/IO62RSB0
116	GDC1/IO61RSB0
117	NC
118	NC
119	NC
120	NC
121	NC
122	GND
123	V <sub>CCI</sub> B0
124	NC
125	NC
126	V <sub>CC</sub>
127	IO60RSB0
128	GCC2/IO59RSB0
129	GCB2/IO58RSB0
130	GND
131	GCA2/IO57RSB0
132	GCA0/IO56RSB0
133	GCA1/IO55RSB0
134	GCB0/IO54RSB0
135	GCB1/IO53RSB0
136	GCC0/IO52RSB0
137	GCC1/IO51RSB0
138	IO50RSB0
139	IO49RSB0
140	V <sub>CCI</sub> BO
141	GND
142	V <sub>CC</sub>
143	IO48RSB0
144	IO47RSB0
145	IO46RSB0
146	NC
147	NC
148	NC
149	GBC2/IO45RSB0
150	IO44RSB0
151	GBB2/IO43RSB0
152	IO42RSB0

208-Pin PQFP*	
Pin Number	A3P125 Function
153	GBA2/IO41RSB0
154	VMV0
155	GNDQ
156	GND
157	NC
158	GBA1/IO40RSB0
159	GBA0/IO39RSB0
160	GBB1/IO38RSB0
161	GBB0/IO37RSB0
162	GND
163	GBC1/IO36RSB0
164	GBC0/IO35RSB0
165	IO34RSB0
166	IO33RSB0
167	IO32RSB0
168	IO31RSB0
169	IO30RSB0
170	V <sub>CCI</sub> B0
171	V <sub>CC</sub>
172	IO29RSB0
173	IO28RSB0
174	IO27RSB0
175	IO26RSB0
176	IO25RSB0
177	IO24RSB0
178	GND
179	IO23RSB0
180	IO22RSB0
181	IO21RSB0
182	IO20RSB0
183	IO19RSB0
184	IO18RSB0
185	IO17RSB0
186	V <sub>CCI</sub> B0
187	V <sub>CC</sub>
188	IO16RSB0
189	IO15RSB0
190	IO14RSB0

208-Pin PQFP*		
Pin Number	A3P125 Function	
191	IO13RSB0	
192	IO12RSB0	
193	IO11RSB0	
194	IO10RSB0	
195	GND	
196	IO09RSB0	
197	IO08RSB0	
198	IO07RSB0	
199	IO06RSB0	
200	V <sub>CCI</sub> B0	
201	GAC1/IO05RSB0	
202	GAC0/IO04RSB0	
203	GAB1/IO03RSB0	
204	GAB0/IO02RSB0	
205	GAA1/IO01RSB0	
206	GAA0/IO00RSB0	
207	GNDQ	
208	VMV0	

208-Pin PQFP*		208
Pin Number	A3P250 Function	Pin Number
1	GND	37
2	GAA2/IO118UDB3	38
3	IO118VDB3	39
4	GAB2/IO117UDB3	40
5	IO117VDB3	41
6	GAC2/IO116UDB3	42
7	IO116VDB3	43
8	IO115UDB3	44
9	IO115VDB3	45
10	IO114UDB3	46
11	IO114VDB3	47
12	IO113PDB3	48
13	IO113NDB3	49
14	IO112PDB3	50
15	IO112NDB3	51
16	V <sub>CC</sub>	52
17	GND	53
18	V <sub>CCI</sub> B3	54
19	IO111PDB3	55
20	IO111NDB3	56
21	GFC1/IO110PDB3	57
22	GFC0/IO110NDB3	58
23	GFB1/IO109PDB3	59
24	GFB0/IO109NDB3	60
25	V <sub>COMPLF</sub>	61
26	GFA0/IO108NPB3	62
27	V <sub>CCPLF</sub>	63
28	GFA1/IO108PPB3	64
29	GND	65
30	GFA2/IO107PDB3	66
31	IO107NDB3	67
32	GFB2/IO106PDB3	68
33	IO106NDB3	69
34	GFC2/IO105PDB3	70
35	IO105NDB3	71
36	NC	72

208	-Pin PQFP*
Pin Number	A3P250 Function
37	IO104PDB3
38	IO104NDB3
39	IO103PSB3
40	V <sub>CCI</sub> B3
41	GND
42	IO101PDB3
43	IO101NDB3
44	GEC1/IO100PDB3
45	GEC0/IO100NDB3
46	GEB1/IO99PDB3
47	GEB0/IO99NDB3
48	GEA1/IO98PDB3
49	GEA0/IO98NDB3
50	VMV3
51	GNDQ
52	GND
53	NC
54	NC
55	GEA2/IO97RSB2
56	GEB2/IO96RSB2
57	GEC2/IO95RSB2
58	IO94RSB2
59	IO93RSB2
60	IO92RSB2
61	IO91RSB2
62	V <sub>CCI</sub> B2
63	IO90RSB2
64	IO89RSB2
65	GND
66	IO88RSB2
67	IO87RSB2
68	IO86RSB2
69	IO85RSB2
70	IO84RSB2
71	V <sub>CC</sub>
	V <sub>CCI</sub> B2

208-Pin PQFP*		
Pin Number A3P250 Function		
73	IO83RSB2	
74	IO82RSB2	
75	IO81RSB2	
76	IO80RSB2	
77	IO79RSB2	
78	IO78RSB2	
79	IO77RSB2	
80	IO76RSB2	
81	GND	
82	IO75RSB2	
83	IO74RSB2	
84	IO73RSB2	
85	IO72RSB2	
86	IO71RSB2	
87	IO70RSB2	
88	V <sub>CC</sub>	
89	V <sub>CCI</sub> B2	
90	IO69RSB2	
91	IO68RSB2	
92	IO67RSB2	
93	IO66RSB2	
94	IO65RSB2	
95	IO64RSB2	
96	GDC2/IO63RSB2	
97	GND	
98	GDB2/IO62RSB2	
99	GDA2/IO61RSB2	
100	GNDQ	
101	ТСК	
102	TDI	
103	TMS	
104	VMV2	
105	GND	
106	V <sub>PUMP</sub>	
107	NC	
108	TDO	

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208-Pin PQFP*		
Pin Number	A3P250 Function	Pin Nu
109	TRST	14
110	V <sub>JTAG</sub>	14
111	GDA0/IO60VDB1	14
112	GDA1/IO60UDB1	14
113	GDB0/IO59VDB1	14
114	GDB1/IO59UDB1	15
115	GDC0/IO58VDB1	15
116	GDC1/IO58UDB1	15
117	IO57VDB1	15
118	IO57UDB1	15
119	IO56NDB1	15
120	IO56PDB1	15
121	IO55RSB1	15
122	GND	15
123	V <sub>CCI</sub> B1	15
124	NC	16
125	NC	16
126	V <sub>CC</sub>	16
127	IO53NDB1	16
128	GCC2/IO53PDB1	16
129	GCB2/IO52PSB1	16
130	GND	16
131	GCA2/IO51PSB1	16
132	GCA1/IO50PDB1	16
133	GCA0/IO50NDB1	16
134	GCB0/IO49NDB1	17
135	GCB1/IO49PDB1	17
136	GCC0/IO48NDB1	17.
137	GCC1/IO48PDB1	17
138	IO47NDB1	17-
139	IO47PDB1	17
140	V <sub>CCI</sub> B1	17
141	GND	17
142	V <sub>CC</sub>	17
143	IO46RSB1	17
144	IO45NDB1	18

208-Pin PQFP*	
Pin Number A3P250 Function	
145	IO45PDB1
146	IO44NDB1
147	IO44PDB1
148	IO43NDB1
149	GBC2/IO43PDB1
150	IO42NDB1
151	GBB2/IO42PDB1
152	IO41NDB1
153	GBA2/IO41PDB1
154	VMV1
155	GNDQ
156	GND
157	NC
158	GBA1/IO40RSB0
159	GBA0/IO39RSB0
160	GBB1/IO38RSB0
161	GBB0/IO37RSB0
162	GND
163	GBC1/IO36RSB0
164	GBC0/IO35RSB0
165	IO34RSB0
166	IO33RSB0
167	IO32RSB0
168	IO31RSB0
169	IO30RSB0
170	V <sub>CCI</sub> B0
171	V <sub>CC</sub>
172	IO29RSB0
173	IO28RSB0
174	IO27RSB0
175	IO26RSB0
176	IO25RSB0
177	IO24RSB0
178	GND
179	IO23RSB0
180	IO22RSB0

208-Pin PQFP*	
Pin Number	A3P250 Function
181	IO21RSB0
182	IO20RSB0
183	IO19RSB0
184	IO18RSB0
185	IO17RSB0
186	V <sub>CCI</sub> B0
187	V <sub>CC</sub>
188	IO16RSB0
189	IO15RSB0
190	IO14RSB0
191	IO13RSB0
192	IO12RSB0
193	IO11RSB0
194	IO10RSB0
195	GND
196	IO09RSB0
197	IO08RSB0
198	IO07RSB0
199	IO06RSB0
200	V <sub>CCI</sub> B0
201	GAC1/IO05RSB0
202	GAC0/IO04RSB0
203	GAB1/IO03RSB0
204	GAB0/IO02RSB0
205	GAA1/IO01RSB0
206	GAA0/IO00RSB0
207	GNDQ
208	VMV0

208-Pin PQFP*	
Pin Number A3P400 Function	
1	GND
2	GAA2/IO155PDB3
3	IO155NDB3
4	GAB2/IO154PDB3
5	IO154NDB3
6	GAC2/IO153PDB3
7	IO153NDB3
8	IO152PDB3
9	IO152NDB3
10	IO151PDB3
11	IO151NDB3
12	IO150PDB3
13	IO150NDB3
14	IO149PDB3
15	IO149NDB3
16	V <sub>CC</sub>
17	GND
18	V <sub>CCI</sub> B3
19	IO148PDB3
20	IO148NDB3
21	GFC1/IO147PDB3
22	GFC0/IO147NDB3
23	GFB1/IO146PDB3
24	GFB0/IO146NDB3
25	V <sub>COMPLF</sub>
26	GFA0/IO145NPB3
27	V <sub>CCPLF</sub>
28	GFA1/IO145PPB3
29	GND
30	GFA2/IO144PDB3
31	IO144NDB3
32	GFB2/IO143PDB3
33	IO143NDB3
34	GFC2/IO142PDB3
35	IO142NDB3
36	NC
37	IO141PDB3
38	IO141NDB3

208-Pin PQFP*	
Pin Number	A3P400 Function
39	IO140PSB3
40	V <sub>CCI</sub> B3
41	GND
42	IO138PDB3
43	IO138NDB3
44	GEC1/IO137PDB3
45	GEC0/IO137NDB3
46	GEB1/IO136PDB3
47	GEB0/IO136NDB3
48	GEA1/IO135PDB3
49	GEA0/IO135NDB3
50	VMV3
51	GNDQ
52	GND
53	NC
54	NC
55	GEA2/IO134RSB2
56	GEB2/IO133RSB2
57	GEC2/IO132RSB2
58	IO131RSB2
59	IO130RSB2
60	IO129RSB2
61	IO128RSB2
62	V <sub>CCI</sub> B2
63	IO126RSB2
64	IO124RSB2
65	GND
66	IO122RSB2
67	IO120RSB2
68	IO118RSB2
69	IO116RSB2
70	IO114RSB2
71	V <sub>CC</sub>
72	V <sub>CCI</sub> B2
73	IO112RSB2
74	IO111RSB2
75	IO110RSB2
76	IO109RSB2

208-Pin PQFP*	
Pin Number	A3P400 Function
77	IO108RSB2
78	IO107RSB2
79	IO106RSB2
80	IO103RSB2
81	GND
82	IO102RSB2
83	IO101RSB2
84	IO100RSB2
85	IO99RSB2
86	IO98RSB2
87	IO97RSB2
88	V <sub>CC</sub>
89	V <sub>CCI</sub> B2
90	IO94RSB2
91	IO92RSB2
92	IO90RSB2
93	IO88RSB2
94	IO86RSB2
95	IO84RSB2
96	GDC2/IO82RSB2
97	GND
98	GDB2/IO81RSB2
99	GDA2/IO80RSB2
100	GNDQ
101	TCK
102	TDI
103	TMS
104	VMV2
105	GND
106	V <sub>PUMP</sub>
107	NC
108	TDO
109	TRST
110	V <sub>JTAG</sub>
111	GDA0/IO79NDB1
112	GDA1/IO79PDB1
113	GDB0/IO78NDB1
114	GDB1/IO78PDB1

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208-Pin PQFP*	
Pin Number	A3P400 Function
115	GDC0/IO77NDB1
116	GDC1/IO77PDB1
117	IO76NDB1
118	IO76PDB1
119	IO75NDB1
120	IO75PDB1
121	IO74RSB1
122	GND
123	V <sub>CCI</sub> B1
124	NC
125	NC
126	V <sub>CC</sub>
127	IO73PSB1
128	GCC2/IO72PSB1
129	GCB2/IO71PSB1
130	GND
131	GCA2/IO70PSB1
132	GCA1/IO69PDB1
133	GCA0/IO69NDB1
134	GCB0/IO68NDB1
135	GCB1/IO68PDB1
136	GCC0/IO67NDB1
137	GCC1/IO67PDB1
138	IO66NDB1
139	IO66PDB1
140	V <sub>CCI</sub> B1
141	GND
142	V <sub>CC</sub>
143	IO65RSB1
144	IO64NDB1
145	IO64PDB1
146	IO63NDB1
147	IO63PDB1
148	IO62NDB1
149	GBC2/IO62PDB1
150	IO61NDB1
151	GBB2/IO61PDB1
152	IO60NDB1

208-Pin PQFP*	
Pin Number	A3P400 Function
153	GBA2/IO60PDB1
154	VMV1
155	GNDQ
156	GND
157	NC
158	GBA1/IO59RSB0
159	GBA0/IO58RSB0
160	GBB1/IO57RSB0
161	GBB0/IO56RSB0
162	GND
163	GBC1/IO55RSB0
164	GBC0/IO54RSB0
165	IO52RSB0
166	IO50RSB0
167	IO48RSB0
168	IO46RSB0
169	IO44RSB0
170	V <sub>CCI</sub> B0
171	V <sub>CC</sub>
172	IO37RSB0
173	IO36RSB0
174	IO35RSB0
175	IO34RSB0
176	IO33RSB0
177	IO32RSB0
178	GND
179	IO31RSB0
180	IO30RSB0
181	IO29RSB0
182	IO28RSB0
183	IO27RSB0
184	IO25RSB0
185	IO23RSB0
186	V <sub>CCI</sub> B0
187	V <sub>CC</sub>
188	IO19RSB0
189	IO17RSB0
190	IO15RSB0

208-Pin PQFP*	
Pin Number	A3P400 Function
191	IO13RSB0
192	IO12RSB0
193	IO11RSB0
194	IO10RSB0
195	GND
196	IO09RSB0
197	IO08RSB0
198	IO07RSB0
199	IO06RSB0
200	V <sub>CCI</sub> B0
201	GAC1/IO05RSB0
202	GAC0/IO04RSB0
203	GAB1/IO03RSB0
204	GAB0/IO02RSB0
205	GAA1/IO01RSB0
206	GAA0/IO00RSB0
207	GNDQ
208	VMV0

208-Pin PQFP*	
Pin Number A3P600 Function	
1	GND
2	GAA2/IO170PDB3
3	IO170NDB3
4	GAB2/IO169PDB3
5	IO169NDB3
6	GAC2/IO168PDB3
7	IO168NDB3
8	IO167PDB3
9	IO167NDB3
10	IO166PDB3
11	IO166NDB3
12	IO165PDB3
13	IO165NDB3
14	IO164PDB3
15	IO164NDB3
16	V <sub>CC</sub>
17	GND
18	V <sub>CCI</sub> B3
19	IO163PDB3
20	IO163NDB3
21	GFC1/IO161PDB3
22	GFC0/IO161NDB3
23	GFB1/IO160PDB3
24	GFB0/IO160NDB3
25	V <sub>COMPLF</sub>
26	GFA0/IO159NPB3
27	V <sub>CCPLF</sub>
28	GFA1/IO159PPB3
29	GND
30	GFA2/IO158PDB3
31	IO158NDB3
32	GFB2/IO157PDB3
33	IO157NDB3
34	GFC2/IO156PDB3
35	IO156NDB3
36	V <sub>CC</sub>
37	IO147PDB3
38	IO147NDB3

208-Pin PQFP*	
Pin Number	A3P600 Function
39	IO146PSB3
40	V <sub>CCI</sub> B3
41	GND
42	IO145PDB3
43	IO145NDB3
44	GEC1/IO144PDB3
45	GEC0/IO144NDB3
46	GEB1/IO143PDB3
47	GEB0/IO143NDB3
48	GEA1/IO142PDB3
49	GEA0/IO142NDB3
50	VMV3
51	GNDQ
52	GND
53	NC
54	GEA2/IO141RSB2
55	GEB2/IO140RSB2
56	GEC2/IO139RSB2
57	IO138RSB2
58	IO137RSB2
59	IO136RSB2
60	IO135RSB2
61	IO134RSB2
62	V <sub>CCI</sub> B2
63	IO133RSB2
64	IO131RSB2
65	GND
66	IO129RSB2
67	IO127RSB2
68	IO125RSB2
69	IO123RSB2
70	IO121RSB2
71	V <sub>CC</sub>
72	V <sub>CCI</sub> B2
73	IO118RSB2
74	IO117RSB2
75	IO116RSB2
76	IO115RSB2

208-Pin PQFP*	
Pin Number	A3P600 Function
77	IO114RSB2
78	IO113RSB2
79	IO112RSB2
80	IO110RSB2
81	GND
82	IO109RSB2
83	IO108RSB2
84	IO107RSB2
85	IO106RSB2
86	IO105RSB2
87	IO104RSB2
88	V <sub>CC</sub>
89	V <sub>CCI</sub> B2
90	IO102RSB2
91	IO100RSB2
92	IO98RSB2
93	IO96RSB2
94	IO94RSB2
95	IO90RSB2
96	GDC2/IO89RSB2
97	GND
98	GDB2/IO88RSB2
99	GDA2/IO87RSB2
100	GNDQ
101	ТСК
102	TDI
103	TMS
104	VMV2
105	GND
106	V <sub>PUMP</sub>
107	GNDQ
108	TDO
109	TRST
110	V <sub>JTAG</sub>
111	GDA0/IO86NDB1
112	GDA1/IO86PDB1
113	GDB0/IO85NDB1
114	GDB1/IO85PDB1

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208-Pin PQFP*		
Pin Number	A3P600 Function	
115	GDC0/IO84NDB1	
116	GDC1/IO84PDB1	
117	IO82NDB1	
118	IO82PDB1	
119	IO80NDB1	
120	IO80PDB1	
121	IO79PSB1	
122	GND	
123	V <sub>CCI</sub> B1	
124	IO75NDB1	
125	IO75PDB1	
126	NC	
127	IO73NDB1	
128	GCC2/IO73PDB1	
129	GCB2/IO72PSB1	
130	GND	
131	GCA2/IO71PSB1	
132	GCA1/IO70PDB1	
133	GCA0/IO70NDB1	
134	GCB0/IO69NDB1	
135	GCB1/IO69PDB1	
136	GCC0/IO68NDB1	
137	GCC1/IO68PDB1	
138	IO66NDB1	
139	IO66PDB1	
140	V <sub>CCI</sub> B1	
141	GND	
142	V <sub>CC</sub>	
143	IO65PSB1	
144	IO64NDB1	
145	IO64PDB1	
146	IO63NDB1	
147	IO63PDB1	
148	IO62NDB1	
149	GBC2/IO62PDB1	
150	IO61NDB1	
151	GBB2/IO61PDB1	
152	IO60NDB1	

208	-Pin PQFP*
Pin Number	A3P600 Function
153	GBA2/IO60PDB1
154	VMV1
155	GNDQ
156	GND
157	NC
158	GBA1/IO59RSB0
159	GBA0/IO58RSB0
160	GBB1/IO57RSB0
161	GBB0/IO56RSB0
162	GND
163	GBC1/IO55RSB0
164	GBC0/IO54RSB0
165	IO52RSB0
166	IO50RSB0
167	IO48RSB0
168	IO46RSB0
169	IO44RSB0
170	V <sub>CCI</sub> B0
171	V <sub>CC</sub>
172	IO36RSB0
173	IO35RSB0
174	IO34RSB0
175	IO33RSB0
176	IO32RSB0
177	IO31RSB0
178	GND
179	IO29RSB0
180	IO28RSB0
181	IO27RSB0
182	IO26RSB0
183	IO25RSB0
184	IO24RSB0
185	IO23RSB0
186	V <sub>CCI</sub> B0
187	V <sub>CC</sub>
188	IO20RSB0
189	IO19RSB0
190	IO18RSB0

208-Pin PQFP*		
Pin Number	A3P600 Function	
191	IO17RSB0	
192	IO16RSB0	
193	IO14RSB0	
194	IO12RSB0	
195	GND	
196	IO10RSB0	
197	IO09RSB0	
198	IO08RSB0	
199	IO07RSB0	
200	V <sub>CCI</sub> B0	
201	GAC1/IO05RSB0	
202	GAC0/IO04RSB0	
203	GAB1/IO03RSB0	
204	GAB0/IO02RSB0	
205	GAA1/IO01RSB0	
206	GAA0/IO00RSB0	
207	GNDQ	
208	VMV0	

208-Pin PQFP*		
Pin		
Number	A3P1000 Function	
1	GND	
2	GAA2/IO225PDB3	
3	IO225NDB3	
4	GAB2/IO224PDB3	
5	IO224NDB3	
6	GAC2/IO223PDB3	
7	IO223NDB3	
8	IO222PDB3	
9	IO222NDB3	
10	IO220PDB3	
11	IO220NDB3	
12	IO218PDB3	
13	IO218NDB3	
14	IO216PDB3	
15	IO216NDB3	
16	V <sub>CC</sub>	
17	GND	
18	V <sub>CCI</sub> B3	
19	IO212PDB3	
20	IO212NDB3	
21	GFC1/IO209PDB3	
22	GFC0/IO209NDB3	
23	GFB1/IO208PDB3	
24	GFB0/IO208NDB3	
25	V <sub>COMPLF</sub>	
26	GFA0/IO207NPB3	
27	V <sub>CCPLF</sub>	
28	GFA1/IO207PPB3	
29	GND	
30	GFA2/IO206PDB3	
31	IO206NDB3	
32	GFB2/IO205PDB3	
33	IO205NDB3	
34	GFC2/IO204PDB3	
35	IO204NDB3	

208-Pin PQFP*		
Pin		
Number	A3P1000 Function	
36	V <sub>CC</sub>	
37	IO199PDB3	
38	IO199NDB3	
39	IO197PSB3	
40	V <sub>CCI</sub> B3	
41	GND	
42	IO191PDB3	
43	IO191NDB3	
44	GEC1/IO190PDB3	
45	GEC0/IO190NDB3	
46	GEB1/IO189PDB3	
47	GEB0/IO189NDB3	
48	GEA1/IO188PDB3	
49	GEA0/IO188NDB3	
50	VMV3	
51	GNDQ	
52	GND	
53	VMV2	
54	GEA2/IO187RSB2	
55	GEB2/IO186RSB2	
56	GEC2/IO185RSB2	
57	IO184RSB2	
58	IO183RSB2	
59	IO182RSB2	
60	IO181RSB2	
61	IO180RSB2	
62	V <sub>CCI</sub> B2	
63	IO178RSB2	
64	IO176RSB2	
65	GND	
66	IO174RSB2	
67	IO172RSB2	
68	IO170RSB2	
69	IO168RSB2	
70	IO166RSB2	

208-Pin PQFP*		
Pin Number	A3P1000 Function	
71	V <sub>CC</sub>	
72	V <sub>CCI</sub> B2	
73	IO162RSB2	
74	IO160RSB2	
75	IO158RSB2	
76	IO156RSB2	
77	IO154RSB2	
78	IO152RSB2	
79	IO150RSB2	
80	IO148RSB2	
81	GND	
82	IO143RSB2	
83	IO141RSB2	
84	IO139RSB2	
85	IO137RSB2	
86	IO135RSB2	
87	IO133RSB2	
88	V <sub>CC</sub>	
89	V <sub>CCI</sub> B2	
90	IO128RSB2	
91	IO126RSB2	
92	IO124RSB2	
93	IO122RSB2	
94	IO120RSB2	
95	IO118RSB2	
96	GDC2/IO116RSB2	
97	GND	
98	GDB2/IO115RSB2	
99	GDA2/IO114RSB2	
100	GNDQ	
101	ТСК	
102	TDI	
103	TMS	
104	VMV2	
105	GND	

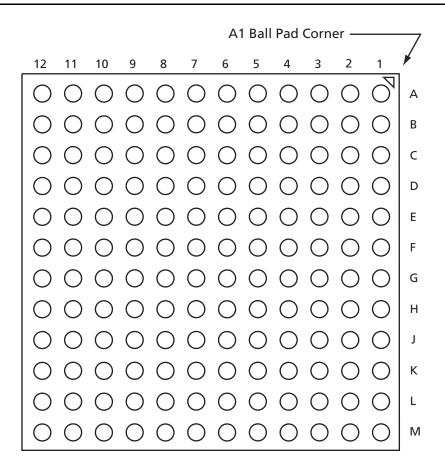
ProASIC3 Flash Family FPGAs

208-Pin PQFP*	
Pin Number	A3P1000 Function
106	V <sub>PUMP</sub>
107	GNDQ
108	TDO
109	TRST
110	V <sub>JTAG</sub>
111	GDA0/IO113NDB1
112	GDA1/IO113PDB1
113	GDB0/IO112NDB1
114	GDB1/IO112PDB1
115	GDC0/IO111NDB1
116	GDC1/IO111PDB1
117	IO109NDB1
118	IO109PDB1
119	IO106NDB1
120	IO106PDB1
121	IO104PSB1
122	GND
123	V <sub>CCI</sub> B1
124	IO99NDB1
125	IO99PDB1
126	NC
127	IO96NDB1
128	GCC2/IO96PDB1
129	GCB2/IO95PSB1
130	GND
131	GCA2/IO94PSB1
132	GCA1/IO93PDB1
133	GCA0/IO93NDB1
134	GCB0/IO92NDB1
135	GCB1/IO92PDB1
136	GCC0/IO91NDB1
137	GCC1/IO91PDB1
138	IO88NDB1
139	IO88PDB1
140	V <sub>CCI</sub> B1

208-Pin PQFP*		
Pin Number A3P1000 Function		
141	GND	
142	V <sub>CC</sub>	
143	IO86PSB1	
144	IO84NDB1	
145	IO84PDB1	
146	IO82NDB1	
147	IO82PDB1	
148	IO80NDB1	
149	GBC2/IO80PDB1	
150	IO79NDB1	
151	GBB2/IO79PDB1	
152	IO78NDB1	
153	GBA2/IO78PDB1	
154	VMV1	
155	GNDQ	
156	GND	
157	VMV0	
158	GBA1/IO77RSB0	
159	GBA0/IO76RSB0	
160	GBB1/IO75RSB0	
161	GBB0/IO74RSB0	
162	GND	
163	GBC1/IO73RSB0	
164	GBC0/IO72RSB0	
165	IO70RSB0	
166	IO67RSB0	
167	IO63RSB0	
168	IO60RSB0	
169	IO57RSB0	
170	V <sub>CCI</sub> B0	
171	V <sub>CC</sub>	
172	IO54RSB0	
173	IO51RSB0	
174	IO48RSB0	
175	IO45RSB0	

208-Pin PQFP*		
Pin Number A3P1000 Function		
176	IO42RSB0	
177	IO40RSB0	
178	GND	
179	IO38RSB0	
180	IO35RSB0	
181	IO33RSB0	
182	IO31RSB0	
183	IO29RSB0	
184	IO27RSB0	
185	IO25RSB0	
186	V <sub>CCI</sub> B0	
187	V <sub>CC</sub>	
188	IO22RSB0	
189	IO20RSB0	
190	IO18RSB0	
191	IO16RSB0	
192	IO15RSB0	
193	IO14RSB0	
194	IO13RSB0	
195	GND	
196	IO12RSB0	
197	IO11RSB0	
198	IO10RSB0	
199	IO09RSB0	
200	V <sub>CCI</sub> B0	
201	GAC1/IO05RSB0	
202	GAC0/IO04RSB0	
203	GAB1/IO03RSB0	
204	GAB0/IO02RSB0	
205	GAA1/IO01RSB0	
206	GAA0/IO00RSB0	
207	GNDQ	
208	VMV0	

# 144-Pin FBGA



# Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.actel.com/products/rescenter/package/index.html.

ProASIC3 Flash Family FPGAs

144-F	Pin FBGA*
Pin Number	A3P060 Function
A1	GNDQ
A2	VMV0
A3	GAB0/IO04RSB0
A4	GAB1/IO05RSB0
A5	IO08RSB0
A6	GND
A7	IO11RSB0
A8	V <sub>CC</sub>
A9	IO16RSB0
A10	GBA0/IO23RSB0
A11	GBA1/IO24RSB0
A12	GNDQ
B1	GAB2/IO53RSB1
B2	GND
B3	GAA0/IO02RSB0
B4	GAA1/IO03RSB0
B5	IOOORSBO
B6	IO10RSB0
B7	IO12RSB0
B8	IO14RSB0
B9	GBB0/IO21RSB0
B10	GBB1/IO22RSB0
B11	GND
B12	VMV0
C1	IO95RSB1
C2	GFA2/IO83RSB1
C3	GAC2/IO94RSB1
C4	V <sub>CC</sub>
C5	IO01RSB0
C6	IO09RSB0
С7	IO13RSB0
C8	IO15RSB0
С9	IO17RSB0
C10	GBA2/IO25RSB0
C11	IO26RSB0
C12	GBC2/IO29RSB0
	1

144-Pin FBGA*		
Pin Number A3P060 Funct		
D1	IO91RSB1	
D2	IO92RSB1	
D3	IO93RSB1	
D4	GAA2/IO51RSB1	
D5	GAC0/IO06RSB0	
D6	GAC1/IO07RSB0	
D7	GBC0/IO19RSB0	
D8	GBC1/IO20RSB0	
D9	GBB2/IO27RSB0	
D10	IO18RSB0	
D11	IO28RSB0	
D12	GCB1/IO37RSB0	
E1	V <sub>CC</sub>	
E2	GFC0/IO88RSB1	
E3	GFC1/IO89RSB1	
E4 V <sub>CCI</sub> B1		
E5	IO52RSB1	
E6	V <sub>CCI</sub> B0	
E7	V <sub>CCI</sub> B0	
E8	GCC1/IO35RSB0	
E9	V <sub>CCI</sub> B0	
E10	V <sub>CC</sub>	
E11	GCA0/IO40RSB0	
E12	IO30RSB0	
F1	GFB0/IO86RSB1	
F2	V <sub>COMPLF</sub>	
F3	GFB1/IO87RSB1	
F4	IO90RSB1	
F5	GND	
F6	GND	
F7	GND	
F8	GCC0/IO36RSB0	
F9	GCB0/IO38RSB0	
F10	GND	
F11	GCA1/IO39RSB0	
F12	GCA2/IO41RSB0	
on" section on page	2.46	

144-Pin FBGA*		
Pin Number A3P060 Functi		
G1	GFA1/IO84RSB1	
G2	GND	
G3	V <sub>CCPLF</sub>	
G4	GFA0/IO85RSB1	
G5	GND	
G6	GND	
G7	GND	
G8	GDC1/IO45RSB0	
G9	IO32RSB0	
G10	GCC2/IO43RSB0	
G11	IO31RSB0	
G12	GCB2/IO42RSB0	
H1	V <sub>CC</sub>	
H2	GFB2/IO82RSB1	
H3 GFC2/IO81RSB1		
H4	GEC1/IO77RSB1	
H5	V <sub>CC</sub>	
H6	IO34RSB0	
H7	IO44RSB0	
H8	GDB2/IO56RSB1	
H9	GDC0/IO46RSB0	
H10	V <sub>CCI</sub> B0	
H11	IO33RSB0	
H12	V <sub>CC</sub>	
J1	GEB1/IO75RSB1	
J2	IO78RSB1	
J3	V <sub>CCI</sub> B1	
J4	GEC0/IO76RSB1	
J5	IO79RSB1	
J6	IO80RSB1	
J7	V <sub>CC</sub>	
J8	ТСК	
J9	GDA2/IO55RSB1	
J10	TDO	
J11	GDA1/IO49RSB0	
J12	GDB1/IO47RSB0	

144-Pin FBGA*		
Pin Number A3P060 Functio		
K1	GEB0/IO74RSB1	
K2	GEA1/IO73RSB1	
К3	GEA0/IO72RSB1	
K4	GEA2/IO71RSB1	
K5	IO65RSB1	
K6	IO64RSB1	
K7	GND	
K8	IO54RSB1	
К9	GDC2/IO57RSB1	
K10	GND	
K11	GDA0/IO50RSB0	
K12	GDB0/IO48RSB0	
L1	GND	
L2	VMV1	
L3	GEB2/IO70RSB1	
L4	IO67RSB1	
L5	V <sub>CCI</sub> B1	
L6	IO62RSB1	
L7	IO59RSB1	
L8	IO58RSB1	
L9	TMS	
L10	V <sub>JTAG</sub>	
L11	VMV1	
L12	TRST	
M1	GNDQ	
M2	GEC2/IO69RSB1	
M3	IO68RSB1	
M4	IO66RSB1	
M5	IO63RSB1	
M6	IO61RSB1	
M7	IO60RSB1	
M8 NC		
M9	TDI	
M10	V <sub>CCI</sub> B1	
M11	V <sub>PUMP</sub>	
M12	GNDQ	

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ProASIC3 Flash Family FPGAs	

144-	Pin FBGA	
Pin Number	A3P250 Function	Pin Num
A1	GNDQ	D1
A2	VMV0	D2
A3	GAB0/IO02RSB0	D3
A4	GAB1/IO03RSB0	D4
A5	IO16RSB0	D5
A6	GND	D6
A7	IO29RSB0	D7
A8	V <sub>CC</sub>	D8
A9	IO33RSB0	D9
A10	GBA0/IO39RSB0	D10
A11	GBA1/IO40RSB0	D11
A12	GNDQ	D12
B1	GAB2/IO117UDB3	E1
B2	GND	E2
B3	GAA0/IO00RSB0	E3
B4	GAA1/IO01RSB0	E4
B5	IO14RSB0	E5
B6	IO19RSB0	E6
B7	IO22RSB0	E7
B8	IO30RSB0	E8
B9	GBB0/IO37RSB0	E9
B10	GBB1/IO38RSB0	E10
B11	GND	E11
B12	VMV1	E12
C1	IO117VDB3	F1
C2	GFA2/IO107PPB3	F2
C3	GAC2/IO116UDB3	F3
C4	V <sub>CC</sub>	F4
C5	IO12RSB0	F5
C6	IO17RSB0	F6
C7	IO24RSB0	F7
C8	IO31RSB0	F8
С9	IO34RSB0	F9
C10	GBA2/IO41PDB1	F10
C11	IO41NDB1	F11
C12	GBC2/IO43PPB1	F12
		112

144-Pin FBGA		
Pin Number	A3P250 Function	
D1	IO112NDB3	
D2	IO112PDB3	
D3	IO116VDB3	
D4	GAA2/IO118UPB3	
D5	GAC0/IO04RSB0	
D6	GAC1/IO05RSB0	
D7	GBC0/IO35RSB0	
D8	GBC1/IO36RSB0	
D9	GBB2/IO42PDB1	
D10	IO42NDB1	
D11	IO43NPB1	
D12	GCB1/IO49PPB1	
E1	V <sub>CC</sub>	
E2	GFC0/IO110NDB3	
E3	GFC1/IO110PDB3	
E4	V <sub>CCI</sub> B3	
E5	IO118VPB3	
E6	V <sub>CCI</sub> B0	
E7	V <sub>CCI</sub> B0	
E8	GCC1/IO48PDB1	
E9	V <sub>CCI</sub> B1	
E10	V <sub>CC</sub>	
E11	GCA0/IO50NDB1	
E12	IO51NDB1	
F1	GFB0/IO109NPB3	
F2	V <sub>COMPLF</sub>	
F3	GFB1/IO109PPB3	
F4	IO107NPB3	
F5	GND	
F6	GND	
F7	GND	
F8	GCC0/IO48NDB1	
F9	GCB0/IO49NPB1	
F10	GND	
F11	GCA1/IO50PDB1	
F12	GCA2/IO51PDB1	

144-	144-Pin FBGA	
Pin Number	A3P250 Function	
G1	GFA1/IO108PPB3	
G2	GND	
G3	V <sub>CCPLF</sub>	
G4	GFA0/IO108NPB3	
G5	GND	
G6	GND	
G7	GND	
G8	GDC1/IO58UPB1	
G9	IO53NDB1	
G10	GCC2/IO53PDB1	
G11	IO52NDB1	
G12	GCB2/IO52PDB1	
H1	V <sub>CC</sub>	
H2	GFB2/IO106PDB3	
H3	GFC2/IO105PSB3	
H4	GEC1/IO100PDB3	
H5	V <sub>CC</sub>	
H6	IO79RSB2	
H7	IO65RSB2	
H8	GDB2/IO62RSB2	
H9	GDC0/IO58VPB1	
H10	V <sub>CCI</sub> B1	
H11	IO54PSB1	
H12	V <sub>CC</sub>	
J1	GEB1/IO99PDB3	
J2	IO106NDB3	
J3	V <sub>CCI</sub> B3	
J4	GEC0/IO100NDB3	
J5	IO88RSB2	
JG	IO81RSB2	
J7	V <sub>CC</sub>	
J8	тск	
J9	GDA2/IO61RSB2	
J10	TDO	
J11	GDA1/IO60UDB1	
J12	GDB1/IO59UDB1	

144-	Pin FBGA
Pin Number	A3P250 Function
K1	GEB0/IO99NDB3
К2	GEA1/IO98PDB3
К3	GEA0/IO98NDB3
К4	GEA2/IO97RSB2
K5	IO90RSB2
K6	IO84RSB2
K7	GND
K8	IO66RSB2
К9	GDC2/IO63RSB2
K10	GND
K11	GDA0/IO60VDB1
K12	GDB0/IO59VDB1
L1	GND
L2	VMV3
L3	GEB2/IO96RSB2
L4	IO91RSB2
L5	V <sub>CCI</sub> B2
L6	IO82RSB2
L7	IO80RSB2
L8	IO72RSB2
L9	TMS
L10	V <sub>JTAG</sub>
L11	VMV2
L12	TRST
M1	GNDQ
M2	GEC2/IO95RSB2
M3	IO92RSB2
M4	IO89RSB2
M5	IO87RSB2
M6	IO85RSB2
M7	IO78RSB2
M8	IO76RSB2
M9	TDI
M10	V <sub>CCI</sub> B2
M11	V <sub>PUMP</sub>
M12	GNDQ

ProASIC3 Flash Family FPGAs

144-P	144-Pin FBGA*	
Pin Number	A3P1000 Function	
A1	GNDQ	
A2	VMV0	
A3	GAB0/IO02RSB0	
A4	GAB1/IO03RSB0	
A5	IO10RSB0	
A6	GND	
A7	IO44RSB0	
A8	V <sub>CC</sub>	
A9	IO69RSB0	
A10	GBA0/IO76RSB0	
A11	GBA1/IO77RSB0	
A12	GNDQ	
B1	GAB2/IO224PDB3	
B2	GND	
B3	GAA0/IO00RSB0	
B4	GAA1/IO01RSB0	
B5	IO13RSB0	
B6	IO26RSB0	
B7	IO35RSB0	
B8	IO60RSB0	
B9	GBB0/IO74RSB0	
B10	GBB1/IO75RSB0	
B11	GND	
B12	VMV1	
C1	IO224NDB3	
C2	GFA2/IO206PPB3	
C3	GAC2/IO223PDB3	
C4	V <sub>CC</sub>	
C5	IO16RSB0	
C6	IO29RSB0	
C7	IO32RSB0	
C8	IO63RSB0	
С9	IO66RSB0	
C10	GBA2/IO78PDB1	
C11	IO78NDB1	
C12	GBC2/IO80PPB1	

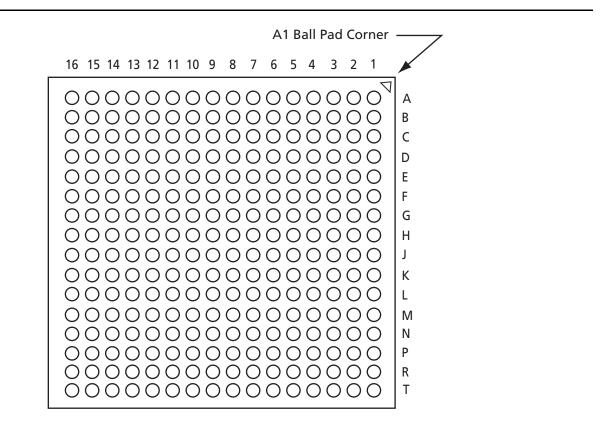
144-P	in FBGA*
Pin Number	A3P1000 Function
D1	IO213PDB3
D2	IO213NDB3
D3	IO223NDB3
D4	GAA2/IO225PPB3
D5	GAC0/IO04RSB0
D6	GAC1/IO05RSB0
D7	GBC0/IO72RSB0
D8	GBC1/IO73RSB0
D9	GBB2/IO79PDB1
D10	IO79NDB1
D11	IO80NPB1
D12	GCB1/IO92PPB1
E1	V <sub>CC</sub>
E2	GFC0/IO209NDB3
E3	GFC1/IO209PDB3
E4	V <sub>CCI</sub> B3
E5	IO225NPB3
E6	V <sub>CCI</sub> B0
E7	V <sub>CCI</sub> B0
E8	GCC1/IO91PDB1
E9	V <sub>CCI</sub> B1
E10	V <sub>CC</sub>
E11	GCA0/IO93NDB1
E12	IO94NDB1
F1	GFB0/IO208NPB3
F2	V <sub>COMPLF</sub>
F3	GFB1/IO208PPB3
F4	IO206NPB3
F5	GND
F6	GND
F7	GND
F8	GCC0/IO91NDB1
F9	GCB0/IO92NPB1
F10	GND
F11	GCA1/IO93PDB1
F12	GCA2/IO94PDB1

144-Pi	in FBGA*
Pin Number	A3P1000 Function
G1	GFA1/IO207PPB3
G2	GND
G3	V <sub>CCPLF</sub>
G4	GFA0/IO207NPB3
G5	GND
G6	GND
G7	GND
G8	GDC1/IO111PPB1
G9	IO96NDB1
G10	GCC2/IO96PDB1
G11	IO95NDB1
G12	GCB2/IO95PDB1
H1	V <sub>CC</sub>
H2	GFB2/IO205PDB3
H3	GFC2/IO204PSB3
H4	GEC1/IO190PDB3
H5	V <sub>CC</sub>
H6	IO105PDB1
H7	IO105NDB1
H8	GDB2/IO115RSB2
Н9	GDC0/IO111NPB1
H10	V <sub>CCI</sub> B1
H11	IO101PSB1
H12	V <sub>CC</sub>
J1	GEB1/IO189PDB3
J2	IO205NDB3
J3	V <sub>CCI</sub> B3
J4	GEC0/IO190NDB3
J5	IO160RSB2
JG	IO157RSB2
J7	V <sub>CC</sub>
8L	TCK
J9	GDA2/IO114RSB2
J10	TDO
J11	GDA1/IO113PDB1
J12	GDB1/IO112PDB1

144-P	in FBGA*
Pin Number	A3P1000 Function
K1	GEB0/IO189NDB3
К2	GEA1/IO188PDB3
К3	GEA0/IO188NDB3
K4	GEA2/IO187RSB2
K5	IO169RSB2
K6	IO152RSB2
K7	GND
K8	IO117RSB2
К9	GDC2/IO116RSB2
K10	GND
K11	GDA0/IO113NDB1
K12	GDB0/IO112NDB1
L1	GND
L2	VMV3
L3	GEB2/IO186RSB2
L4	IO172RSB2
L5	V <sub>CCI</sub> B2
L6	IO153RSB2
L7	IO144RSB2
L8	IO140RSB2
L9	TMS
L10	V <sub>JTAG</sub>
L11	VMV2
L12	TRST
M1	GNDQ
M2	GEC2/IO185RSB2
M3	IO173RSB2
M4	IO168RSB2
M5	IO161RSB2
M6	IO156RSB2
M7	IO145RSB2
M8	IO141RSB2
M9	TDI
M10	V <sub>CCI</sub> B2
M11	V <sub>PUMP</sub>
M12	GNDQ



# 256-Pin FBGA



# Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.actel.com/products/rescenter/package/index.html.

256-Pin FBGA	
Pin Number	A3P250 Function
A1	GND
A2	GAA0/IO00RSB0
A3	GAA1/IO01RSB0
A4	GAB0/IO02RSB0
A5	IO07RSB0
A6	IO10RSB0
A7	IO11RSB0
A8	IO15RSB0
A9	IO20RSB0
A10	IO25RSB0
A11	IO29RSB0
A12	IO33RSB0
A13	GBB1/IO38RSB0
A14	GBA0/IO39RSB0
A15	GBA1/IO40RSB0
A16	GND
B1	GAB2/IO117UDB3
B2	GAA2/IO118UDB3
B3	NC
B4	GAB1/IO03RSB0
B5	IO06RSB0
B6	IO09RSB0
В7	IO12RSB0
B8	IO16RSB0
B9	IO21RSB0
B10	IO26RSB0
B11	IO30RSB0
B12	GBC1/IO36RSB0
B13	GBB0/IO37RSB0
B14	NC
B15	GBA2/IO41PDB1
B16	IO41NDB1
C1	IO117VDB3
C2	IO118VDB3
C3	NC

256-Pi	256-Pin FBGA	
Pin Number	A3P250 Function	
C4	NC	
C5	GAC0/IO04RSB0	
C6	GAC1/IO05RSB0	
C7	IO13RSB0	
C8	IO17RSB0	
С9	IO22RSB0	
C10	IO27RSB0	
C11	IO31RSB0	
C12	GBC0/IO35RSB0	
C13	IO34RSB0	
C14	NC	
C15	IO42NPB1	
C16	IO44PDB1	
D1	IO114VDB3	
D2	IO114UDB3	
D3	GAC2/IO116UDB3	
D4	NC	
D5	GNDQ	
D6	IO08RSB0	
D7	IO14RSB0	
D8	IO18RSB0	
D9	IO23RSB0	
D10	IO28RSB0	
D11	IO32RSB0	
D12	GNDQ	
D13	NC	
D14	GBB2/IO42PPB1	
D15	NC	
D16	IO44NDB1	
E1	IO113PDB3	
E2	NC	
E3	IO116VDB3	
E4	IO115UDB3	
E5	VMV0	
E6	V <sub>CCI</sub> B0	

256-Pi	n FBGA
Pin Number	A3P250 Function
E7	V <sub>CCI</sub> B0
E8	IO19RSB0
E9	IO24RSB0
E10	V <sub>CCI</sub> B0
E11	V <sub>CCI</sub> B0
E12	VMV1
E13	GBC2/IO43PDB1
E14	IO46RSB1
E15	NC
E16	IO45PDB1
F1	IO113NDB3
F2	IO112PPB3
F3	NC
F4	IO115VDB3
F5	V <sub>CCI</sub> B3
F6	GND
F7	V <sub>CC</sub>
F8	V <sub>CC</sub>
F9	V <sub>CC</sub>
F10	V <sub>CC</sub>
F11	GND
F12	V <sub>CCI</sub> B1
F13	IO43NDB1
F14	NC
F15	IO47PPB1
F16	IO45NDB1
G1	IO111NDB3
G2	IO111PDB3
G3	IO112NPB3
G4	GFC1/IO110PPB3
G5	V <sub>CCI</sub> B3
G6	V <sub>CC</sub>
G7	GND
G8	GND
G9	GND

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ProASIC3 Flash Family FPGAs

256-Pin FBGA	
A3P250	
Pin Number	Function
G10	GND
G11	V <sub>CC</sub>
G12	V <sub>CCI</sub> B1
G13	GCC1/IO48PPB1
G14	IO47NPB1
G15	IO54PDB1
G16	IO54NDB1
H1	GFB0/IO109NPB3
H2	GFA0/IO108NDB3
H3	GFB1/IO109PPB3
H4	V <sub>COMPLF</sub>
H5	GFC0/IO110NPB3
H6	V <sub>CC</sub>
H7	GND
H8	GND
H9	GND
H10	GND
H11	V <sub>CC</sub>
H12	GCC0/IO48NPB1
H13	GCB1/IO49PPB1
H14	GCA0/IO50NPB1
H15	NC
H16	GCB0/IO49NPB1
J1	GFA2/IO107PPB3
J2	GFA1/IO108PDB3
J3	V <sub>CCPLF</sub>
J4	IO106NDB3
J5	GFB2/IO106PDB3
J6	V <sub>CC</sub>
J7	GND
J8	GND
J9	GND
J10	GND
J11	V <sub>CC</sub>
J12	GCB2/IO52PPB1

256-Pin FBGA	
Pin Number	A3P250 Function
J13	GCA1/IO50PPB1
J14	GCC2/IO53PPB1
J15	NC
J16	GCA2/IO51PDB1
K1	GFC2/IO105PDB3
K2	IO107NPB3
К3	IO104PPB3
К4	NC
К5	V <sub>CCI</sub> B3
К6	V <sub>CC</sub>
К7	GND
K8	GND
К9	GND
K10	GND
K11	V <sub>CC</sub>
K12	V <sub>CCI</sub> B1
K13	IO52NPB1
K14	IO55RSB1
K15	IO53NPB1
K16	IO51NDB1
L1	IO105NDB3
L2	IO104NPB3
L3	NC
L4	IO102RSB3
L5	V <sub>CCI</sub> B3
L6	GND
L7	V <sub>CC</sub>
L8	V <sub>CC</sub>
L9	V <sub>CC</sub>
L10	V <sub>CC</sub>
L11	GND
L12	V <sub>CCI</sub> B1
L13	GDB0/IO59VPB1
L14	IO57VDB1
L15	IO57UDB1

256-Pin FBGA	
Pin Number	A3P250 Function
L16	IO56PDB1
M1	IO103PDB3
M2	NC
М3	IO101NPB3
M4	GEC0/IO100NPB3
M5	VMV3
M6	V <sub>CCI</sub> B2
M7	V <sub>CCI</sub> B2
M8	NC
M9	IO74RSB2
M10	V <sub>CCI</sub> B2
M11	V <sub>CCI</sub> B2
M12	VMV2
M13	NC
M14	GDB1/IO59UPB1
M15	GDC1/IO58UDB1
M16	IO56NDB1
N1	IO103NDB3
N2	IO101PPB3
N3	GEC1/IO100PPB3
N4	NC
N5	GNDQ
N6	GEA2/IO97RSB2
N7	IO86RSB2
N8	IO82RSB2
N9	IO75RSB2
N10	IO69RSB2
N11	IO64RSB2
N12	GNDQ
N13	NC
N14	V <sub>JTAG</sub>
N15	GDC0/IO58VDB1
N16	GDA1/IO60UDB1
P1	GEB1/IO99PDB3
P2	GEB0/IO99NDB3

256-Pin FBGA	
Pin Number	A3P250 Function
Р3	NC
P4	NC
Р5	IO92RSB2
P6	IO89RSB2
Р7	IO85RSB2
P8	IO81RSB2
Р9	IO76RSB2
P10	IO71RSB2
P11	IO66RSB2
P12	NC
P13	ТСК
P14	V <sub>PUMP</sub>
P15	TRST
P16	GDA0/IO60VDB1
R1	GEA1/IO98PDB3
R2	GEA0/IO98NDB3
R3	NC
R4	GEC2/IO95RSB2
R5	IO91RSB2
R6	IO88RSB2
R7	IO84RSB2
R8	IO80RSB2
R9	IO77RSB2
R10	IO72RSB2
R11	IO68RSB2
R12	IO65RSB2
R13	GDB2/IO62RSB2
R14	TDI
R15	NC
R16	TDO
T1	GND
T2	IO94RSB2
T3	GEB2/IO96RSB2
T4	IO93RSB2
Τ5	IO90RSB2

256-Pi	256-Pin FBGA	
Pin Number	A3P250 Function	
T6	IO87RSB2	
Τ7	IO83RSB2	
Τ8	IO79RSB2	
Т9	IO78RSB2	
T10	IO73RSB2	
T11	IO70RSB2	
T12	GDC2/IO63RSB2	
T13	IO67RSB2	
T14	GDA2/IO61RSB2	
T15	TMS	
T16	GND	

ProASIC3 Flash Family FPGAs

256-Pin FBGA*	
Pin Number	A3P400 Function
A1	GND
A2	GAA0/IO00RSB0
A3	GAA1/IO01RSB0
A4	GAB0/IO02RSB0
A5	IO14RSB0
A6	IO18RSB0
A7	IO22RSB0
A8	IO27RSB0
A9	IO30RSB0
A10	IO39RSB0
A11	IO41RSB0
A12	IO46RSB0
A13	GBB1/IO57RSB0
A14	GBA0/IO58RSB0
A15	GBA1/IO59RSB0
A16	GND
B1	GAB2/IO154PDB3
B2	GAA2/IO155PPB3
B3	IO10RSB0
B4	GAB1/IO03RSB0
B5	IO12RSB0
B6	IO16RSB0
B7	IO21RSB0
B8	IO26RSB0
B9	IO31RSB0
B10	IO37RSB0
B11	IO42RSB0
B12	GBC1/IO55RSB0
B13	GBB0/IO56RSB0
B14	IO48RSB0
B15	GBA2/IO60PPB1
B16	IO50RSB0
C1	IO154NDB3
C2	IO08RSB0
С3	IO07RSB0
C4	IO06RSB0
C5	GAC0/IO04RSB0

256-Pin FBGA*	
Pin Number	A3P400 Function
C6	GAC1/IO05RSB0
С7	IO20RSB0
C8	IO25RSB0
С9	IO32RSB0
C10	IO38RSB0
C11	IO44RSB0
C12	GBC0/IO54RSB0
C13	IO51RSB0
C14	IO52RSB0
C15	IO53RSB0
C16	IO60NPB1
D1	IO152NPB3
D2	IO155NPB3
D3	GAC2/IO153PDB3
D4	IO09RSB0
D5	GNDQ
D6	IO15RSB0
D7	IO19RSB0
D8	IO24RSB0
D9	IO33RSB0
D10	IO40RSB0
D11	IO43RSB0
D12	GNDQ
D13	IO49RSB0
D14	GBB2/IO61PDB1
D15	IO63NDB1
D16	IO64NDB1
E1	IO151PDB3
E2	IO152PPB3
E3	IO153NDB3
E4	IO11RSB0
E5	VMV0
E6	V <sub>CCI</sub> B0
E7	V <sub>CCI</sub> B0
E8	IO28RSB0
E9	IO35RSB0
E10	V <sub>CCI</sub> B0
on" section on page 2	

256-Pin FBGA*	
Pin Number	A3P400 Function
E11	V <sub>CCI</sub> B0
E12	VMV1
E13	GBC2/IO62PDB1
E14	IO61NDB1
E15	IO63PDB1
E16	IO64PDB1
F1	IO151NDB3
F2	IO150PPB3
F3	NC
F4	IO148PPB3
F5	V <sub>CCI</sub> B3
F6	GND
F7	V <sub>CC</sub>
F8	V <sub>CC</sub>
F9	V <sub>CC</sub>
F10	V <sub>CC</sub>
F11	GND
F12	V <sub>CCI</sub> B1
F13	IO62NDB1
F14	NC
F15	IO65RSB1
F16	IO73NDB1
G1	IO150NPB3
G2	IO149PDB3
G3	IO149NDB3
G4	GFC1/IO147PPB3
G5	V <sub>CCI</sub> B3
G6	V <sub>CC</sub>
G7	GND
G8	GND
G9	GND
G10	GND
G11	V <sub>CC</sub>
G12	V <sub>CCI</sub> B1
G13	GCC1/IO67PPB1
G14	IO66NDB1
G15	IO66PDB1

256-Pin FBGA*	
Pin Number	A3P400 Function
G16	IO73PDB1
H1	GFB0/IO146NPB3
H2	GFA0/IO145NDB3
H3	GFB1/IO146PPB3
H4	V <sub>COMPLF</sub>
H5	GFC0/IO147NPB3
H6	V <sub>CC</sub>
H7	GND
H8	GND
Н9	GND
H10	GND
H11	V <sub>CC</sub>
H12	GCC0/IO67NPB1
H13	GCB1/IO68PPB1
H14	GCA0/IO69NPB1
H15	NC
H16	GCB0/IO68NPB1
J1	GFA2/IO144PPB3
J2	GFA1/IO145PDB3
J3	V <sub>CCPLF</sub>
J4	IO148NPB3
J5	GFB2/IO143PPB3
J6	V <sub>CC</sub>
J7	GND
J8	GND
J9	GND
J10	GND
J11	V <sub>CC</sub>
J12	GCB2/IO71PPB1
J13	GCA1/IO69PPB1
J14	GCC2/IO72PDB1
J15	NC
J16	GCA2/IO70PDB1
K1	GFC2/IO142PDB3
K2	IO144NPB3
К3	IO143NPB3
K4	IO138PDB3

256-Pin FBGA*	
Pin Number	A3P400 Function
K5	V <sub>CCI</sub> B3
K6	V <sub>CC</sub>
K7	GND
K8	GND
К9	GND
K10	GND
K11	V <sub>CC</sub>
K12	V <sub>CCI</sub> B1
K13	IO71NPB1
K14	IO72NDB1
K15	IO74RSB1
K16	IO70NDB1
L1	IO142NDB3
L2	IO140NDB3
L3	IO139RSB3
L4	IO138NDB3
L5	V <sub>CCI</sub> B3
L6	GND
L7	V <sub>CC</sub>
L8	V <sub>CC</sub>
L9	V <sub>CC</sub>
L10	V <sub>CC</sub>
L11	GND
L12	V <sub>CCI</sub> B0
L13	GDB0/IO78NPB1
L14	IO75NDB1
L15	IO75PDB1
L16	IO76PDB1
M1	IO141NDB3
M2	IO140PDB3
M3	IO127RSB2
M4	GEC0/IO137NPB3
M5	VMV3
M6	V <sub>CCI</sub> B2
M7	V <sub>CCI</sub> B2
M8	IO106RSB2
M9	IO99RSB2
on" section on page 2	

256-Pin FBGA*	
Pin Number	A3P400 Function
M10	V <sub>CCI</sub> B2
M11	V <sub>CCI</sub> B2
M12	VMV2
M13	IO85RSB2
M14	GDB1/IO78PPB1
M15	GDC1/IO77PDB1
M16	IO76NDB1
N1	IO141PDB3
N2	IO131RSB2
N3	GEC1/IO137PPB3
N4	IO128RSB2
N5	GNDQ
N6	GEA2/IO134RSB2
N7	IO113RSB2
N8	IO109RSB2
N9	IO100RSB2
N10	IO95RSB2
N11	IO90RSB2
N12	GNDQ
N13	IO83RSB2
N14	V <sub>JTAG</sub>
N15	GDC0/IO77NDB1
N16	GDA1/IO79PDB1
P1	GEB1/IO136PDB3
P2	GEB0/IO136NDB3
РЗ	IO130RSB2
P4	IO129RSB2
P5	IO126RSB2
P6	IO121RSB2
P7	IO115RSB2
P8	IO108RSB2
P9	IO101RSB2
P10	IO94RSB2
P11	IO88RSB2
P12	IO84RSB2
P13	ТСК
P14	V <sub>PUMP</sub>



256-Pin FBGA*	
Pin Number	A3P400 Function
P15	TRST
P16	GDA0/IO79NDB1
R1	GEA1/IO135PDB3
R2	GEA0/IO135NDB3
R3	IO125RSB2
R4	GEC2/IO132RSB2
R5	IO122RSB2
R6	IO118RSB2
R7	IO112RSB2
R8	IO107RSB2
R9	IO102RSB2
R10	IO96RSB2
R11	IO91RSB2
R12	IO87RSB2
R13	GDB2/IO81RSB2
R14	TDI
R15	NC
R16	TDO
T1	GND
T2	IO124RSB2
T3	GEB2/IO133RSB2
T4	IO123RSB2
T5	IO120RSB2
T6	IO116RSB2
Τ7	IO111RSB2
Т8	IO105RSB2
Т9	IO103RSB2
T10	IO97RSB2
T11	IO93RSB2
T12	GDC2/IO82RSB2
T13	IO86RSB2
T14	GDA2/IO80RSB2
T15	TMS
T16	GND

Note:	*Refer to the	"User I/O Naming	Convention"	section on page 2-46.
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256-Pin FBGA*			
Pin Number	A3P600 Function		
A1	GND		
A2	GAA0/IO00RSB0		
A3	GAA1/IO01RSB0		
A4	GAB0/IO02RSB0		
A5	IO12RSB0		
A6	IO14RSB0		
A7	IO19RSB0		
A8	IO26RSB0		
A9	IO31RSB0		
A10	IO37RSB0		
A11	IO41RSB0		
A12	IO47RSB0		
A13	GBB1/IO57RSB0		
A14	GBA0/IO58RSB0		
A15	GBA1/IO59RSB0		
A16	GND		
B1	GAB2/IO169PDB3		
B2	GAA2/IO170PDB3		
B3	GNDQ		
B4	GAB1/IO03RSB0		
B5	IO10RSB0		
B6	IO15RSB0		
В7	IO18RSB0		
B8	IO24RSB0		
B9	IO32RSB0		
B10	IO40RSB0		
B11	IO43RSB0		
B12	GBC1/IO55RSB0		
B13	GBB0/IO56RSB0		
B14	IO49RSB0		
B15	GBA2/IO60PDB1		
B16	IO60NDB1		
C1	IO169NDB3		
C2	IO170NDB3		
C3	VMV3		
C4	IO06RSB0		
C5	GAC0/IO04RSB0		

Pin Number         A3P600 Function           C6         GAC1/IO05RSB0           C7         IO17RSB0           C8         IO25RSB0           C9         IO33RSB0           C10         IO38RSB0           C11         IO42RSB0           C12         GBC0/IO54RSB0           C13         IO52RSB0           C14         IO51RSB0           C15         IO50RSB0           C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO18NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         IO43PRSB0           D15         IO63PRS1           D16         IO63PRS1           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1<	256-Pin FBGA*			
C7         IO17RSB0           C8         IO25RSB0           C9         IO33RSB0           C10         IO38RSB0           C11         IO42RSB0           C12         GBC0/IO54RSB0           C13         IO52RSB0           C14         IO51RSB0           C15         IO50RSB0           C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO168NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D1         IO46RSB0           D1         IO46RSB0           D1         IO46RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E2         IO167NDB3           E3         IO167NDB3           E4         IO167NDB3	Pin Number	A3P600 Function		
C8         IO25RSB0           C9         IO33RSB0           C10         IO38RSB0           C11         IO42RSB0           C12         GBC0/IO54RSB0           C13         IO52RSB0           C14         IO51RSB0           C15         IO50RSB0           C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO18NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D11         IO48RSB0           D11         IO48RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E1         IO165NDB3           E2         IO167PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0      <	C6	GAC1/IO05RSB0		
C9         IO33RSB0           C10         IO38RSB0           C11         IO42RSB0           C12         GBC0/IO54RSB0           C13         IO52RSB0           C14         IO51RSB0           C15         IO50RSB0           C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO18NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D1         IO46RSB0           D1         IO48RSB0           D1         IO48RSB0           D1         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E2         IO165NDB3           E3         IO167NDB3           E4         IO167NDB3           E5         VMV0 <tr< td=""><td>С7</td><td>IO17RSB0</td></tr<>	С7	IO17RSB0		
C10         IO38RSB0           C11         IO42RSB0           C12         GBC0/IO54RSB0           C13         IO52RSB0           C14         IO51RSB0           C15         IO50RSB0           C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO188NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO166RSB0           D7         IO16RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0	C8	IO25RSB0		
C11         IO42RSB0           C12         GBC0/IO54RSB0           C13         IO52RSB0           C14         IO51RSB0           C15         IO50RSB0           C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO18NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO168NDB3           D8         IO22RSB0           D9         IO36RSB0           D1         IO39RSB0           D1         IO46RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E8         IO29RSB0           E8         IO29RSB0 <t< td=""><td>С9</td><td>IO33RSB0</td></t<>	С9	IO33RSB0		
C12         GBC0/I054RSB0           C13         I052RSB0           C14         I051RSB0           C15         I050RSB0           C16         I061NPB1           D1         I0166NDB3           D2         I0166PDB3           D3         GAC2/I0168PDB3           D4         I0168NDB3           D5         GNDQ           D6         I013RSB0           D7         I016RSB0           D8         I022RSB0           D9         I036RSB0           D11         I046RSB0           D11         I046RSB0           D11         I046RSB0           D11         I046RSB0           D11         I046RSB0           D11         I046RSB0           D12         GNDQ           D13         I053RSB0           D14         GBB2/I061PPB1           D15         I063PPB1           D16         I065PDB3           E2         I0165NDB3           E3         I0167NDB3           E4         I0167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E8         I029RSB0	C10	IO38RSB0		
C13         IO52RSB0           C14         IO51RSB0           C15         IO50RSB0           C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO168NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         IO46RSB0           D15         IO46RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0	C11	IO42RSB0		
C14         IO51RSB0           C15         IO50RSB0           C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO168NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO166RSB0           D7         IO166RSB0           D8         IO22RSB0           D9         IO36RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO167NDB3           E3         IO167NDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	C12	GBC0/IO54RSB0		
C15         IO50RSB0           C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO168NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D11         IO468SB0           D11         IO46RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E1         IO165NDB3           E2         IO165PDB3           E3         IO167NDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	C13	IO52RSB0		
C16         IO61NPB1           D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO168NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO166RSB0           D8         IO22RSB0           D9         IO36RSB0           D11         IO46RSB0           D10         IO39RSB0           D11         IO46RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E1         IO165NDB3           E2         IO167NDB3           E3         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0	C14	IO51RSB0		
D1         IO166NDB3           D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO168NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E1         IO165NDB3           E2         IO165PDB3           E3         IO167NDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0	C15	IO50RSB0		
D2         IO166PDB3           D3         GAC2/IO168PDB3           D4         IO168NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB3           E1         IO165NDB3           E2         IO165PDB3           E3         IO167NDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0	C16	IO61NPB1		
D3         GAC2/IO168PDB3           D4         IO168NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D10         IO39RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0	D1	IO166NDB3		
D4         IO168NDB3           D5         GNDQ           D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           D16         IO65PDB3           E2         IO165PDB3           E3         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0	D2	IO166PDB3		
D5         GNDQ           D6         IO13RSBO           D7         IO16RSBO           D8         IO22RSBO           D9         IO36RSBO           D10         IO39RSBO           D11         IO46RSBO           D12         GNDQ           D13         IO53RSBO           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMVO           E6         V <sub>CCI</sub> BO           E7         V <sub>CCI</sub> BO           E8         IO29RSBO	D3	GAC2/IO168PDB3		
D6         IO13RSB0           D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D4	IO168NDB3		
D7         IO16RSB0           D8         IO22RSB0           D9         IO36RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D5	GNDQ		
D8         IO22RSB0           D9         IO36RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0	D6	IO13RSB0		
D9         IO36RSB0           D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0	D7	IO16RSB0		
D10         IO39RSB0           D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0	D8	IO22RSB0		
D11         IO46RSB0           D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D9	IO36RSB0		
D12         GNDQ           D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO167PDB3           E3         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D10	IO39RSB0		
D13         IO53RSB0           D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D11	IO46RSB0		
D14         GBB2/IO61PPB1           D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167NDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D12	GNDQ		
D15         IO63PPB1           D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D13	IO53RSB0		
D16         IO65PDB1           E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D14	GBB2/IO61PPB1		
E1         IO165NDB3           E2         IO165PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D15	IO63PPB1		
E2         IO165PDB3           E3         IO167PDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	D16	IO65PDB1		
E3         IO167PDB3           E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	E1	IO165NDB3		
E4         IO167NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	E2	IO165PDB3		
E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	E3	IO167PDB3		
E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	E4	IO167NDB3		
E7         V <sub>CCI</sub> B0           E8         IO29RSB0           E9         IO30RSB0	E5	VMV0		
E8 IO29RSB0 E9 IO30RSB0	E6	V <sub>CCI</sub> B0		
E9 IO30RSB0	E7	V <sub>CCI</sub> B0		
	E8	IO29RSB0		
F10	E9	IO30RSB0		
etu V <sub>CCI</sub> BO	E10	V <sub>CCI</sub> B0		

256-Pin FBGA*			
Pin Number	A3P600 Function		
E11	V <sub>CCI</sub> B0		
E12	VMV1		
E13	GBC2/IO62PDB1		
E14	IO63NPB1		
E15	IO64PPB1		
E16	IO65NDB1		
F1	IO154PSB3		
F2	IO162PPB3		
F3	IO164PDB3		
F4	IO164NDB3		
F5	V <sub>CCI</sub> B3		
F6	GND		
F7	V <sub>CC</sub>		
F8	V <sub>CC</sub>		
F9	V <sub>CC</sub>		
F10	V <sub>CC</sub>		
F11	GND		
F12	V <sub>CCI</sub> B1		
F13	IO62NDB1		
F14	IO64NPB1		
F15	IO66PPB1		
F16	IO67PPB1		
G1	IO155NDB3		
G2	IO155PDB3		
G3	IO162NPB3		
G4	GFC1/IO161PPB3		
G5	V <sub>CCI</sub> B3		
G6	V <sub>CC</sub>		
G7	GND		
G8	GND		
G9	GND		
G10	GND		
G11	V <sub>CC</sub>		
G12	V <sub>CCI</sub> B1		
G13	GCC1/IO68PPB1		
G14	IO66NPB1		
G15	IO67NPB1		

Actel <sup>®</sup>
ProASIC3 Flash Family FPGAs

256-Pin FBGA*			
Pin Number	A3P600 Function		
G16	IO71NPB1		
H1	GFB0/IO160NPB3		
H2	GFA0/IO159NDB3		
H3	GFB1/IO160PPB3		
H4	V <sub>COMPLF</sub>		
H5	GFC0/IO161NPB3		
H6	V <sub>CC</sub>		
H7	GND		
H8	GND		
H9	GND		
H10	GND		
H11	V <sub>CC</sub>		
H12	GCC0/IO68NPB1		
H13	GCB1/IO69PPB1		
H14	GCA0/IO70NPB1		
H15	IO73NPB1		
H16	GCB0/IO69NPB1		
J1	GFA2/IO158PPB3		
J2	GFA1/IO159PDB3		
J3	V <sub>CCPLF</sub>		
J4	IO157NDB3		
J5	GFB2/IO157PDB3		
J6	V <sub>CC</sub>		
J7	GND		
J8	GND		
J9	GND		
J10	GND		
J11	V <sub>CC</sub>		
J12	GCB2/IO72PPB1		
J13	GCA1/IO70PPB1		
J14	GCC2/IO73PPB1		
J15	IO77PPB1		
J16	GCA2/IO71PPB1		
K1	GFC2/IO156PPB3		
K2	IO158NPB3		
K3	IO151PDB3		
K4	IO151NDB3		

256-Pin FBGA*			
Pin Number	A3P600 Function		
K5	V <sub>CCI</sub> B3		
K6	V <sub>CC</sub>		
K7	GND		
K8	GND		
К9	GND		
K10	GND		
K11	V <sub>CC</sub>		
K12	V <sub>CCI</sub> B1		
K13	IO72NPB1		
K14	IO82PDB1		
K15	IO79PDB1		
K16	IO77NPB1		
L1	IO149PDB3		
L2	IO156NPB3		
L3	IO147PDB3		
L4	IO147NDB3		
L5	V <sub>CCI</sub> B3		
L6	GND		
L7	V <sub>CC</sub>		
L8	V <sub>CC</sub>		
L9	V <sub>CC</sub>		
L10	V <sub>CC</sub>		
L11	GND		
L12	V <sub>CCI</sub> B1		
L13	GDB0/IO85NPB1		
L14	IO82NDB1		
L15	IO79NDB1		
L16	IO80PDB1		
M1	IO149NDB3		
M2	IO146PDB3		
M3	IO146NDB3		
M4	GEC0/IO144NPB3		
M5	VMV3		
M6	V <sub>CCI</sub> B2		
M7	V <sub>CCI</sub> B2		
M8	IO111RSB2		
M9	IO110RSB2		

256-Pin FBGA*			
Pin Number	A3P600 Function		
M10	V <sub>CCI</sub> B2		
M11	V <sub>CCI</sub> B2		
M12	VMV2		
M13	IO81NDB1		
M14	GDB1/IO85PPB1		
M15	GDC1/IO84PDB1		
M16	IO80NDB1		
N1	IO145PDB3		
N2	IO145NDB3		
N3	GEC1/IO144PPB3		
N4	IO137RSB2		
N5	GNDQ		
N6	GEA2/IO141RSB2		
N7	IO120RSB2		
N8	IO113RSB2		
N9	IO106RSB2		
N10	IO99RSB2		
N11	IO94RSB2		
N12	GNDQ		
N13	IO81PDB1		
N14	V <sub>JTAG</sub>		
N15	GDC0/IO84NDB1		
N16	GDA1/IO86PDB1		
P1	GEB1/IO143PDB3		
P2	GEB0/IO143NDB3		
РЗ	IO138RSB2		
P4	IO135RSB2		
P5	IO134RSB2		
P6	IO128RSB2		
P7	IO121RSB2		
P8	IO115RSB2		
Р9	IO108RSB2		
P10	IO100RSB2		
P11	IO95RSB2		
P12	VMV1		
P13	ТСК		
P14	V <sub>PUMP</sub>		

Pin NumberA3P600 FunctionP15TRSTP16GDA0/I086NDB1R1GEA1/I0142PDB3R2GEA0/I0142NDB3R3I0136RSB2R4GEC2/I0139RSB2R5I0130RSB2R6I0125RSB2R7I0119RSB2R8I0114RSB2R9I0107RSB2R10I0101RSB2R11I096RSB2R12I090RSB2R13GDB2/I088RSB2R14TDIR15GNDQR16TDOT1GNDT2I0133RSB2T3GEB2/I0140RSB2T4I0122RSB2T5I0127RSB2T6I0123RSB2T7I0117RSB2T6I0123RSB2T7I0117RSB2T6I0102RSB2T7I0117RSB2T10I0102RSB2T11IO97RSB2T12GDC2/I089RSB2T13I091RSB2T14GDA2/I087RSB2T15I0127RSB2T14GDA2/I087RSB2T15TMST15TMS	256-Pin FBGA*		
P16         GDA0/IO86NDB1           R1         GEA1/IO142PDB3           R2         GEA0/IO142NDB3           R3         IO136RSB2           R4         GEC2/IO139RSB2           R5         IO130RSB2           R6         IO125RSB2           R7         IO119RSB2           R8         IO114RSB2           R9         IO107RSB2           R11         IO96RSB2           R12         IO900RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO97RSB2	Pin Number	A3P600 Function	
R1         GEA1/I0142PDB3           R2         GEA0/I0142NDB3           R3         I0136RSB2           R4         GEC2/I0139RSB2           R5         I0130RSB2           R6         I0125RSB2           R7         I0119RSB2           R8         I0114RSB2           R9         I0107RSB2           R11         I096RSB2           R12         I0900RSB2           R13         GDB2/I088RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           R15         GNDQ           R16         TDO           T1         GND           T2         I0133RSB2           T3         GEB2/I0140RSB2           T4         I0132RSB2           T5         I0127RSB2           T6         I0123RSB2           T6         I0123RSB2           T6         I0123RSB2           T6         I0123RSB2           T6         I0123RSB2           T6         I0123RSB2           T7         I0117RSB2           T8         I0112RSB2 <tr< td=""><td>P15</td><td>TRST</td></tr<>	P15	TRST	
R2         GEA0/IO142NDB3           R3         IO136RSB2           R4         GEC2/IO139RSB2           R5         IO130RSB2           R6         IO125RSB2           R7         IO119RSB2           R8         IO114RSB2           R9         IO107RSB2           R10         IO101RSB2           R11         IO96RSB2           R12         IO900RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T6         IO123RSB2           T6         IO123RSB2           T6         IO123RSB2           T8         IO1102RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2	P16	GDA0/IO86NDB1	
R3         IO136RSB2           R4         GEC2/IO139RSB2           R5         IO130RSB2           R6         IO125RSB2           R7         IO119RSB2           R8         IO114RSB2           R9         IO107RSB2           R10         IO101RSB2           R11         IO96RSB2           R12         IO90RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO197RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2 <t< td=""><td>R1</td><td>GEA1/IO142PDB3</td></t<>	R1	GEA1/IO142PDB3	
R4         GEC2/IO139RSB2           R5         IO130RSB2           R6         IO125RSB2           R7         IO119RSB2           R8         IO114RSB2           R9         IO107RSB2           R10         IO101RSB2           R11         IO96RSB2           R12         IO900RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO123RSB2           T6         IO123RSB2           T7         IO117RSB2           T6         IO123RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO109RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS     <	R2	GEA0/IO142NDB3	
R5         IO130RSB2           R6         IO125RSB2           R7         IO119RSB2           R8         IO114RSB2           R9         IO107RSB2           R10         IO101RSB2           R11         IO96RSB2           R12         IO90RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R3	IO136RSB2	
R6         IO125RSB2           R7         IO119RSB2           R8         IO114RSB2           R9         IO107RSB2           R10         IO101RSB2           R11         IO96RSB2           R12         IO90RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R4	GEC2/IO139RSB2	
R7         IO119RSB2           R8         IO114RSB2           R9         IO107RSB2           R10         IO101RSB2           R11         IO96RSB2           R12         IO90RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R5	IO130RSB2	
R8         IO114RSB2           R9         IO107RSB2           R10         IO101RSB2           R11         IO96RSB2           R12         IO90RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO102RSB2           T11         IO97RSB2           T11         IO97RSB2           T113         IO91RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R6	IO125RSB2	
R9         IO107RSB2           R10         IO101RSB2           R11         IO96RSB2           R12         IO90RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T113         IO91RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R7	IO119RSB2	
R10         IO101RSB2           R11         IO96RSB2           R12         IO90RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R8	IO114RSB2	
R11         IO96RSB2           R12         IO90RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R9	IO107RSB2	
R12         IO90RSB2           R13         GDB2/IO88RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T11         IO97RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R10	IO101RSB2	
R13         GDB2/I088RSB2           R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         IO112RSB2	R11	IO96RSB2	
R14         TDI           R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R12	IO90RSB2	
R15         GNDQ           R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R13	GDB2/IO88RSB2	
R16         TDO           T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T10         IO109RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2	R14	TDI	
T1         GND           T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R15	GNDQ	
T2         IO133RSB2           T3         GEB2/IO140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	R16	TDO	
T3         GEB2/I0140RSB2           T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	T1	GND	
T4         IO132RSB2           T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	T2	IO133RSB2	
T5         IO127RSB2           T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	T3	GEB2/IO140RSB2	
T6         IO123RSB2           T7         IO117RSB2           T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	T4	IO132RSB2	
T7       IO117RSB2         T8       IO112RSB2         T9       IO109RSB2         T10       IO102RSB2         T11       IO97RSB2         T12       GDC2/IO89RSB2         T13       IO91RSB2         T14       GDA2/IO87RSB2         T15       TMS	T5	IO127RSB2	
T8         IO112RSB2           T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	T6	IO123RSB2	
T9         IO109RSB2           T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	T7	IO117RSB2	
T10         IO102RSB2           T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	Т8	IO112RSB2	
T11         IO97RSB2           T12         GDC2/IO89RSB2           T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	Т9	IO109RSB2	
T12         GDC2/I089RSB2           T13         IO91RSB2           T14         GDA2/I087RSB2           T15         TMS	T10	IO102RSB2	
T13         IO91RSB2           T14         GDA2/IO87RSB2           T15         TMS	T11	IO97RSB2	
T14         GDA2/I087RSB2           T15         TMS	T12	GDC2/IO89RSB2	
T15 TMS	T13	IO91RSB2	
	T14	GDA2/IO87RSB2	
T16 GND	T15	TMS	
	T16	GND	

Note: \*Refer to the "User I/O Naming Convention" section on page 2-46.

ProASIC3 Flash Family FPGAs

256-Pin FBGA*		
Pin Number	A3P1000 Function	1
A1	GND	1
A2	GAA0/IO00RSB0	1
A3	GAA1/IO01RSB0	1
A4	GAB0/IO02RSB0	1
A5	IO16RSB0	1
A6	IO22RSB0	1
A7	IO28RSB0	1
A8	IO35RSB0	1
A9	IO45RSB0	1
A10	IO50RSB0	1
A11	IO55RSB0	1
A12	IO61RSB0	1
A13	GBB1/IO75RSB0	1
A14	GBA0/IO76RSB0	1
A15	GBA1/IO77RSB0	1
A16	GND	1
B1	GAB2/IO224PDB3	1
B2	GAA2/IO225PDB3	1
B3	GNDQ	1
B4	GAB1/IO03RSB0	1
B5	IO17RSB0	1
B6	IO21RSB0	1
B7	IO27RSB0	1
B8	IO34RSB0	1
B9	IO44RSB0	1
B10	IO51RSB0	1
B11	IO57RSB0	1
B12	GBC1/IO73RSB0	1
B13	GBB0/IO74RSB0	1
B14	IO71RSB0	1
B15	GBA2/IO78PDB1	1
B16	IO81PDB1	1
C1	IO224NDB3	1
C2	IO225NDB3	1
C3	VMV3	1
C4	IO11RSB0	
C5	GAC0/IO04RSB0	╽┠

Pin NumberA3P1000 FunctionC7IO25RSB0C8IO36RSB0C9IO42RSB0C10IO49RSB0C11IO56RSB0C112GBC0/IO72RSB0C13IO62RSB0C13IO62RSB0C14VMV0C15IO78NDB1C16IO81NDB1D1IO222NDB3D2IO222PDB3D3GAC2/IO223PDB3D4IO23RSB0D5GNDQD6IO23RSB0D7IO29RSB0D8IO33RSB0D9IO46RSB0D10IO52RSB0D11IO60RSB0D12GNDQD13IO80NDB1D14GBB2/IO79PDB1D15IO79NDB1D15IO218PDB3E1IO2117PDB3E2IO218PDB3E3IO221NDB3E4IO221NDB3E5VMV0E6V <sub>CCI</sub> B0E8IO38RSB0E9IO47RSB0E10V <sub>CCI</sub> B0E11V <sub>CCI</sub> B0E11V <sub>CCI</sub> B0E11V <sub>CCI</sub> B0	256-Pin FBGA*			
C8         IO36RSB0           C9         IO42RSB0           C10         IO49RSB0           C11         IO56RSB0           C12         GBC0/IO72RSB0           C13         IO62RSB0           C14         VMV0           C15         IO78NDB1           C16         IO81NDB1           D1         IO222NDB3           D2         IO222PDB3           D3         GAC2/IO223PDB3           D4         IO23RSB0           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D11         IO60RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO211RPDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0	Pin Number	A3P1000 Function		
C9         IO42RSB0           C10         IO49RSB0           C11         IO56RSB0           C12         GBC0/IO72RSB0           C13         IO62RSB0           C14         VMV0           C15         IO78NDB1           C16         IO81NDB1           D1         IO222NDB3           D2         IO222NDB3           D3         GAC2/IO223PDB3           D4         IO23RSB0           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D11         IO60RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO211RPDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0	С7	IO25RSB0		
C10         IO49RSB0           C11         IO56RSB0           C12         GBC0/IO72RSB0           C13         IO62RSB0           C14         VMV0           C15         IO78NDB1           C16         IO81NDB1           D1         IO222NDB3           D2         IO223NDB3           D3         GAC2/IO223PDB3           D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D11         IO60RSB0           D11         IO60RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO21TPDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0 <tr< td=""><td>C8</td><td>IO36RSB0</td></tr<>	C8	IO36RSB0		
C11         IO56RSB0           C12         GBC0/IO72RSB0           C13         IO62RSB0           C14         VMV0           C15         IO78NDB1           C16         IO81NDB1           D1         IO222NDB3           D2         IO222PDB3           D3         GAC2/IO223PDB3           D4         IO23RSB0           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D11         IO60RSB0           D11         IO60RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0	С9	IO42RSB0		
C12         GBC0/I072RSB0           C13         IO62RSB0           C14         VMV0           C15         IO78NDB1           C16         IO81NDB1           D1         IO222NDB3           D2         IO222NDB3           D3         GAC2/IO223PDB3           D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D11         IO60RSB0           D11         IO60RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/I079PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0	C10	IO49RSB0		
C13         IO62RSB0           C14         VMV0           C15         IO78NDB1           C16         IO81NDB1           D1         IO222NDB3           D2         IO222PDB3           D3         GAC2/IO223PDB3           D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D11         IO60RSB0           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO211PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0	C11	IO56RSB0		
C14         VMV0           C15         IO78NDB1           C16         IO81NDB1           D1         IO222NDB3           D2         IO222PDB3           D3         GAC2/IO223PDB3           D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D11         IO60RSB0           D11         IO60RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO2117PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E11         V <sub>CCI</sub> B0	C12	GBC0/IO72RSB0		
C15         IO78NDB1           C16         IO81NDB1           D1         IO222NDB3           D2         IO222PDB3           D3         GAC2/IO223PDB3           D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D11         IO60RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221NDB3           E4         IO221NDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E11         V <sub>CCI</sub> B0	C13	IO62RSB0		
C16         IO81NDB1           D1         IO222NDB3           D2         IO222PDB3           D3         GAC2/IO223PDB3           D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D11         IO60RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO211PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E11         V <sub>CCI</sub> B0	C14	VMV0		
D1         IO222NDB3           D2         IO222PDB3           D3         GAC2/IO223PDB3           D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO211PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E11         V <sub>CCI</sub> B0	C15	IO78NDB1		
D2         IO222PDB3           D3         GAC2/IO223PDB3           D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO21RPDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E11         V <sub>CCI</sub> B0	C16	IO81NDB1		
D3         GAC2/IO223PDB3           D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO211PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D1	IO222NDB3		
D4         IO223NDB3           D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D2	IO222PDB3		
D5         GNDQ           D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D3	GAC2/IO223PDB3		
D6         IO23RSB0           D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D4	IO223NDB3		
D7         IO29RSB0           D8         IO33RSB0           D9         IO46RSB0           D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D5	GNDQ		
D8         IO33RSB0           D9         IO46RSB0           D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D6	IO23RSB0		
D9         IO46RSB0           D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D7	IO29RSB0		
D10         IO52RSB0           D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO21RPDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D8	IO33RSB0		
D11         IO60RSB0           D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D9	IO46RSB0		
D12         GNDQ           D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D10	IO52RSB0		
D13         IO80NDB1           D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D11	IO60RSB0		
D14         GBB2/IO79PDB1           D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D12	GNDQ		
D15         IO79NDB1           D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D13	IO80NDB1		
D16         IO82NSB1           E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMVO           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0	D14	GBB2/IO79PDB1		
E1         IO217PDB3           E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	D15	IO79NDB1		
E2         IO218PDB3           E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	D16	IO82NSB1		
E3         IO221NDB3           E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	E1	IO217PDB3		
E4         IO221PDB3           E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	E2	IO218PDB3		
E5         VMV0           E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	E3	IO221NDB3		
E6         V <sub>CCI</sub> B0           E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	E4	IO221PDB3		
E7         V <sub>CCI</sub> B0           E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	E5	VMV0		
E8         IO38RSB0           E9         IO47RSB0           E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	E6	V <sub>CCI</sub> BO		
E9         IO47RSB0           E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	E7	V <sub>CCI</sub> BO		
E10         V <sub>CCI</sub> B0           E11         V <sub>CCI</sub> B0	E8	IO38RSB0		
E11 V <sub>CCI</sub> B0	E9	IO47RSB0		
	E10	V <sub>CCI</sub> BO		
E12 VMV1	E11	V <sub>CCI</sub> B0		
	E12	VMV1		

256	5-Pin FBGA*
Pin Number	A3P1000 Function
E13	GBC2/IO80PDB1
E14	IO83PPB1
E15	IO86PPB1
E16	IO87PDB1
F1	IO217NDB3
F2	IO218NDB3
F3	IO216PDB3
F4	IO216NDB3
F5	V <sub>CCI</sub> B3
F6	GND
F7	V <sub>CC</sub>
F8	V <sub>CC</sub>
F9	V <sub>CC</sub>
F10	V <sub>CC</sub>
F11	GND
F12	V <sub>CCI</sub> B1
F13	IO83NPB1
F14	IO86NPB1
F15	IO90PPB1
F16	IO87NDB1
G1	IO210PSB3
G2	IO213NDB3
G3	IO213PDB3
G4	GFC1/IO209PPB3
G5	V <sub>CCI</sub> B3
G6	V <sub>CC</sub>
G7	GND
G8	GND
G9	GND
G10	GND
G11	V <sub>CC</sub>
G12	V <sub>CCI</sub> B1
G13	GCC1/IO91PPB1
G14	IO90NPB1
G15	IO88PDB1
G16	IO88NDB1
H1	GFB0/IO208NPB3
H2	GFA0/IO207NDB3

256	256-Pin FBGA*	
Pin Number	A3P1000 Function	Pin Numbe
H3	GFB1/IO208PPB3	К9
H4	V <sub>COMPLF</sub>	K10
H5	GFC0/IO209NPB3	K11
H6	V <sub>CC</sub>	K12
H7	GND	K13
H8	GND	K14
H9	GND	K15
H10	GND	K16
H11	V <sub>CC</sub>	L1
H12	GCC0/IO91NPB1	L2
H13	GCB1/IO92PPB1	L3
H14	GCA0/IO93NPB1	L4
H15	IO96NPB1	L5
H16	GCB0/IO92NPB1	L6
J1	GFA2/IO206PSB3	L7
J2	GFA1/IO207PDB3	L8
J3	V <sub>CCPLF</sub>	L9
J4	IO205NDB3	L10
J5	GFB2/IO205PDB3	L11
J6	V <sub>CC</sub>	L12
J7	GND	L13
J8	GND	L14
J9	GND	L15
J10	GND	L16
J11	V <sub>CC</sub>	M1
J12	GCB2/IO95PPB1	M2
J13	GCA1/IO93PPB1	M3
J14	GCC2/IO96PPB1	M4
J15	IO100PPB1	M5
J16	GCA2/IO94PSB1	M6
K1	GFC2/IO204PDB3	M7
K2	IO204NDB3	M8
К3	IO203NDB3	M9
К4	IO203PDB3	M10
K5	V <sub>CCI</sub> B3	M11
K6	V <sub>CC</sub>	M12
K7	GND	M13
K8	GND	M14

256	5-Pin FBGA*	
in Number	A3P1000 Function	Р
К9	GND	
K10	GND	
K11	V <sub>CC</sub>	
K12	V <sub>CCI</sub> B1	
K13	IO95NPB1	
K14	IO100NPB1	
K15	IO102NDB1	
K16	IO102PDB1	
L1	IO202NDB3	
L2	IO202PDB3	
L3	IO196PPB3	
L4	IO193PPB3	[
L5	V <sub>CCI</sub> B3	
L6	GND	
L7	V <sub>CC</sub>	
L8	V <sub>CC</sub>	
L9	V <sub>CC</sub>	
L10	V <sub>CC</sub>	
L11	GND	
L12	V <sub>CCI</sub> B1	
L13	GDB0/IO112NPB1	
L14	IO106NDB1	
L15	IO106PDB1	
L16	IO107PDB1	
M1	IO197NSB3	
M2	IO196NPB3	
M3	IO193NPB3	
M4	GEC0/IO190NPB3	
M5	VMV3	
M6	V <sub>CCI</sub> B2	
M7	V <sub>CCI</sub> B2	
M8	IO147RSB2	
M9	IO136RSB2	
M10	V <sub>CCI</sub> B2	[
M11	V <sub>CCI</sub> B2	[
M12	VMV2	[
M13	IO110NDB1	
M14	GDB1/IO112PPB1	[
M14 " section on pa		

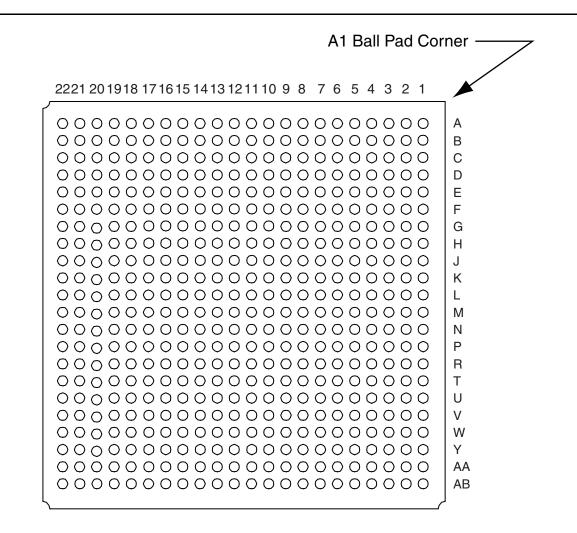
25	6-Pin FBGA*
Pin Number	A3P1000 Function
M15	GDC1/IO111PDB1
M16	IO107NDB1
N1	IO194PSB3
N2	IO192PPB3
N3	GEC1/IO190PPB3
N4	IO192NPB3
N5	GNDQ
N6	GEA2/IO187RSB2
N7	IO161RSB2
N8	IO155RSB2
N9	IO141RSB2
N10	IO129RSB2
N11	IO124RSB2
N12	GNDQ
N13	IO110PDB1
N14	V <sub>JTAG</sub>
N15	GDC0/IO111NDB1
N16	GDA1/IO113PDB1
P1	GEB1/IO189PDB3
P2	GEB0/IO189NDB3
Р3	VMV2
P4	IO179RSB2
P5	IO171RSB2
P6	IO165RSB2
P7	IO159RSB2
P8	IO151RSB2
P9	IO137RSB2
P10	IO134RSB2
P11	IO128RSB2
P12	VMV1
P13	ТСК
P14	V <sub>PUMP</sub>
P15	TRST
P16	GDA0/IO113NDB1
R1	GEA1/IO188PDB3
R2	GEA0/IO188NDB3
R3	IO184RSB2
R4	GEC2/IO185RSB2



256	5-Pin FBGA*
Pin Number	A3P1000 Function
R5	IO168RSB2
R6	IO163RSB2
R7	IO157RSB2
R8	IO149RSB2
R9	IO143RSB2
R10	IO138RSB2
R11	IO131RSB2
R12	IO125RSB2
R13	GDB2/IO115RSB2
R14	TDI
R15	GNDQ
R16	TDO
T1	GND
T2	IO183RSB2
T3	GEB2/IO186RSB2
T4	IO172RSB2
T5	IO170RSB2
T6	IO164RSB2
T7	IO158RSB2
T8	IO153RSB2
Т9	IO142RSB2
T10	IO135RSB2
T11	IO130RSB2
T12	GDC2/IO116RSB2
T13	IO120RSB2
T14	GDA2/IO114RSB2
T15	TMS
T16	GND

**Note:** \*Refer to the "User I/O Naming Convention" section on page 2-46.

# 484-Pin FBGA



#### Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.actel.com/products/rescenter/package/index.html.

ProASIC3 Flash Family FPGAs	

484-Pin FBGA*		
Pin Number	A3P400 Function	Pin
A1	GND	
A2	GND	
A3	V <sub>CCI</sub> B0	
A4	NC	
A5	NC	
A6	IO13RSB0	
A7	IO17RSB0	
A8	NC	
A9	NC	
A10	IO23RSB0	
A11	IO29RSB0	
A12	IO34RSB0	
A13	IO36RSB0	
A14	NC	
A15	NC	-
A16	IO45RSB0	
A17	IO47RSB0	
A18	NC	
A19	NC	-
A20	V <sub>CCI</sub> B0	
A21	GND	
A22	GND	
B1	GND	
B2	V <sub>CCI</sub> B3	
B3	NC	
B4	NC	
B5	NC	
B6	NC	
Β7	NC	
B8	NC	
B9	NC	
B10	NC	
B11	NC	
B12	NC	
B13	NC	
B14	NC	

484-P	in FBGA*
Pin Number	A3P400 Function
B15	NC
B16	NC
B17	NC
B18	NC
B19	NC
B20	NC
B21	V <sub>CCI</sub> B1
B22	GND
C1	V <sub>CCI</sub> B3
C2	NC
С3	NC
C4	NC
C5	GND
C6	NC
С7	NC
C8	V <sub>CC</sub>
С9	V <sub>CC</sub>
C10	NC
C11	NC
C12	NC
C13	NC
C14	V <sub>CC</sub>
C15	V <sub>CC</sub>
C16	NC
C17	NC
C18	GND
C19	NC
C20	NC
C21	NC
C22	V <sub>CCI</sub> B1
D1	NC
D2	NC
D3	NC
D4	GND
D5	GAA0/IO00RSB0
D6	GAA1/IO01RSB0

484-Pi	in FBGA*
Pin Number	A3P400 Function
D7	GAB0/IO02RSB0
D8	IO14RSB0
D9	IO18RSB0
D10	IO22RSB0
D11	IO27RSB0
D12	IO30RSB0
D13	IO39RSB0
D14	IO41RSB0
D15	IO46RSB0
D16	GBB1/IO57RSB0
D17	GBA0/IO58RSB0
D18	GBA1/IO59RSB0
D19	GND
D20	NC
D21	NC
D22	NC
E1	NC
E2	NC
E3	GND
E4	GAB2/IO154PDB3
E5	GAA2/IO155PPB3
E6	IO10RSB0
E7	GAB1/IO03RSB0
E8	IO12RSB0
E9	IO16RSB0
E10	IO21RSB0
E11	IO26RSB0
E12	IO31RSB0
E13	IO37RSB0
E14	IO42RSB0
E15	GBC1/IO55RSB0
E16	GBB0/IO56RSB0
E17	IO48RSB0
E18	GBA2/IO60PPB1
E19	IO50RSB0
E20	GND

484-P	in FBGA*	484-P	in FBGA*
Pin Number	A3P400 Function	Pin Number	A3P400 Function
E21	NC	G13	IO40RSB0
E22	NC	G14	IO43RSB0
F1	NC	G15	GNDQ
F2	NC	G16	IO49RSB0
F3	NC	G17	GBB2/IO61PDB1
F4	IO154NDB3	G18	IO63NDB1
F5	IO08RSB0	G19	IO64NDB1
F6	IO07RSB0	G20	NC
F7	IO06RSB0	G21	NC
F8	GAC0/IO04RSB0	G22	NC
F9	GAC1/IO05RSB0	H1	NC
F10	IO20RSB0	H2	NC
F11	IO25RSB0	H3	V <sub>CC</sub>
F12	IO32RSB0	H4	IO151PDB3
F13	IO38RSB0	H5	IO152PPB3
F14	IO44RSB0	H6	IO153NDB3
F15	GBC0/IO54RSB0	H7	IO11RSB0
F16	IO51RSB0	H8	VMV0
F17	IO52RSB0	Н9	V <sub>CCI</sub> B0
F18	IO53RSB0	H10	V <sub>CCI</sub> B0
F19	IO60NPB1	H11	IO28RSB0
F20	NC	H12	IO35RSB0
F21	NC	H13	V <sub>CCI</sub> B0
F22	NC	H14	V <sub>CCI</sub> B0
G1	NC	H15	VMV1
G2	NC	H16	GBC2/IO62PDB1
G3	NC	H17	IO61NDB1
G4	IO152NPB3	H18	IO63PDB1
G5	IO155NPB3	H19	IO64PDB1
G6	GAC2/IO153PDB3	H20	V <sub>CC</sub>
G7	IO09RSB0	H21	NC
G8	GNDQ	H22	NC
G9	IO15RSB0	J1	NC
G10	IO19RSB0	J2	NC
G11	IO24RSB0	13	NC
G12	IO33RSB0	J4	IO151NDB3

**Pin Number** A3P400 Function J5 IO150PPB3 J6 NC IO148PPB3 J7 J8 V<sub>CCI</sub>B3 J9 GND J10  $V_{CC}$ J11  $V_{CC}$  $\mathsf{V}_{\mathsf{C}\mathsf{C}}$ J12 J13  $V_{CC}$ J14 GND J15 V<sub>CCI</sub>B1 J16 IO62NDB1 J17 NC IO65RSB1 J18 J19 IO73NDB1 J20 NC J21 NC J22 NC Κ1 NC K2 NC NC K3 Κ4 IO150NPB3 Κ5 IO149PDB3 IO149NDB3 Κ6 Κ7 GFC1/IO147PPB3 K8 V<sub>CCI</sub>B3 К9  $V_{CC}$ GND K10 K11 GND GND K12 K13 GND K14  $V_{CC}$ K15 V<sub>CCI</sub>B1 K16 GCC1/IO67PPB1 K17 IO66NDB1 K18 IO66PDB1

484-Pin FBGA\*

ProASIC3 Flash Family FPGAs

484-Pin FBGA*	
Pin Number	A3P400 Function
K19	IO73PDB1
K20	NC
K21	NC
K22	NC
L1	NC
L2	NC
L3	NC
L4	GFB0/IO146NPB3
L5	GFA0/IO145NDB3
L6	GFB1/IO146PPB3
L7	V <sub>COMPLF</sub>
L8	GFC0/IO147NPB3
L9	V <sub>CC</sub>
L10	GND
L11	GND
L12	GND
L13	GND
L14	V <sub>CC</sub>
L15	GCC0/IO67NPB1
L16	GCB1/IO68PPB1
L17	GCA0/IO69NPB1
L18	NC
L19	GCB0/IO68NPB1
L20	NC
L21	NC
L22	NC
M1	NC
M2	NC
M3	NC
M4	GFA2/IO144PPB3
M5	GFA1/IO145PDB3
M6	V <sub>CCPLF</sub>
M7	IO148NPB3
M8	GFB2/IO143PPB3
M9	V <sub>CC</sub>
M10	GND

484-Pi	n FBGA*
Pin Number	A3P400 Function
M11	GND
M12	GND
M13	GND
M14	V <sub>CC</sub>
M15	GCB2/IO71PPB1
M16	GCA1/IO69PPB1
M17	GCC2/IO72PDB1
M18	NC
M19	GCA2/IO70PDB1
M20	NC
M21	NC
M22	NC
N1	NC
N2	NC
N3	NC
N4	GFC2/IO142PDB3
N5	IO144NPB3
N6	IO143NPB3
N7	IO138PDB3
N8	V <sub>CCI</sub> B3
N9	V <sub>CC</sub>
N10	GND
N11	GND
N12	GND
N13	GND
N14	V <sub>CC</sub>
N15	V <sub>CCI</sub> B1
N16	IO71NPB1
N17	IO72NDB1
N18	IO74RSB1
N19	IO70NDB1
N20	NC
N21	NC
N22	NC
P1	NC
P2	NC
on" section on page 2	2-46

484-P	in FBGA*
Pin Number	A3P400 Function
РЗ	NC
P4	IO142NDB3
P5	IO140NDB3
P6	IO139RSB3
P7	IO138NDB3
P8	V <sub>CCI</sub> B3
P9	GND
P10	V <sub>CC</sub>
P11	V <sub>CC</sub>
P12	V <sub>CC</sub>
P13	V <sub>CC</sub>
P14	GND
P15	V <sub>CCI</sub> B1
P16	GDB0/IO78NPB1
P17	IO75NDB1
P18	IO75PDB1
P19	IO76PDB1
P20	NC
P21	NC
P22	NC
R1	NC
R2	NC
R3	V <sub>CC</sub>
R4	IO141NDB3
R5	IO140PDB3
R6	IO127RSB2
R7	GEC0/IO137NPB3
R8	VMV3
R9	V <sub>CCI</sub> B2
R10	V <sub>CCI</sub> B2
R11	IO106RSB2
R12	IO99RSB2
R13	V <sub>CCI</sub> B2
R14	V <sub>CCI</sub> B2
R15	VMV2
R16	IO85RSB2

484-Pin FBGA* 44		484-
Pin Number	A3P400 Function	Pin Number
R17	GDB1/IO78PPB1	U9
R18	GDC1/IO77PDB1	U10
R19	IO76NDB1	U11
R20	V <sub>CC</sub>	U12
R21	NC	U13
R22	NC	U14
T1	NC	U15
T2	NC	U16
Т3	NC	U17
T4	IO141PDB3	U18
T5	IO131RSB2	U19
T6	GEC1/IO137PPB3	U20
T7	IO128RSB2	U21
T8	GNDQ	U22
Т9	GEA2/IO134RSB2	V1
T10	IO113RSB2	V2
T11	IO109RSB2	V3
T12	IO100RSB2	V4
T13	IO95RSB2	V5
T14	IO90RSB2	V6
T15	GNDQ	V7
T16	IO83RSB2	V8
T17	V <sub>JTAG</sub>	V9
T18	GDC0/IO77NDB1	V10
T19	GDA1/IO79PDB1	V11
T20	NC	V12
T21	NC	V13
T22	NC	V14
U1	NC	V15
U2	NC	V16
U3	NC	V17
U4	GEB1/IO136PDB3	V18
U5	GEB0/IO136NDB3	V19
U6	IO130RSB2	V20
U7	IO129RSB2	V21
U8	IO126RSB2	V22

-Pin FBGA\* A3P400 Function IO121RSB2 IO115RSB2 IO108RSB2 IO101RSB2 IO94RSB2 IO88RSB2 IO84RSB2 TCK V<sub>PUMP</sub> TRST GDA0/IO79NDB1 NC NC NC NC NC GND GEA1/IO135PDB3 GEA0/IO135NDB3 IO125RSB2 GEC2/IO132RSB2 IO122RSB2 IO118RSB2 IO112RSB2 IO107RSB2 IO102RSB2 IO96RSB2 IO91RSB2 IO87RSB2 GDB2/IO81RSB2 TDI NC TDO GND NC NC

484-Pi	n FBGA*
Pin Number	A3P400 Function
W1	NC
W2	NC
W3	NC
W4	GND
W5	IO124RSB2
W6	GEB2/IO133RSB2
W7	IO123RSB2
W8	IO120RSB2
W9	IO116RSB2
W10	IO111RSB2
W11	IO105RSB2
W12	IO103RSB2
W13	IO97RSB2
W14	IO93RSB2
W15	GDC2/IO82RSB2
W16	IO86RSB2
W17	GDA2/IO80RSB2
W18	TMS
W19	GND
W20	NC
W21	NC
W22	NC
Y1	V <sub>CCI</sub> B3
Y2	NC
Y3	NC
Y4	NC
Y5	GND
Y6	NC
Y7	NC
Y8	V <sub>CC</sub>
Y9	V <sub>CC</sub>
Y10	NC
Y11	NC
Y12	NC
Y13	NC
Y14	V <sub>CC</sub>



484-P	in FBGA*
Pin Number	A3P400 Function
Y15	V <sub>CC</sub>
Y16	NC
Y17	NC
Y18	GND
Y19	NC
Y20	NC
Y21	NC
Y22	V <sub>CCI</sub> B1
AA1	GND
AA2	V <sub>CCI</sub> B3
AA3	NC
AA4	NC
AA5	NC
AA6	NC
AA7	NC
AA8	NC
AA9	NC
AA10	NC
AA11	NC
AA12	NC
AA13	NC
AA14	NC
AA15	NC
AA16	NC
AA17	NC
AA18	NC
AA19	NC
AA20	NC
AA21	V <sub>CCI</sub> B1
AA22	GND
AB1	GND
AB2	GND
AB3	V <sub>CCI</sub> B2
AB4	NC
AB5	NC
AB6	IO119RSB2
Авр	IOT TAK2R5

484-Pi	n FBGA*
Pin Number	A3P400 Function
AB7	IO117RSB2
AB8	IO114RSB2
AB9	IO110RSB2
AB10	NC
AB11	NC
AB12	IO104RSB2
AB13	IO98RSB2
AB14	NC
AB15	NC
AB16	IO92RSB2
AB17	IO89RSB2
AB18	NC
AB19	NC
AB20	V <sub>CCI</sub> B2
AB21	GND
AB22	GND

484-P	484-Pin FBGA*	
Pin Number	A3P600 Function	Pin Number
A1	GND	B15
A2	GND	B16
A3	V <sub>CCI</sub> B0	B17
A4	NC	B18
A5	NC	B19
A6	IO08RSB0	B20
A7	IO09RSB0	B21
A8	NC	B22
A9	NC	C1
A10	IO21RSB0	C2
A11	IO23RSB0	C3
A12	IO27RSB0	C4
A13	IO28RSB0	C5
A14	NC	C6
A15	NC	C7
A16	IO35RSB0	C8
A17	IO45RSB0	С9
A18	NC	C10
A19	NC	C11
A20	V <sub>CCI</sub> B0	C12
A21	GND	C13
A22	GND	C14
B1	GND	C15
B2	V <sub>CCI</sub> B3	C16
B3	NC	C17
B4	NC	C18
B5	NC	C19
B6	IO07RSB0	C20
B7	IO11RSB0	C21
B8	NC	C22
B9	NC	D1
B10	IO20RSB0	D2
B11	NC	D3
B12	NC	D4
B13	IO34RSB0	D5
B14	NC	D6

-Pin FBGA\* 484-Pin FBGA\* A3P600 Function **Pin Number** NC D7 IO44RSB0 D8 IO48RSB0 D9 NC D10 NC D11 NC D12 V<sub>CCI</sub>B1 D13 GND D14 D15 V<sub>CCI</sub>B3 NC D16 NC D17 NC D18 GND D19 NC D20 NC D21  $V_{CC}$ D22  $V_{CC}$ E1 NC E2 NC E3 NC E4 NC E5  $V_{CC}$ E6  $V_{CC}$ E7 NC E8 NC E9 GND E10 NC E11 NC E12 NC E13 E14 V<sub>CCI</sub>B1 NC E15 NC E16 NC E17 GND E18 GAA0/IO00RSB0 E19 GAA1/IO01RSB0 E20

A3P600 Function GAB0/IO02RSB0 IO12RSB0 IO14RSB0 IO19RSB0 IO26RSB0 IO31RSB0 IO37RSB0 IO41RSB0 IO47RSB0 GBB1/IO57RSB0 GBA0/IO58RSB0 GBA1/IO59RSB0 GND NC NC NC NC NC GND GAB2/IO169PDB3 GAA2/IO170PDB3 GNDQ GAB1/IO03RSB0 IO10RSB0 IO15RSB0 IO18RSB0 IO24RSB0 IO32RSB0 IO40RSB0 IO43RSB0 GBC1/IO55RSB0 GBB0/IO56RSB0 IO49RSB0 GBA2/IO60PDB1 IO60NDB1 GND

ProASIC3 Flash Family FPGAs

484-P	484-Pin FBGA*	
Pin Number	A3P600 Function	
E21	NC	
E22	NC	
F1	NC	
F2	NC	
F3	NC	
F4	IO169NDB3	
F5	IO170NDB3	
F6	VMV3	
F7	IO06RSB0	
F8	GAC0/IO04RSB0	
F9	GAC1/IO05RSB0	
F10	IO17RSB0	
F11	IO25RSB0	
F12	IO33RSB0	
F13	IO38RSB0	
F14	IO42RSB0	
F15	GBC0/IO54RSB0	
F16	IO52RSB0	
F17	IO51RSB0	
F18	IO50RSB0	
F19	IO61NPB1	
F20	NC	
F21	NC	
F22	NC	
G1	IO163NDB3	
G2	IO163PDB3	
G3	NC	
G4	IO166NDB3	
G5	IO166PDB3	
G6	GAC2/IO168PDB3	
G7	IO168NDB3	
G8	GNDQ	
G9	IO13RSB0	
G10	IO16RSB0	
G11	IO22RSB0	
G12	IO36RSB0	

Pin Number         A3P600 Function           G13         IO39RSB0           G14         IO46RSB0           G15         GNDQ           G16         IO53RSB0           G17         GBB2/IO61PPB1           G18         IO63PPB1           G19         IO65PDB1           G20         NC           G21         NC           G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO167NDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H6         GBC2/IO62PDB1           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20	484-Pi	n FBGA*
G14         IO46RSB0           G15         GNDQ           G16         IO53RSB0           G17         GBB2/IO61PPB1           G18         IO63PPB1           G19         IO65PDB1           G20         NC           G21         NC           G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H19         IO65NDB1           H19         IO65NDB1           H19         IO65NDB1           H12         NC           H13         IO64PPB1           H19         IO	Pin Number	A3P600 Function
G15         GNDQ           G16         IO53RSB0           G17         GBB2/IO61PPB1           G18         IO63PPB1           G19         IO65PDB1           G20         NC           G21         NC           G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H19         IO65NDB1           H19         IO65NDB1           H19         IO65NDB1           H19         IO65NDB1           H19         IO65NDB1           H20	G13	IO39RSB0
G16         IO53RSB0           G17         GBB2/IO61PPB1           G18         IO63PPB1           G19         IO65PDB1           G20         NC           G21         NC           G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165PDB3           H5         IO165PDB3           H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H6         GBC2/IO62PDB1           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> J1         IO153PDB3           J2	G14	IO46RSB0
G17         GBB2/IO61PPB1           G18         IO63PPB1           G19         IO65PDB1           G20         NC           G21         NC           G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H19         IO65NDB1           H19         IO65NDB1           H19         IO65NDB1           H12         NC           H13         IO44PPB1           IO153PDB3         J2           J1         IO153PDB3	G15	GNDQ
G18         IO63PPB1           G19         IO65PDB1           G20         NC           G21         NC           G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H19         IO65NDB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           J1         IO153PDB3           J2         IO154NDB3	G16	IO53RSB0
G19         IO65PDB1           G20         NC           G21         NC           G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	G17	GBB2/IO61PPB1
G20         NC           G21         NC           G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H19         IO65NDB1           H12         NC           H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	G18	IO63PPB1
G21         NC           G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167NDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H19         IO65NDB1           H12         NC           H13         V <sub>CC</sub>	G19	IO65PDB1
G22         NC           H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167NDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H12         NC           H13         V <sub>CC</sub> H14         V <sub>CCI</sub> B0	G20	NC
H1         NC           H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	G21	NC
H2         NC           H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H12         NC           H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	G22	NC
H3         V <sub>CC</sub> H4         IO165NDB3           H5         IO165PDB3           H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H12         NC           H13         V <sub>CCI</sub> B0	H1	NC
H4         IO165NDB3           H5         IO165PDB3           H6         IO167NDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H12         NC           H13         V <sub>CC</sub> H14         IO63NPB1           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H2	NC
H5         IO165PDB3           H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H10         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H3	V <sub>CC</sub>
H6         IO167PDB3           H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H10         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H4	IO165NDB3
H7         IO167NDB3           H8         VMV0           H9         V <sub>CCI</sub> B0           H10         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H5	IO165PDB3
H8         VMV0           H9         V <sub>CCI</sub> B0           H10         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           J1         IO153PDB3           J2         IO154NDB3	H6	IO167PDB3
H9         V <sub>CCI</sub> B0           H10         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H7	IO167NDB3
H10         V <sub>CCI</sub> B0           H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H8	VMV0
H11         IO29RSB0           H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H9	V <sub>CCI</sub> B0
H12         IO30RSB0           H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H10	V <sub>CCI</sub> B0
H13         V <sub>CCI</sub> B0           H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H11	IO29RSB0
H14         V <sub>CCI</sub> B0           H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H12	IO30RSB0
H15         VMV1           H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H13	V <sub>CCI</sub> B0
H16         GBC2/IO62PDB1           H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H14	V <sub>CCI</sub> B0
H17         IO63NPB1           H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H15	VMV1
H18         IO64PPB1           H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H16	GBC2/IO62PDB1
H19         IO65NDB1           H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H17	IO63NPB1
H20         V <sub>CC</sub> H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H18	IO64PPB1
H21         NC           H22         NC           J1         IO153PDB3           J2         IO154NDB3	H19	IO65NDB1
H22         NC           J1         IO153PDB3           J2         IO154NDB3	H20	V <sub>CC</sub>
J1         IO153PDB3           J2         IO154NDB3	H21	NC
J2 IO154NDB3	H22	NC
	J1	IO153PDB3
J3 NC	J2	IO154NDB3
	J3	NC
J4 IO154PDB3	J4	IO154PDB3

484-Pi	n FBGA*
Pin Number	A3P600 Function
J5	IO162PPB3
J6	IO164PDB3
J7	IO164NDB3
J8	V <sub>CCI</sub> B3
J9	GND
J10	V <sub>CC</sub>
J11	V <sub>CC</sub>
J12	V <sub>CC</sub>
J13	V <sub>CC</sub>
J14	GND
J15	V <sub>CCI</sub> B1
J16	IO62NDB1
J17	IO64NPB1
J18	IO66PPB1
J19	IO67PPB1
J20	NC
J21	IO74PDB1
J22	IO74NDB1
K1	IO153NDB3
K2	NC
К3	NC
K4	IO155NDB3
K5	IO155PDB3
K6	IO162NPB3
K7	GFC1/IO161PPB3
K8	V <sub>CCI</sub> B3
К9	V <sub>CC</sub>
К10	GND
K11	GND
K12	GND
K13	GND
K14	V <sub>CC</sub>
K15	V <sub>CCI</sub> B1
K16	GCC1/IO68PPB1
K17	IO66NPB1
K18	IO67NPB1

484-Pin FBGA*	
Pin Number	A3P600 Function
K19	IO71NPB1
K20	NC
K21	NC
K22	IO75PDB1
L1	NC
L2	IO152PDB3
L3	NC
L4	GFB0/IO160NPB3
L5	GFA0/IO159NDB3
L6	GFB1/IO160PPB3
L7	V <sub>COMPLF</sub>
L8	GFC0/IO161NPB3
L9	V <sub>CC</sub>
L10	GND
L11	GND
L12	GND
L13	GND
L14	V <sub>CC</sub>
L15	GCC0/IO68NPB1
L16	GCB1/IO69PPB1
L17	GCA0/IO70NPB1
L18	IO73NPB1
L19	GCB0/IO69NPB1
L20	NC
L21	NC
L22	IO75NDB1
M1	NC
M2	IO152NDB3
M3	NC
M4	GFA2/IO158PPB3
M5	GFA1/IO159PDB3
M6	V <sub>CCPLF</sub>
M7	IO157NDB3
M8	GFB2/IO157PDB3
M9	V <sub>CC</sub>
M10	GND

484-P	484-Pin FBGA*	
Pin Number A3P600 Function		
M11	GND	
M12	GND	
M13	GND	
M14	V <sub>CC</sub>	
M15	GCB2/IO72PPB1	
M16	GCA1/IO70PPB1	
M17	GCC2/IO73PPB1	
M18	IO77PPB1	
M19	GCA2/IO71PPB1	
M20	NC	
M21	IO76PDB1	
M22	NC	
N1	IO150PPB3	
N2	NC	
N3	NC	
N4	GFC2/IO156PPB3	
N5	IO158NPB3	
N6	IO151PDB3	
N7	IO151NDB3	
N8	V <sub>CCI</sub> B3	
N9	V <sub>CC</sub>	
N10	GND	
N11	GND	
N12	GND	
N13	GND	
N14	V <sub>CC</sub>	
N15	V <sub>CCI</sub> B1	
N16	IO72NPB1	
N17	IO82PDB1	
N18	IO79PDB1	
N19	IO77NPB1	
N20	NC	
N21	IO76NDB1	
N22	NC	
P1	NC	
P2	IO150NPB3	

484-Pin FBGA*	
Pin Number A3P600 Funct	
РЗ	NC
P4	IO149PDB3
Р5	IO156NPB3
P6	IO147PDB3
P7	IO147NDB3
P8	V <sub>CCI</sub> B3
Р9	GND
P10	V <sub>CC</sub>
P11	V <sub>CC</sub>
P12	V <sub>CC</sub>
P13	V <sub>CC</sub>
P14	GND
P15	V <sub>CCI</sub> B1
P16	GDB0/IO85NPB1
P17	IO82NDB1
P18	IO79NDB1
P19	IO80PDB1
P20	NC
P21	NC
P22	IO78PDB1
R1	NC
R2	IO148PDB3
R3	V <sub>CC</sub>
R4	IO149NDB3
R5	IO146PDB3
R6	IO146NDB3
R7	GEC0/IO144NPB3
R8	VMV3
R9	V <sub>CCI</sub> B2
R10	V <sub>CCI</sub> B2
R11	IO111RSB2
R12	IO110RSB2
R13	V <sub>CCI</sub> B2
R14	V <sub>CCI</sub> B2
R15	VMV2
R16	IO81NDB1

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484-Pin FBGA*	
Pin Number	A3P600 Function
R17	GDB1/IO85PPB1
R18	GDC1/IO84PDB1
R19	IO80NDB1
R20	V <sub>CC</sub>
R21	IO83PDB1
R22	IO78NDB1
T1	NC
T2	IO148NDB3
T3	NC
T4	IO145PDB3
T5	IO145NDB3
T6	GEC1/IO144PPB3
T7	IO137RSB2
T8	GNDQ
Т9	GEA2/IO141RSB2
T10	IO120RSB2
T11	IO113RSB2
T12	IO106RSB2
T13	IO99RSB2
T14	IO94RSB2
T15	GNDQ
T16	IO81PDB1
T17	V <sub>JTAG</sub>
T18	GDC0/IO84NDB1
T19	GDA1/IO86PDB1
T20	NC
T21	IO83NDB1
T22	NC
U1	NC
U2	NC
U3	NC
U4	GEB1/IO143PDB3
U5	GEB0/IO143NDB3
U6	IO138RSB2
U7	IO135RSB2
U8	IO134RSB2

484-Pi	484-Pin FBGA*	
Pin Number	A3P600 Function	
U9	IO128RSB2	
U10	IO121RSB2	
U11	IO115RSB2	
U12	IO108RSB2	
U13	IO100RSB2	
U14	IO95RSB2	
U15	VMV1	
U16	ТСК	
U17	V <sub>PUMP</sub>	
U18	TRST	
U19	GDA0/IO86NDB1	
U20	NC	
U21	NC	
U22	NC	
V1	NC	
V2	NC	
V3	GND	
V4	GEA1/IO142PDB3	
V5	GEA0/IO142NDB3	
V6	IO136RSB2	
V7	GEC2/IO139RSB2	
V8	IO130RSB2	
V9	IO125RSB2	
V10	IO119RSB2	
V11	IO114RSB2	
V12	IO107RSB2	
V13	IO101RSB2	
V14	IO96RSB2	
V15	IO90RSB2	
V16	GDB2/IO88RSB2	
V17	TDI	
V18	GNDQ	
V19	TDO	
V20	GND	
V21	NC	
V22	NC	
ion" section on page 2	2-46.	

484-Pin FBGA*	
Pin Number	A3P600 Function
W1	NC
W2	NC
W3	NC
W4	GND
W5	IO133RSB2
W6	GEB2/IO140RSB2
W7	IO132RSB2
W8	IO127RSB2
W9	IO123RSB2
W10	IO117RSB2
W11	IO112RSB2
W12	IO109RSB2
W13	IO102RSB2
W14	IO97RSB2
W15	GDC2/IO89RSB2
W16	IO91RSB2
W17	GDA2/IO87RSB2
W18	TMS
W19	GND
W20	NC
W21	NC
W22	NC
Y1	V <sub>CCI</sub> B3
Y2	NC
Y3	NC
Y4	NC
Y5	GND
Y6	NC
Y7	NC
Y8	V <sub>CC</sub>
Y9	V <sub>CC</sub>
Y10	NC
Y11	NC
Y12	NC
Y13	NC
Y14	V <sub>CC</sub>

484-Pin FBGA*	
Pin Number	A3P600 Function
Y15	V <sub>CC</sub>
Y16	NC
Y17	NC
Y18	GND
Y19	NC
Y20	NC
Y21	NC
Y22	V <sub>CCI</sub> B1
AA1	GND
AA2	V <sub>CCI</sub> B3
AA3	NC
AA4	NC
AA5	NC
AA6	IO131RSB2
AA7	IO126RSB2
AA8	NC
AA9	NC
AA10	IO116RSB2
AA11	NC
AA12	NC
AA13	IO103RSB2
AA14	NC
AA15	NC
AA16	IO93RSB2
AA17	NC
AA18	NC
AA19	NC
AA20	NC
AA21	V <sub>CCI</sub> B1
AA22	GND
AB1	GND
AB2	GND
AB3	V <sub>CCI</sub> B2
AB4	NC
AB5	NC
AB6	IO129RSB2

484-Pin FBGA*	
Pin Number	A3P600 Function
AB7	IO124RSB2
AB8	IO122RSB2
AB9	IO118RSB2
AB10	NC
AB11	NC
AB12	IO105RSB2
AB13	IO104RSB2
AB14	NC
AB15	NC
AB16	IO98RSB2
AB17	IO92RSB2
AB18	NC
AB19	NC
AB20	V <sub>CCI</sub> B2
AB21	GND
AB22	GND

48	484-Pin FBGA*	
Pin Number	A3P1000 Function	
A1	GND	
A2	GND	
A3	V <sub>CCI</sub> B0	
A4	IO07RSB0	
A5	IO09RSB0	
A6	IO13RSB0	
A7	IO18RSB0	
A8	IO20RSB0	
A9	IO26RSB0	
A10	IO32RSB0	
A11	IO40RSB0	
A12	IO41RSB0	
A13	IO53RSB0	
A14	IO59RSB0	
A15	IO64RSB0	
A16	IO65RSB0	
A17	IO67RSB0	
A18	IO69RSB0	
A19	NC	
A20	V <sub>CCI</sub> B0	
A21	GND	
A22	GND	
AA1	GND	
AA2	V <sub>CCI</sub> B3	
AA3	NC	
AA4	IO181RSB2	
AA5	IO178RSB2	
AA6	IO175RSB2	
AA7	IO169RSB2	
AA8	IO166RSB2	
AA9	IO160RSB2	
AA10	IO152RSB2	
AA11	IO146RSB2	
AA12	IO139RSB2	
AA13	IO133RSB2	

484-Pin FBGA*	
Pin Number	A3P1000 Function
AA14	NC
AA15	NC
AA16	IO122RSB2
AA17	IO119RSB2
AA18	IO117RSB2
AA19	NC
AA20	NC
AA21	V <sub>CCI</sub> B1
AA22	GND
AB1	GND
AB2	GND
AB3	V <sub>CCI</sub> B2
AB4	IO180RSB2
AB5	IO176RSB2
AB6	IO173RSB2
AB7	IO167RSB2
AB8	IO162RSB2
AB9	IO156RSB2
AB10	IO150RSB2
AB11	IO145RSB2
AB12	IO144RSB2
AB13	IO132RSB2
AB14	IO127RSB2
AB15	IO126RSB2
AB16	IO123RSB2
AB17	IO121RSB2
AB18	IO118RSB2
AB19	NC
AB20	V <sub>CCI</sub> B2
AB21	GND
AB22	GND
B1	GND
B2	V <sub>CCI</sub> B3
B3	NC
B4	IO06RSB0

484-Pin FBGA*		
Pin Number A3P1000 Function		
B5	IO08RSB0	
B6	IO12RSB0	
B7	IO15RSB0	
B8	IO19RSB0	
B9	IO24RSB0	
B10	IO31RSB0	
B11	IO39RSB0	
B12	IO48RSB0	
B13	IO54RSB0	
B14	IO58RSB0	
B15	IO63RSB0	
B16	IO66RSB0	
B17	IO68RSB0	
B18	IO70RSB0	
B19	NC	
B20	NC	
B21	V <sub>CCI</sub> B1	
B22	GND	
C1	V <sub>CCI</sub> B3	
C2	IO220PDB3	
С3	NC	
C4	NC	
C5	GND	
C6	IO10RSB0	
С7	IO14RSB0	
C8	V <sub>CC</sub>	
С9	V <sub>CC</sub>	
C10	IO30RSB0	
C11	IO37RSB0	
C12	IO43RSB0	
C13	NC	
C14	V <sub>CC</sub>	
C15	V <sub>CC</sub>	
C16	NC	
C17	NC	

484-Pin FBGA*	
Pin Number	A3P1000 Function
C18	GND
C19	NC
C20	NC
C21	NC
C22	V <sub>CCI</sub> B1
D1	IO219PDB3
D2	IO220NDB3
D3	NC
D4	GND
D5	GAA0/IO00RSB0
D6	GAA1/IO01RSB0
D7	GAB0/IO02RSB0
D8	IO16RSB0
D9	IO22RSB0
D10	IO28RSB0
D11	IO35RSB0
D12	IO45RSB0
D13	IO50RSB0
D14	IO55RSB0
D15	IO61RSB0
D16	GBB1/IO75RSB0
D17	GBA0/IO76RSB0
D18	GBA1/IO77RSB0
D19	GND
D20	NC
D21	NC
D22	NC
E1	IO219NDB3
E2	NC
E3	GND
E4	GAB2/IO224PDB3
E5	GAA2/IO225PDB3
E6	GNDQ
E7	GAB1/IO03RSB0
E8	IO17RSB0

484-Pin FBGA*		
Pin Number	A3P1000 Function	
E9		
-	IO21RSB0	
E10		
E11	IO34RSB0	
E12	IO44RSB0	
E13	IO51RSB0	
E14	IO57RSB0	
E15	GBC1/IO73RSB0	
E16	GBB0/IO74RSB0	
E17	IO71RSB0	
E18	GBA2/IO78PDB1	
E19	IO81PDB1	
E20	GND	
E21	NC	
E22	IO84PDB1	
F1	NC	
F2	IO215PDB3	
F3	IO215NDB3	
F4	IO224NDB3	
F5	IO225NDB3	
F6	VMV3	
F7	IO11RSB0	
F8	GAC0/IO04RSB0	
F9	GAC1/IO05RSB0	
F10	IO25RSB0	
F11	IO36RSB0	
F12	IO42RSB0	
F13	IO49RSB0	
F14	IO56RSB0	
F15	GBC0/IO72RSB0	
F16	IO62RSB0	
F17	VMV0	
F18	IO78NDB1	
F19	IO81NDB1	
F20	IO82PPB1	
F21	NC	
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484-Pin FBGA*		
Pin Number	A3P1000 Function	
F22	IO84NDB1	
G1	IO214NDB3	
G2	IO214PDB3	
G3	NC	
G4	IO222NDB3	
G5	IO222PDB3	
G6	GAC2/IO223PDB3	
G7	IO223NDB3	
G8	GNDQ	
G9	IO23RSB0	
G10	IO29RSB0	
G11	IO33RSB0	
G12	IO46RSB0	
G13	IO52RSB0	
G14	IO60RSB0	
G15	GNDQ	
G16	IO80NDB1	
G17	GBB2/IO79PDB1	
G18	IO79NDB1	
G19	IO82NPB1	
G20	IO85PDB1	
G21	IO85NDB1	
G22	NC	
H1	NC	
H2	NC	
Н3	V <sub>CC</sub>	
H4	IO217PDB3	
H5	IO218PDB3	
H6	IO221NDB3	
H7	IO221PDB3	
H8	VMV0	
H9	V <sub>CCI</sub> B0	
H10	V <sub>CCI</sub> B0	
H11	IO38RSB0	
H12	IO47RSB0	

484-Pin FBGA*	
Pin Number A3P1000 Function	
H13	V <sub>CCI</sub> B0
H14	V <sub>CCI</sub> B0
H15	VMV1
H16	GBC2/IO80PDB1
H17	IO83PPB1
H18	IO86PPB1
H19	IO87PDB1
H20	V <sub>CC</sub>
H21	NC
H22	NC
J1	IO212NDB3
J2	IO212PDB3
J3	NC
J4	IO217NDB3
J5	IO218NDB3
JG	IO216PDB3
J7	IO216NDB3
J8	V <sub>CCI</sub> B3
19	GND
J10	V <sub>CC</sub>
J11	V <sub>CC</sub>
J12	V <sub>CC</sub>
J13	V <sub>CC</sub>
J14	GND
J15	V <sub>CCI</sub> B1
J16	IO83NPB1
J17	IO86NPB1
J18	IO90PPB1
J19	IO87NDB1
J20	NC
J21	IO89PDB1
J22	IO89NDB1
K1	IO211PDB3
K2	IO211NDB3
К3	NC

48	4-Pin FBGA*	
Pin Number A3P1000 Function		
K4	IO210PPB3	
K5	IO213NDB3	
K6	IO213PDB3	
K7	GFC1/IO209PPB3	
K8	V <sub>CCI</sub> B3	
K9	V <sub>CC</sub>	
K10	GND	
K11	GND	
K12	GND	
K13	GND	
K14	V <sub>CC</sub>	
K15	V <sub>CCI</sub> B1	
K16	GCC1/IO91PPB1	
K17	IO90NPB1	
K18	IO88PDB1	
K19	IO88NDB1	
K20	IO94NPB1	
K21	IO98NDB1	
K22	IO98PDB1	
L1	NC	
L2	IO200PDB3	
L3	IO210NPB3	
L4	GFB0/IO208NPB3	
L5	GFA0/IO207NDB3	
L6	GFB1/IO208PPB3	
L7	V <sub>COMPLF</sub>	
L8	GFC0/IO209NPB3	
L9	V <sub>CC</sub>	
L10	GND	
L11	GND	
L12	GND	
L13	GND	
L14	V <sub>CC</sub>	
L15	GCC0/IO91NPB1	
L16	GCB1/IO92PPB1	

484-Pin FBGA*		
Pin Number A3P1000 Function		
L17	GCA0/IO93NPB1	
L18	IO96NPB1	
L19	GCB0/IO92NPB1	
L20	IO97PDB1	
L21	IO97NDB1	
L22	IO99NPB1	
M1	NC	
M2	IO200NDB3	
M3	IO206NDB3	
M4	GFA2/IO206PDB3	
M5	GFA1/IO207PDB3	
M6	V <sub>CCPLF</sub>	
M7	IO205NDB3	
M8	GFB2/IO205PDB3	
M9	V <sub>CC</sub>	
M10	GND	
M11	GND	
M12	GND	
M13	GND	
M14	V <sub>CC</sub>	
M15	GCB2/IO95PPB1	
M16	GCA1/IO93PPB1	
M17	GCC2/IO96PPB1	
M18	IO100PPB1	
M19	GCA2/IO94PPB1	
M20	IO101PPB1	
M21	IO99PPB1	
M22	NC	
N1	IO201NDB3	
N2	IO201PDB3	
N3	NC	
N4	GFC2/IO204PDB3	
N5	IO204NDB3	
N6	IO203NDB3	
N7	IO203PDB3	

484-Pin FBGA*		
Pin Number	A3P1000 Function	
N8	V <sub>CCI</sub> B3	
N9	V <sub>CC</sub>	
N10	GND	
N11	GND	
N12	GND	
N13	GND	
N14	V <sub>CC</sub>	
N15	V <sub>CCI</sub> B1	
N16	IO95NPB1	
N17	IO100NPB1	
N18	IO102NDB1	
N19	IO102PDB1	
N20	NC	
N21	IO101NPB1	
N22	IO103PDB1	
P1	NC	
P2	IO199PDB3	
P3	IO199NDB3	
P4	IO202NDB3	
P5	IO202PDB3	
P6	IO196PPB3	
P7	IO193PPB3	
P8	V <sub>CCI</sub> B3	
P9	GND	
P10	V <sub>CC</sub>	
P11	V <sub>CC</sub>	
P12	V <sub>CC</sub>	
P13	V <sub>CC</sub>	
P14	GND	
P15	V <sub>CCI</sub> B1	
P16	GDB0/IO112NPB1	
P17	IO106NDB1	
P18	IO106PDB1	
P19	IO107PDB1	
P20	NC	

484-Pin FBGA*		
Pin Number	A3P1000 Function	
P21	IO104PDB1	
P22	IO103NDB1	
R1	NC	
R2	IO197PPB3	
R3	V <sub>CC</sub>	
R4	IO197NPB3	
R5	IO196NPB3	
R6	IO193NPB3	
R7	GEC0/IO190NPB3	
R8	VMV3	
R9	V <sub>CCI</sub> B2	
R10	V <sub>CCI</sub> B2	
R11	IO147RSB2	
R12	IO136RSB2	
R13	V <sub>CCI</sub> B2	
R14	V <sub>CCI</sub> B2	
R15	VMV2	
R16	IO110NDB1	
R17	GDB1/IO112PPB1	
R18	GDC1/IO111PDB1	
R19	IO107NDB1	
R20	V <sub>CC</sub>	
R21	IO104NDB1	
R22	IO105PDB1	
T1	IO198PDB3	
T2	IO198NDB3	
Т3	NC	
T4	IO194PPB3	
T5	IO192PPB3	
T6	GEC1/IO190PPB3	
Τ7	IO192NPB3	
Т8	GNDQ	
Т9	GEA2/IO187RSB2	
T10	IO161RSB2	
T11	IO155RSB2	
	200 2 46	

484-Pin FBGA*		
Pin Number A3P1000 Function		
T12	IO141RSB2	
T13	IO129RSB2	
T14	IO124RSB2	
T15	GNDQ	
T16	IO110PDB1	
T17	V <sub>JTAG</sub>	
T18	GDC0/IO111NDB1	
T19	GDA1/IO113PDB1	
T20	NC	
T21	IO108PDB1	
T22	IO105NDB1	
U1	IO195PDB3	
U2	IO195NDB3	
U3	IO194NPB3	
U4	GEB1/IO189PDB3	
U5	GEB0/IO189NDB3	
U6	VMV2	
U7	IO179RSB2	
U8	IO171RSB2	
U9	IO165RSB2	
U10	IO159RSB2	
U11	IO151RSB2	
U12	IO137RSB2	
U13	IO134RSB2	
U14	IO128RSB2	
U15	VMV1	
U16	TCK	
U17	V <sub>PUMP</sub>	
U18	TRST	
U19	GDA0/IO113NDB1	
U20	NC	
U21	IO108NDB1	
U22	IO109PDB1	
V1	NC	
V2	NC	



484-Pin FBGA*		
Pin Number A3P1000 Function		
V3	GND	
V4	GEA1/IO188PDB3	
V5	GEA0/IO188NDB3	
V6	IO184RSB2	
V7	GEC2/IO185RSB2	
V8	IO168RSB2	
V9	IO163RSB2	
V10	IO157RSB2	
V11	IO149RSB2	
V12	IO143RSB2	
V13	IO138RSB2	
V14	IO131RSB2	
V15	IO125RSB2	
V16	GDB2/IO115RSB2	
V17	TDI	
V18	GNDQ	
V19	TDO	
V20	GND	
V21	NC	
V22	IO109NDB1	
W1	NC	
W2	IO191PDB3	
W3	NC	
W4	GND	
W5	IO183RSB2	
W6	GEB2/IO186RSB2	
W7	IO172RSB2	
W8	IO170RSB2	
W9	IO164RSB2	
W10	IO158RSB2	
W11	IO153RSB2	
W12	IO142RSB2	
W13	IO135RSB2	
W14	IO130RSB2	
W15	GDC2/IO116RSB2	

484-Pin FBGA*		
Pin Number	A3P1000 Function	
W16	IO120RSB2	
W17	GDA2/IO114RSB2	
W18	TMS	
W19	GND	
W20	NC	
W21	NC	
W22	NC	
Y1	V <sub>CCI</sub> B3	
Y2	IO191NDB3	
Y3	NC	
Y4	IO182RSB2	
Y5	GND	
Y6	IO177RSB2	
Y7	IO174RSB2	
Y8	V <sub>CC</sub>	
Y9	V <sub>CC</sub>	
Y10	IO154RSB2	
Y11	IO148RSB2	
Y12	IO140RSB2	
Y13	NC	
Y14	V <sub>CC</sub>	
Y15	V <sub>CC</sub>	
Y16	NC	
Y17	NC	
Y18	GND	
Y19	NC	
Y20	NC	
Y21	NC	
Y22	V <sub>CCI</sub> B1	

# **Datasheet Information**

# List of Changes

The following table lists critical changes that were made in the current version of the document.

<b>Previous Version</b>	Changes in Current Version (Advanced v0.5)	Page
Advanced v0.4	The "I/Os Per Package" was updated for the following devices and packagesDevicePackageA3P250/M7ACP250VQ100A3P250/M7ACP250FG144A3P1000FG256	ii
Advanced v0.3	M7 device information is new.	
	The I/O counts in the "I/Os Per Package" table were updated.	ii
	The "Security" section was updated to include information concerning M7 ProASIC3 AES support.	1-1
	In the "PLL and Clock Conditioning Circuitry (CCC)" section, the low jitter bullet was updated.	1-5
	Table 2-2 was updated to include the number of rows in each top or bottom spine.	2-11
	EXTFB was removed from Figure 2-14.	2-16
	The "PLL Macro" section was updated. EXTFB information was removed from this section.	2-17
	EXTFB was removed from Figure 2-17.	2-19
	The CCC Output Peak-to-Peak Period Jitter F <sub>CCC_OUT</sub> was updated in Table 2-4.	2-20
	EXTFB was removed from Figure 2-19.	
	The "Hot-Swap Support" section was updated.	2-35
	Table 2-15 was updated.	
	The "Cold-Sparing Support" section was updated.	2-36
	The "Electrostatic Discharge (ESD) Protection" section was updated.	2-36
	The LVPECL specification in Table 2-16 was updated.	2-36
	In the Bank 1 area of Figure 2-36, VMV2 was changed to VMV1 and $V_{CCI}B2$ was changed to $V_{CCI}B1.$	2-46
	The "JTAG Pins" were updated.	2-49
	The V <sub>JTAG</sub> and I/O pin descriptions were updated in the "Pin Descriptions" section	2-48
	The "128-Bit AES Decryption" section was updated to include M7 device information.	2-50
	Table 3-6 was updated.	3-4
	Table 3-7 was updated.	3-5
	In Table 3-10 PAC4 was updated.	3-6
	Table 3-17 was updated.	3-15
	The note in Table 3-23 was updated.	3-17
	All Timing Characteristic tables were updated from LVTTL to Register Delays.	3-19 to 3-44
	The Timing Characteristics for RAM4K9, RAM512X18, and FIFO were updated.	3-54 to 3-58
	The data for F <sub>TCKMAX</sub> was updated in Table 3-71.	3-59

Previous Version	Changes in Current Version (Advanced v0.5)	Page
Advanced v0.2	The A3P1000 table was updated in the "208-Pin PQFP*".	4-20
	The A3P1000 table was updated in the "144-Pin FBGA*".	4-27
	The A3P1000 table was updated in the "256-Pin FBGA*".	4-39
	The A3P1000 table was updated in the "484-Pin FBGA*".	4-53
	The "I/Os Per Package" table was updated.	ii
	The "Live at Power-Up" is new.	1-2
	Figure 2-5 was updated.	2-6
	The "Clock Resources (VersaNets)" was updated.	2-10
	The "VersaNet Global Networks and Spine Access" was updated.	2-12
	The "PLL Macro" was updated.	2-17
	Figure 2-17 was updated.	2-19
	Figure 2-19 was updated.	2-21
	Table 2-6 was updated.	2-26
	Table 2-7 was updated.	2-26
	The "FIFO Flag Usage Considerations" was updated.	2-29
	Table 2-13 was updated.	2-30
	Figure 2-23 was updated.	2-32
	The "Cold-Sparing Support" is new.	2-36
	Table 2-16 was updated.	2-36
	Table 2-18 was updated.	2-44
	The "User I/O Naming Convention" was updated.	2-46
	Pin descriptions in the "JTAG Pins" section on page 2-49 were updated.	2-48
	Table 3-7 was updated.	3-5
	The "Methodology" section was updated.	3-7
	Table 3-34 and Table 3-35 were updated.	3-23
	The A3P250 "100-Pin VQFP*" pin table was updated.	4-5
	The A3P250 "208-Pin PQFP*" pin table was updated.	4-16
	The A3P250 "144-Pin FBGA*" pin table was updated.	4-25
	The A3P250 "256-Pin FBGA*" pin table was updated.	4-28

# **Datasheet Categories**

In order to provide the latest information to designers, some datasheets are published before data has been fully characterized. Datasheets are designated as "Product Brief," "Advanced," "Production," and "Web-only." The definition of these categories are as follows:

# **Product Brief**

The product brief is a summarized version of a advanced datasheet (advanced or production) containing general product information. This brief gives an overview of specific device and family information.

# **Advanced**

This datasheet version contains initial estimated information based on simulation, other products, devices, or speed grades. This information can be used as estimates, but not for production.

# **Datasheet Supplement**

The datasheet supplement gives specific device information for a derivative family that differs from the general family datasheet. The supplement is to be used in conjunction with the datasheet to obtain more detailed information and for specifications that do not differ between the two families.

# **Unmarked (production)**

This datasheet version contains information that is considered to be final.

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